

**TOSHIBA**

**8 Bit Microcontroller  
TLCS-870/C Series**

**TMP86FS28DFG**

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### Revision History

Date	Revision	
2006/4/8	1	First Release
2006/6/29	2	Periodical updating.No change in contents.
2006/9/28	3	Contents Revised
2007/7/24	4	Contents Revised



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## 21. Package Dimensions

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This is a technical document that describes the operating functions and electrical specifications of the 8-bit microcontroller series TLCS-870/C (LSI).

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## CMOS 8-Bit Microcontroller

# TMP86FS28DFG

The TMP86FS28DFG is a single-chip 8-bit high-speed and high-functionality microcomputer incorporating 61440 bytes of Flash Memory. It is pin-compatible with the TMP86CS28DFG (Mask ROM version). The TMP86FS28DFG can realize operations equivalent to those of the TMP86CS28DFG by programming the on-chip Flash Memory.

Product No.	ROM (FLASH)	RAM	Package	MASK ROM MCU	Emulation Chip
TMP86FS28DFG	61440 bytes	2048 bytes	LQFP80-P-1212-0.50E	TMP86CS28DFG	TMP86C989XB

## 1.1 Features

- 8-bit single chip microcomputer TLCS-870/C series
  - Instruction execution time :
    - 0.25  $\mu$ s (at 16 MHz)
    - 122  $\mu$ s (at 32.768 kHz)
  - 132 types & 731 basic instructions
- 23interrupt sources (External : 6 Internal : 17)
- Input / Output ports (62 pins)
- Watchdog Timer
- Prescaler
  - Time base timer
  - Divider output function
- 16-bit timer counter: 2 ch
  - Timer, External trigger, Window, Pulse width measurement, Event counter, Programmable pulse generate (PPG) modes
- 8-bit timer counter : 4 ch
  - Timer, Event counter, Programmable divider output (PDO), Pulse width modulation (PWM) output,

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Programmable pulse generation (PPG) modes

8. 8-bit UART/SIO: 1 ch
9. 8-bit UART : 1 ch
10. 10-bit successive approximation type AD converter
  - Analog input: 8 ch
11. Key-on wakeup : 4 ch
12. LCD driver/controller

Built-in voltage booster for LCD driver With display memory  
 LCD direct drive capability (MAX 40 seg × 4 com)  
 1/4,1/3,1/2duties or static drive are programmably selectable

13. Clock operation

Single clock mode

Dual clock mode

14. Low power consumption operation

STOP mode: Oscillation stops. (Battery/Capacitor back-up.)

SLOW1 mode: Low power consumption operation using low-frequency clock.(High-frequency clock stop.)

SLOW2 mode: Low power consumption operation using low-frequency clock.(High-frequency clock oscillate.)

IDLE0 mode: CPU stops, and only the Time-Based-Timer(TBT) on peripherals operate using high frequency clock. Release by falling edge of the source clock which is set by TBTCCR<TBTCK>.

IDLE1 mode: CPU stops and peripherals operate using high frequency clock. Release by interrupts(CPU restarts).

IDLE2 mode: CPU stops and peripherals operate using high and low frequency clock. Release by interrupts. (CPU restarts).

SLEEP0 mode: CPU stops, and only the Time-Based-Timer(TBT) on peripherals operate using low frequency clock.Release by falling edge of the source clock which is set by TBTCCR<TBTCK>.

SLEEP1 mode: CPU stops, and peripherals operate using low frequency clock. Release by interrupt.(CPU restarts).

SLEEP2 mode: CPU stops and peripherals operate using high and low frequency clock. Release by interrupt.

15. Wide operation voltage:

2.7 V to 5.5 V at 8MHz /32.768 kHz

4.0 V to 5.5 V at 16 MHz /32.768 kHz

1.2 Pin Assignment

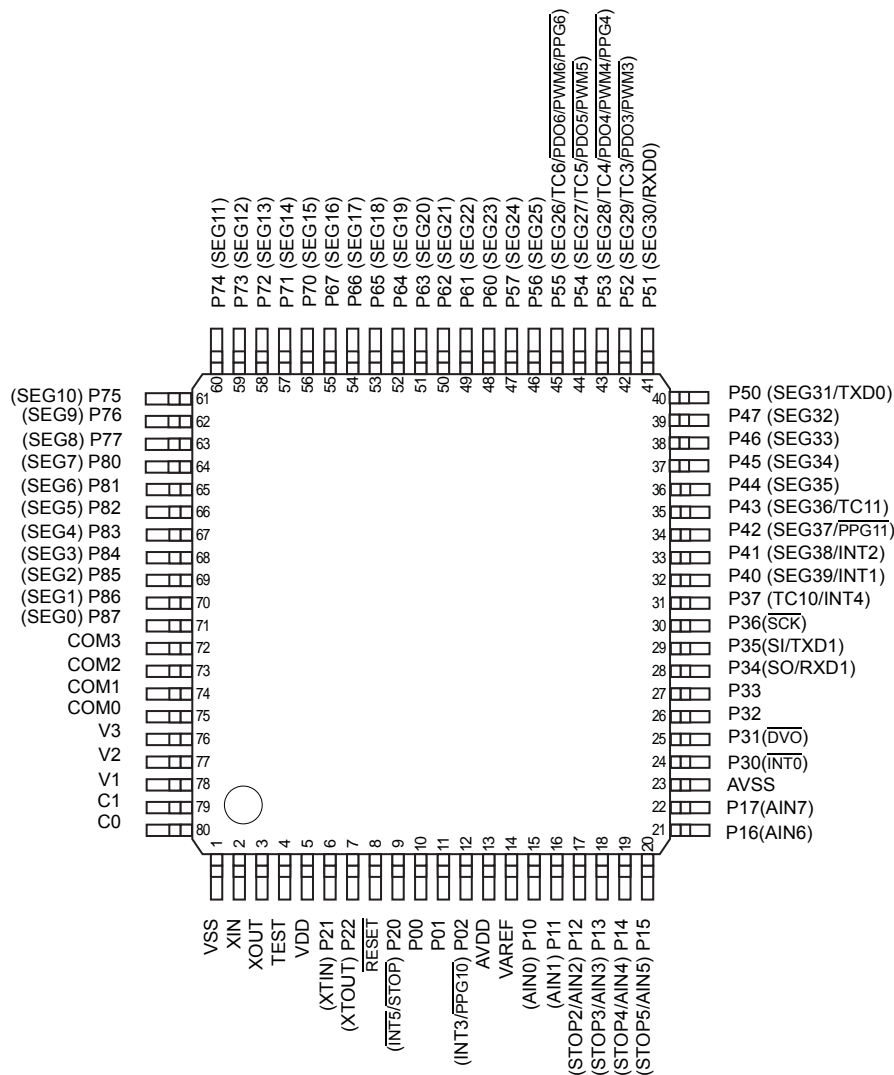


Figure 1-1 Pin Assignment

1.3 Block Diagram

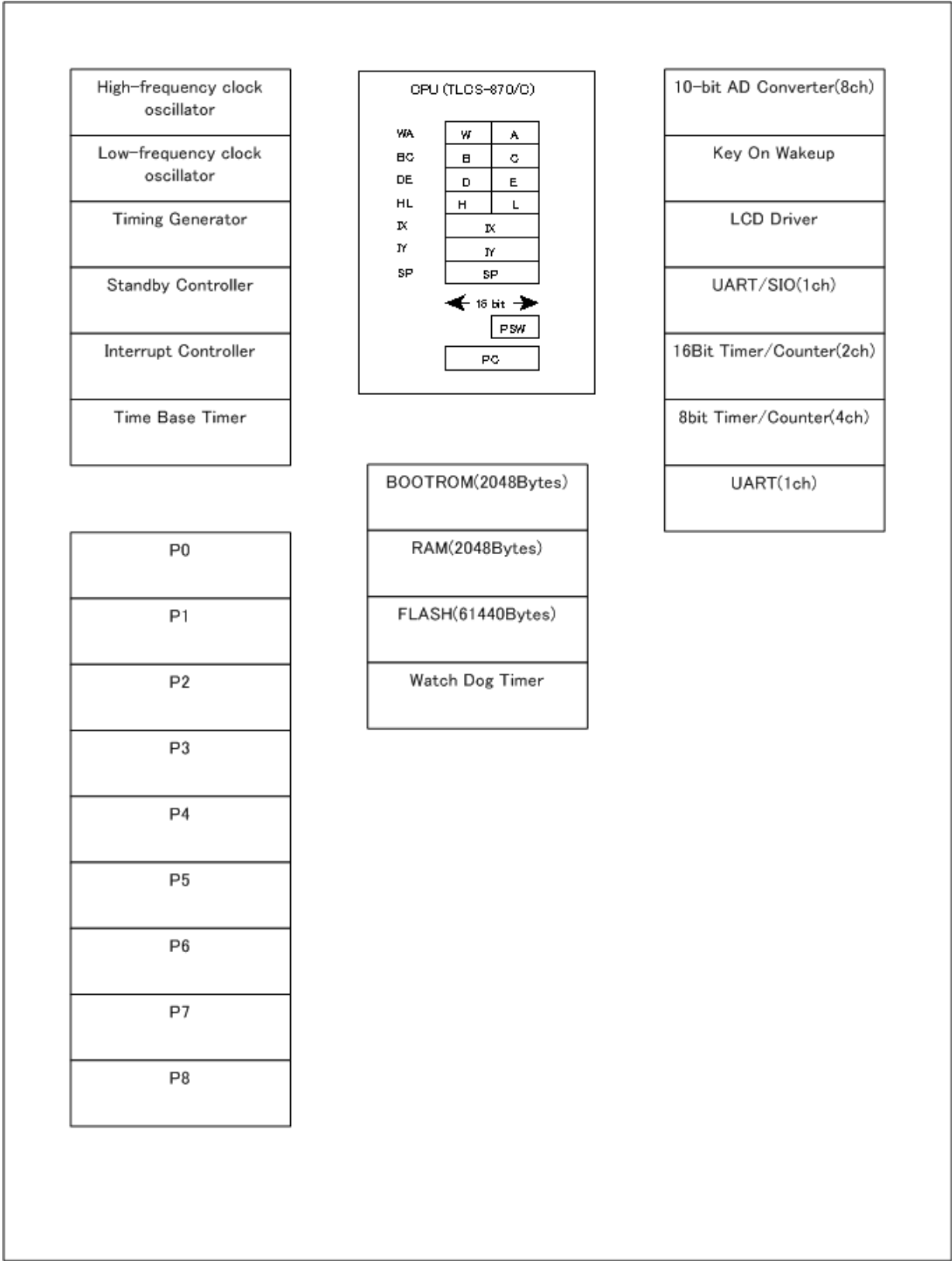


Figure 1-2 Block Diagram



## 1.4 Pin Names and Functions

The TMP86FS28DFG has MCU mode, parallel PROM mode, and serial PROM mode. Table 1-1 shows the pin functions in MCU mode. The serial PROM mode is explained later in a separate chapter.

Table 1-1 Pin Names and Functions(1/4)

Pin Name	Pin Number	Input/Output	Functions
P02 PPG10 INT3	12	IO O I	PORT02 PPG10 output External interrupt 3 input
P01	11	IO	PORT01
P00	10	IO	PORT00
P17 AIN7	22	IO I	PORT17 Analog Input7
P16 AIN6	21	IO I	PORT16 Analog Input6
P15 AIN5 STOP5	20	IO I I	PORT15 Analog Input5 STOP5 input
P14 AIN4 STOP4	19	IO I I	PORT14 Analog Input4 STOP4 input
P13 AIN3 STOP3	18	IO I I	PORT13 Analog Input3 STOP3 input
P12 AIN2 STOP2	17	IO I I	PORT12 Analog Input2 STOP2 input
P11 AIN1	16	IO I	PORT11 Analog Input1
P10 AIN0	15	IO I	PORT10 Analog Input0
P22 XTOUT	7	IO O	PORT22 Resonator connecting pins(32.768kHz) for inputting external clock
P21 XTIN	6	IO I	PORT21 Resonator connecting pins(32.768kHz) for inputting external clock
P20 STOP INT5	9	IO I I	PORT20 STOP mode release signal input External interrupt 5 input
P37 TC10 INT4	31	IO I I	PORT37 TC10 input External interrupt 4 input
P36 SCK	30	IO IO	PORT36 Serial Clock I/O
P35 SI TXD1	29	IO I O	PORT35 Serial Data Input UART data output 1
P34 SO RXD1	28	IO O I	PORT34 Serial Data Output UART data input 1

Table 1-1 Pin Names and Functions(2/4)

Pin Name	Pin Number	Input/Output	Functions
P33	27	IO	PORT33
P32	26	IO	PORT32
P31 DVO	25	IO O	PORT31 Divider Output
P30 INT0	24	IO I	PORT30 External interrupt 0 input
P47 SEG32	39	IO O	PORT47 LCD segment output 32
P46 SEG33	38	IO O	PORT46 LCD segment output 33
P45 SEG34	37	IO O	PORT45 LCD segment output 34
P44 SEG35	36	IO O	PORT44 LCD segment output 35
P43 SEG36 TC11	35	IO O I	PORT43 LCD segment output 36 TC11 input
P42 SEG37 PPG11	34	IO O O	PORT42 LCD segment output 37 PPG11 output
P41 SEG38 INT2	33	IO O I	PORT41 LCD segment output 38 External interrupt 2 input
P40 SEG39 INT1	32	IO O I	PORT40 LCD segment output 39 External interrupt 1 input
P57 SEG24	47	IO O	PORT57 LCD segment output 24
P56 SEG25	46	IO O	PORT56 LCD segment output 25
P55 SEG26 TC6 PDO6/PWM6/PPG6	45	IO O I O	PORT55 LCD segment output 26 TC6 input PDO6/PWM6/PPG6 output
P54 SEG27 TC5 PDO5/PWM5	44	IO O I O	PORT54 LCD segment output 27 TC5 input PDO5/PWM5 output
P53 SEG28 TC4 PDO4/PWM4/PPG4	43	IO O I O	PORT53 LCD segment output 28 TC4 input PDO4/PWM4/PPG4 output
P52 SEG29 TC3 PDO3/PWM3	42	IO O I O	PORT52 LCD segment output 29 TC3 input
P51 SEG30 RXD0	41	IO O I	PORT51 LCD segment output 30 UART data input 0

Table 1-1 Pin Names and Functions(3/4)

Pin Name	Pin Number	Input/Output	Functions
P50 SEG31 TXD0	40	IO O O	PORT50 LCD segment output 31 UART data output 0
P67 SEG16	55	IO O	PORT67 LCD segment output 16
P66 SEG17	54	IO O	PORT66 LCD segment output 17
P65 SEG18	53	IO O	PORT65 LCD segment output 18
P64 SEG19	52	IO O	PORT64 LCD segment output 19
P63 SEG20	51	IO O	PORT63 LCD segment output 20
P62 SEG21	50	IO O	PORT62 LCD segment output 21
P61 SEG22	49	IO O	PORT61 LCD segment output 22
P60 SEG23	48	IO O	PORT60 LCD segment output 23
P77 SEG8	63	IO O	PORT77 LCD segment output 8
P76 SEG9	62	IO O	PORT76 LCD segment output 9
P75 SEG10	61	IO O	PORT75 LCD segment output 10
P74 SEG11	60	IO O	PORT74 LCD segment output 11
P73 SEG12	59	IO O	PORT73 LCD segment output 12
P72 SEG13	58	IO O	PORT72 LCD segment output 13
P71 SEG14	57	IO O	PORT71 LCD segment output 14
P70 SEG15	56	IO O	PORT70 LCD segment output 15
P87 SEG0	71	IO O	PORT87 LCD segment output 0
P86 SEG1	70	IO O	PORT86 LCD segment output 1
P85 SEG2	69	IO O	PORT85 LCD segment output 2
P84 SEG3	68	IO O	PORT84 LCD segment output 3
P83 SEG4	67	IO O	PORT83 LCD segment output 4
P82 SEG5	66	IO O	PORT82 LCD segment output 5

Table 1-1 Pin Names and Functions(4/4)

Pin Name	Pin Number	Input/Output	Functions
P81 SEG6	65	IO O	PORT81 LCD segment output 6
P80 SEG7	64	IO O	PORT80 LCD segment output 7
COM3	72	O	LCD common output 3
COM2	73	O	LCD common output 2
COM1	74	O	LCD common output 1
COM0	75	O	LCD common output 0
V3	76	I	LCD voltage booster pin
V2	77	I	LCD voltage booster pin
V1	78	I	LCD voltage booster pin
C1	79	I	LCD voltage booster pin
C0	80	I	LCD voltage booster pin
XIN	2	I	Resonator connecting pins for high-frequency clock
XOUT	3	O	Resonator connecting pins for high-frequency clock
RESET	8	I	Reset signal
TEST	4	I	Test pin for out-going test. Normally, be fixed to low.
VAREF	14	I	Analog Base Voltage Input Pin for A/D Conversion
AVDD	13	I	Analog Power Supply
AVSS	23	I	Analog Power Supply
VDD	5	I	+5V
VSS	1	I	0(GND)

# 2. Operational Description

## 2.1 CPU Core Functions

The CPU core consists of a CPU, a system clock controller, and an interrupt controller.

This section provides a description of the CPU core, the program memory, the data memory, and the reset circuit.

### 2.1.1 Memory Address Map

The TMP86FS28DFG memory is composed Flash, RAM, DBR(Data buffer register) and SFR(Special function register). They are all mapped in 64-Kbyte address space. Figure 2-1 shows the TMP86FS28DFG memory address map.

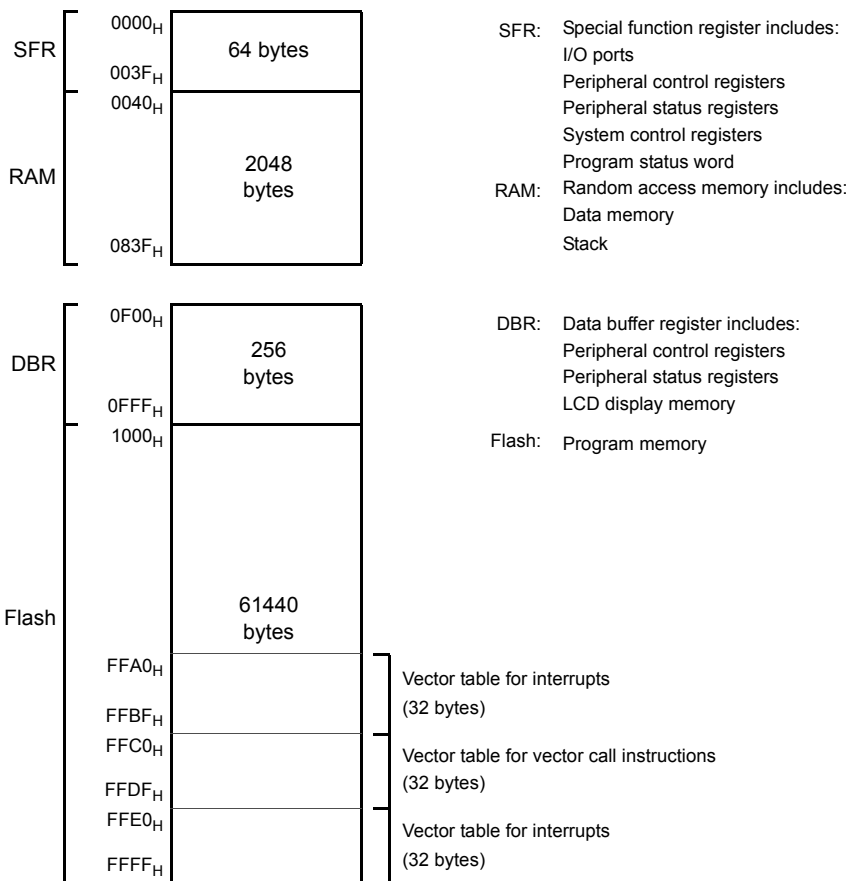


Figure 2-1 Memory Address Map

### 2.1.2 Program Memory (Flash)

The TMP86FS28DFG has a 61440 bytes (Address 1000H to FFFFH) of program memory (Flash ).

### 2.1.3 Data Memory (RAM)

The TMP86FS28DFG has 2048 bytes (Address 0040H to 083FH) of internal RAM. The first 192 bytes (0040H to 00FFH) of the internal RAM are located in the direct area; instructions with shorten operations are available against such an area.

The data memory contents become unstable when the power supply is turned on; therefore, the data memory should be initialized by an initialization routine.

Example :Clears RAM to “00H”. (TMP86FS28DFG)

	LD	HL, 0040H	; Start address setup
	LD	A, H	; Initial value (00H) setup
	LD	BC, 07FFH	
SRAMCLR:	LD	(HL), A	
	INC	HL	
	DEC	BC	
	JRS	F, SRAMCLR	

## 2.2 System Clock Controller

The system clock controller consists of a clock generator, a timing generator, and a standby controller.

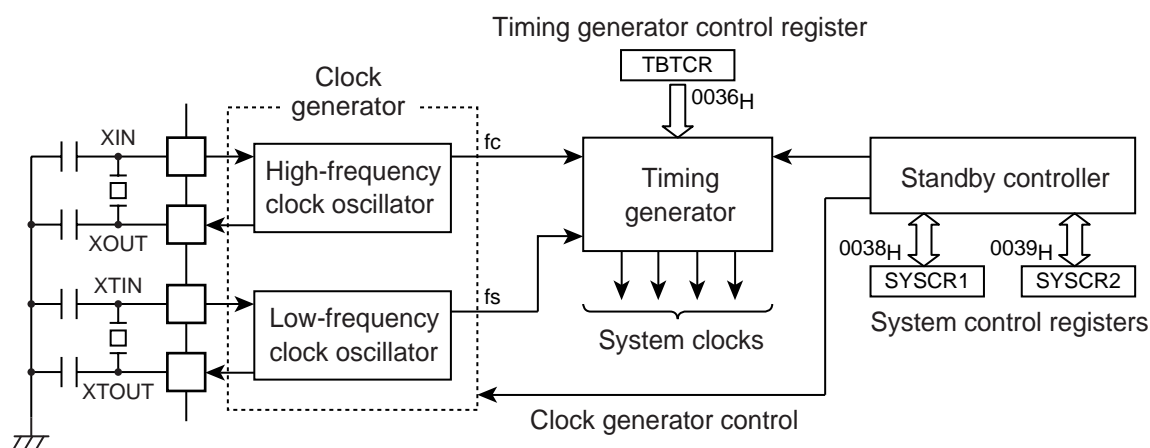


Figure 2-2 System Colck Control

### 2.2.1 Clock Generator

The clock generator generates the basic clock which provides the system clocks supplied to the CPU core and peripheral hardware. It contains two oscillation circuits: One for the high-frequency clock and one for the low-frequency clock. Power consumption can be reduced by switching of the standby controller to low-power operation based on the low-frequency clock.

The high-frequency (fc) clock and low-frequency (fs) clock can easily be obtained by connecting a resonator between the XIN/XOUT and XTIN/XTOUT pins respectively. Clock input from an external oscillator is also possible. In this case, external clock is applied to XIN/XTIN pin with XOUT/XTOUT pin not connected.

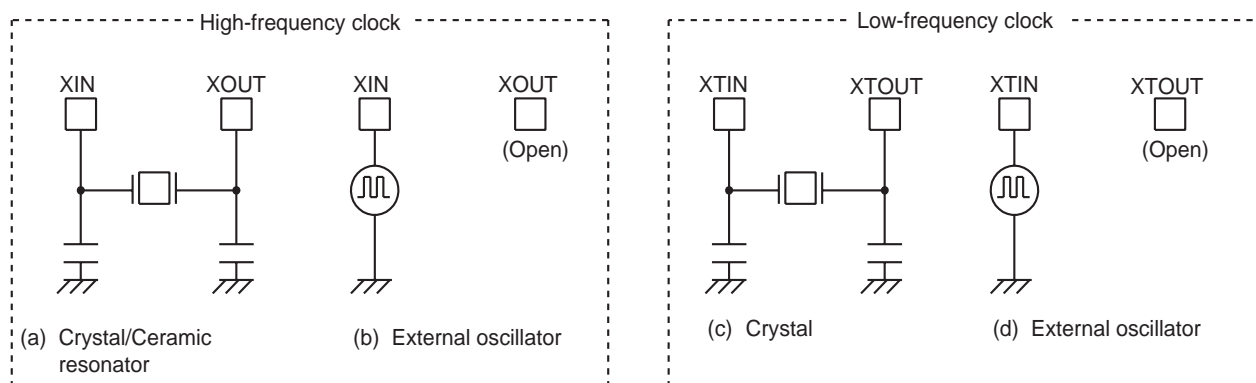


Figure 2-3 Examples of Resonator Connection

Note: The function to monitor the basic clock directly at external is not provided for hardware, however, with disabling all interrupts and watchdog timers, the oscillation frequency can be adjusted by monitoring the pulse which the fixed frequency is outputted to the port by the program.  
The system to require the adjustment of the oscillation frequency should create the program for the adjustment in advance.

## 2.2.2 Timing Generator

The timing generator generates the various system clocks supplied to the CPU core and peripheral hardware from the basic clock (fc or fs). The timing generator provides the following functions.

1. Generation of main system clock
2. Generation of divider output ( $\overline{DVO}$ ) pulses
3. Generation of source clocks for time base timer
4. Generation of source clocks for watchdog timer
5. Generation of internal source clocks for timer/counters
6. Generation of warm-up clocks for releasing STOP mode
7. LCD

### 2.2.2.1 Configuration of timing generator

The timing generator consists of a 2-stage prescaler, a 21-stage divider, a main system clock generator, and machine cycle counters.

An input clock to the 7th stage of the divider depends on the operating mode, SYSCR2<SYSCK> and TBTCR<DV7CK>, that is shown in Figure 2-4. As reset and STOP mode started/canceled, the prescaler and the divider are cleared to “0”.

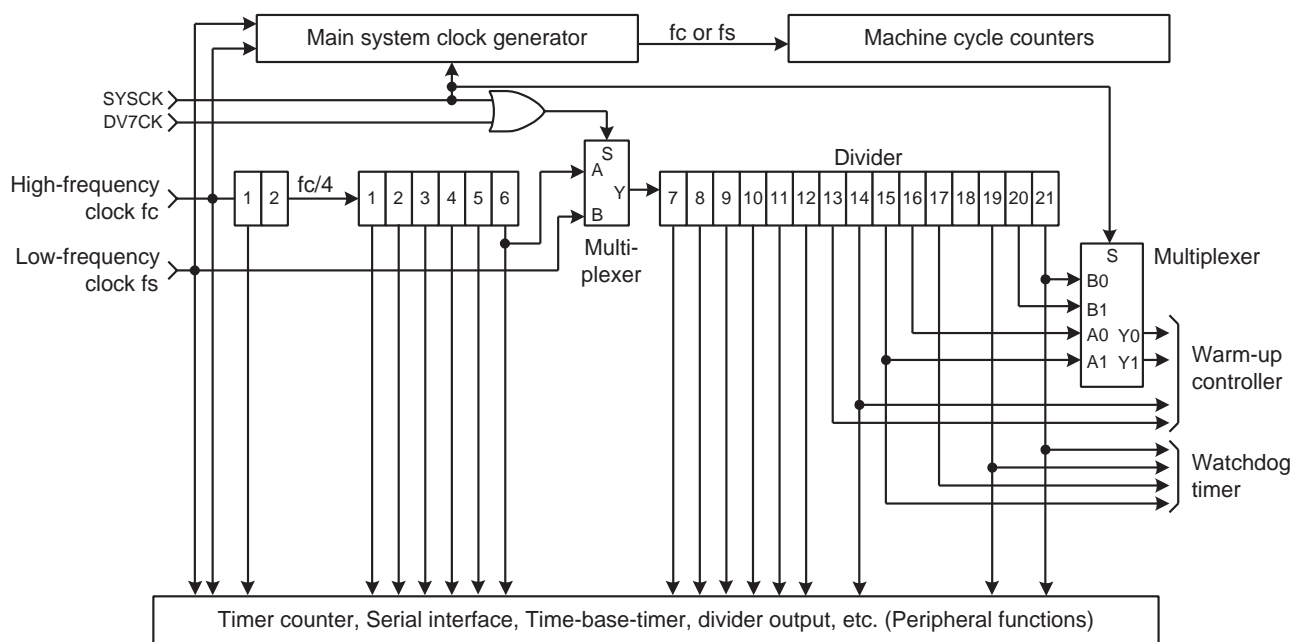


Figure 2-4 Configuration of Timing Generator



Timing Generator Control Register

TBTCR (0036H)	7	6	5	4	3	2	1	0	
	(DVOEN)	(DVOCK)	DV7CK	(TBTEN)	(TBTCK)				(Initial value: 0000 0000)
	DV7CK	Selection of input to the 7th stage of the divider			0: $f_c/2^8$ [Hz] 1: fs				R/W

- Note 1: In single clock mode, do not set DV7CK to “1”.
- Note 2: Do not set “1” on DV7CK while the low-frequency clock is not operated stably.
- Note 3:  $f_c$ : High-frequency clock [Hz],  $f_s$ : Low-frequency clock [Hz], \*: Don't care
- Note 4: In SLOW1/2 and SLEEP1/2 modes, the DV7CK setting is ineffective, and  $f_s$  is input to the 7th stage of the divider.
- Note 5: When STOP mode is entered from NORMAL1/2 mode, the DV7CK setting is ineffective during the warm-up period after release of STOP mode, and the 6th stage of the divider is input to the 7th stage during this period.

2.2.2.2 Machine cycle

Instruction execution and peripheral hardware operation are synchronized with the main system clock.

The minimum instruction execution unit is called an “machine cycle”. There are a total of 10 different types of instructions for the TLCS-870/C Series: Ranging from 1-cycle instructions which require one machine cycle for execution to 10-cycle instructions which require 10 machine cycles for execution. A machine cycle consists of 4 states (S0 to S3), and each state consists of one main system clock.

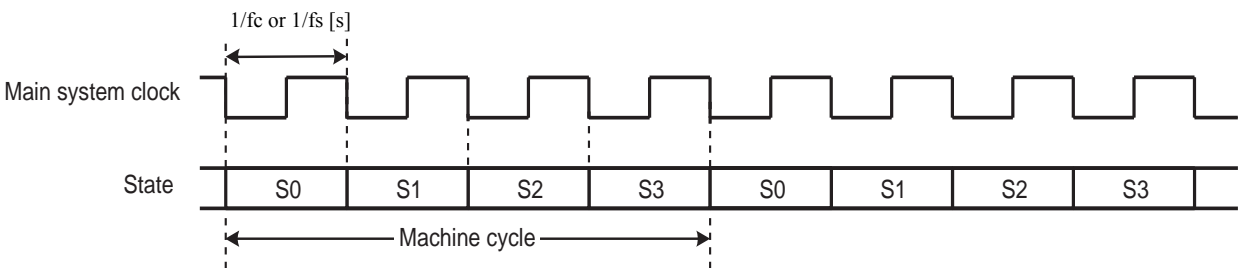


Figure 2-5 Machine Cycle

2.2.3 Operation Mode Control Circuit

The operation mode control circuit starts and stops the oscillation circuits for the high-frequency and low-frequency clocks, and switches the main system clock. There are three operating modes: Single clock mode, dual clock mode and STOP mode. These modes are controlled by the system control registers (SYSCR1 and SYSCR2). Figure 2-6 shows the operating mode transition diagram.

2.2.3.1 Single-clock mode

Only the oscillation circuit for the high-frequency clock is used, and P21 (XTIN) and P22 (XTOUT) pins are used as input/output ports. The main-system clock is obtained from the high-frequency clock. In the single-clock mode, the machine cycle time is  $4/f_c$  [s].

(1) NORMAL1 mode

In this mode, both the CPU core and on-chip peripherals operate using the high-frequency clock. The TMP86FS28DFG is placed in this mode after reset.

## (2) IDLE1 mode

In this mode, the internal oscillation circuit remains active. The CPU and the watchdog timer are halted; however on-chip peripherals remain active (Operate using the high-frequency clock).

IDLE1 mode is started by `SYSCR2<IDLE> = "1"`, and IDLE1 mode is released to NORMAL1 mode by an interrupt request from the on-chip peripherals or external interrupt inputs. When the IMF (Interrupt master enable flag) is "1" (Interrupt enable), the execution will resume with the acceptance of the interrupt, and the operation will return to normal after the interrupt service is completed. When the IMF is "0" (Interrupt disable), the execution will resume with the instruction which follows the IDLE1 mode start instruction.

## (3) IDLE0 mode

In this mode, all the circuit, except oscillator and the timer-base-timer, stops operation.

This mode is enabled by `SYSCR2<TGHALT> = "1"`.

When IDLE0 mode starts, the CPU stops and the timing generator stops feeding the clock to the peripheral circuits other than TBT. Then, upon detecting the falling edge of the source clock selected with `TBTCR<TBTCK>`, the timing generator starts feeding the clock to all peripheral circuits.

When returned from IDLE0 mode, the CPU restarts operating, entering NORMAL1 mode back again. IDLE0 mode is entered and returned regardless of how `TBTCR<TBTEN>` is set. When IMF = "1", EF6 (TBT interrupt individual enable flag) = "1", and `TBTCR<TBTEN> = "1"`, interrupt processing is performed. When IDLE0 mode is entered while `TBTCR<TBTEN> = "1"`, the INTTBT interrupt latch is set after returning to NORMAL1 mode.

### 2.2.3.2 Dual-clock mode

Both the high-frequency and low-frequency oscillation circuits are used in this mode. P21 (XTIN) and P22 (XTOUT) pins cannot be used as input/output ports. The main system clock is obtained from the high-frequency clock in NORMAL2 and IDLE2 modes, and is obtained from the low-frequency clock in SLOW and SLEEP modes. The machine cycle time is  $4/f_c$  [s] in the NORMAL2 and IDLE2 modes, and  $4/f_s$  [s] (122  $\mu$ s at  $f_s = 32.768$  kHz) in the SLOW and SLEEP modes.

The TLCS-870/C is placed in the signal-clock mode during reset. To use the dual-clock mode, the low-frequency oscillator should be turned on at the start of a program.

## (1) NORMAL2 mode

In this mode, the CPU core operates with the high-frequency clock. On-chip peripherals operate using the high-frequency clock and/or low-frequency clock.

## (2) SLOW2 mode

In this mode, the CPU core operates with the low-frequency clock, while both the high-frequency clock and the low-frequency clock are operated. As the `SYSCR2<SYSCK>` becomes "1", the hardware changes into SLOW2 mode. As the `SYSCR2<SYSCK>` becomes "0", the hardware changes into NORMAL2 mode. As the `SYSCR2<XEN>` becomes "0", the hardware changes into SLOW1 mode. Do not clear `SYSCR2<XTEN>` to "0" during SLOW2 mode.

## (3) SLOW1 mode

This mode can be used to reduce power-consumption by turning off oscillation of the high-frequency clock. The CPU core and on-chip peripherals operate using the low-frequency clock.

Switching back and forth between SLOW1 and SLOW2 modes are performed by SYSCR2<XEN>. In SLOW1 and SLEEP modes, the input clock to the 1st stage of the divider is stopped; output from the 1st to 6th stages is also stopped.

#### (4) IDLE2 mode

In this mode, the internal oscillation circuit remain active. The CPU and the watchdog timer are halted; however, on-chip peripherals remain active (Operate using the high-frequency clock and/or the low-frequency clock). Starting and releasing of IDLE2 mode are the same as for IDLE1 mode, except that operation returns to NORMAL2 mode.

#### (5) SLEEP1 mode

In this mode, the internal oscillation circuit of the low-frequency clock remains active. The CPU, the watchdog timer, and the internal oscillation circuit of the high-frequency clock are halted; however, on-chip peripherals remain active (Operate using the low-frequency clock). Starting and releasing of SLEEP mode are the same as for IDLE1 mode, except that operation returns to SLOW1 mode. In SLOW1 and SLEEP1 modes, the input clock to the 1st stage of the divider is stopped; output from the 1st to 6th stages is also stopped.

#### (6) SLEEP2 mode

The SLEEP2 mode is the idle mode corresponding to the SLOW2 mode. The status under the SLEEP2 mode is same as that under the SLEEP1 mode, except for the oscillation circuit of the high-frequency clock.

#### (7) SLEEP0 mode

In this mode, all the circuit, except oscillator and the timer-base-timer, stops operation. This mode is enabled by setting “1” on bit SYSCR2<TGHALT>.

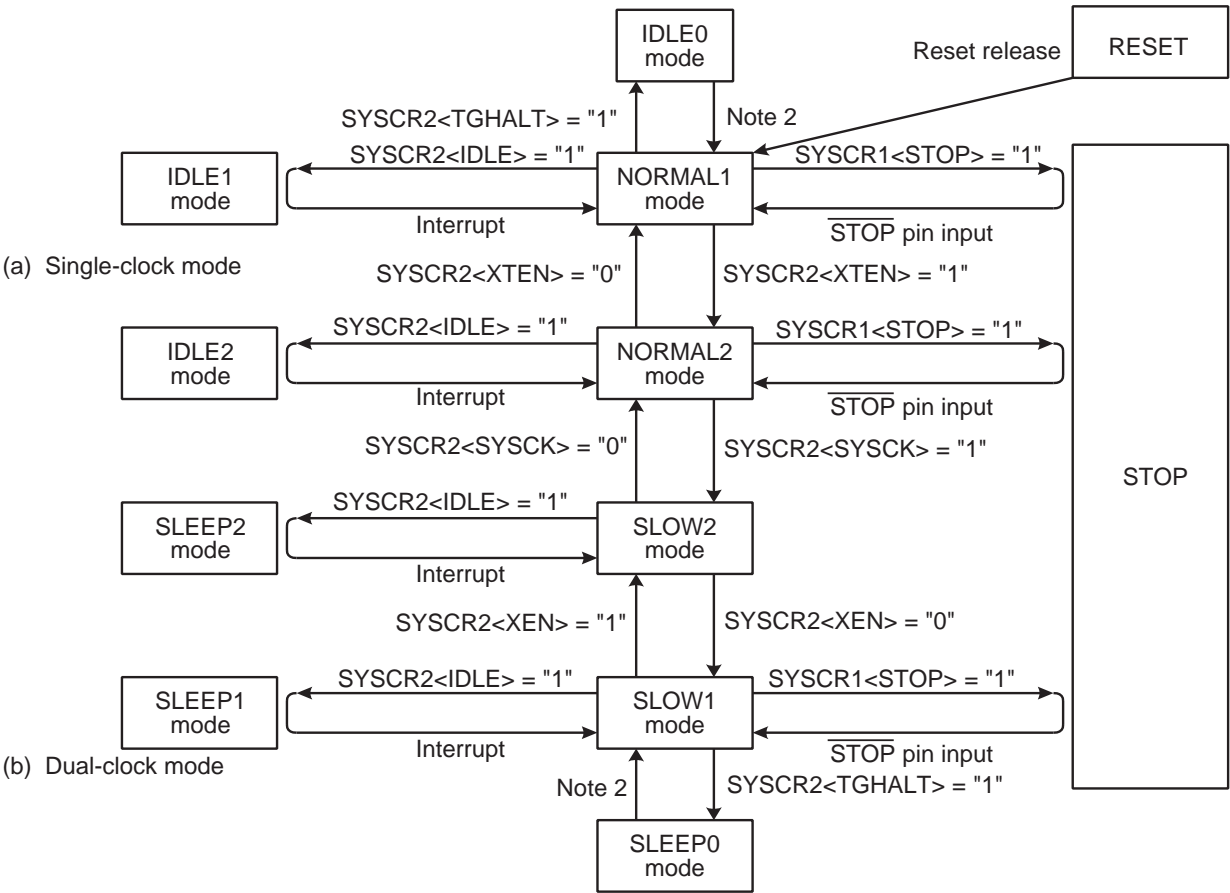
When SLEEP0 mode starts, the CPU stops and the timing generator stops feeding the clock to the peripheral circuits other than TBT. Then, upon detecting the falling edge of the source clock selected with TBTCR<TBTC>, the timing generator starts feeding the clock to all peripheral circuits.

When returned from SLEEP0 mode, the CPU restarts operating, entering SLOW1 mode back again. SLEEP0 mode is entered and returned regardless of how TBTCR<TBTEN> is set. When IMF = “1”, EF6 (TBT interrupt individual enable flag) = “1”, and TBTCR<TBTEN> = “1”, interrupt processing is performed. When SLEEP0 mode is entered while TBTCR<TBTEN> = “1”, the INTTBT interrupt latch is set after returning to SLOW1 mode.

### 2.2.3.3 STOP mode

In this mode, the internal oscillation circuit is turned off, causing all system operations to be halted. The internal status immediately prior to the halt is held with a lowest power consumption during STOP mode.

STOP mode is started by the system control register 1 (SYSCR1), and STOP mode is released by a inputting (Either level-sensitive or edge-sensitive can be programmably selected) to the STOP pin. After the warm-up period is completed, the execution resumes with the instruction which follows the STOP mode start instruction.



Note 1: NORMAL1 and NORMAL2 modes are generically called NORMAL; SLOW1 and SLOW2 are called SLOW; IDLE0, IDLE1 and IDLE2 are called IDLE; SLEEP0, SLEEP1 and SLEEP2 are called SLEEP.  
Note 2: The mode is released by falling edge of TBTCCR<TBTCK> setting.

Figure 2-6 Operating Mode Transition Diagram

Table 2-1 Operating Mode and Conditions

Operating Mode		Oscillator		CPU Core	TBT	Other Peripherals	Machine Cycle Time		
		High Frequency	Low Frequency						
Single clock	RESET	Oscillation	Stop	Reset	Reset	Reset	4/fc [s]		
	NORMAL1			Operate	Operate	Operate			
	IDLE1			Halt		Halt			
	IDLE0								
	STOP	Stop	Halt	Halt	–				
Dual clock	NORMAL2	Oscillation	Oscillation	Operate with high frequency	Operate	Operate	4/fc [s]		
	IDLE2			Halt					
	SLOW2			Operate with low frequency					
	SLEEP2			Halt					
	SLOW1	Stop		Operate with low frequency			Halt	Halt	4/fs [s]
	SLEEP1								
	SLEEP0								
	STOP			Stop	Halt	–			

## System Control Register 1

SYSCR1	7	6	5	4	3	2	1	0	
(0038H)	STOP	RELM	RETM	OUTEN	WUT				(Initial value: 0000 00**)

STOP	STOP mode start	0: CPU core and peripherals remain active 1: CPU core and peripherals are halted (Start STOP mode)			R/W
RELM	Release method for STOP mode	0: Edge-sensitive release 1: Level-sensitive release			R/W
RETM	Operating mode after STOP mode	0: Return to NORMAL1/2 mode 1: Return to SLOW1 mode			R/W
OUTEN	Port output during STOP mode	0: High impedance 1: Output kept			R/W
WUT	Warm-up time at releasing STOP mode		Return to NORMAL mode	Return to SLOW mode	R/W
		00	$3 \times 2^{16}/f_c$	$3 \times 2^{13}/f_s$	
		01	$2^{16}/f_c$	$2^{13}/f_s$	
		10	$3 \times 2^{14}/f_c$	$3 \times 2^6/f_s$	
		11	$2^{14}/f_c$	$2^6/f_s$	

Note 1: Always set RETM to "0" when transiting from NORMAL mode to STOP mode. Always set RETM to "1" when transiting from SLOW mode to STOP mode.

Note 2: When STOP mode is released with  $\overline{\text{RESET}}$  pin input, a return is made to NORMAL1 regardless of the RETM contents.

Note 3: fc: High-frequency clock [Hz], fs: Low-frequency clock [Hz], \*: Don't care

Note 4: Bits 1 and 0 in SYSCR1 are read as undefined data when a read instruction is executed.

Note 5: As the hardware becomes STOP mode under OUTEN = "0", input value is fixed to "0"; therefore it may cause external interrupt request on account of falling edge.

Note 6: When the key-on wakeup is used, RELM should be set to "1".

Note 7: Port P20 is used as  $\overline{\text{STOP}}$  pin. Therefore, when stop mode is started, OUTEN does not affect to P20, and P20 becomes High-Z mode.

Note 8: The warmig-up time should be set correctly for using oscillator.

## System Control Register 2

SYSCR2	7	6	5	4	3	2	1	0	
(0039H)	XEN	XTEN	SYSCK	IDLE		TGHALT			(Initial value: 1000 *0**)

XEN	High-frequency oscillator control	0: Turn off oscillation 1: Turn on oscillation	R/W
XTEN	Low-frequency oscillator control	0: Turn off oscillation 1: Turn on oscillation	
SYSCK	Main system clock select (Write)/main system clock monitor (Read)	0: High-frequency clock (NORMAL1/NORMAL2/IDLE1/IDLE2) 1: Low-frequency clock (SLOW1/SLOW2/SLEEP1/SLEEP2)	
IDLE	CPU and watchdog timer control (IDLE1/2 and SLEEP1/2 modes)	0: CPU and watchdog timer remain active 1: CPU and watchdog timer are stopped (Start IDLE1/2 and SLEEP1/2 modes)	R/W
TGHALT	TG control (IDLE0 and SLEEP0 modes)	0: Feeding clock to all peripherals from TG 1: Stop feeding clock to peripherals except TBT from TG. (Start IDLE0 and SLEEP0 modes)	

Note 1: A reset is applied if both XEN and XTEN are cleared to "0", XEN is cleared to "0" when SYSCK = "0", or XTEN is cleared to "0" when SYSCK = "1".

Note 2: \*: Don't care, TG: Timing generator, \*: Don't care

Note 3: Bits 3, 1 and 0 in SYSCR2 are always read as undefined value.

Note 4: Do not set IDLE and TGHALT to "1" simultaneously.

Note 5: Because returning from IDLE0/SLEEP0 to NORMAL1/SLOW1 is executed by the asynchronous internal clock, the period of IDLE0/SLEEP0 mode might be shorter than the period setting by  $\text{TBTCTCR} < \text{TBTCK} >$ .

Note 6: When IDLE1/2 or SLEEP1/2 mode is released, IDLE is automatically cleared to "0".

Note 7: When IDLE0 or SLEEP0 mode is released, TGHALT is automatically cleared to "0".

Note 8: Before setting TGHALT to "1", be sure to stop peripherals. If peripherals are not stopped, the interrupt latch of peripherals may be set after IDLE0 or SLEEP0 mode is released.

## 2.2.4 Operating Mode Control

### 2.2.4.1 STOP mode

STOP mode is controlled by the system control register 1, the  $\overline{\text{STOP}}$  pin input and key-on wakeup input (STOP5 to STOP2) which is controlled by the STOP mode release control register (STOPCR).

The  $\overline{\text{STOP}}$  pin is also used both as a port P20 and an  $\overline{\text{INT5}}$  (external interrupt input 5) pin. STOP mode is started by setting SYSCR1<STOP> to “1”. During STOP mode, the following status is maintained.

1. Oscillations are turned off, and all internal operations are halted.
2. The data memory, registers, the program status word and port output latches are all held in the status in effect before STOP mode was entered.
3. The prescaler and the divider of the timing generator are cleared to “0”.
4. The program counter holds the address 2 ahead of the instruction (e.g., [SET (SYSCR1).7]) which started STOP mode.

STOP mode includes a level-sensitive mode and an edge-sensitive mode, either of which can be selected with the SYSCR1<RELM>. Do not use any key-on wakeup input (STOP5 to STOP2) for releasing STOP mode in edge-sensitive mode.

Note 1: The STOP mode can be released by either the STOP or key-on wakeup pin (STOP5 to STOP2). However, because the STOP pin is different from the key-on wakeup and can not inhibit the release input, the STOP pin must be used for releasing STOP mode.

Note 2: During STOP period (from start of STOP mode to end of warm up), due to changes in the external interrupt pin signal, interrupt latches may be set to “1” and interrupts may be accepted immediately after STOP mode is released. Before starting STOP mode, therefore, disable interrupts. Also, before enabling interrupts after STOP mode is released, clear unnecessary interrupt latches.

#### (1) Level-sensitive release mode (RELM = “1”)

In this mode, STOP mode is released by setting the  $\overline{\text{STOP}}$  pin high or setting the STOP5 to STOP2 pin input which is enabled by STOPCR. This mode is used for capacitor backup when the main power supply is cut off and long term battery backup.

Even if an instruction for starting STOP mode is executed while  $\overline{\text{STOP}}$  pin input is high or STOP5 to STOP2 input is low, STOP mode does not start but instead the warm-up sequence starts immediately. Thus, to start STOP mode in the level-sensitive release mode, it is necessary for the program to first confirm that the  $\overline{\text{STOP}}$  pin input is low or STOP5 to STOP2 input is high. The following two methods can be used for confirmation.

1. Testing a port.
2. Using an external interrupt input  $\overline{\text{INT5}}$  ( $\overline{\text{INT5}}$  is a falling edge-sensitive input).

Example 1 :Starting STOP mode from NORMAL mode by testing a port P20.

	LD	(SYSCR1). 01010000B	; Sets up the level-sensitive release mode
SSTOPH:	TEST	(P2PRD). 0	; Wait until the $\overline{\text{STOP}}$ pin input goes low level
	JRS	F, SSTOPH	
	DI		; IMF ← 0
	SET	(SYSCR1). 7	; Starts STOP mode

Example 2 :Starting STOP mode from NORMAL mode with an INT5 interrupt.

```
PINT5:      TEST      (P2PRD). 0      ; To reject noise, STOP mode does not start if
           JRS        F, SINT5        port P20 is at high
           LD         (SYSCR1), 01010000B ; Sets up the level-sensitive release mode.
           DI         ; IMF ← 0
           SET        (SYSCR1). 7      ; Starts STOP mode
SINT5:      RETI
```

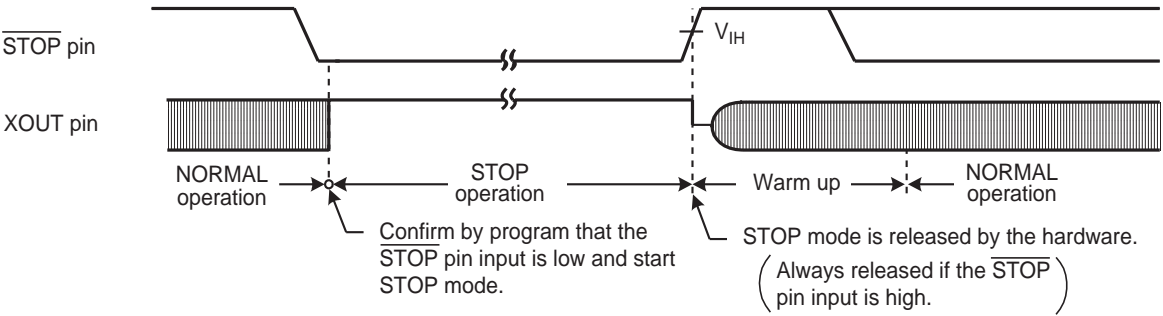


Figure 2-7 Level-sensitive Release Mode

Note 1: Even if the  $\overline{\text{STOP}}$  pin input is low after warm-up start, the STOP mode is not restarted.

Note 2: In this case of changing to the level-sensitive mode from the edge-sensitive mode, the release mode is not switched until a rising edge of the  $\overline{\text{STOP}}$  pin input is detected.

(2) Edge-sensitive release mode (RELM = “0”)

In this mode, STOP mode is released by a rising edge of the  $\overline{\text{STOP}}$  pin input. This is used in applications where a relatively short program is executed repeatedly at periodic intervals. This periodic signal (for example, a clock from a low-power consumption oscillator) is input to the  $\overline{\text{STOP}}$  pin. In the edge-sensitive release mode, STOP mode is started even when the  $\overline{\text{STOP}}$  pin input is high level. Do not use any STOP5 to STOP2 pin input for releasing STOP mode in edge-sensitive release mode.

Example :Starting STOP mode from NORMAL mode

```
DI         ; IMF ← 0
LD         (SYSCR1), 10010000B ; Starts after specified to the edge-sensitive release mode
```

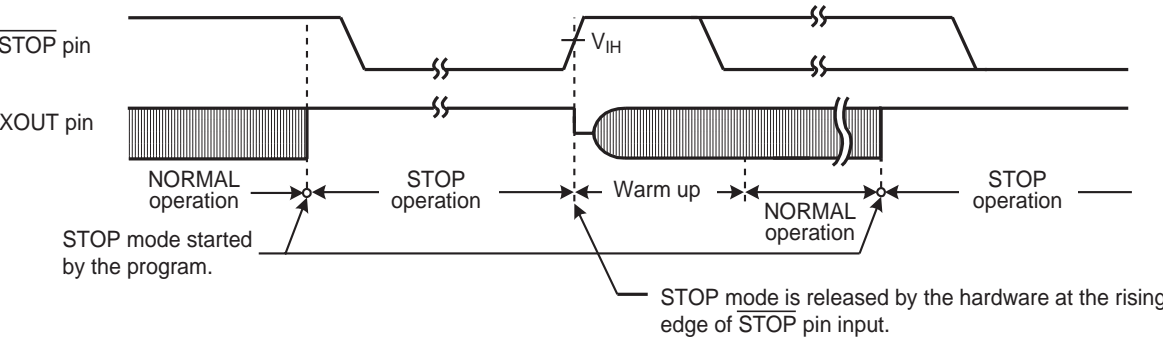


Figure 2-8 Edge-sensitive Release Mode

STOP mode is released by the following sequence.

1. In the dual-clock mode, when returning to NORMAL2, both the high-frequency and low-frequency clock oscillators are turned on; when returning to SLOW1 mode, only the low-frequency clock oscillator is turned on. In the single-clock mode, only the high-frequency clock oscillator is turned on.
2. A warm-up period is inserted to allow oscillation time to stabilize. During warm up, all internal operations remain halted. Four different warm-up times can be selected with the SYSCR1<WUT> in accordance with the resonator characteristics.
3. When the warm-up time has elapsed, normal operation resumes with the instruction following the STOP mode start instruction.

Note 1: When the STOP mode is released, the start is made after the prescaler and the divider of the timing generator are cleared to "0".

Note 2: STOP mode can also be released by inputting low level on the  $\overline{\text{RESET}}$  pin, which immediately performs the normal reset operation.

Note 3: When STOP mode is released with a low hold voltage, the following cautions must be observed. The power supply voltage must be at the operating voltage level before releasing STOP mode. The  $\overline{\text{RESET}}$  pin input must also be "H" level, rising together with the power supply voltage. In this case, if an external time constant circuit has been connected, the  $\overline{\text{RESET}}$  pin input voltage will increase at a slower pace than the power supply voltage. At this time, there is a danger that a reset may occur if input voltage level of the  $\overline{\text{RESET}}$  pin drops below the non-inverting high-level input voltage (Hysteresis input).

Table 2-2 Warm-up Time Example (at  $f_c = 16.0$  MHz,  $f_s = 32.768$  kHz)

WUT	Warm-up Time [ms]	
	Return to NORMAL Mode	Return to SLOW Mode
00	12.288	750
01	4.096	250
10	3.072	5.85
11	1.024	1.95

Note 1: The warm-up time is obtained by dividing the basic clock by the divider. Therefore, the warm-up time may include a certain amount of error if there is any fluctuation of the oscillation frequency when STOP mode is released. Thus, the warm-up time must be considered as an approximate value.



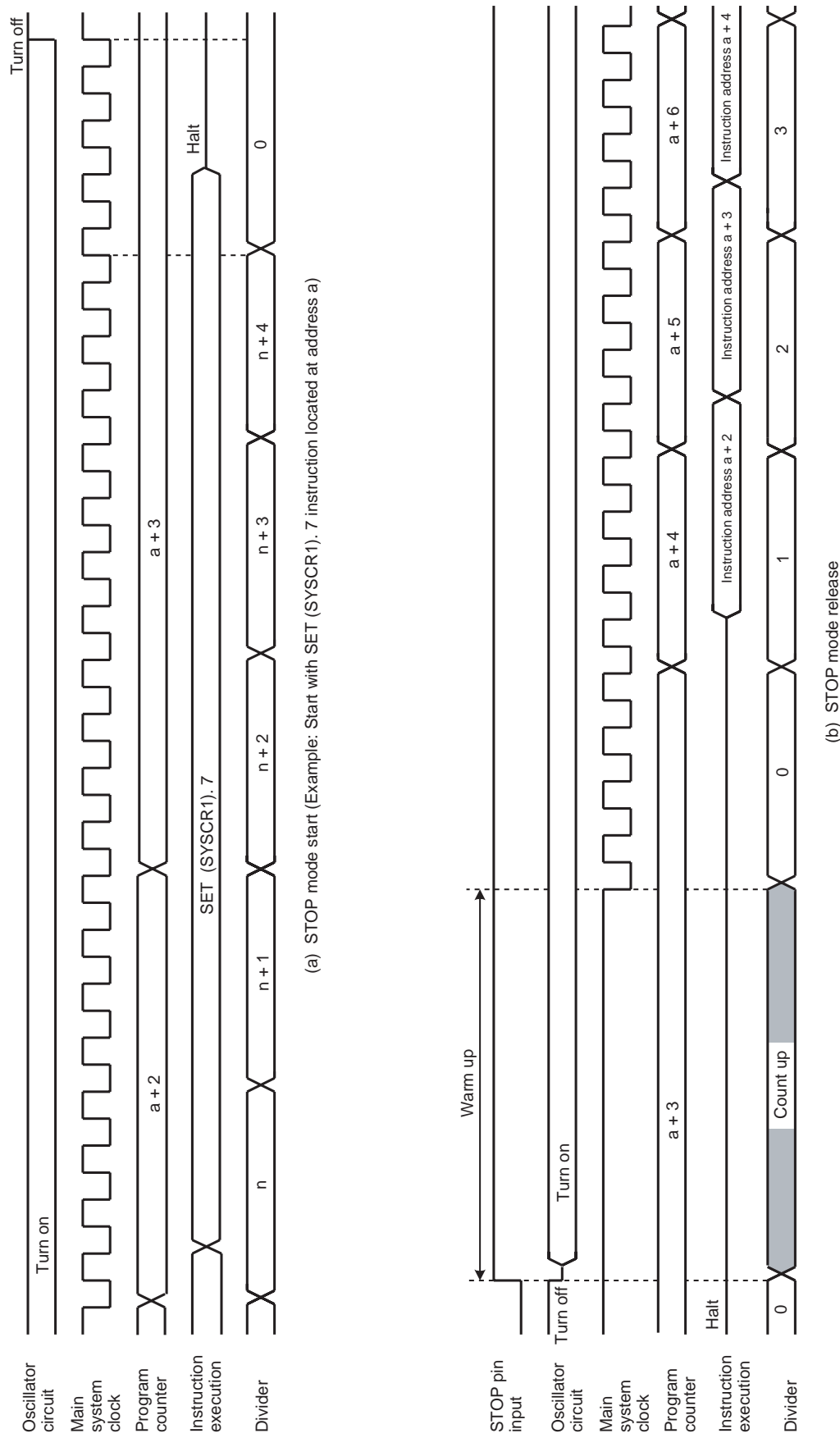


Figure 2-9 STOP Mode Start/Release

### 2.2.4.2 IDLE1/2 mode and SLEEP1/2 mode

IDLE1/2 and SLEEP1/2 modes are controlled by the system control register 2 (SYSCR2) and maskable interrupts. The following status is maintained during these modes.

1. Operation of the CPU and watchdog timer (WDT) is halted. On-chip peripherals continue to operate.
2. The data memory, CPU registers, program status word and port output latches are all held in the status in effect before these modes were entered.
3. The program counter holds the address 2 ahead of the instruction which starts these modes.

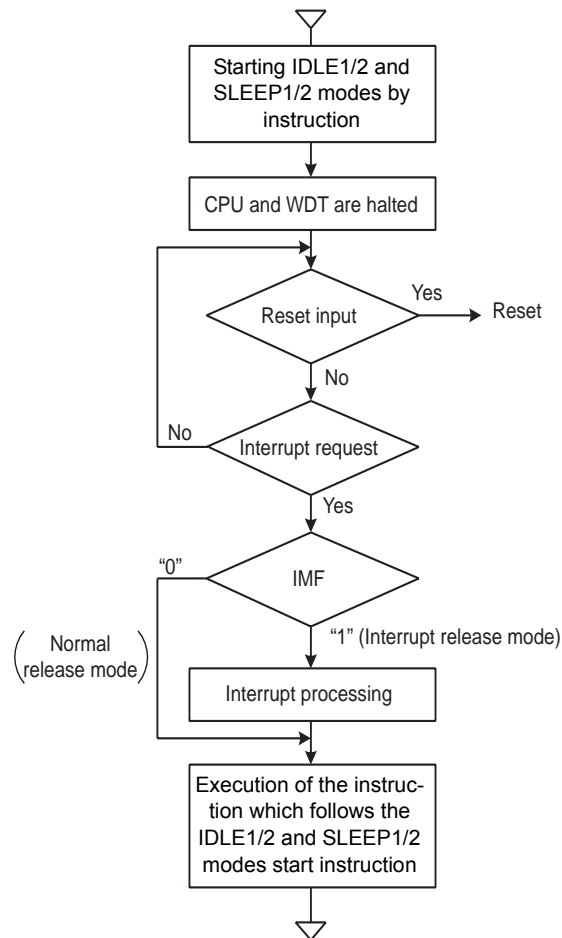


Figure 2-10 IDLE1/2 and SLEEP1/2 Modes

- Start the IDLE1/2 and SLEEP1/2 modes

After IMF is set to "0", set the individual interrupt enable flag (EF) which releases IDLE1/2 and SLEEP1/2 modes. To start IDLE1/2 and SLEEP1/2 modes, set SYSCR2<IDLE> to "1".

- Release the IDLE1/2 and SLEEP1/2 modes

IDLE1/2 and SLEEP1/2 modes include a normal release mode and an interrupt release mode. These modes are selected by interrupt master enable flag (IMF). After releasing IDLE1/2 and SLEEP1/2 modes, the SYSCR2<IDLE> is automatically cleared to "0" and the operation mode is returned to the mode preceding IDLE1/2 and SLEEP1/2 modes.

IDLE1/2 and SLEEP1/2 modes can also be released by inputting low level on the  $\overline{\text{RESET}}$  pin. After releasing reset, the operation mode is started from NORMAL1 mode.

(1) Normal release mode (IMF = "0")

IDLE1/2 and SLEEP1/2 modes are released by any interrupt source enabled by the individual interrupt enable flag (EF). After the interrupt is generated, the program operation is resumed from the instruction following the IDLE1/2 and SLEEP1/2 modes start instruction. Normally, the interrupt latches (IL) of the interrupt source used for releasing must be cleared to "0" by load instructions.

(2) Interrupt release mode (IMF = "1")

IDLE1/2 and SLEEP1/2 modes are released by any interrupt source enabled with the individual interrupt enable flag (EF) and the interrupt processing is started. After the interrupt is processed, the program operation is resumed from the instruction following the instruction, which starts IDLE1/2 and SLEEP1/2 modes.

Note: When a watchdog timer interrupts is generated immediately before IDLE1/2 and SLEEP1/2 modes are started, the watchdog timer interrupt will be processed but IDLE1/2 and SLEEP1/2 modes will not be started.

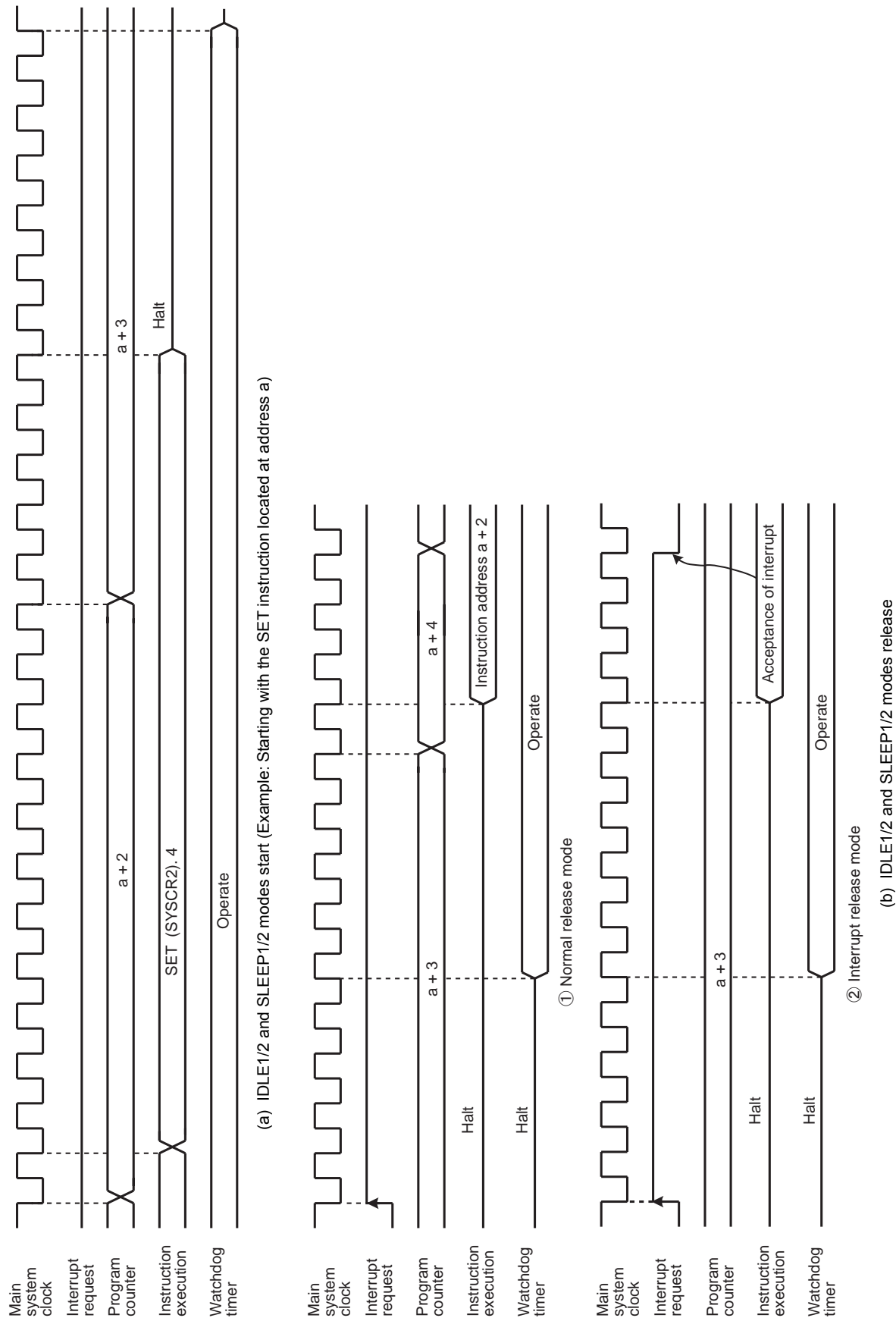


Figure 2-11 IDLE1/2 and SLEEP1/2 Modes Start/Release

### 2.2.4.3 IDLE0 and SLEEP0 modes (IDLE0, SLEEP0)

IDLE0 and SLEEP0 modes are controlled by the system control register 2 (SYSCR2) and the time base timer control register (TBTCCR). The following status is maintained during IDLE0 and SLEEP0 modes.

1. Timing generator stops feeding clock to peripherals except TBT.
2. The data memory, CPU registers, program status word and port output latches are all held in the status in effect before IDLE0 and SLEEP0 modes were entered.
3. The program counter holds the address 2 ahead of the instruction which starts IDLE0 and SLEEP0 modes.

Note: Before starting IDLE0 or SLEEP0 mode, be sure to stop (Disable) peripherals.

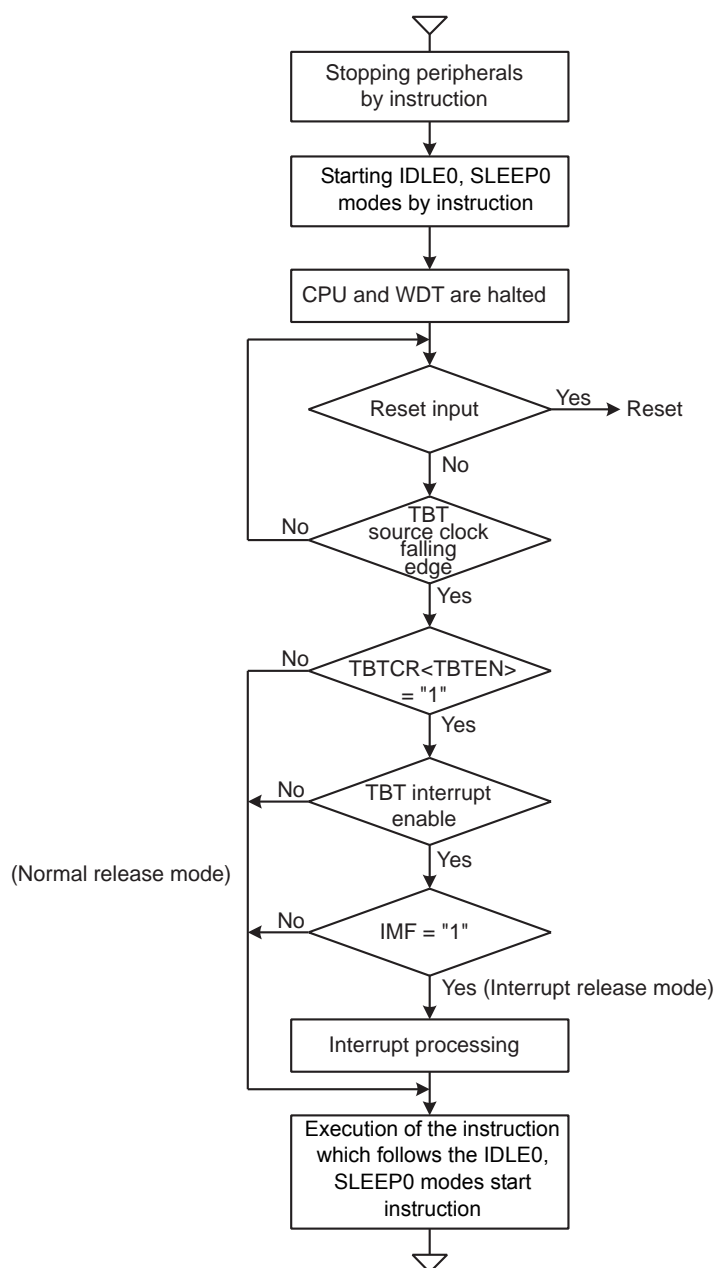


Figure 2-12 IDLE0 and SLEEP0 Modes

- Start the IDLE0 and SLEEP0 modes

Stop (Disable) peripherals such as a timer counter.

To start IDLE0 and SLEEP0 modes, set SYSCR2<TGHALT> to “1”.

- Release the IDLE0 and SLEEP0 modes

IDLE0 and SLEEP0 modes include a normal release mode and an interrupt release mode.

These modes are selected by interrupt master flag (IMF), the individual interrupt enable flag of TBT and TBTCR<TBTEN>.

After releasing IDLE0 and SLEEP0 modes, the SYSCR2<TGHALT> is automatically cleared to “0” and the operation mode is returned to the mode preceding IDLE0 and SLEEP0 modes. Before starting the IDLE0 or SLEEP0 mode, when the TBTCR<TBTEN> is set to “1”, INTTBT interrupt latch is set to “1”.

IDLE0 and SLEEP0 modes can also be released by inputting low level on the  $\overline{\text{RESET}}$  pin. After releasing reset, the operation mode is started from NORMAL1 mode.

Note: IDLE0 and SLEEP0 modes start/release without reference to TBTCR<TBTEN> setting.

(1) Normal release mode (IMF•EF6•TBTCR<TBTEN> = “0”)

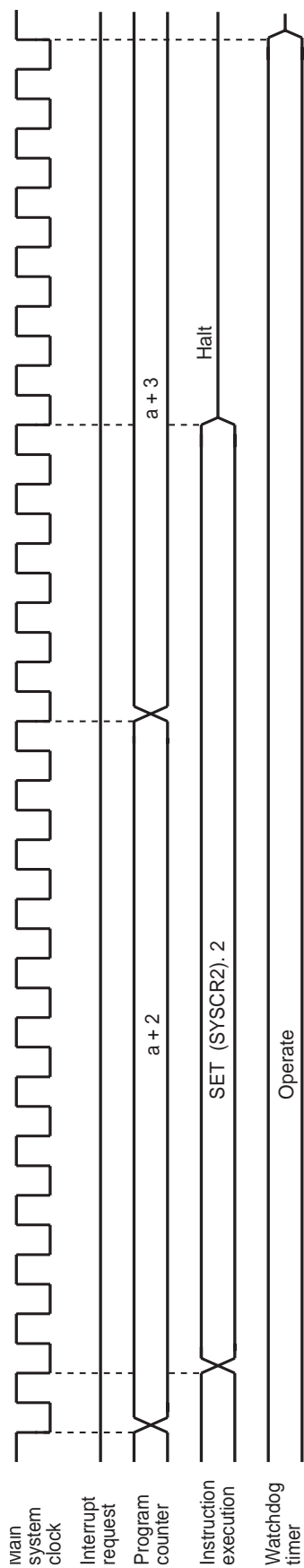
IDLE0 and SLEEP0 modes are released by the source clock falling edge, which is setting by the TBTCR<TBTCK>. After the falling edge is detected, the program operation is resumed from the instruction following the IDLE0 and SLEEP0 modes start instruction. Before starting the IDLE0 or SLEEP0 mode, when the TBTCR<TBTEN> is set to “1”, INTTBT interrupt latch is set to “1”.

(2) Interrupt release mode (IMF•EF6•TBTCR<TBTEN> = “1”)

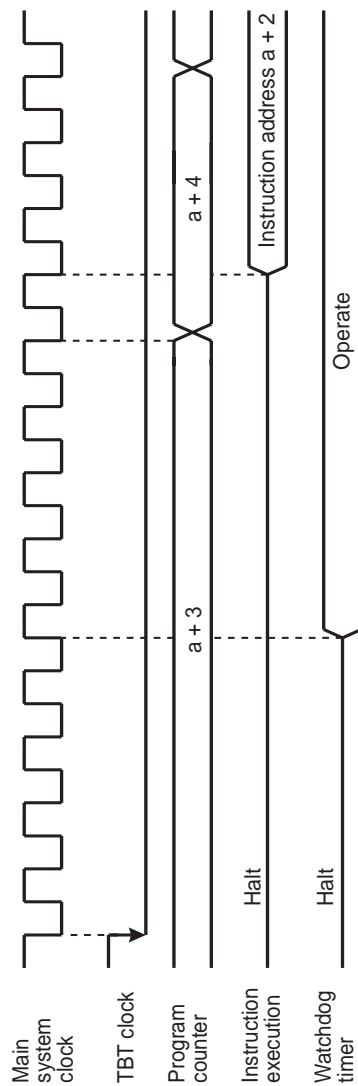
IDLE0 and SLEEP0 modes are released by the source clock falling edge, which is setting by the TBTCR<TBTCK> and INTTBT interrupt processing is started.

Note 1: Because returning from IDLE0, SLEEP0 to NORMAL1, SLOW1 is executed by the asynchronous internal clock, the period of IDLE0, SLEEP0 mode might be the shorter than the period setting by TBTCR<TBTCK>.

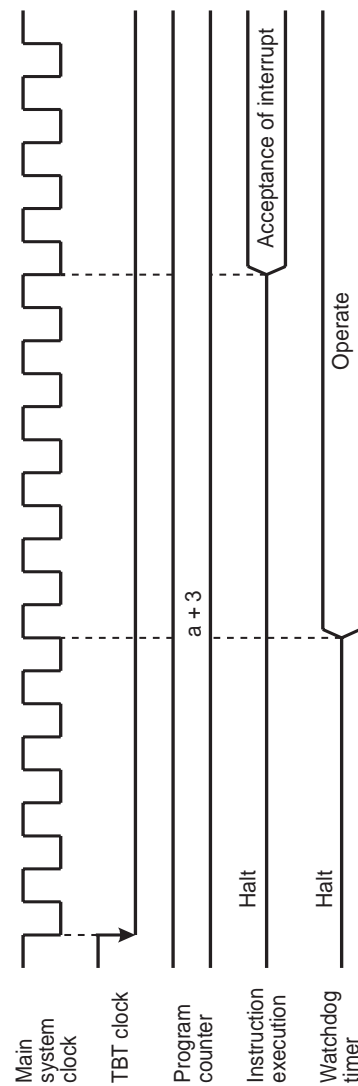
Note 2: When a watchdog timer interrupt is generated immediately before IDLE0/SLEEP0 mode is started, the watchdog timer interrupt will be processed but IDLE0/SLEEP0 mode will not be started.



(a) IDLE0 and SLEEP0 modes start (Example: Starting with the SET instruction located at address a



① Normal release mode



② Interrupt release mode

(b) IDLE and SLEEP0 modes release

Figure 2-13 IDLE0 and SLEEP0 Modes Start/Release

#### 2.2.4.4 SLOW mode

SLOW mode is controlled by the system control register 2 (SYSCR2).

The following is the methods to switch the mode with the warm-up counter.

##### (1) Switching from NORMAL2 mode to SLOW1 mode

First, set SYSCR2<SYSCK> to switch the main system clock to the low-frequency clock for SLOW2 mode. Next, clear SYSCR2<XEN> to turn off high-frequency oscillation.

Note: The high-frequency clock can be continued oscillation in order to return to NORMAL2 mode from SLOW mode quickly. Always turn off oscillation of high-frequency clock when switching from SLOW mode to stop mode.

Example 1 :Switching from NORMAL2 mode to SLOW1 mode.

SET	(SYSCR2). 5	; SYSCR2<SYSCK> ← 1 (Switches the main system clock to the low-frequency clock for SLOW2)
CLR	(SYSCR2). 7	; SYSCR2<XEN> ← 0 (Turns off high-frequency oscillation)

Example 2 :Switching to the SLOW1 mode after low-frequency clock has stabilized.

	SET	(SYSCR2). 6	; SYSCR2<XTEN> ← 1
	LD	(TC3CR), 43H	; Sets mode for TC4, 3 (16-bit mode, fs for source)
	LD	(TC4CR), 05H	; Sets warming-up counter mode
	LDW	(TTREG3), 8000H	; Sets warm-up time (Depend on oscillator accompanied)
	DI		; IMF ← 0
	SET	(EIRE). 5	; Enables INTTC4
	EI		; IMF ← 1
	SET	(TC4CR). 3	; Starts TC4, 3
	:		
PINTTC4:	CLR	(TC4CR). 3	; Stops TC4, 3
	SET	(SYSCR2). 5	; SYSCR2<SYSCK> ← 1 (Switches the main system clock to the low-frequency clock)
	CLR	(SYSCR2). 7	; SYSCR2<XEN> ← 0 (Turns off high-frequency oscillation)
	RETI		
	:		
VINTTC4:	DW	PINTTC4	; INTTC4 vector table

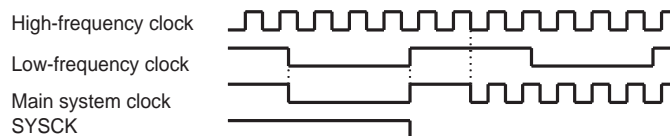


## (2) Switching from SLOW1 mode to NORMAL2 mode

First, set SYSCR2<XEN> to turn on the high-frequency oscillation. When time for stabilization (Warm up) has been taken by the timer/counter (TC4,TC3), clear SYSCR2<SYSCK> to switch the main system clock to the high-frequency clock.

SLOW mode can also be released by inputting low level on the  $\overline{\text{RESET}}$  pin. After releasing reset, the operation mode is started from NORMAL1 mode.

Note: After SYSCK is cleared to "0", executing the instructions is continued by the low-frequency clock for the period synchronized with low-frequency and high-frequency clocks.



Example :Switching from the SLOW1 mode to the NORMAL2 mode ( $f_c = 16 \text{ MHz}$ , warm-up time is 4.0 ms).

	SET	(SYSCR2). 7	; SYSCR2<XEN> ← 1 (Starts high-frequency oscillation)
	LD	(TC3CR), 63H	; Sets mode for TC4, 3 (16-bit mode, $f_c$ for source)
	LD	(TC4CR), 05H	; Sets warming-up counter mode
	LD	(TTREG4), 0F8H	; Sets warm-up time
	DI		; IMF ← 0
	SET	(EIRE). 5	; Enables INTTC4
	EI		; IMF ← 1
	SET	(TC4CR). 3	; Starts TC4, 3
	:		
PINTTC4:	CLR	(TC4CR). 3	; Stops TC4, 3
	CLR	(SYSCR2). 5	; SYSCR2<SYSCK> ← 0 (Switches the main system clock to the high-frequency clock)
	RETI		
	:		
VINTTC4:	DW	PINTTC4	; INTTC4 vector table

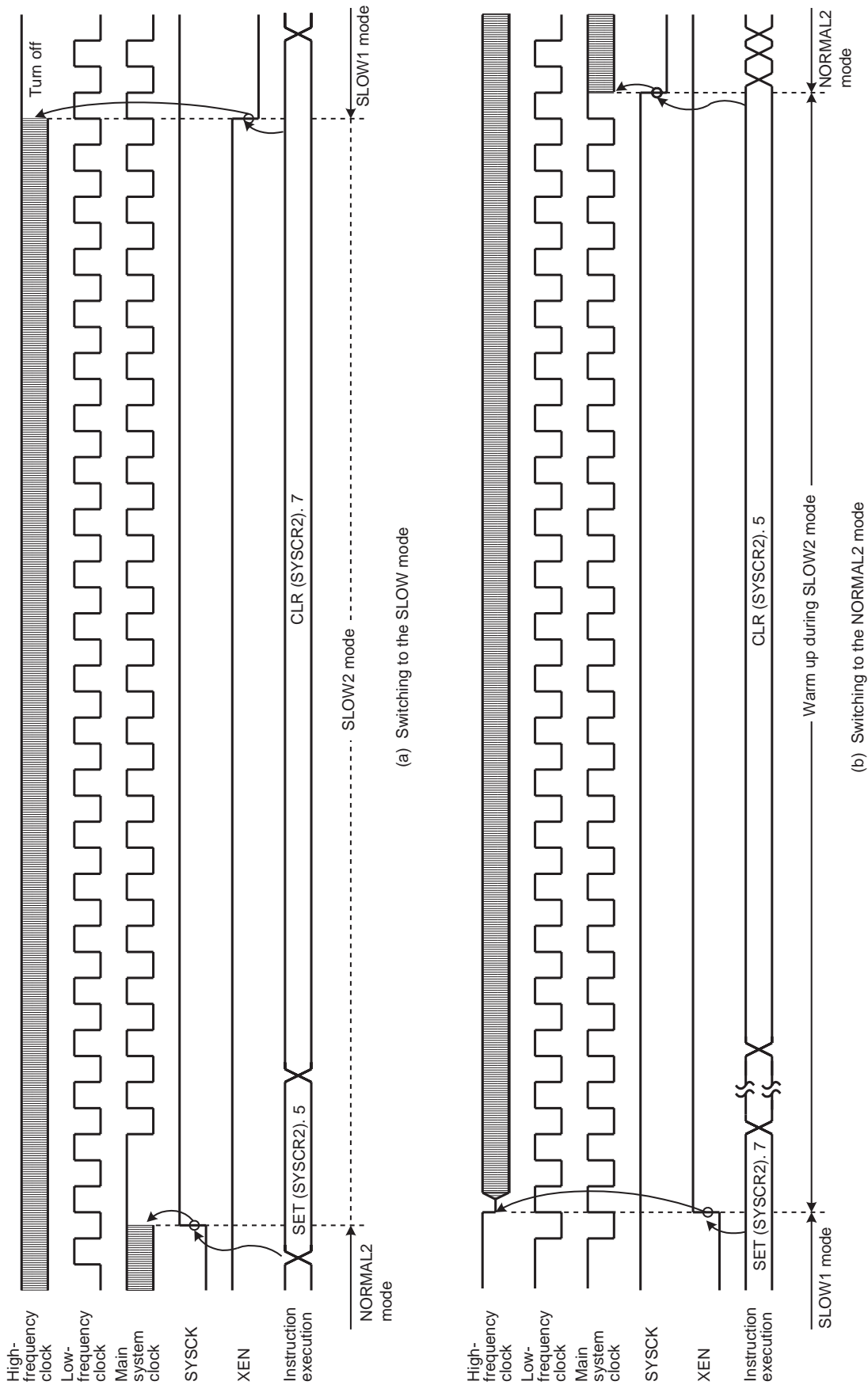


Figure 2-14 Switching between the NORMAL2 and SLOW Modes

## 2.3 Reset Circuit

The TMP86FS28DFG has four types of reset generation procedures: An external reset input, an address trap reset, a watchdog timer reset and a system clock reset. Of these reset, the address trap reset, the watchdog timer and the system clock reset are a malfunction reset. When the malfunction reset request is detected, reset occurs during the maximum  $24/f_c[s]$ .

The malfunction reset circuit such as watchdog timer reset, address trap reset and system clock reset is not initialized when power is turned on. Therefore, reset may occur during maximum  $24/f_c[s]$  ( $1.5\mu s$  at 16.0 MHz) when power is turned on.

Table 2-3 shows on-chip hardware initialization by reset action.

Table 2-3 Initializing Internal Status by Reset Action

On-chip Hardware	Initial Value	On-chip Hardware	Initial Value
Program counter (PC)	(FFFEH)	Prescaler and divider of timing generator	0
Stack pointer (SP)	Not initialized		
General-purpose registers (W, A, B, C, D, E, H, L, IX, IY)	Not initialized		
Jump status flag (JF)	Not initialized	Watchdog timer	Enable
Zero flag (ZF)	Not initialized	Output latches of I/O ports	Refer to I/O port circuitry
Carry flag (CF)	Not initialized		
Half carry flag (HF)	Not initialized		
Sign flag (SF)	Not initialized		
Overflow flag (VF)	Not initialized		
Interrupt master enable flag (IMF)	0		
Interrupt individual enable flags (EF)	0	Control registers	Refer to each of control register
Interrupt latches (IL)	0		
		LCD data buffer	Not initialized
		RAM	Not initialized

### 2.3.1 External Reset Input

The  $\overline{\text{RESET}}$  pin contains a Schmitt trigger (Hysteresis) with an internal pull-up resistor.

When the  $\overline{\text{RESET}}$  pin is held at “L” level for at least 3 machine cycles ( $12/f_c [s]$ ) with the power supply voltage within the operating voltage range and oscillation stable, a reset is applied and the internal state is initialized.

When the  $\overline{\text{RESET}}$  pin input goes high, the reset operation is released and the program execution starts at the vector address stored at addresses FFFEh to FFFFh.

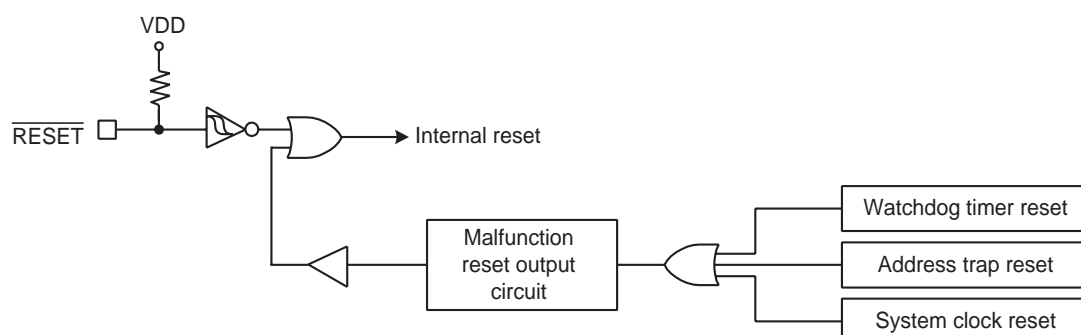
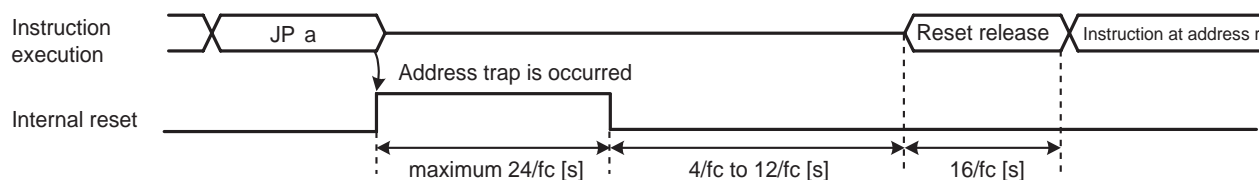


Figure 2-15 Reset Circuit

### 2.3.2 Address trap reset

If the CPU should start looping for some cause such as noise and an attempt be made to fetch an instruction from the on-chip RAM (when  $WDTCR1<ATAS>$  is set to "1"), DBR or the SFR area, address trap reset will be generated. The reset time is maximum  $24/f_c[s]$  ( $1.5\mu s$  at 16.0 MHz).

Note: The operating mode under address trapped is alternative of reset or interrupt. The address trap area is alternative.



Note 1: Address "a" is in the SFR, DBR or on-chip RAM ( $WDTCR1<ATAS> = "1"$ ) space.

Note 2: During reset release, reset vector "r" is read out, and an instruction at address "r" is fetched and decoded.

Figure 2-16 Address Trap Reset

### 2.3.3 Watchdog timer reset

Refer to Section "Watchdog Timer".

### 2.3.4 System clock reset

If the condition as follows is detected, the system clock reset occurs automatically to prevent dead lock of the CPU. (The oscillation is continued without stopping.)

- In case of clearing  $SYSCR2<XEN>$  and  $SYSCR2<XTEN>$  simultaneously to "0".
- In case of clearing  $SYSCR2<XEN>$  to "0", when the  $SYSCR2<SYSCK>$  is "0".
- In case of clearing  $SYSCR2<XTEN>$  to "0", when the  $SYSCR2<SYSCK>$  is "1".

The reset time is maximum  $24/f_c$  ( $1.5\mu s$  at 16.0 MHz).





### 3. Interrupt Control Circuit

The TMP86FS28DFG has a total of 23 interrupt sources excluding reset. Interrupts can be nested with priorities. Four of the internal interrupt sources are non-maskable while the rest are maskable.

Interrupt sources are provided with interrupt latches (IL), which hold interrupt requests, and independent vectors. The interrupt latch is set to "1" by the generation of its interrupt request which requests the CPU to accept its interrupts. Interrupts are enabled or disabled by software using the interrupt master enable flag (IMF) and interrupt enable flag (EF). If more than one interrupts are generated simultaneously, interrupts are accepted in order which is dominated by hardware. However, there are no prioritized interrupt factors among non-maskable interrupts.

Interrupt Factors		Enable Condition	Interrupt Latch	Vector Address	Priority
Internal/External	(Reset)	Non-maskable	—	FFFE	1
Internal	INTSWI (Software interrupt)	Non-maskable	—	FFFC	2
Internal	INTUNDEF (Executed the undefined instruction interrupt)	Non-maskable	—	FFFC	2
Internal	INTATRAP (Address trap interrupt)	Non-maskable	IL2	FFFA	2
Internal	INTWDT (Watchdog timer interrupt)	Non-maskable	IL3	FFF8	2
External	$\overline{\text{INT0}}$	IMF•EF4 = 1, INT0EN = 1	IL4	FFF6	5
External	INT1	IMF•EF5 = 1	IL5	FFF4	6
Internal	INTTBT	IMF•EF6 = 1	IL6	FFF2	7
Internal	INTTC10	IMF•EF7 = 1	IL7	FFF0	8
Internal	INTRXD0	IMF•EF8 = 1	IL8	FFEE	9
Internal	INTTXD0	IMF•EF9 = 1	IL9	FFEC	10
Internal	INTTC11	IMF•EF10 = 1	IL10	FFEA	11
External	INT2	IMF•EF11 = 1	IL11	FFE8	12
-	Reserved	IMF•EF12 = 1	IL12	FFE6	13
Internal	INTSIO	IMF•EF13 = 1	IL13	FFE4	14
-	Reserved	IMF•EF14 = 1	IL14	FFE2	15
-	Reserved	IMF•EF15 = 1	IL15	FFE0	16
-	Reserved	IMF•EF16 = 1	IL16	FFBE	17
-	Reserved	IMF•EF17 = 1	IL17	FFBC	18
-	Reserved	IMF•EF18 = 1	IL18	FFBA	19
-	Reserved	IMF•EF19 = 1	IL19	FFB8	20
Internal	INTTC3	IMF•EF20 = 1	IL20	FFB6	21
Internal	INTTC4	IMF•EF21 = 1	IL21	FFB4	22
External	INT3	IMF•EF22 = 1	IL22	FFB2	23
Internal	INTTC5	IMF•EF23 = 1	IL23	FFB0	24
Internal	INTTC6	IMF•EF24 = 1	IL24	FFAE	25
External	INT4	IMF•EF25 = 1	IL25	FFAC	26
External	$\overline{\text{INT5}}$	IMF•EF26 = 1	IL26	FFAA	27
Internal	INTRXD1	IMF•EF27 = 1	IL27	FFA8	28
Internal	INTTXD1	IMF•EF28 = 1	IL28	FFA6	29
Internal	INTADC	IMF•EF29 = 1	IL29	FFA4	30
-	Reserved	IMF•EF30 = 1	IL30	FFA2	31
-	Reserved	IMF•EF31 = 1	IL31	FFA0	32

Note 1: To use the address trap interrupt (INTATRAP), clear WDTCR1<ATOUT> to "0" (It is set for the "reset request" after reset is cancelled). For details, see "Address Trap".

Note 2: To use the watchdog timer interrupt (INTWDT), clear WDTCR1<WDTOUT> to "0" (It is set for the "Reset request" after reset is released). For details, see "Watchdog Timer".

## 3.1 Interrupt latches (IL29 to IL2)

An interrupt latch is provided for each interrupt source, except for a software interrupt and an executed the undefined instruction interrupt. When interrupt request is generated, the latch is set to "1", and the CPU is requested to accept the interrupt if its interrupt is enabled. The interrupt latch is cleared to "0" immediately after accepting interrupt. All interrupt latches are initialized to "0" during reset.

The interrupt latches are located on address 002EH, 002FH, 003CH and 003DH in SFR area. Each latch can be cleared to "0" individually by instruction. However, IL2 and IL3 should not be cleared to "0" by software. For clearing the interrupt latch, load instruction should be used and then IL2 and IL3 should be set to "1". If the read-modify-write instructions such as bit manipulation or operation instructions are used, interrupt request would be cleared inadequately if interrupt is requested while such instructions are executed.

Interrupt latches are not set to "1" by an instruction.

Since interrupt latches can be read, the status for interrupt requests can be monitored by software.

**Note:** In main program, before manipulating the interrupt enable flag (EF) or the interrupt latch (IL), be sure to clear IMF to "0" (Disable interrupt by DI instruction). Then set IMF newly again as required after operating on the EF or IL (Enable interrupt by EI instruction)  
In interrupt service routine, because the IMF becomes "0" automatically, clearing IMF need not execute normally on interrupt service routine. However, if using multiple interrupt on interrupt service routine, manipulating EF or IL should be executed before setting IMF="1".

Example 1 :Clears interrupt latches

```
DI                                ; IMF ← 0
LDW      (ILL), 1110100000111111B ; IL12, IL10 to IL6 ← 0
EI                                ; IMF ← 1
```

Example 2 :Reads interrupt latchess

```
LD      WA, (ILL)                ; W ← ILH, A ← ILL
```

Example 3 :Tests interrupt latches

```
TEST      (ILL). 7                ; if IL7 = 1 then jump
JR      F, SSET
```

## 3.2 Interrupt enable register (EIR)

The interrupt enable register (EIR) enables and disables the acceptance of interrupts, except for the non-maskable interrupts (Software interrupt, undefined instruction interrupt, address trap interrupt and watchdog interrupt). Non-maskable interrupt is accepted regardless of the contents of the EIR.

The EIR consists of an interrupt master enable flag (IMF) and the individual interrupt enable flags (EF). These registers are located on address 002CH, 002DH, 003AH and 003BH in SFR area, and they can be read and written by an instructions (Including read-modify-write instructions such as bit manipulation or operation instructions).

### 3.2.1 Interrupt master enable flag (IMF)

The interrupt enable register (IMF) enables and disables the acceptance of the whole maskable interrupt. While IMF = "0", all maskable interrupts are not accepted regardless of the status on each individual interrupt enable flag (EF). By setting IMF to "1", the interrupt becomes acceptable if the individuals are enabled. When an interrupt is accepted, IMF is cleared to "0" after the latest status on IMF is stacked. Thus the maskable interrupts which follow are disabled. By executing return interrupt instruction [RETI/RETN], the stacked data, which was the status before interrupt acceptance, is loaded on IMF again.

The IMF is located on bit0 in EIRL (Address: 003AH in SFR), and can be read and written by an instruction. The IMF is normally set and cleared by [EI] and [DI] instruction respectively. During reset, the IMF is initialized to "0".



### 3.2.2 Individual interrupt enable flags (EF29 to EF4)

Each of these flags enables and disables the acceptance of its maskable interrupt. Setting the corresponding bit of an individual interrupt enable flag to “1” enables acceptance of its interrupt, and setting the bit to “0” disables acceptance. During reset, all the individual interrupt enable flags (EF29 to EF4) are initialized to “0” and all maskable interrupts are not accepted until they are set to “1”.

Note: In main program, before manipulating the interrupt enable flag (EF) or the interrupt latch (IL), be sure to clear IMF to “0” (Disable interrupt by DI instruction). Then set IMF newly again as required after operating on the EF or IL (Enable interrupt by EI instruction).  
In interrupt service routine, because the IMF becomes “0” automatically, clearing IMF need not execute normally on interrupt service routine. However, if using multiple interrupt on interrupt service routine, manipulating EF or IL should be executed before setting IMF=“1”.

Example 1 : Enables interrupts individually and sets IMF

DI		; IMF ← 0
LDW	(EIRL), 1110100010100000B	; EF15 to EF13, EF11, EF7, EF5 ← 1
:		Note: IMF should not be set.
:		
EI		; IMF ← 1

Example 2 : C compiler description example

```
unsigned int _io (3AH) EIRL;          /* 3AH shows EIRL address */
_DI();
EIRL = 10100000B;
:
_EI();
```

## Interrupt Latches

(Initial value: 00000000 000000\*\*)

ILH,ILL (003DH, 003CH)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	IL15	IL14	IL13	IL12	IL11	IL10	IL9	IL8	IL7	IL6	IL5	IL4	IL3	IL2		

ILH (003DH)

ILL (003CH)

(Initial value: 00000000 00000000)

ILD,ILE (002FH, 002EH)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	IL31	IL30	IL29	IL28	IL27	IL26	IL25	IL24	IL23	IL22	IL21	IL20	IL19	IL18	IL17	IL16

ILD (002FH)

ILE (002EH)

IL29 to IL2	Interrupt latches	at RD 0: No interrupt request 1: Interrupt request	at WR 0: Clears the interrupt request 1: (Interrupt latch is not set.)	R/W
-------------	-------------------	--	--	-----

Note 1: To clear any one of bits IL7 to IL4, be sure to write "1" into IL2 and IL3.

Note 2: In main program, before manipulating the interrupt enable flag (EF) or the interrupt latch (IL), be sure to clear IMF to "0" (Disable interrupt by DI instruction). Then set IMF newly again as required after operating on the EF or IL (Enable interrupt by EI instruction).  
In interrupt service routine, because the IMF becomes "0" automatically, clearing IMF need not execute normally on interrupt service routine. However, if using multiple interrupt on interrupt service routine, manipulating EF or IL should be executed before setting IMF="1".

Note 3: Do not clear IL with read-modify-write instructions such as bit operations.

## Interrupt Enable Registers

(Initial value: 00000000 0000\*\*\*\*)

EIRH,EIRL (003BH, 003AH)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	EF15	EF14	EF13	EF12	EF11	EF10	EF9	EF8	EF7	EF6	EF5	EF4				IMF

EIRH (003BH)

EIRL (003AH)

(Initial value: 00000000 00000000)

EIRD,EIRE (002DH, 002CH)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	EF31	EF30	EF29	EF28	EF27	EF26	EF25	EF24	EF23	EF22	EF21	EF20	EF19	EF18	EF17	EF16

EIRD (002DH)

EIRE (002CH)

EF29 to EF4	Individual-interrupt enable flag (Specified for each bit)	0: Disables the acceptance of each maskable interrupt. 1: Enables the acceptance of each maskable interrupt.	R/W
IMF	Interrupt master enable flag	0: Disables the acceptance of all maskable interrupts 1: Enables the acceptance of all maskable interrupts	

Note 1: \*: Don't care

Note 2: Do not set IMF and the interrupt enable flag (EF15 to EF4) to "1" at the same time.

Note 3: In main program, before manipulating the interrupt enable flag (EF) or the interrupt latch (IL), be sure to clear IMF to "0" (Disable interrupt by DI instruction). Then set IMF newly again as required after operating on the EF or IL (Enable interrupt by EI instruction).  
In interrupt service routine, because the IMF becomes "0" automatically, clearing IMF need not execute normally on interrupt service routine. However, if using multiple interrupt on interrupt service routine, manipulating EF or IL should be executed before setting IMF="1".

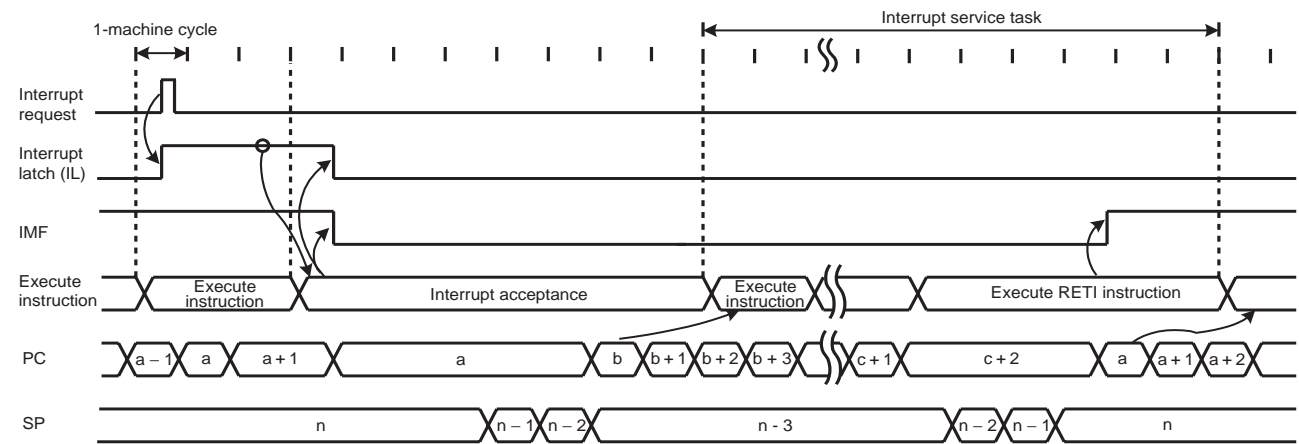
3.3 Interrupt Sequence

An interrupt request, which raised interrupt latch, is held, until interrupt is accepted or interrupt latch is cleared to “0” by resetting or an instruction. Interrupt acceptance sequence requires 8 machine cycles (2  $\mu$ s @16 MHz) after the completion of the current instruction. The interrupt service task terminates upon execution of an interrupt return instruction [RETI] (for maskable interrupts) or [RETN] (for non-maskable interrupts). Figure 3-1 shows the timing chart of interrupt acceptance processing.

3.3.1 Interrupt acceptance processing is packaged as follows.

- a. The interrupt master enable flag (IMF) is cleared to “0” in order to disable the acceptance of any following interrupt.
- b. The interrupt latch (IL) for the interrupt source accepted is cleared to “0”.
- c. The contents of the program counter (PC) and the program status word, including the interrupt master enable flag (IMF), are saved (Pushed) on the stack in sequence of PSW + IMF, PCH, PCL. Meanwhile, the stack pointer (SP) is decremented by 3.
- d. The entry address (Interrupt vector) of the corresponding interrupt service program, loaded on the vector table, is transferred to the program counter.
- e. The instruction stored at the entry address of the interrupt service program is executed.

Note: When the contents of PSW are saved on the stack, the contents of IMF are also saved.



Note 1: a: Return address entry address, b: Entry address, c: Address which RETI instruction is stored  
Note 2: On condition that interrupt is enabled, it takes 38/fc [s] or 38/fs [s] at maximum (If the interrupt latch is set at the first machine cycle on 10 cycle instruction) to start interrupt acceptance processing since its interrupt latch is set.

Figure 3-1 Timing Chart of Interrupt Acceptance/Return Interrupt Instruction

Example: Correspondence between vector table address for INTTBT and the entry address of the interrupt service program

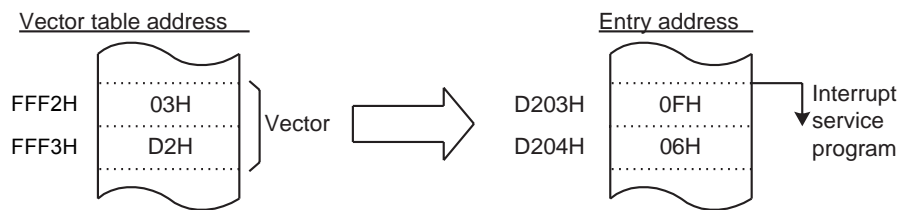


Figure 3-2 Vector table address,Entry address

A maskable interrupt is not accepted until the IMF is set to “1” even if the maskable interrupt higher than the level of current servicing interrupt is requested.

In order to utilize nested interrupt service, the IMF is set to “1” in the interrupt service program. In this case, acceptable interrupt sources are selectively enabled by the individual interrupt enable flags.

To avoid overloaded nesting, clear the individual interrupt enable flag whose interrupt is currently serviced, before setting IMF to “1”. As for non-maskable interrupt, keep interrupt service shorten compared with length between interrupt requests; otherwise the status cannot be recovered as non-maskable interrupt would simply nested.

3.3.2 Saving/restoring general-purpose registers

During interrupt acceptance processing, the program counter (PC) and the program status word (PSW, includes IMF) are automatically saved on the stack, but the accumulator and others are not. These registers are saved by software if necessary. When multiple interrupt services are nested, it is also necessary to avoid using the same data memory area for saving registers. The following methods are used to save/restore the general-purpose registers.

3.3.2.1 Using PUSH and POP instructions

If only a specific register is saved or interrupts of the same source are nested, general-purpose registers can be saved/restored using the PUSH/POP instructions.

Example :Save/store register using PUSH and POP instructions

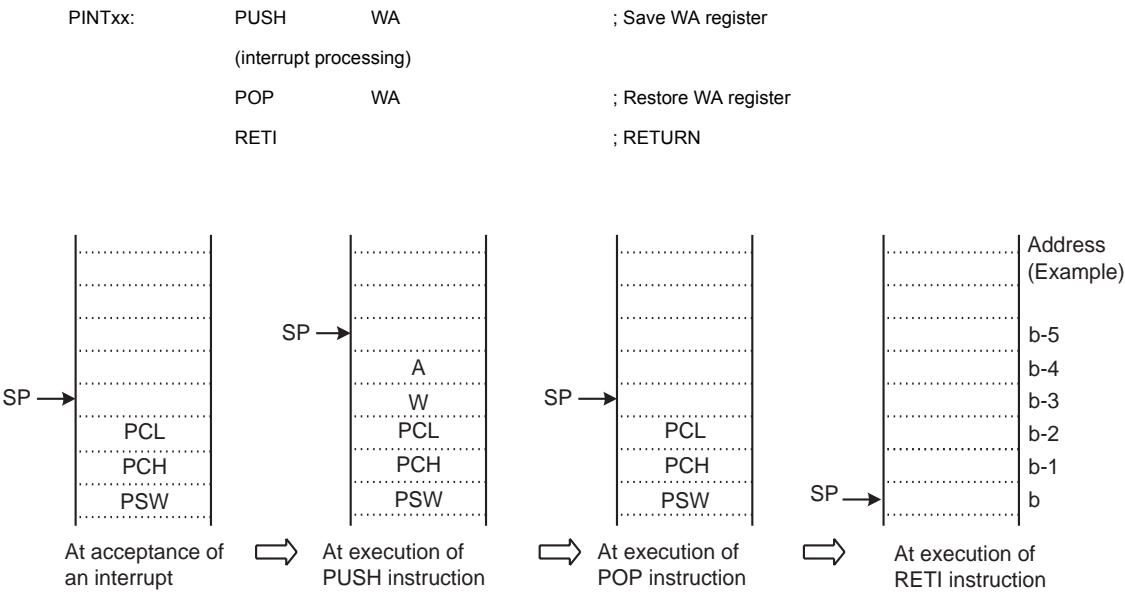


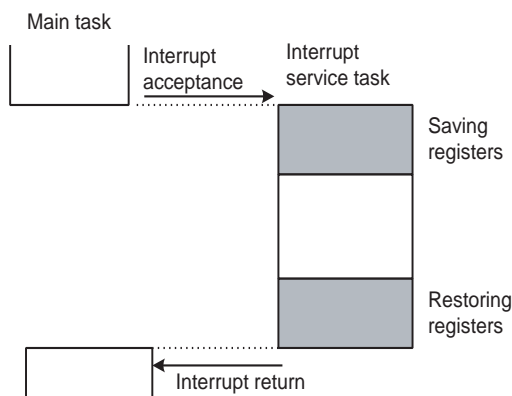
Figure 3-3 Save/store register using PUSH and POP instructions

3.3.2.2 Using data transfer instructions

To save only a specific register without nested interrupts, data transfer instructions are available.

Example :Save/store register using data transfer instructions

```
PINTxx:      LD      (GSAVA), A      ; Save A register
              (interrupt processing)
              LD      A, (GSAVA)     ; Restore A register
              RETI                    ; RETURN
```



Saving/Restoring general-purpose registers using PUSH/POP data transfer instruction

Figure 3-4 Saving/Restoring General-purpose Registers under Interrupt Processing

3.3.3 Interrupt return

Interrupt return instructions [RETI]/[RETN] perform as follows.

[RETI]/[RETN] Interrupt Return
1. Program counter (PC) and program status word (PSW, includes IMF) are restored from the stack.
2. Stack pointer (SP) is incremented by 3.

As for address trap interrupt (INTATRAP), it is required to alter stacked data for program counter (PC) to restarting address, during interrupt service program.

Note: If [RETN] is executed with the above data unaltered, the program returns to the address trap area and INTATRAP occurs again. When interrupt acceptance processing has completed, stacked data for PCL and PCH are located on address (SP + 1) and (SP + 2) respectively.

Example 1 :Returning from address trap interrupt (INTATRAP) service program

```
PINTxx:      POP      WA              ; Recover SP by 2
              LD      WA, Return Address ;
              PUSH     WA              ; Alter stacked data
              (interrupt processing)
              RETN                    ; RETURN
```

Example 2 :Restarting without returning interrupt  
(In this case, PSW (Includes IMF) before interrupt acceptance is discarded.)

```
PINTxx:      INC      SP      ; Recover SP by 3
              INC      SP      ;
              INC      SP      ;
              (interrupt processing)
              LD      EIRL, data      ; Set IMF to "1" or clear it to "0"
              JP      Restart Address ; Jump into restarting address
```

Interrupt requests are sampled during the final cycle of the instruction being executed. Thus, the next interrupt can be accepted immediately after the interrupt return instruction is executed.

Note 1: It is recommended that stack pointer be return to rate before INTATRAP (Increment 3 times), if return interrupt instruction [RETN] is not utilized during interrupt service program under INTATRAP (such as Example 2).

Note 2: When the interrupt processing time is longer than the interrupt request generation time, the interrupt service task is performed but not the main task.

3.4 Software Interrupt (INTSW)

Executing the SWI instruction generates a software interrupt and immediately starts interrupt processing (INTSW is highest prioritized interrupt).

Use the SWI instruction only for detection of the address error or for debugging.

3.4.1 Address error detection

FFH is read if for some cause such as noise the CPU attempts to fetch an instruction from a non-existent memory address during single chip mode. Code FFH is the SWI instruction, so a software interrupt is generated and an address error is detected. The address error detection range can be further expanded by writing FFH to unused areas of the program memory. Address trap reset is generated in case that an instruction is fetched from RAM, DBR or SFR areas.

3.4.2 Debugging

Debugging efficiency can be increased by placing the SWI instruction at the software break point setting address.

3.5 Undefined Instruction Interrupt (INTUNDEF)

Taking code which is not defined as authorized instruction for instruction causes INTUNDEF. INTUNDEF is generated when the CPU fetches such a code and tries to execute it. INTUNDEF is accepted even if non-maskable interrupt is in process. Contemporary process is broken and INTUNDEF interrupt process starts, soon after it is requested.

Note: The undefined instruction interrupt (INTUNDEF) forces CPU to jump into vector address, as software interrupt (SWI) does.

3.6 Address Trap Interrupt (INTATRAP)

Fetching instruction from unauthorized area for instructions (Address trapped area) causes reset output or address trap interrupt (INTATRAP). INTATRAP is accepted even if non-maskable interrupt is in process. Contemporary process is broken and INTATRAP interrupt process starts, soon after it is requested.

Note: The operating mode under address trapped, whether to be reset output or interrupt processing, is selected on watchdog timer control register (WDTCTCR).

## 3.7 External Interrupts

The TMP86FS28DFG has 6 external interrupt inputs. These inputs are equipped with digital noise reject circuits (Pulse inputs of less than a certain time are eliminated as noise).

Edge selection is also possible with INT1 to INT4. The  $\overline{\text{INT0}}$ /P30 pin can be configured as either an external interrupt input pin or an input/output port, and is configured as an input port during reset.

Edge selection, noise reject control and  $\overline{\text{INT0}}$ /P30 pin function selection are performed by the external interrupt control register (EINTCR).

Source	Pin	Enable Conditions	Release Edge (level)	Digital Noise Reject
INT0	$\overline{\text{INT0}}$	IMF • EF4 • INT0EN=1	Falling edge	Pulses of less than 2/fc [s] are eliminated as noise. Pulses of 7/fc [s] or more are considered to be signals. In the SLOW or the SLEEP mode, pulses of less than 1/fs [s] are eliminated as noise. Pulses of 3.5/fs [s] or more are considered to be signals.
INT1	INT1	IMF • EF5 = 1	Falling edge or Rising edge	Pulses of less than 15/fc or 63/fc [s] are eliminated as noise. Pulses of 49/fc or 193/fc [s] or more are considered to be signals. In the SLOW or the SLEEP mode, pulses of less than 1/fs [s] are eliminated as noise. Pulses of 3.5/fs [s] or more are considered to be signals.
INT2	INT2	IMF • EF11 = 1	Falling edge or Rising edge	Pulses of less than 7/fc [s] are eliminated as noise. Pulses of 25/fc [s] or more are considered to be signals. In the SLOW or the SLEEP mode, pulses of less than 1/fs [s] are eliminated as noise. Pulses of 3.5/fs [s] or more are considered to be signals.
INT3	INT3	IMF • EF22 = 1	Falling edge or Rising edge	Pulses of less than 7/fc [s] are eliminated as noise. Pulses of 25/fc [s] or more are considered to be signals. In the SLOW or the SLEEP mode, pulses of less than 1/fs [s] are eliminated as noise. Pulses of 3.5/fs [s] or more are considered to be signals.
INT4	INT4	IMF • EF25 = 1	Falling edge, Rising edge, Falling and Rising edge or H level	Pulses of less than 7/fc [s] are eliminated as noise. Pulses of 25/fc [s] or more are considered to be signals. In the SLOW or the SLEEP mode, pulses of less than 1/fs [s] are eliminated as noise. Pulses of 3.5/fs [s] or more are considered to be signals.
INT5	$\overline{\text{INT5}}$	IMF • EF26 = 1	Falling edge	Pulses of less than 2/fc [s] are eliminated as noise. Pulses of 7/fc [s] or more are considered to be signals. In the SLOW or the SLEEP mode, pulses of less than 1/fs [s] are eliminated as noise. Pulses of 3.5/fs [s] or more are considered to be signals.

Note 1: In NORMAL1/2 or IDLE1/2 mode, if a signal with no noise is input on an external interrupt pin, it takes a maximum of "signal establishment time + 6/fs[s]" from the input signal's edge to set the interrupt latch.

Note 2: When INT0EN = "0", IL4 is not set even if a falling edge is detected on the  $\overline{\text{INT0}}$  pin input.

Note 3: When a pin with more than one function is used as an output and a change occurs in data or input/output status, an interrupt request signal is generated in a pseudo manner. In this case, it is necessary to perform appropriate processing such as disabling the interrupt enable flag.

External Interrupt Control Register

EINTCR	7	6	5	4	3	2	1	0	
(0037H)	INT1NC	INT0EN	INT4ES	INT3ES	INT2ES	INT1ES			(Initial value: 0000 000*)

INT1NC	Noise reject time select	0: Pulses of less than 63/fc [s] are eliminated as noise 1: Pulses of less than 15/fc [s] are eliminated as noise	R/W
INT0EN	P30/ $\overline{\text{INT0}}$ pin configuration	0: P30 input/output port 1: $\overline{\text{INT0}}$ pin (Port P30 should be set to an input mode)	R/W
INT4 ES	INT4 edge select	00: Rising edge 01: Falling edge 10: Rising edge and Falling edge 11: H level	R/W
INT3 ES	INT3 edge select	0: Rising edge 1: Falling edge	R/W
INT2 ES	INT2 edge select	0: Rising edge 1: Falling edge	R/W
INT1 ES	INT1 edge select	0: Rising edge 1: Falling edge	R/W

- Note 1: fc: High-frequency clock [Hz], \*: Don't care
- Note 2: When the system clock frequency is switched between high and low or when the external interrupt control register (EINTCR) is overwritten, the noise canceller may not operate normally. It is recommended that external interrupts are disabled using the interrupt enable register (EIR).
- Note 3: The maximum time from modifying INT1NC until a noise reject time is changed is  $2^6/\text{fc}$ .
- Note 4: In case  $\overline{\text{RESET}}$  pin is released while the state of INT4 pin keeps "H" level, the external interrupt 4 request is not generated even if the INT4 edge select is specified as "H" level. The rising edge is needed after  $\overline{\text{RESET}}$  pin is released.



## 4. Special Function Register (SFR)

The TMP86FS28DFG adopts the memory mapped I/O system, and all peripheral control and data transfers are performed through the special function register (SFR) or the data buffer register (DBR). The SFR is mapped on address 0000H to 003FH, DBR is mapped on address 0F00H to 0FFFH.

This chapter shows the arrangement of the special function register (SFR) and data buffer register (DBR) for TMP86FS28DFG.

### 4.1 SFR

Address	Read	Write
0000H		P0DR
0001H		P1DR
0002H		P2DR
0003H		P3DR
0004H		P4DR
0005H		P5DR
0006H		P6DR
0007H		P7DR
0008H		P8DR
0009H		TC3CR
000AH		TC4CR
000BH		TC5CR
000CH		TC6CR
000DH		Reserved
000EH		Reserved
000FH		Reserved
0010H		TC10DRAL
0011H		TC10DRAH
0012H		TC10DRBL
0013H		TC10DRBH
0014H		TC10CR
0015H		TTREG3
0016H		TTREG4
0017H		TTREG5
0018H		TTREG6
0019H		PWREG3
001AH		PWREG4
001BH		PWREG5
001CH		PWREG6
001DH		Reserved
001EH		Reserved
001FH		Reserved
0020H		TC11DRAL
0021H		TC11DRAH
0022H		TC11DRBL
0023H		TC11DRBH
0024H		TC11CR
0025H		Reserved

Address	Read	Write
0026H	Reserved	
0027H	Reserved	
0028H	Reserved	
0029H	Reserved	
002AH	Reserved	
002BH	P3OUTCR	
002CH	EIRE	
002DH	EIRD	
002EH	ILE	
002FH	ILD	
0030H	Reserved	
0031H	-	STOPCR
0032H	P0OUTCR	
0033H	Reserved	
0034H	-	WDTCR1
0035H	-	WDTCR2
0036H	TBTCR	
0037H	EINTCR	
0038H	SYSCR1	
0039H	SYSCR2	
003AH	EIRL	
003BH	EIRH	
003CH	ILL	
003DH	ILH	
003EH	Reserved	
003FH	PSW	

Note 1: Do not access reserved areas by the program.

Note 2: - ; Cannot be accessed.

Note 3: Write-only registers and interrupt latches cannot use the read-modify-write instructions (Bit manipulation instructions such as SET, CLR, etc. and logical operation instructions such as AND, OR, etc.).

## 4.2 DBR

Address	Read	Write
0F00H	Reserved	
...	...	
0F5FH	Reserved	

Address	Read	Write
0F60H	SIOBR0	
0F61H	SIOBR1	
0F62H	SIOBR2	
0F63H	SIOBR3	
0F64H	SIOBR4	
0F65H	SIOBR5	
0F66H	SIOBR6	
0F67H	SIOBR7	
0F68H	-	SIOCR1
0F69H	SIOSR	SIOCR2

Address	Read	Write
0F70H	Reserved	
...	...	
0F7FH	Reserved	

Address	Read	Write
0F80H	Reserved	
...	...	
0F9FH	Reserved	

Address	Read	Write
0FA0H	Reserved	
0FA1H	Reserved	
0FA2H	Reserved	
0FA3H	Reserved	
0FA4H	Reserved	
0FA5H	Reserved	
0FA6H	Reserved	
0FA7H	Reserved	
0FA8H	Reserved	
0FA9H	Reserved	
0FAAH	Reserved	
0FABH	Reserved	
0FACH	Reserved	
0FADH	Reserved	FLSSTB
0FAEH	Reserved	
0FAFH	FLSCR	
0FB0H	Reserved	
0FB1H	Reserved	
0FB2H	Reserved	
0FB3H	Reserved	
0FB4H	Reserved	
0FB5H	Reserved	
0FB6H	Reserved	
0FB7H	Reserved	
0FB8H	Reserved	
0FB9H	Reserved	
0FBAH	Reserved	
0FBBH	Reserved	
0FBCH	Reserved	
0FBDH	Reserved	
0FBEH	Reserved	
0FBFH	Reserved	

Address	Read	Write
0FC0H		SEG1/0
0FC1H		SEG3/2
0FC2H		SEG5/4
0FC3H		SEG7/6
0FC4H		SEG9/8
0FC5H		SEG11/10
0FC6H		SEG13/12
0FC7H		SEG15/14
0FC8H		SEG17/16
0FC9H		SEG19/18
0FCAH		SEG21/20
0FCBH		SEG23/22
0FCH		SEG25/24
0FCDH		SEG27/26
0FCEH		SEG29/28
0FCFH		SEG31/30
0FD0H		SEG33/32
0FD1H		SEG35/34
0FD2H		SEG37/36
0FD3H		SEG39/38
0FD4H		P4LCR
0FD5H		P5LCR
0FD6H		P6LCR
0FD7H		P7LCR
0FD8H		P8LCR
0FD9H		LCD CR
0FDAH		Reserved
0FDBH		Reserved
0FDC		Reserved
0FDDH		Reserved
0FDEH		Reserved
0PDFH		Reserved

Address	Read	Write
0FE0H	ADCDR2	-
0FE1H	ADCDR1	-
0FE2H	ADCCR1	
0FE3H	ADCCR2	
0FE4H	Reserved	
0FE5H	UART0SR	UART0CR1
0FE6H	-	UART0CR2
0FE7H	RD0BUF	TD0BUF
0FE8H	UART1SR	UART1CR1
0FE9H	-	UART1CR2
0FEAH	RD1BUF	TD1BUF
0FEBH	Reserved	
0FECH	Reserved	
0FEDH	Reserved	
0FEEH	Reserved	
0FEFH	Reserved	
0FF0H	P0PRD	-
0FF1H	Reserved	
0FF2H	P2PRD	-
0FF3H	P3PRD	-
0FF4H	P4PRD	-
0FF5H	P5PRD	-
0FF6H	P6PRD	-
0FF7H	P7PRD	-
0FF8H	P8PRD	-
0FF9H	P1CR1	
0FFAH	P1CR2	
0FFBH	P4OUTCR	
0FFCH	P5OUTCR	
0FFDH	P6OUTCR	
0FFEH	P7OUTCR	
0FFFH	P8OUTCR	

Note 1: Do not access reserved areas by the program.

Note 2: - ; Cannot be accessed.

Note 3: Write-only registers and interrupt latches cannot use the read-modify-write instructions (Bit manipulation instructions such as SET, CLR, etc. and logical operation instructions such as AND, OR, etc.).

## 5. I/O Ports

The TMP86FS28DFG has 9 input/output ports (62 pins) as shown below.

Table 5-1 Port Functions

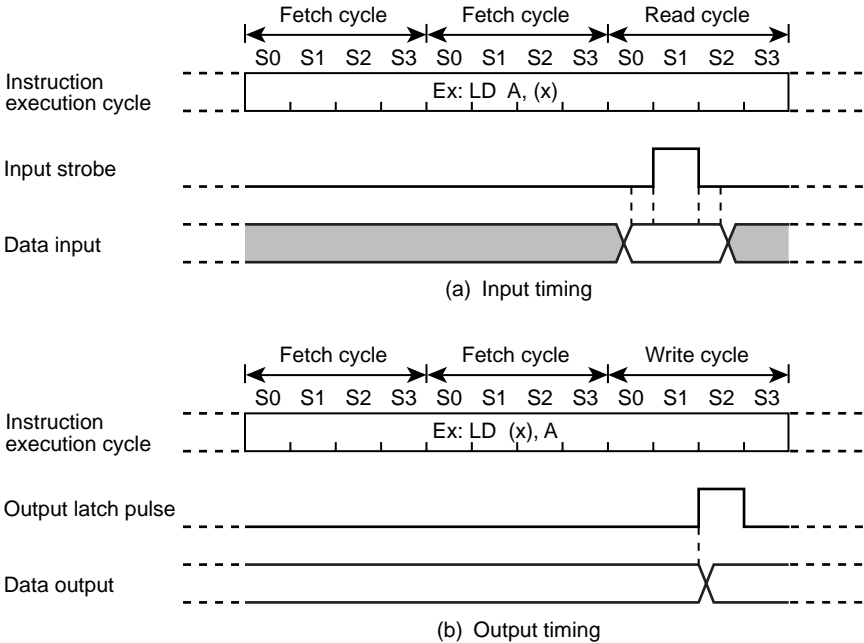
	Primary Function	Secondary Functions
Port P0	3-bit input/output port	External interrupt input, PPG output
Port P1	8-bit input/output port	Analog input, STOP mode release signal input
Port P2	3-bit input/output port	External interrupt input, low-frequency resonator connection, STOP mode release signal input
Port P3	8-bit input/output port	External interrupt input, timer/counter input, serial interface input/output, UART input/output, divider output
Port P4	8-bit input/output port	External interrupt input, timer/counter input, LCD segment output, PPG output
Port P5	8-bit input/output port	Timer/counter input/output, LCD segment output, UART input/output
Port P6	8-bit input/output port	LCD segment output
Port P7	8-bit input/output port	LCD segment output
Port P8	8-bit input/output port	LCD segment output

Table 5-2 Register List

Port	Latch	Read	Pch Control	CR1	CR2	LCD Control
P0	P0DR (0000H)	P0PRD (0FF0H)	P0OUTCR (0032H)	–	–	–
P1	P1DR (0001H)	–	–	P1CR1 (0FF9H)	P1CR2 (0FFAH)	–
P2	P2DR (0002H)	P2PRD (0FF2H)	–	–	–	–
P3	P3DR (0003H)	P3PRD (0FF3H)	P3OUTCR (002BH)	–	–	–
P4	P4DR (0004H)	P4PRD (0FF4H)	P4OUTCR (0FFBH)	–	–	P4LCR (0FD4H)
P5	P5DR (0005H)	P5PRD (0FF5H)	P5OUTCR (0FFCH)	–	–	P5LCR (0FD5H)
P6	P6DR (0006H)	P6PRD (0FF6H)	P6OUTCR (0FFDH)	–	–	P6LCR (0FD6H)
P7	P7DR (0007H)	P7PRD (0FF7H)	P7OUTCR (0FFEh)	–	–	P7LCR (0FD7H)
P8	P8DR (0008H)	P8PRD (0FF8H)	P8OUTCR (0FFFH)	–	–	P8LCR (0FD8H)

Each output port contains a latch for holding output data. All input ports do not have latches, making it necessary to externally hold input data until it is read externally or to read input data multiple times before it is processed. Figure 5-1 shows input/output timings.

External data is read from an input/output port in the S1 state of the read cycle in instruction execution. Since this timing cannot be recognized externally, transient input such as chattering must be processed by software. Data is output to an input/output port in the S2 state of the write cycle in instruction execution.



Note: The positions of the read and write cycles may vary depending on the instruction.

Figure 5-1 Input/Output Timings (Example)



## 5.1 Port P0 (P00 to P02)

Port P0 is a 3-bit input/output port that can also be used for external interrupt input or PPG output.

A reset initializes the output latch (P0DR) to “1” and the Pch control (P0OUTCR) to “0”.

To use a pin in Port P0 as an input port or external interrupt input, set P0DR to “1” and then set the corresponding bit in P0OUTCR to “0”.

To use a pin in Port P0 as a PPG output, set P0DR to “1”.

The output circuit of Port P0 can be set either as sink open-drain output (“0”) or CMOS output (“1”) individually for each bit in P0OUTCR.

Port P0 has a separate data input register. The output latch state can be read from the P0DR register, and the pin state can be read from the P0PRD register.

Table 5-3 Register Programming for Port P0 (P00 to P02)

Function	Programmed Value	
	P0DR	P0OUTCR
Port input, external interrupt input	“1”	“0”
Port “0” output	“0”	Set as appropriate.
Port “1” output, PPG output	“1”	

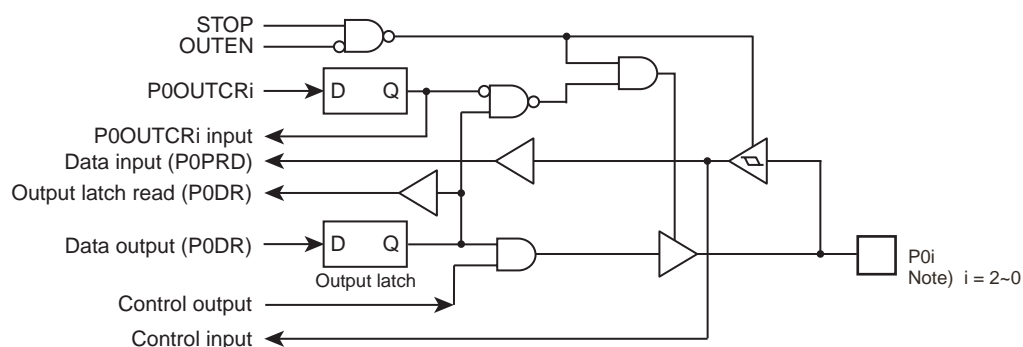
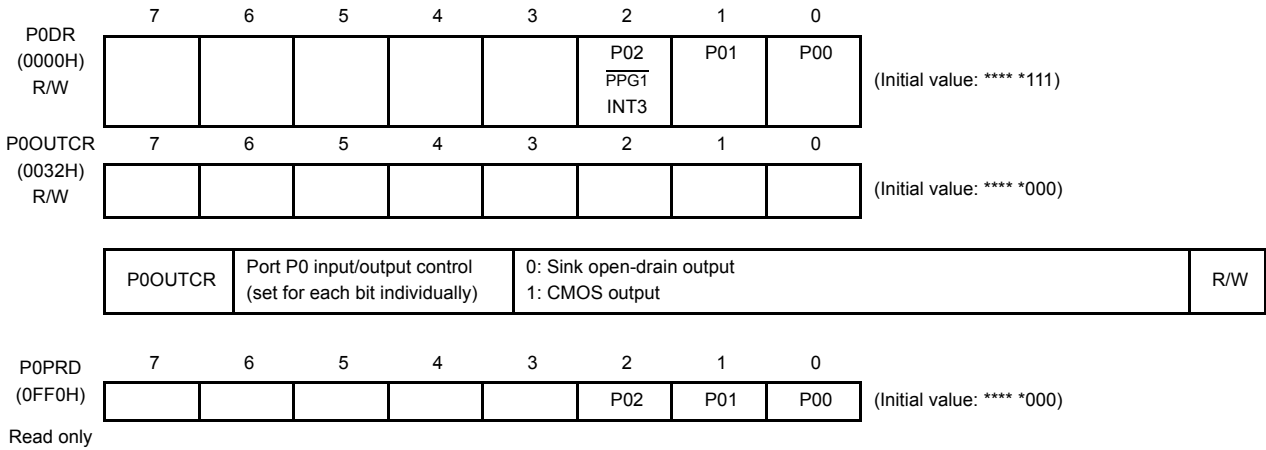


Figure 5-2 Port P0



## 5.2 Port P1 (P10 to P17)

Port P1 is an 8-bit input/output port that can be configured as an input or an output on a bit basis. Port P1 is also used for analog input or key-on wake-up input.

The Port P1 input/output control register (P1CR1) and Port P1 input control register (P1CR2) are used to specify the function of each pin.

A reset initializes P1CR1 to “0”, P1CR2 to “1”, and the output latch (P1DR) to “0” so that Port P1 becomes an input port.

To use a pin in Port P1 as an input port, set P1CR1 to “0” and then set P1CR2 to “1”. To use a pin in Port P1 as an analog input or key-on wake-up input, set P1CR1 to “0” and then set P1CR2 to “0”.

To use a pin in Port P1 as an output port, set the corresponding bit in P1CR1 to “1”.

To read the output latch data, set P1CR1 to “1” and read P1DR. To read the pin state, set P1CR1 to “0” and P1CR2 to “1” and then read P1DR. When P1CR1 = “0” and P1CR2 = “0”, P1DR is read as “0”.

Bits not used as analog inputs are used as input/output pins. During AD conversion, however, output instructions must not be executed to ensure the accuracy of conversion results. Also, during AD conversion, do not input signals that fluctuate widely to pins near analog input pins.

Table 5-4 Register Programming for Port P1 (P10 to P17)

Function	Programmed Value		
	P1DR	P1CR1	P1CR2
Port input	*	“0”	“1”
Analog input, key-on wake-up input	*	“0”	“0”
Port “0” output	“0”	“1”	*
Port “1” output	“1”	“1”	*

Note: An asterisk (\*) indicates that either “1” or “0” can be set.

Table 5-5 Values Read from P1DR according to Register Programming

Conditions		Values Read from P1DR
P1CR1	P1CR2	
“0”	“0”	“0”
“0”	“1”	Pin state
“1”	“0”	Output latch state
	“1”	

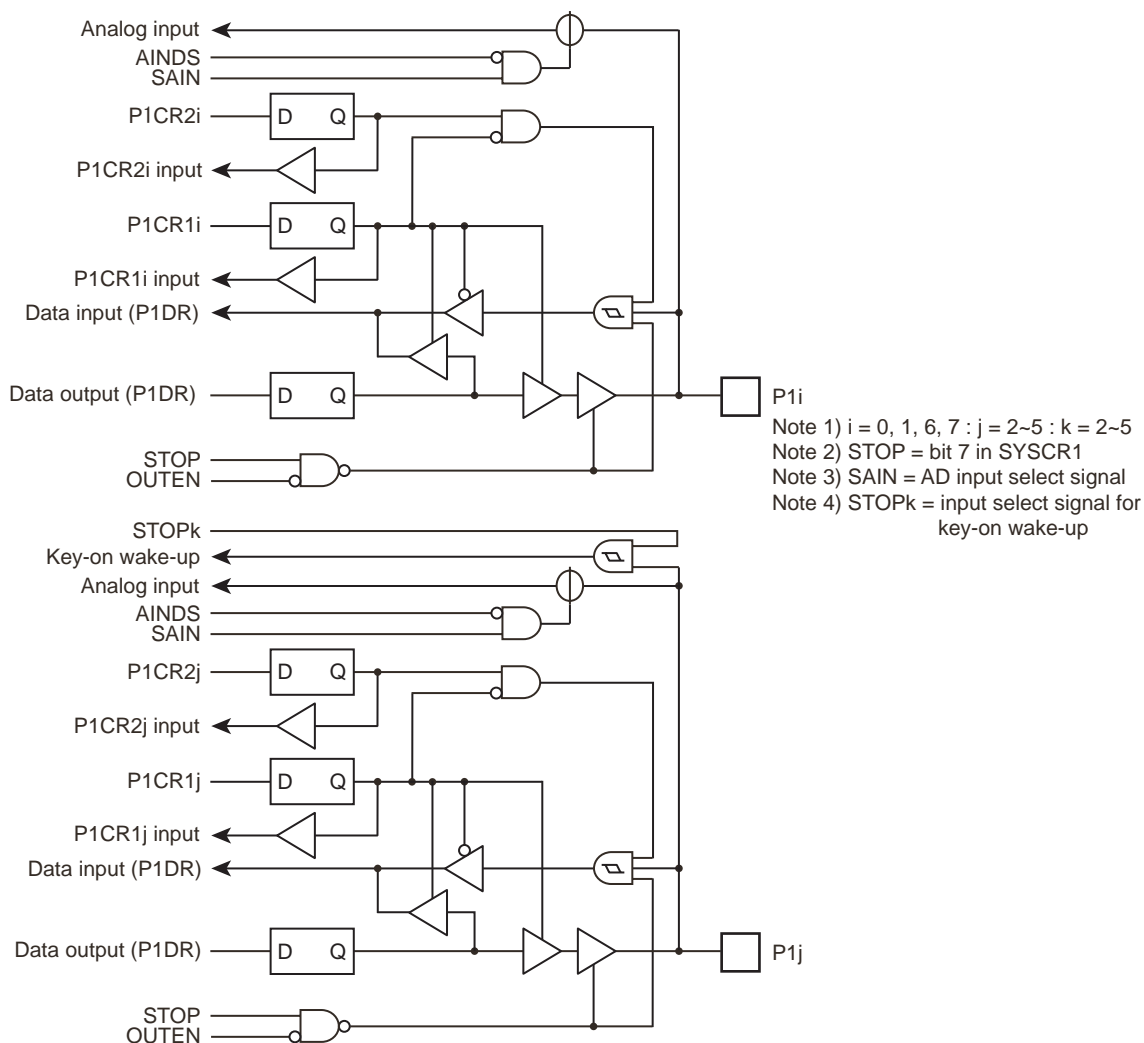


Figure 5-3 Port P1

- Note 1: Pins set to input mode read the pin input data. Therefore, when both input and output modes are used in Port P1, the contents of the output latch of a pin set to input mode may be overwritten by a bit manipulation instruction.
- Note 2: For a pin used as an analog input, be sure to clear the corresponding bit in P1CR2 to "0" to prevent flow-through current.
- Note 3: For a pin used as an analog input, do not set P1CR1 to "1" (port output) to prevent the pin from becoming shorted with an external signal.
- Note 4: Pins not used as analog inputs can be used as input/output pins. During AD conversion, however, output instructions must not be executed to ensure the accuracy of conversion results. Also, during AD conversion, do not input signals that fluctuate widely to pins near analog input pins.

	7	6	5	4	3	2	1	0	
P1DR (0001H) R/W	P17 AIN7	P16 AIN6	P15 AIN5 STOP5	P14 AIN4 STOP4	P13 AIN3 STOP3	P12 AIN2 STOP2	P11 AIN1	P10 AIN0	(Initial value: 0000 0000)

	7	6	5	4	3	2	1	0	
P1CR1 (0FF9H)									(Initial value: 0000 0000)

P1CR1	Port P1 input/output control (set for each bit individually)	0: Port input, key-on wake-up input, analog input 1: Port output	R/W
-------	---	---	-----

	7	6	5	4	3	2	1	0	
P1CR2 (0FFAH)									(Initial value: 1111 1111)

P1CR2	Port P1 input control (set for each bit individually)	0: Analog input, key-on wake-up input 1: Port input	R/W
-------	--	--	-----

5.3 Port P2 (P20 to P22)

Port P2 is a 3-bit input/output port that can also be used for external interrupt input, STOP mode release signal input, or low-frequency resonator connection.

To use Port P2 as an input port or function pins, set the output latch (P2DR) to “1”. A reset initializes P2DR to “1”.

In the dual clock mode, pins P21 (XTIN) and P22 (XOUT) are connected with a low-frequency resonator (32.768 kHz). In the single clock mode, pins P21 and P22 can be used as normal input/output port pins.

It is recommended that pin P20 be used as an external interrupt input, STOP release signal input, or input port. (When P20 is used as an output port, the interrupt latch is set on the falling edge of the output pulse.)

Port P2 has a separate data input register. The output latch state can be read from the P2DR register, and the pin state can be read from the P2PRD register.

When a read instruction is executed on P2DR or P2PRD, bits 7 to 3 are read as undefined.

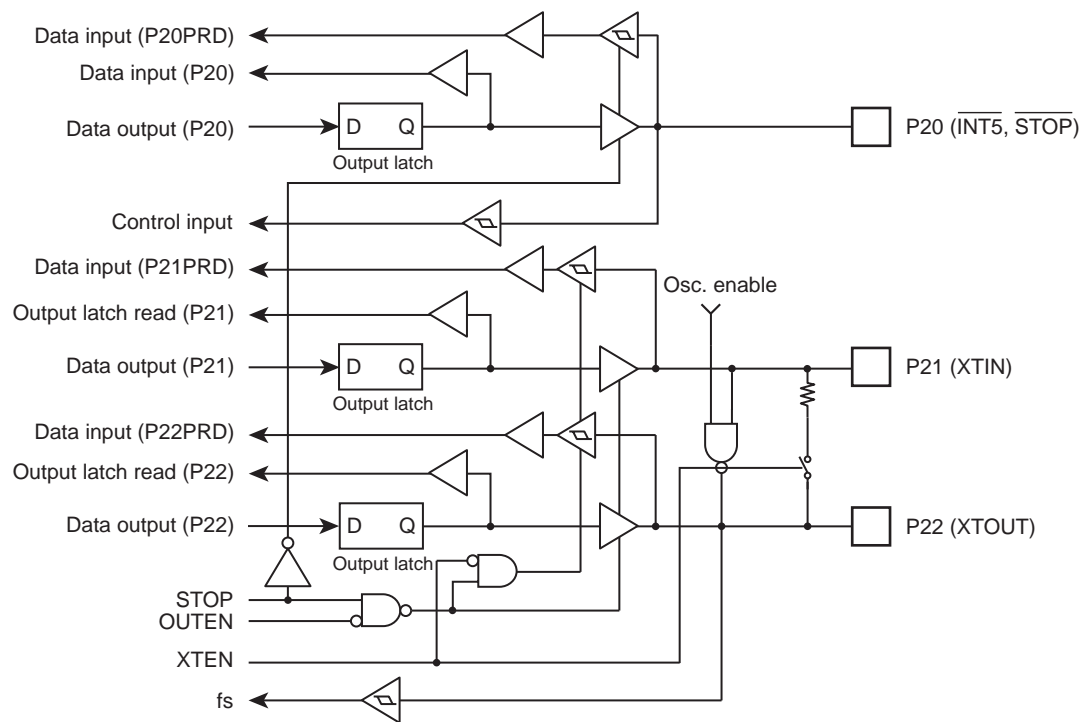


Figure 5-4 Port P2

	7	6	5	4	3	2	1	0	
P2DR (0002H) R/W						P22 XTOUT	P21 XTIN	P20 INT5 STOP	(Initial value: **** *111)
P2PRD (0FF2H) Read only	7	6	5	4	3	2	1	0	
						P22	P21	P20	

Note: Since pin P20 is also used as a  $\overline{\text{STOP}}$  pin, the output of P20 becomes high-impedance in STOP mode regardless of the OUTEN state.

## 5.4 Port P3 (P30 to P37)

Port P3 is an 8-bit input/output port that can also be used for external interrupt input, divider output, timer/counter input, serial interface input/output, or UART input/output.

A reset initializes the output latch (P3DR) to “1” and the Pch control (P3OUTCR) to “0”.

To use a pin in Port P3 as an external interrupt input, timer/counter input, serial interface input, or UART input, set P3DR to “1” and then set the corresponding bit in P3OUTCR to “0”.

To use a pin in Port P3 as a divider output, serial interface output, or UART output, set P3DR to “1”.

Port 3 can be used for either SIO or UART, so be sure not to enable both of these functions at the same time.

The output circuit of Port P3 can be set either as sink open-drain output (“0”) or CMOS output (“1”) individually for each bit in P3OUTCR.

Port P3 has a separate data input register. The output latch state can be read from the P3DR register, and the pin state can be read from the P3PRD register.

Table 5-6 Register Programming for Port P3 (P30 to P37)

Function	Programmed Value	
	P3DR	P3OUTCR
Port input, external interrupt input, timer/counter input, serial interface input, UART input	“1”	“0”
Port “0” output	“0”	Set as appropriate.
Port “1” output, serial interface output, UART output, divider output	“1”	

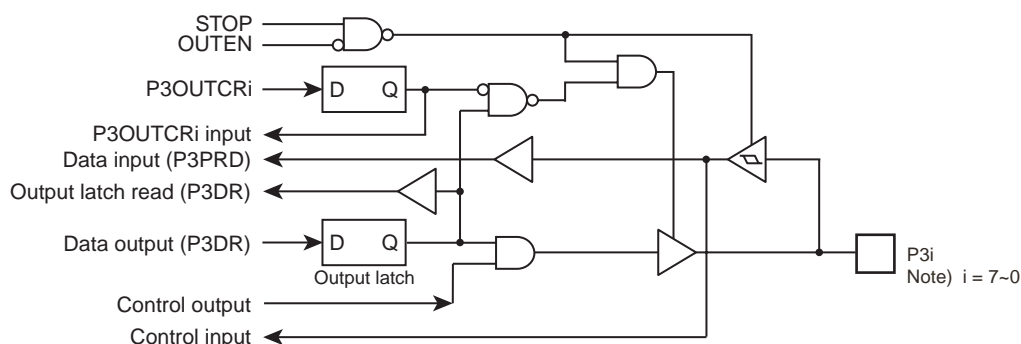


Figure 5-5 Port P3

								7	6	5	4	3	2	1	0	
P3DR (0003H) R/W	P37 TC10 INT4		P36 SCK		P35 SI TXD1		P34 SO RXD1		P33		P32		P31 DVO		P30 INT0	
	(Initial value: 1111 1111)															
P3OUTCR (002BH)	7	6	5	4	3	2	1	0								
									(Initial value: 0000 0000)							
P3OUTCR		Port P3 output circuit control (set for each bit individually)						0: Sink open-drain output 1: CMOS output								R/W
P3PRD (0FF3H) Read only	7	6	5	4	3	2	1	0								
	P37	P36	P35	P34	P33	P32	P31	P30								



5.5 Port P4 (P40 to P47)

Port P4 is an 8-bit input/output port that can also be used for external interrupt input, PPG output, timer/counter input, or LCD segment output.

A reset initializes the output latch (P4DR) to “1”, the Pch control (P4OUTCR) to “0”, and the LCD output control register (P4LCR) to “0”.

To use a pin in Port P4 as an input port, external interrupt input, or timer/counter input, set P4DR to “1” and then set the corresponding bit in P4LCR and P4OUTCR to “0”.

To use a pin in Port P4 as an LCD segment output, set the corresponding bit in P4LCR to “1”.

To use a pin in Port P4 as a PPG output, set P4DR to “1” and then set the corresponding bit in P4LCR to “0”.

The output circuit of Port P4 can be set either as sink open-drain output (“0”) or CMOS output (“1”) individually for each bit in P4OUTCR.

Port P4 has a separate data input register. The output latch state can be read from the P4DR register, and the pin state can be read from the P4PRD register.

Table 5-7 Register Programming for Port P4 (P40 to P47)

Function	Programmed Value		
	P4DR	P4OUTCR	P4LCR
Port input, external interrupt input, timer/counter input	“1”	“0”	“0”
Port “0” output	“0”	Set as appropriate.	“0”
Port “1” output	“1”		“0”
PPG output	“1”		“0”
LCD segment output	*	*	“1”

Note: An asterisk (\*) indicates that either “1” or “0” can be set.

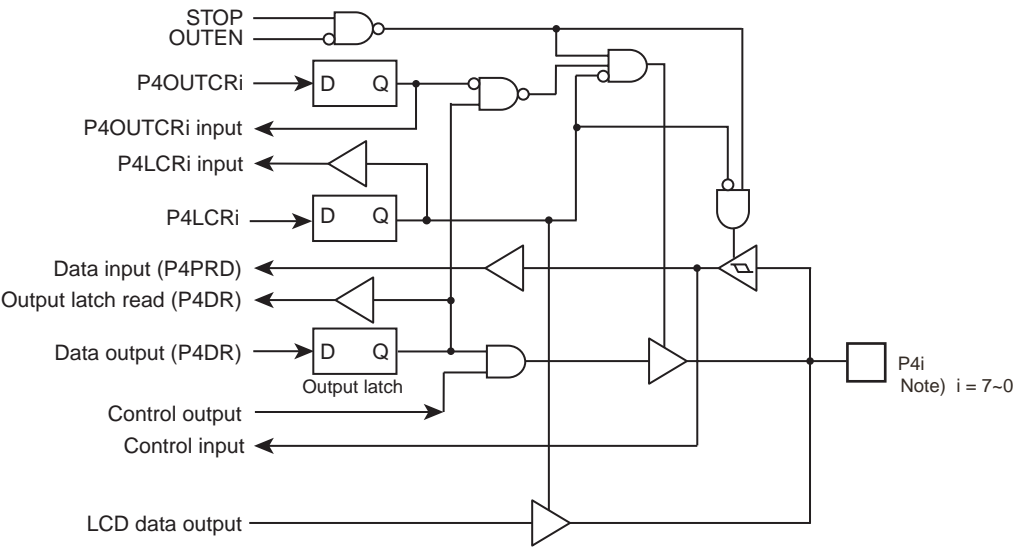


Figure 5-6 Port P4

	7	6	5	4	3	2	1	0	
P4DR (0004H) R/W	P47 SEG32	P46 SEG31	P45 SEG30	P44 SEG29	P43 SEG28 TC11	P42 SEG27 PPG1	P41 SEG26 INT2	P40 SEG25 INT1	(Initial value: 0000 0000)

	7	6	5	4	3	2	1	0	
P4LCR (0FD4H)									(Initial value: 0000 0000)

P4LCR	Port P4 segment output control (Set for each bit individually)	0: Input/output port 1: LCD segment output	R/W
-------	---	---	-----

	7	6	5	4	3	2	1	0	
P4OUTCR (0FFBH)									(Initial value: 0000 0000)

P4OUTCR	P4 output circuit control (Set for each bit individually)	0: Sink open-drain output 1: CMOS output	R/W
---------	--	---	-----

	7	6	5	4	3	2	1	0	
P4PRD (0FF4H) Read only	P47	P46	P45	P44	P43	P42	P41	P40	

5.6 Port P5 (P50 to P57)

Port P5 is an 8-bit input/output port that can also be used for timer/counter input/output, LCD segment output, or UART input/output.

A reset initializes the output latch (P5DR) to “1”, the Pch control (P5OUTCR) to “0”, and the LCD output control register (P5LCR) to “0”.

To use a pin in Port P5 as an input port, timer/counter input, or UART input, set P5DR to “1” and then set the corresponding bit in P5LCR and P5OUTCR to “0”.

To use a pin in Port P5 as an LCD segment output, set the corresponding bit in P5LCR to “1”.

To use a pin in Port P5 as a UART output or timer/counter output, set P5DR to “1” and then set the corresponding bit in P5LCR to “0”.

The output circuit of Port P5 can be set either as sink open-drain output (“0”) or CMOS output (“1”) individually for each bit in P5OUTCR.

Port P5 has a separate data input register. The output latch state can be read from the P5DR register, and the pin state can be read from the P5PRD register.

Table 5-8 Register Programming for Port P5 (P50 to P57)

Function	Programmed Value		
	P5DR	P5OUTCR	P5LCR
Port input, UART input, timer/counter input	“1”	“0”	“0”
Port “0” output	“0”	Set as appropriate.	“0”
Port “1” output, UART output	“1”		“0”
LCD segment output	*	*	“1”

Note: An asterisk (\*) indicates that either “1” or “0” can be set.

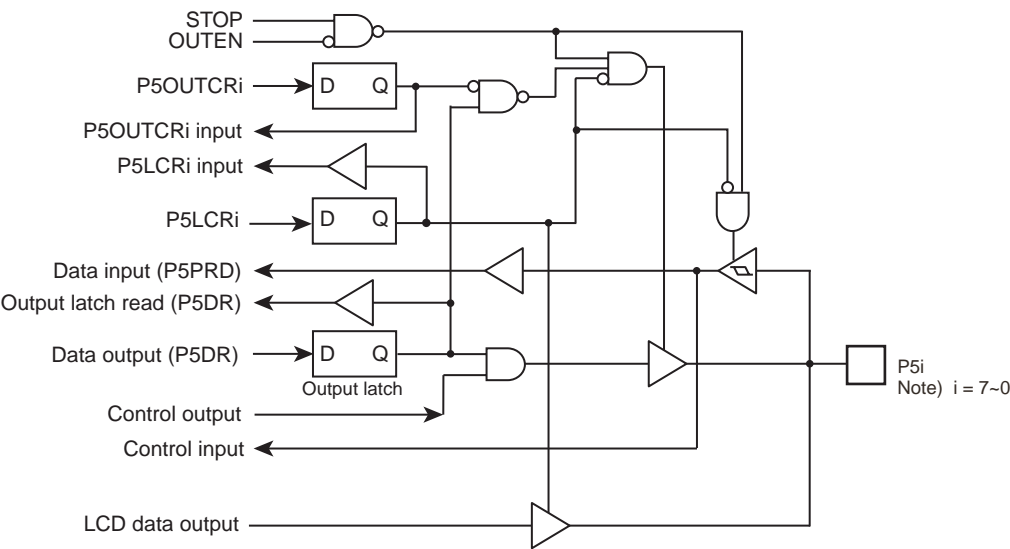


Figure 5-7 Port P5

	7	6	5	4	3	2	1	0	
P5DR (0005H) R/W	P57 SEG24	P56 SEG25	P55 SEG26 TC6 PWM6 PDO6	P54 SEG27 TC5 PWM5 PDO5	P53 SEG28 TC4 PWM4 PDO4	P52 SEG29 TC3 PWM3 PDO3	P51 SEG30 RXD0	P50 SEG31 TXD0	(Initial value: 0000 0000)
P5LCR (0FD5H)	7	6	5	4	3	2	1	0	(Initial value: 0000 0000)
P5LCR	Port P5 segment output control (Set for each bit individually)				0: Input/output port 1: LCD segment output				R/W
P5OUTCR (0FFCH)	7	6	5	4	3	2	1	0	(Initial value: 0000 0000)
P5OUTCR	Port P5 input/output control (Set for each bit individually)				0: Sink open-drain output 1: CMOS output				R/W
P5PRD (0FF5H) Read only	7	6	5	4	3	2	1	0	
	P57	P56	P55	P54	P53	P52	P51	P50	

5.7 Port P6 (P60 to P67)

Port P6 is an 8-bit input/output port that can also be used for LCD segment output.

A reset initializes the output latch (P6DR) to “1”, the Pch control (P6OUTCR) to “0”, and the LCD output control register (P6LCR) to “0”.

To use a pin in Port P6 as an input port, set P6DR to “1” and then set the corresponding bit in P6LCR and P6OUTCR to “0”.

To use a pin in Port P6 as an LCD segment output, set the corresponding bit in P6LCR to “1”.

The output circuit of Port P6 can be set either as sink open-drain output (“0”) or CMOS output (“1”) individually for each bit in P6OUTCR.

Port P6 has a separate data input register. The output latch state can be read from the P6DR register, and the pin state can be read from the P6PRD register.

Table 5-9 Register Programming for Port P6 (P60 to P67)

Function	Programmed Value		
	P6DR	P6OUTCR	P6LCR
Port input	“1”	“0”	“0”
Port “0” output	“0”	Set as appropriate.	“0”
Port “1” output	“1”		“0”
LCD segment output	*	*	“1”

Note: An asterisk (\*) indicates that either “1” or “0” can be set.

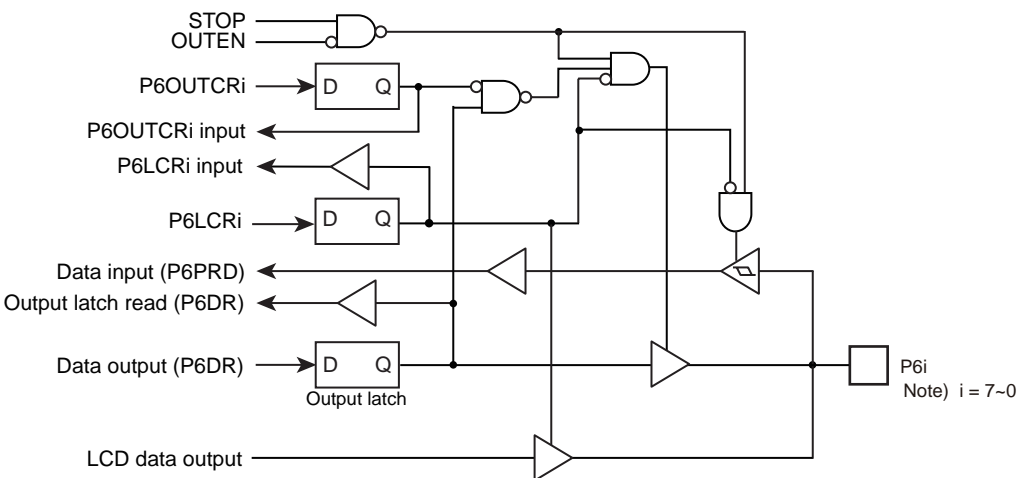


Figure 5-8 Port P6

P6DR (0006H) R/W	7	6	5	4	3	2	1	0	
	P67 SEG16	P66 SEG17	P65 SEG18	P64 SEG19	P63 SEG20	P62 SEG21	P61 SEG22	P60 SEG23	(Initial value: 0000 0000)
P6LCR (0FD6H)	7	6	5	4	3	2	1	0	
									(Initial value: 0000 0000)

P6LCR	Port P6 segment output control (Set for each bit individually)	0: Input/output port 1: Segment output	R/W
-------	---	---	-----

P6OUTCR (0FFDH)	7	6	5	4	3	2	1	0	
									(Initial value: 1111 1111)
P6CR2	Port P6 input/output control (Set for each bit individually)				0: Sink open-drain output 1: CMOS output				

P6PRD (0FF6H) Read only	7	6	5	4	3	2	1	0
	P67	P66	P65	P64	P63	P62	P61	P60

# 5.8 Port P7 (P70 to P77)

Port P7 is an 8-bit input/output port that can also be used for LCD segment output.

A reset initializes the output latch (P7DR) to “1”, the Pch control (P7OUTCR) to “0”, and the LCD output control register (P7LCR) to “0”.

To use a pin in Port P7 as an input port, set P7DR to “1” and then set the corresponding bit in P7LCR and P7OUTCR to “0”.

To use a pin in Port P7 as an LCD segment output, set the corresponding bit in P7LCR to “1”.

The output circuit of Port P7 can be set either as sink open-drain output (“0”) or CMOS output (“1”) individually for each bit in P7OUTCR.

Port P7 has a separate data input register. The output latch state can be read from the P7DR register, and the pin state can be read from the P7PRD register.

Table 5-10 Register Programming for Port P7 (P70 to P77)

Function	Programmed Value		
	P7DR	P7OUTCR	P7LCR
Port input	“1”	“0”	“0”
Port “0” output	“0”	Set as appropriate.	“0”
Port “1” output	“1”		“0”
LCD segment output	*	*	“1”

Note: An asterisk (\*) indicates that either “1” or “0” can be set.

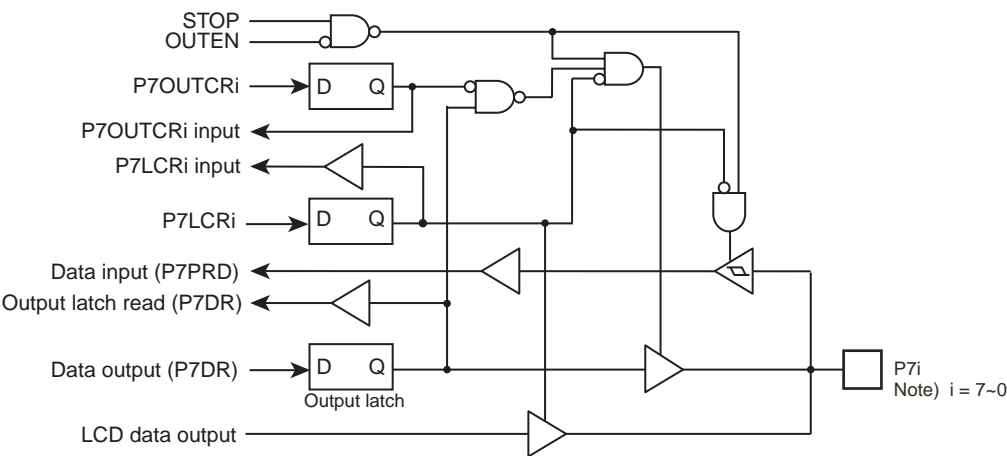


Figure 5-9 Port P7

P7DR (0007H) R/W	7	6	5	4	3	2	1	0	
	P77 SEG8	P76 SEG9	P75 SEG10	P74 SEG11	P73 SEG12	P72 SEG13	P71 SEG14	P70 SEG15	(Initial value: 0000 0000)

P7LCR (0FD7H)	7	6	5	4	3	2	1	0	
									(Initial value: 0000 0000)

P7LCR	Port P7 segment output control (set for each bit individually)	0: Input/output port 1: Segment output	R/W
-------	---	---	-----

P7OUTCR (0FFE7H)	7	6	5	4	3	2	1	0	
									(Initial value: 0000 0000)

P7OUTCR	Port P7 input/output control (set for each bit individually)	0: Sink open-drain output 1: CMOS output	R/W
---------	---	---	-----

P7PRD (0FF7H)	7	6	5	4	3	2	1	0
	P77	P76	P75	P74	P73	P72	P71	P70

Read only



## 5.9 Port P8 (P80 to P87)

Port P8 is an 8-bit input/output port that can also be used for LCD segment output.

A reset initializes the output latch (P8DR) to “1”, the Pch control (P8OUTCR) to “0”, and the LCD output control register (P8LCR) to “0”.

To use a pin in Port P8 as an input port, set P8DR to “1” and then set the corresponding bit in P8LCR and P8OUTCR to “0”.

To use a pin in Port P8 as an LCD segment output, set the corresponding bit in P8LCR to “1”.

The output circuit of Port P8 can be set either as sink open-drain output (“0”) or CMOS output (“1”) individually for each bit in P8OUTCR.

Port P8 has a separate data input register. The output latch state can be read from the P8DR register, and the pin state can be read from the P8PRD register.

Table 5-11 Register Programming for Port P8 (P80 to P87)

Function	Port Input		
	P8DR	P8OUTCR	P8LCR
Port input	“1”	“0”	“0”
Port “0” output	“0”	Set as appropriate.	“0”
Port “1” output	“1”		“0”
LCD segment output	*	*	“1”

Note: An asterisk (\*) indicates that either “1” or “0” can be set.

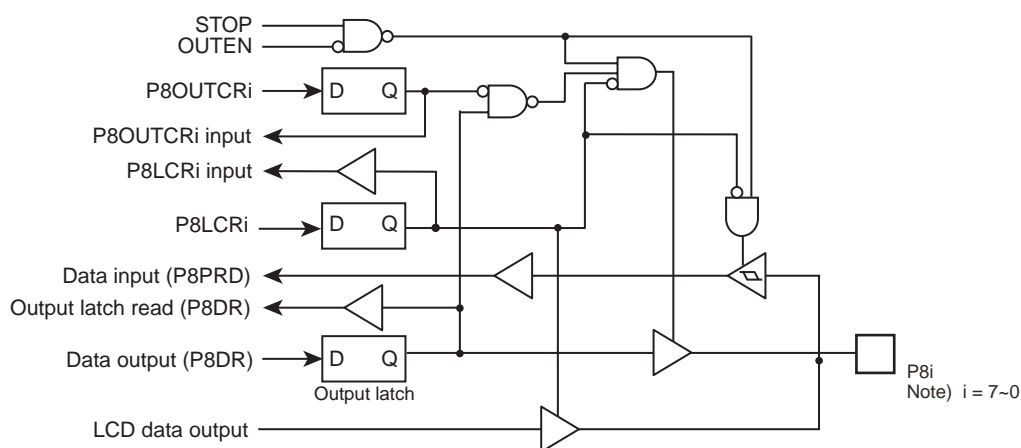


Figure 5-10 Port P8

P8DR (0008H) R/W	7	6	5	4	3	2	1	0	
	P87 SEG0	P86 SEG1	P85 SEG2	P84 SEG3	P83 SEG4	P82 SEG5	P81 SEG6	P80 SEG7	(Initial value: 0000 0000)

P8LCR (0FD8H)	7	6	5	4	3	2	1	0	
									(Initial value: 0000 0000)

P8LCR	Port P8 segment output control (Set for each bit individually)	0: Input/output port 1: LCD segment output	R/W
-------	---	---	-----

P8OUTCR (0FFFH)	7	6	5	4	3	2	1	0	
									(Initial value: 0000 0000)

P8OUTCR	Port P8 input/output control (Set for each bit individually)	0: Sink open-drain output 1: CMOS output	R/W
---------	---	---	-----

P8PRD (0FF8H)	7	6	5	4	3	2	1	0
	P87	P86	P85	P84	P83	P82	P81	P80

Read only

## 6. Watchdog Timer (WDT)

The watchdog timer is a fail-safe system to detect rapidly the CPU malfunctions such as endless loops due to spurious noises or the deadlock conditions, and return the CPU to a system recovery routine.

The watchdog timer signal for detecting malfunctions can be programmed only once as “reset request” or “interrupt request”. Upon the reset release, this signal is initialized to “reset request”.

When the watchdog timer is not used to detect malfunctions, it can be used as the timer to provide a periodic interrupt.

Note: Care must be taken in system design since the watchdog timer functions are not be operated completely due to effect of disturbing noise.

### 6.1 Watchdog Timer Configuration

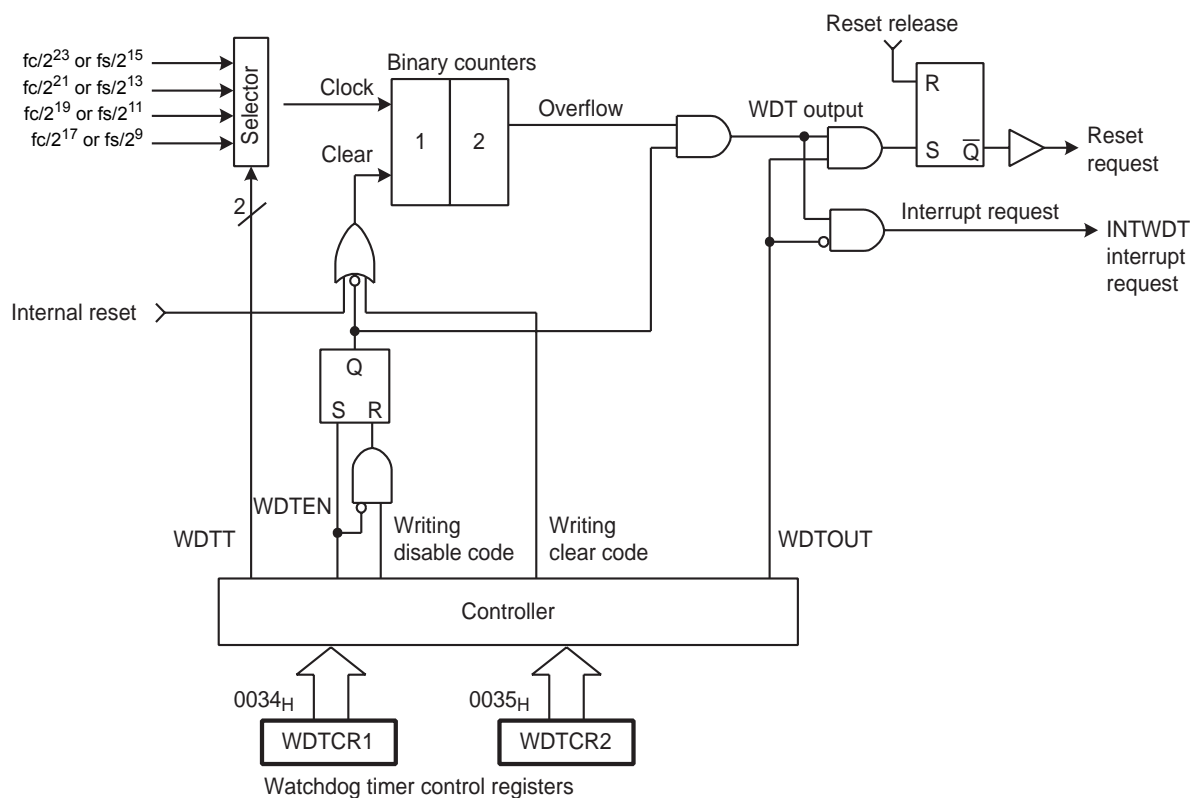


Figure 6-1 Watchdog Timer Configuration

6.2 Watchdog Timer Control

The watchdog timer is controlled by the watchdog timer control registers (WDTCR1 and WDTCR2). The watchdog timer is automatically enabled after the reset release.

6.2.1 Malfunction Detection Methods Using the Watchdog Timer

The CPU malfunction is detected, as shown below.

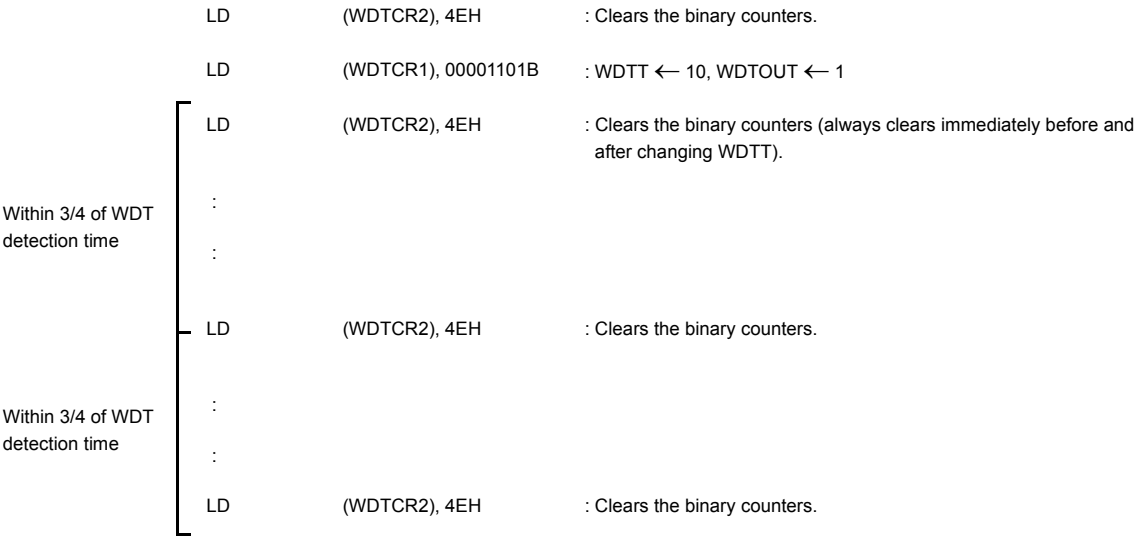
1. Set the detection time, select the output, and clear the binary counter.
  2. Clear the binary counter repeatedly within the specified detection time.

If the CPU malfunctions such as endless loops or the deadlock conditions occur for some reason, the watchdog timer output is activated by the binary-counter overflow unless the binary counters are cleared. When WDTCR1<WDTOUT> is set to “1” at this time, the reset request is generated and then internal hardware is initialized. When WDTCR1<WDTOUT> is set to “0”, a watchdog timer interrupt (INTWDT) is generated.

The watchdog timer temporarily stops counting in the STOP mode including the warm-up or IDLE/SLEEP mode, and automatically restarts (continues counting) when the STOP/IDLE/SLEEP mode is inactivated.

Note: The watchdog timer consists of an internal divider and a two-stage binary counter. When the clear code 4EH is written, only the binary counter is cleared, but not the internal divider. The minimum binary-counter overflow time, that depends on the timing at which the clear code (4EH) is written to the WDTCR2 register, may be 3/4 of the time set in WDTCR1<WDTT>. Therefore, write the clear code using a cycle shorter than 3/4 of the time set to WDTCR1<WDTT>.

Example :Setting the watchdog timer detection time to  $2^{21}/f_c$  [s], and resetting the CPU malfunction detection



## Watchdog Timer Control Register 1

WDTCR1 (0034H)	7	6	5	4	3	2	1	0
			(ATAS)	(ATOUT)	WDTEN	WDTT	WDTOUT	(Initial value: **11 1001)

WDTEN	Watchdog timer enable/disable	0: Disable (Writing the disable code to WDTCR2 is required.) 1: Enable				Write only
WDTT	Watchdog timer detection time [s]		NORMAL1/2 mode		SLOW1/2 mode	Write only
			DV7CK = 0	DV7CK = 1		
		00	2 <sup>25</sup> /fc	2 <sup>17</sup> /fs	2 <sup>17</sup> /fs	
		01	2 <sup>23</sup> /fc	2 <sup>15</sup> /fs	2 <sup>15</sup> fs	
		10	2 <sup>21</sup> fc	2 <sup>13</sup> /fs	2 <sup>13</sup> fs	
		11	2 <sup>19</sup> /fc	2 <sup>11</sup> /fs	2 <sup>11</sup> /fs	
WDTOUT	Watchdog timer output select	0: Interrupt request 1: Reset request				Write only

Note 1: After clearing WDTOUT to "0", the program cannot set it to "1".

Note 2: fc: High-frequency clock [Hz], fs: Low-frequency clock [Hz], \*: Don't care

Note 3: WDTCR1 is a write-only register and must not be used with any of read-modify-write instructions. If WDTCR1 is read, a don't care is read.

Note 4: To activate the STOP mode, disable the watchdog timer or clear the counter immediately before entering the STOP mode. After clearing the counter, clear the counter again immediately after the STOP mode is inactivated.

Note 5: To clear WDTEN, set the register in accordance with the procedures shown in "6.2.3 Watchdog Timer Disable".

## Watchdog Timer Control Register 2

WDTCR2 (0035H)	7	6	5	4	3	2	1	0
								(Initial value: **** *)

WDTCR2	Write Watchdog timer control code	4EH: Clear the watchdog timer binary counter (Clear code) B1H: Disable the watchdog timer (Disable code) D2H: Enable assigning address trap area Others: Invalid	Write only
--------	--------------------------------------	---	------------

Note 1: The disable code is valid only when WDTCR1<WDTEN> = 0.

Note 2: \*: Don't care

Note 3: The binary counter of the watchdog timer must not be cleared by the interrupt task.

Note 4: Write the clear code 4EH using a cycle shorter than 3/4 of the time set in WDTCR1<WDTT>.

## 6.2.2 Watchdog Timer Enable

Setting WDTCR1<WDTEN> to "1" enables the watchdog timer. Since WDTCR1<WDTEN> is initialized to "1" during reset, the watchdog timer is enabled automatically after the reset release.

6.2.3 Watchdog Timer Disable

To disable the watchdog timer, set the register in accordance with the following procedures. Setting the register in other procedures causes a malfunction of the microcontroller.

- 1. Set the interrupt master flag (IMF) to “0”.
- 2. Set WDTCR2 to the clear code (4EH).
- 3. Set WDTCR1<WDTEN> to “0”.
- 4. Set WDTCR2 to the disable code (B1H).

Note: While the watchdog timer is disabled, the binary counters of the watchdog timer are cleared.

Example :Disabling the watchdog timer

```
DI                                     : IMF ← 0

LD      (WDTCR2), 04EH                : Clears the binary counter

LDW     (WDTCR1), 0B101H              : WDTEN ← 0, WDTCR2 ← Disable code
```

Table 6-1 Watchdog Timer Detection Time (Example: fc = 16.0 MHz, fs = 32.768 kHz)

WDTT	Watchdog Timer Detection Time[s]		
	NORMAL1/2 mode		SLOW mode
	DV7CK = 0	DV7CK = 1	
00	2.097	4	4
01	524.288 m	1	1
10	131.072 m	250 m	250 m
11	32.768 m	62.5 m	62.5 m

6.2.4 Watchdog Timer Interrupt (INTWDT)

When WDTCR1<WDTOUT> is cleared to “0”, a watchdog timer interrupt request (INTWDT) is generated by the binary-counter overflow.

A watchdog timer interrupt is the non-maskable interrupt which can be accepted regardless of the interrupt master flag (IMF).

When a watchdog timer interrupt is generated while the other interrupt including a watchdog timer interrupt is already accepted, the new watchdog timer interrupt is processed immediately and the previous interrupt is held pending. Therefore, if watchdog timer interrupts are generated continuously without execution of the RETN instruction, too many levels of nesting may cause a malfunction of the microcontroller.

To generate a watchdog timer interrupt, set the stack pointer before setting WDTCR1<WDTOUT>.

Example :Setting watchdog timer interrupt

```
LD      SP, 083FH                    : Sets the stack pointer

LD      (WDTCR1), 00001000B          : WDTOUT ← 0
```

### 6.2.5 Watchdog Timer Reset

When a binary-counter overflow occurs while WDTCR1<WDTOUT> is set to “1”, a watchdog timer reset request is generated. When a watchdog timer reset request is generated, the internal hardware is reset. The reset time is maximum  $24/f_c$  [s] ( $1.5\ \mu\text{s}$  @  $f_c = 16.0\ \text{MHz}$ ).

Note: When a watchdog timer reset is generated in the SLOW1 mode, the reset time is maximum  $24/f_c$  (high-frequency clock) since the high-frequency clock oscillator is restarted. However, when crystals have inaccuracies upon start of the high-frequency clock oscillator, the reset time should be considered as an approximate value because it has slight errors.

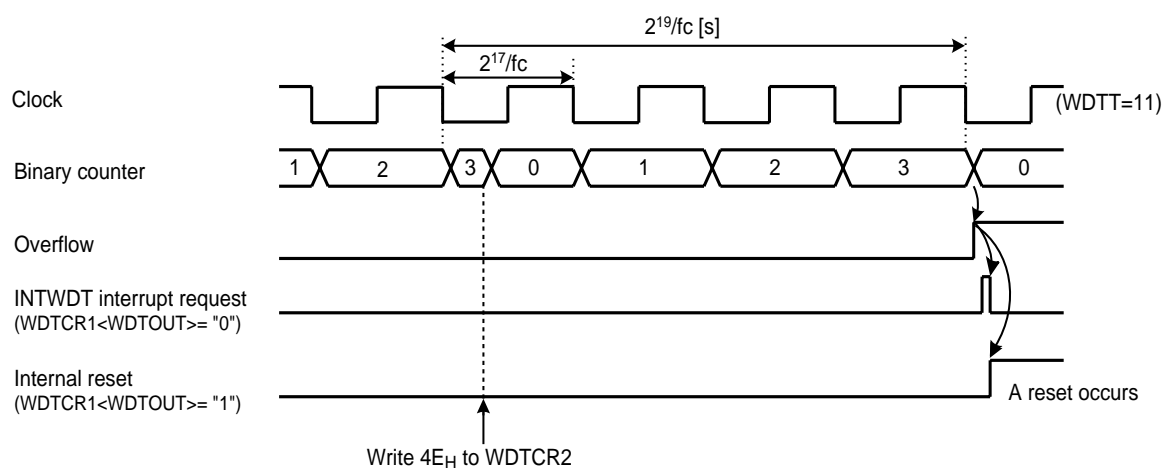


Figure 6-2 Watchdog Timer Interrupt

6.3 Address Trap

The Watchdog Timer Control Register 1 and 2 share the addresses with the control registers to generate address traps.

Watchdog Timer Control Register 1

WDTCR1 (0034H)	7	6	5	4	3	2	1	0	
			ATAS	ATOUT	(WDTEN)	(WDTT)	(WDTOUT)	(Initial value: **11 1001)	
ATAS	Select address trap generation in the internal RAM area				0: Generate no address trap 1: Generate address traps (After setting ATAS to "1", writing the control code D2H to WDTCR2 is required)				Write only
ATOUT	Select operation at address trap				0: Interrupt request 1: Reset request				

Watchdog Timer Control Register 2

WDTCR2 (0035H)	7	6	5	4	3	2	1	0	
									(Initial value: **** *)
WDTCR2	Write Watchdog timer control code and address trap area control code				D2H: Enable address trap area selection (ATRAP control code) 4EH: Clear the watchdog timer binary counter (WDT clear code) B1H: Disable the watchdog timer (WDT disable code) Others: Invalid				Write only

6.3.1 Selection of Address Trap in Internal RAM (ATAS)

WDTCR1<ATAS> specifies whether or not to generate address traps in the internal RAM area. To execute an instruction in the internal RAM area, clear WDTCR1<ATAS> to "0". To enable the WDTCR1<ATAS> setting, set WDTCR1<ATAS> and then write D2H to WDTCR2.

Executing an instruction in the SFR or DBR area generates an address trap unconditionally regardless of the setting in WDTCR1<ATAS>.

6.3.2 Selection of Operation at Address Trap (ATOUT)

When an address trap is generated, either the interrupt request or the reset request can be selected by WDTCR1<ATOUT>.

6.3.3 Address Trap Interrupt (INTATRAP)

While WDTCR1<ATOUT> is "0", if the CPU should start looping for some cause such as noise and an attempt be made to fetch an instruction from the on-chip RAM (while WDTCR1<ATAS> is "1"), DBR or the SFR area, address trap interrupt (INTATRAP) will be generated.

An address trap interrupt is a non-maskable interrupt which can be accepted regardless of the interrupt master flag (IMF).

When an address trap interrupt is generated while the other interrupt including an address trap interrupt is already accepted, the new address trap is processed immediately and the previous interrupt is held pending. Therefore, if address trap interrupts are generated continuously without execution of the RETN instruction, too many levels of nesting may cause a malfunction of the microcontroller.

To generate address trap interrupts, set the stack pointer beforehand.



### 6.3.4 Address Trap Reset

While WDTCR1<ATOUT> is “1”, if the CPU should start looping for some cause such as noise and an attempt be made to fetch an instruction from the on-chip RAM (while WDTCR1<ATAS> is “1”), DBR or the SFR area, address trap reset will be generated.

When an address trap reset request is generated, the internal hardware is reset. The reset time is maximum  $24/f_c$  [s] ( $1.5 \mu\text{s}$  @  $f_c = 16.0 \text{ MHz}$ ).

Note: When an address trap reset is generated in the SLOW1 mode, the reset time is maximum  $24/f_c$  (high-frequency clock) since the high-frequency clock oscillator is restarted. However, when crystals have inaccuracies upon start of the high-frequency clock oscillator, the reset time should be considered as an approximate value because it has slight errors.



## 7. Time Base Timer (TBT)

The time base timer generates time base for key scanning, dynamic displaying, etc. It also provides a time base timer interrupt (INTTBT).

### 7.1 Time Base Timer

#### 7.1.1 Configuration

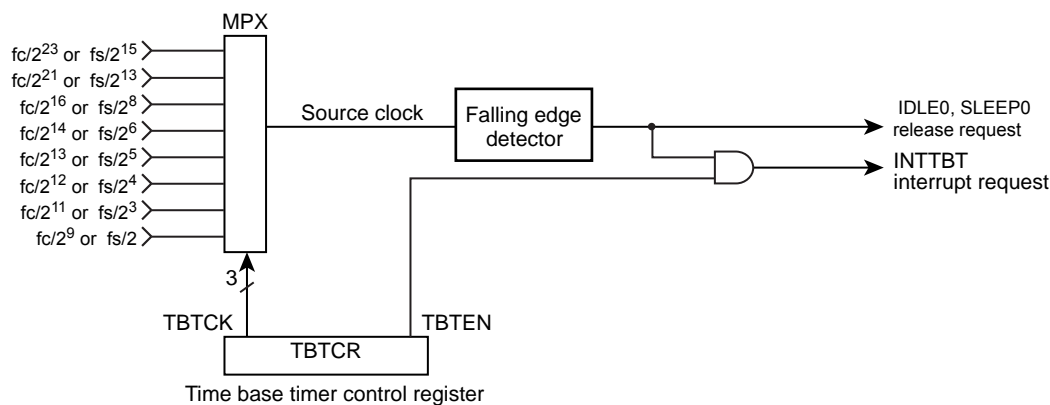


Figure 7-1 Time Base Timer configuration

#### 7.1.2 Control

Time Base Timer is controlled by Time Base Timer control register (TBTCTCR).

##### Time Base Timer Control Register

	7	6	5	4	3	2	1	0	
TBTCTCR (0036H)	(DVOEN)	(DVOCK)	(DV7CK)	TBTEN	TBTCK				(Initial Value: 0000 0000)

TBTEN	Time Base Timer enable / disable	0: Disable 1: Enable				
TBTCK	Time Base Timer interrupt Frequency select : [Hz]		NORMAL1/2, IDLE1/2 Mode		SLOW1/2 SLEEP1/2 Mode	R/W
			DV7CK = 0	DV7CK = 1		
		000	$fc/2^{23}$	$fs/2^{15}$	$fs/2^{15}$	
		001	$fc/2^{21}$	$fs/2^{13}$	$fs/2^{13}$	
		010	$fc/2^{16}$	$fs/2^8$	—	
		011	$fc/2^{14}$	$fs/2^6$	—	
		100	$fc/2^{13}$	$fs/2^5$	—	
		101	$fc/2^{12}$	$fs/2^4$	—	
		110	$fc/2^{11}$	$fs/2^3$	—	
		111	$fc/2^9$	$fs/2$	—	

Note 1: fc; High-frequency clock [Hz], fs; Low-frequency clock [Hz], \*, Don't care

Note 2: The interrupt frequency (TBTCK) must be selected with the time base timer disabled (TBTEN="0"). (The interrupt frequency must not be changed with the disable from the enable state.) Both frequency selection and enabling can be performed simultaneously.

Example :Set the time base timer frequency to  $f_c/2^{16}$  [Hz] and enable an INTTBT interrupt.

```
LD      (TBTCK) , 00000010B      ; TBTCK ← 010
LD      (TBTCK) , 00001010B      ; TBTEN ← 1
DI                               ; IMF ← 0
SET     (EIRL) . 6
```

Table 7-1 Time Base Timer Interrupt Frequency ( Example :  $f_c = 16.0$  MHz,  $f_s = 32.768$  kHz )

TBTCK	Time Base Timer Interrupt Frequency [Hz]		
	NORMAL1/2, IDLE1/2 Mode	NORMAL1/2, IDLE1/2 Mode	SLOW1/2, SLEEP1/2 Mode
	DV7CK = 0	DV7CK = 1	
000	1.91	1	1
001	7.63	4	4
010	244.14	128	—
011	976.56	512	—
100	1953.13	1024	—
101	3906.25	2048	—
110	7812.5	4096	—
111	31250	16384	—

7.1.3 Function

An INTTBT ( Time Base Timer Interrupt ) is generated on the first falling edge of source clock ( The divider output of the timing generator which is selected by TBTCK. ) after time base timer has been enabled.

The divider is not cleared by the program; therefore, only the first interrupt may be generated ahead of the set interrupt period ( Figure 7-2 ).

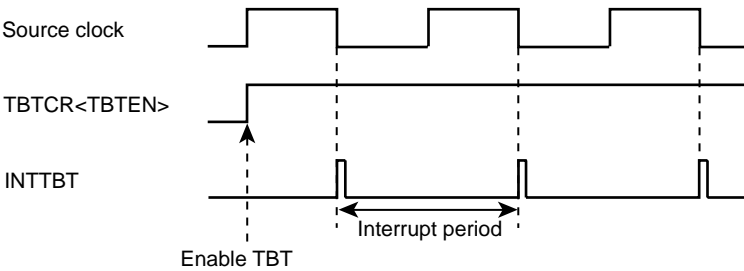


Figure 7-2 Time Base Timer Interrupt

7.2 Divider Output ( $\overline{\text{DVO}}$ )

Approximately 50% duty pulse can be output using the divider output circuit, which is useful for piezoelectric buzzer drive. Divider output is from  $\overline{\text{DVO}}$  pin.

7.2.1 Configuration

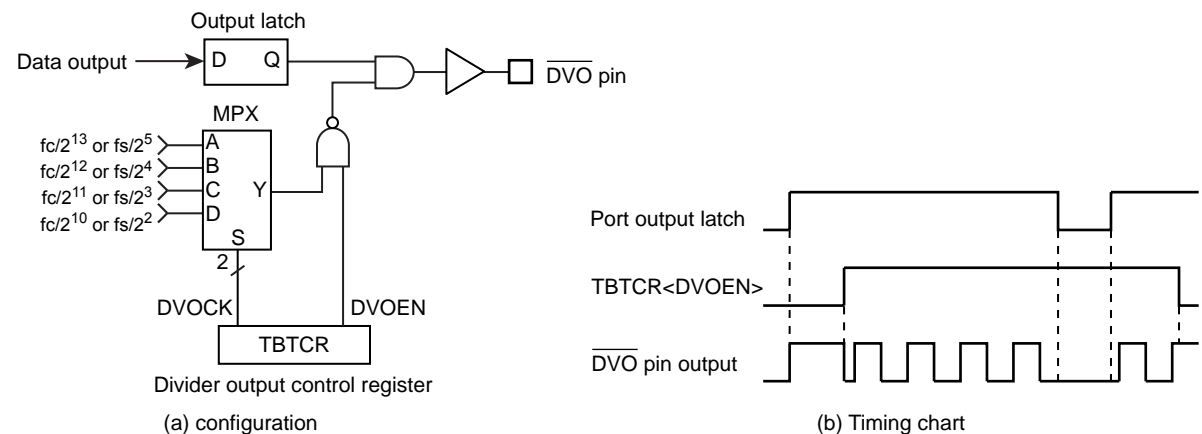


Figure 7-3 Divider Output

7.2.2 Control

The Divider Output is controlled by the Time Base Timer Control Register.

Time Base Timer Control Register

	7	6	5	4	3	2	1	0	
TBTCTCR (0036H)	DVOEN	DVOCK	(DV7CK)	(TBTEN)	(TBTCK)				(Initial value: 0000 0000)

DVOEN	Divider output enable / disable	0: Disable 1: Enable			R/W
DVOCK	Divider Output ( $\overline{\text{DVO}}$ ) frequency selection: [Hz]	NORMAL 1/2, IDLE 1/2 Mode			R/W
		DV7CK = 0		DV7CK = 1	
		00	$fc/2^{13}$	$fs/2^5$	
		01	$fc/2^{12}$	$fs/2^4$	
		10	$fc/2^{11}$	$fs/2^3$	
		11	$fc/2^{10}$	$fs/2^2$	

Note: Selection of divider output frequency (DVOCK) must be made while divider output is disabled (DVOEN="0"). Also, in other words, when changing the state of the divider output frequency from enabled (DVOEN="1") to disable(DVOEN="0"), do not change the setting of the divider output frequency.

Example :1.95 kHz pulse output (fc = 16.0 MHz)

```
LD      (TBTCR) , 00000000B      ; DVOCK ← "00"  
LD      (TBTCR) , 10000000B      ; DVOEN ← "1"
```

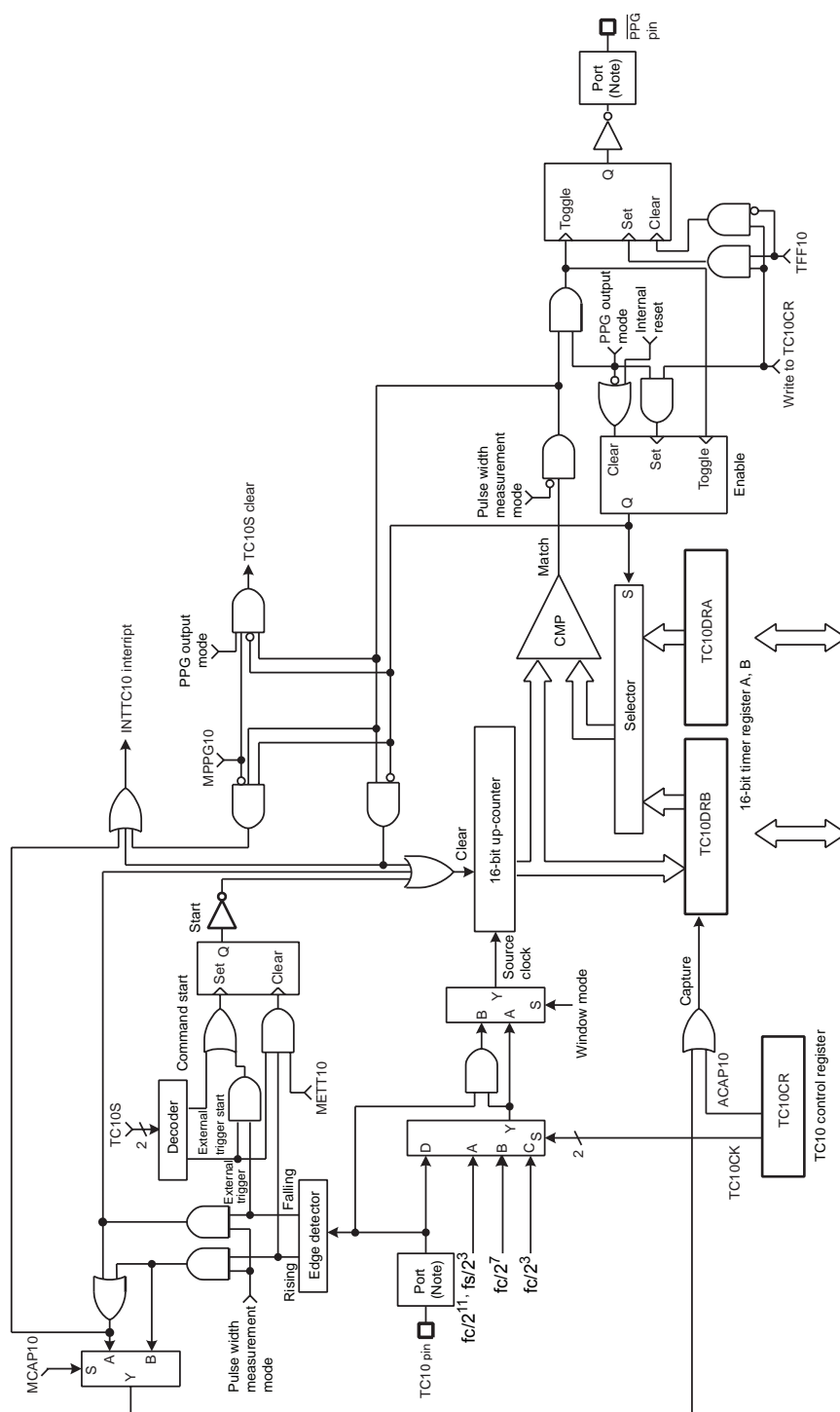
Table 7-2 Divider Output Frequency ( Example : fc = 16.0 MHz, fs = 32.768 kHz )

DVOCK	Divider Output Frequency [Hz]		
	NORMAL1/2, IDLE1/2 Mode		SLOW1/2, SLEEP1/2 Mode
	DV7CK = 0	DV7CK = 1	
00	1.953 k	1.024 k	1.024 k
01	3.906 k	2.048 k	2.048 k
10	7.813 k	4.096 k	4.096 k
11	15.625 k	8.192 k	8.192 k

## 8. 16-Bit TimerCounter (TC10,TC11)

### 8.1 16-Bit TimerCounter 10

#### 8.1.1 Configuration



Note: Function I/O may not operate depending on I/O port setting. For more details, see the chapter "I/O Port".

Figure 8-1 TimerCounter 10 (TC10)

## 8.1.2 TimerCounter Control

The TimerCounter 10 is controlled by the TimerCounter 10 control register (TC10CR) and two 16-bit timer registers (TC10DRA and TC10DRB).

### Timer Register

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TC10DRA (0011H, 0010H)	TC10DRAH (0011H)								TC10DRAL (0010H)							
	(Initial value: 1111 1111 1111 1111)								Read/Write							
TC10DRB (0013H, 0012H)	TC10DRBH (0013H)								TC10DRBL (0012H)							
	(Initial value: 1111 1111 1111 1111)								Read/Write (Write enabled only in the PPG output mode)							

### TimerCounter 10 Control Register

	7	6	5	4	3	2	1	0	
TC10CR (0014H)	TFF10	ACAP10 MCAP10 METT10 MPPG10	TC10S	TC10CK	TC10M	Read/Write (Initial value: 0000 0000)			

TFF10	Timer F/F10 control	0: Clear		1: Set					R/W
ACAP10	Auto capture control	0:Auto-capture disable		1:Auto-capture enable					R/W
MCAP10	Pulse width measurement mode control	0:Double edge capture		1:Single edge capture					
METT10	External trigger timer mode control	0:Trigger start		1:Trigger start and stop					
MPPG10	PPG output control	0:Continuous pulse generation		1:One-shot					
TC10S	TC10 start control		Timer	Extrigger	Event	Window	Pulse	PPG	R/W
		00: Stop and counter clear	0	0	0	0	0	0	
		01: Command start	0	–	–	–	–	0	
		10: Rising edge start (Ex-trigger/Pulse/PPG) Rising edge count (Event) Positive logic count (Window)	–	0	0	0	0	0	
		11: Falling edge start (Ex-trigger/Pulse/PPG) Falling edge count (Event) Negative logic count (Window)	–	0	0	0	0	0	
TC10CK	TC10 source clock select [Hz]		NORMAL 1/2, IDLE 1/2 mode				Divider	SLOW, SLEEP mode	R/W
			DV7CK = 0		DV7CK = 1				
		00	$f_c/2^{11}$	$f_s/2^3$			DV9	$f_s/2^3$	
		01	$f_c/2^7$	$f_c/2^7$			DV5	–	
		10	$f_c/2^3$	$f_c/2^3$			DV1	–	
		11	External clock (TC10 pin input)						
TC10M	TC10 operating mode select	00: Timer/external trigger timer/event counter mode 01: Window mode 10: Pulse width measurement mode 11: PPG (Programmable pulse generate) output mode							R/W

Note 1: fc: High-frequency clock [Hz], fs: Low-frequency clock [Hz]

Note 2: The timer register consists of two shift registers. A value set in the timer register becomes valid at the rising edge of the first source clock pulse that occurs after the upper byte (TC10DRAH and TC10DRBH) is written. Therefore, write the lower byte and the upper byte in this order (it is recommended to write the register with a 16-bit access instruction). Writing only the lower byte (TC10DRAL and TC10DRBL) does not enable the setting of the timer register.

Note 3: To set the mode, source clock, PPG output control and timer F/F control, write to TC10CR1 during TC10S=00. Set the timer F/F10 control until the first timer start after setting the PPG mode.



Note 4: Auto-capture can be used only in the timer, event counter, and window modes.

Note 5: To set the timer registers, the following relationship must be satisfied.

TC10DRA > TC10DRB > 1 (PPG output mode), TC10DRA > 1 (other modes)

Note 6: Set TFF10 to "0" in the mode except PPG output mode.

Note 7: Set TC10DRB after setting TC10M to the PPG output mode.

Note 8: When the STOP mode is entered, the start control (TC10S) is cleared to "00" automatically, and the timer stops. After the STOP mode is exited, set the TC10S to use the timer counter again.

Note 9: Use the auto-capture function in the operative condition of TC10. A captured value may not be fixed if it's read after the execution of the timer stop or auto-capture disable. Read the capture value in a capture enabled condition.

Note 10: Since the up-counter value is captured into TC10DRB by the source clock of up-counter after setting TC10CR<ACAP10> to "1". Therefore, to read the captured value, wait at least one cycle of the internal source clock before reading TC10DRB for the first time.

### 8.1.3 Function

TimerCounter 10 has six types of operating modes: timer, external trigger timer, event counter, window, pulse width measurement, programmable pulse generator output modes.

#### 8.1.3.1 Timer mode

In the timer mode, the up-counter counts up using the internal clock. When a match between the up-counter and the timer register 1A (TC10DRA) value is detected, an INTTC10 interrupt is generated and the up-counter is cleared. After being cleared, the up-counter restarts counting. Setting TC10CR<ACAP10> to "1" captures the up-counter value into the timer register 1B (TC10DRB) with the auto-capture function. Use the auto-capture function in the operative condition of TC10. A captured value may not be fixed if it's read after the execution of the timer stop or auto-capture disable. Read the capture value in a capture enabled condition. Since the up-counter value is captured into TC10DRB by the source clock of up-counter after setting TC10CR<ACAP10> to "1". Therefore, to read the captured value, wait at least one cycle of the internal source clock before reading TC10DRB for the first time.

Table 8-1 Internal Source Clock for TimerCounter 10 (Example:  $f_c = 16$  MHz,  $f_s = 32.768$  kHz)

TC10CK	NORMAL 1/2, IDLE 1/2 mode				SLOW, SLEEP mode	
	DV7CK = 0		DV7CK = 1			
	Resolution [μs]	Maximum Time Setting [s]	Resolution [μs]	Maximum Time Setting [s]	Resolution [μs]	Maximum Time Set- ting [s]
00	128	8.39	244.14	16.0	244.14	16.0
01	8.0	0.524	8.0	0.524	—	—
10	0.5	32.77 m	0.5	32.77 m	—	—

Example 1 :Setting the timer mode with source clock  $f_c/2^{11}$  [Hz] and generating an interrupt 1 second later ( $f_c = 16$  MHz, TBTCR<DV7CK> = "0")

```
LDW      (TC10DRA), 1E84H      ; Sets the timer register ( $1 \text{ s} \div 2^{11}/f_c = 1\text{E}84\text{H}$ )
DI                               ; IMF= "0"
SET      (EIRL), 7              ; Enables INTTC10
EI                               ; IMF= "1"
LD       (TC10CR), 00000000B    ; Selects the source clock and mode
LD       (TC10CR), 00010000B    ; Starts TC10
```

Example 2 :Auto-capture

```

LD      (TC10CR), 01010000B      ; ACAP10 ← 1
:      :
LD      WA, (TC10DRB)            ; Reads the capture value

```

Note: Since the up-counter value is captured into TC10DRB by the source clock of up-counter after setting TC10CR<ACAP10> to "1". Therefore, to read the captured value, wait at least one cycle of the internal source clock before reading TC10DRB for the first time.

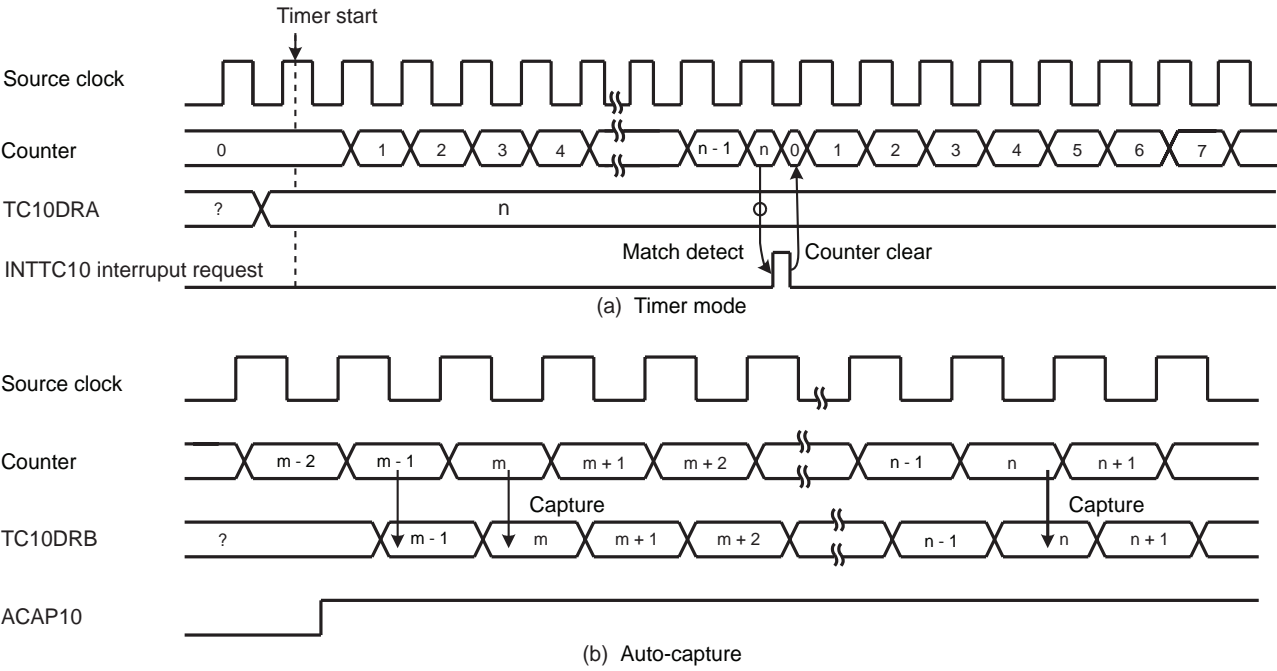


Figure 8-2 Timer Mode Timing Chart

### 8.1.3.2 External Trigger Timer Mode

In the external trigger timer mode, the up-counter starts counting by the input pulse triggering of the TC10 pin, and counts up at the edge of the internal clock. For the trigger edge used to start counting, either the rising or falling edge is defined in TC10CR<TC10S>.

- When TC10CR<METT10> is set to “1” (trigger start and stop)

When a match between the up-counter and the TC10DRA value is detected after the timer starts, the up-counter is cleared and halted and an INTTC10 interrupt request is generated.

If the edge opposite to trigger edge is detected before detecting a match between the up-counter and the TC10DRA, the up-counter is cleared and halted without generating an interrupt request. Therefore, this mode can be used to detect exceeding the specified pulse by interrupt.

After being halted, the up-counter restarts counting when the trigger edge is detected.

- When TC10CR<METT10> is set to “0” (trigger start)

When a match between the up-counter and the TC10DRA value is detected after the timer starts, the up-counter is cleared and halted and an INTTC10 interrupt request is generated.

The edge opposite to the trigger edge has no effect in count up. The trigger edge for the next counting is ignored if detecting it before detecting a match between the up-counter and the TC10DRA.

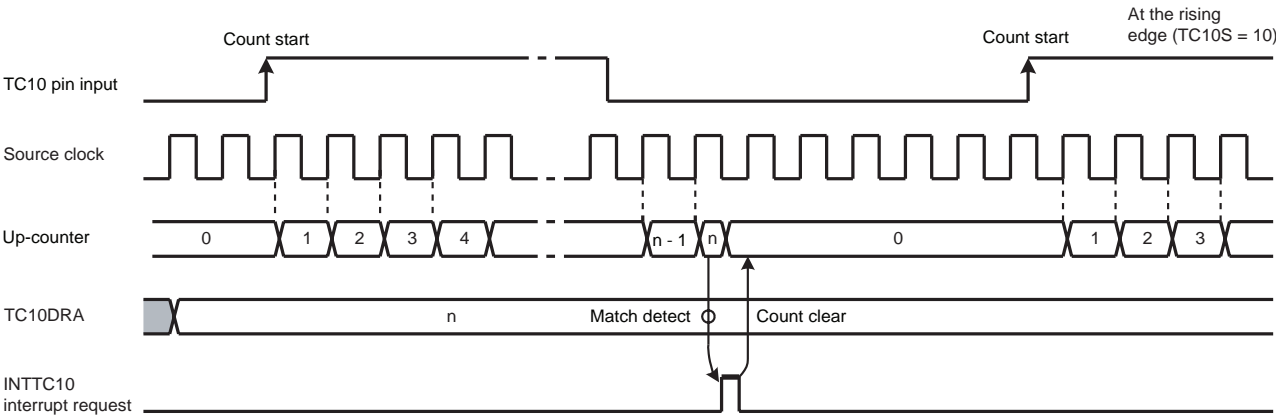
Since the TC10 pin input has the noise rejection, pulses of  $4/f_c$  [s] or less are rejected as noise. A pulse width of  $12/f_c$  [s] or more is required to ensure edge detection. The rejection circuit is turned off in the SLOW1/2 or SLEEP1/2 mode, but a pulse width of one machine cycle or more is required.

Example 1 :Generating an interrupt 1 ms after the rising edge of the input pulse to the TC10 pin  
( $f_c = 16$  MHz)

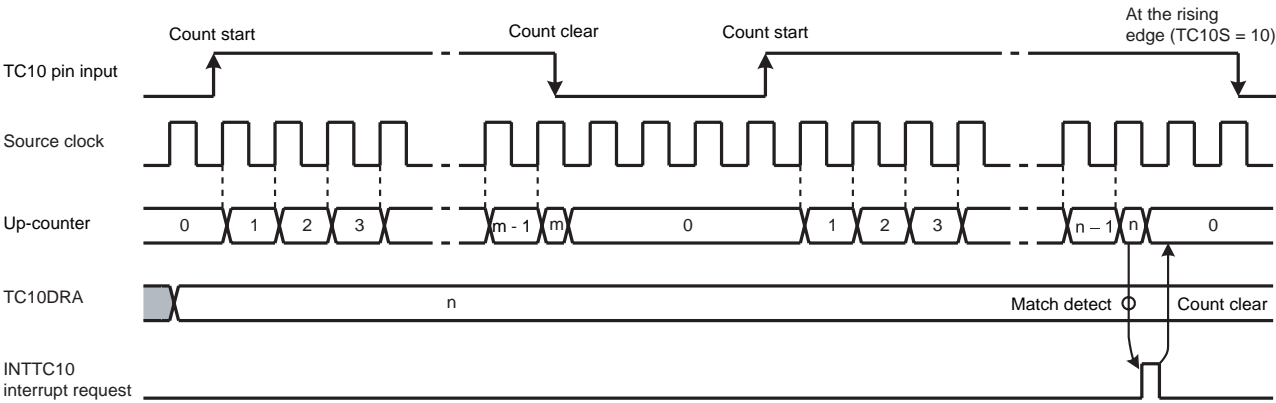
```
LDW      (TC10DRA), 007DH      ;  $1\text{ms} \div 2^7/f_c = 7\text{DH}$ 
DI                          ; IMF= "0"
SET      (EIRL). 7             ; Enables INTTC10 interrupt
EI                          ; IMF= "1"
LD       (TC10CR), 00000100B   ; Selects the source clock and mode
LD       (TC10CR), 00100100B   ; Starts TC10 external trigger, METT10 = 0
```

Example 2 :Generating an interrupt when the low-level pulse with 4 ms or more width is input to the TC10 pin  
( $f_c = 16$  MHz)

```
LDW      (TC10DRA), 01F4H      ;  $4\text{ms} \div 2^7/f_c = 1\text{F4H}$ 
DI                          ; IMF= "0"
SET      (EIRL). 7             ; Enables INTTC10 interrupt
EI                          ; IMF= "1"
LD       (TC10CR), 00000100B   ; Selects the source clock and mode
LD       (TC10CR), 01110100B   ; Starts TC10 external trigger, METT10 = 0
```



(a) Trigger start (METT10 = 0)



(b) Trigger start and stop (METT10 = 1)

Note:  $m < n$

Figure 8-3 External Trigger Timer Mode Timing Chart

## 8.1.3.3 Event Counter Mode

In the event counter mode, the up-counter counts up at the edge of the input pulse to the TC10 pin. Either the rising or falling edge of the input pulse is selected as the count up edge in TC10CR<TC10S>.

When a match between the up-counter and the TC10DRA value is detected, an INTTC10 interrupt is generated and the up-counter is cleared. After being cleared, the up-counter restarts counting at each edge of the input pulse to the TC10 pin. Since a match between the up-counter and the value set to TC10DRA is detected at the edge opposite to the selected edge, an INTTC10 interrupt request is generated after a match of the value at the edge opposite to the selected edge.

Two or more machine cycles are required for the low-or high-level pulse input to the TC10 pin.

Setting TC10CR<ACAP10> to "1" captures the up-counter value into TC10DRB with the auto capture function. Use the auto-capture function in the operative condition of TC10. A captured value may not be fixed if it's read after the execution of the timer stop or auto-capture disable. Read the capture value in a capture enabled condition. Since the up-counter value is captured into TC10DRB by the source clock of up-counter after setting TC10CR<ACAP10> to "1". Therefore, to read the captured value, wait at least one cycle of the internal source clock before reading TC10DRB for the first time.

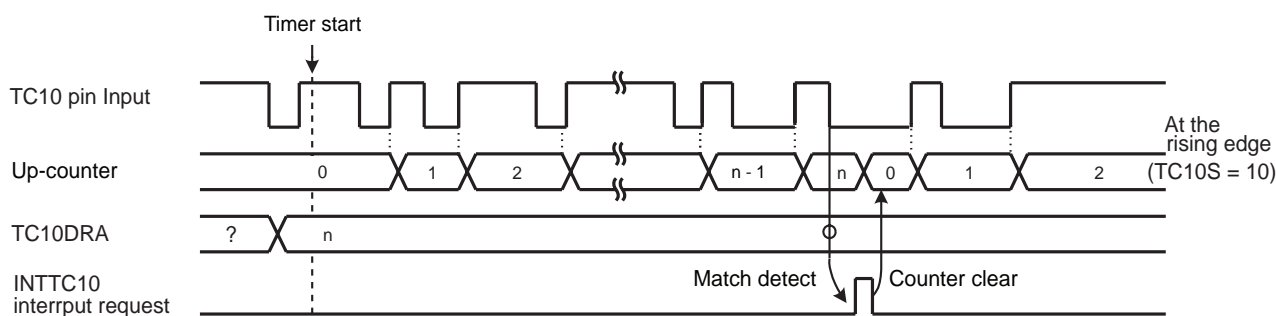


Figure 8-4 Event Counter Mode Timing Chart

Table 8-2 Input Pulse Width to TC10 Pin

	Minimum Pulse Width [s]	
	NORMAL1/2, IDLE1/2 Mode	SLOW1/2, SLEEP1/2 Mode
High-going	$2^3/f_c$	$2^3/f_s$
Low-going	$2^3/f_c$	$2^3/f_s$

8.1.3.4 Window Mode

In the window mode, the up-counter counts up at the rising edge of the pulse that is logical ANDed product of the input pulse to the TC10 pin (window pulse) and the internal source clock. Either the positive logic (count up during high-going pulse) or negative logic (count up during low-going pulse) can be selected.

When a match between the up-counter and the TC10DRA value is detected, an INTTC10 interrupt is generated and the up-counter is cleared.

Define the window pulse to the frequency which is sufficiently lower than the internal source clock programmed with TC10CR<TC10CK>.

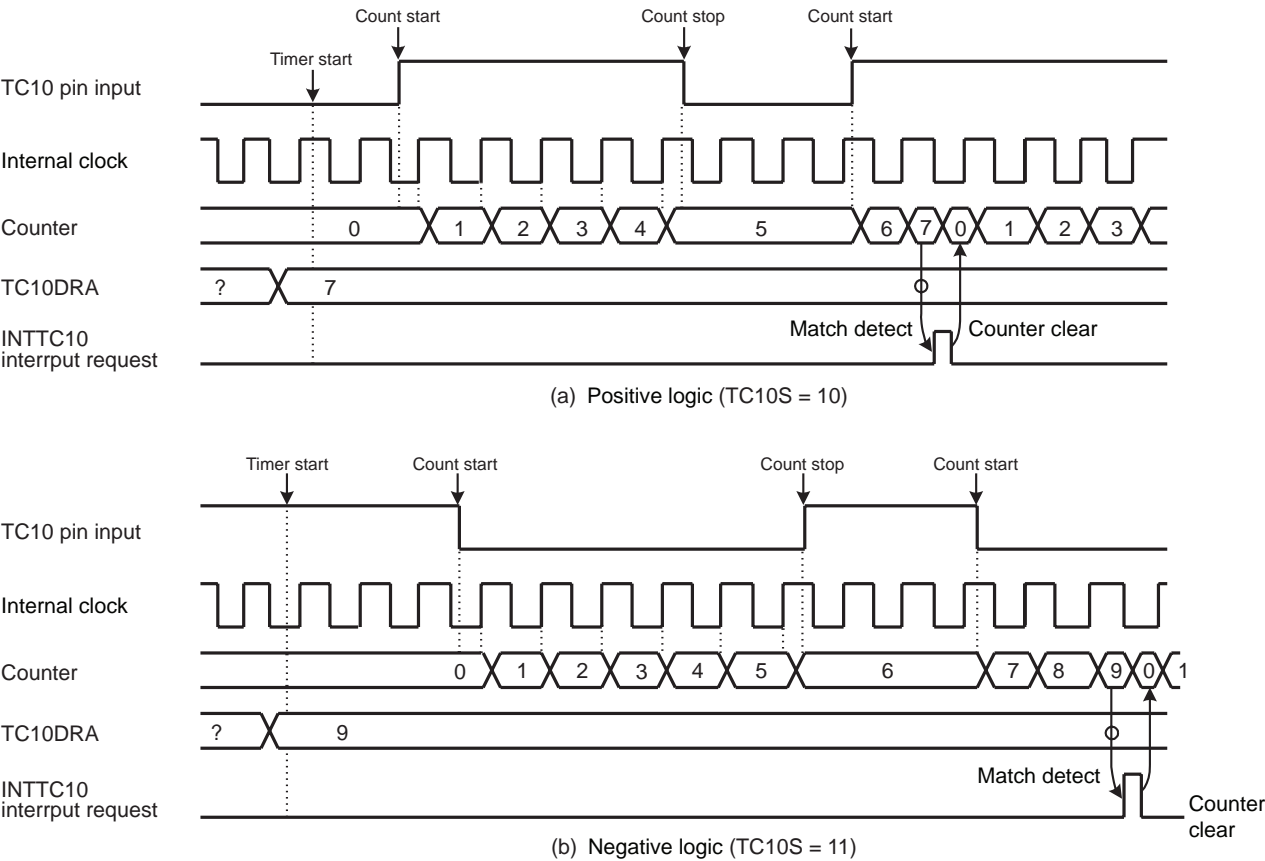


Figure 8-5 Window Mode Timing Chart

### 8.1.3.5 Pulse Width Measurement Mode

In the pulse width measurement mode, the up-counter starts counting by the input pulse triggering of the TC10 pin, and counts up at the edge of the internal clock. Either the rising or falling edge of the internal clock is selected as the trigger edge in TC10CR<TC10S>. Either the single- or double-edge capture is selected as the trigger edge in TC10CR<MCAP10>.

- When TC10CR<MCAP10> is set to “1” (single-edge capture)

Either high- or low-level input pulse width can be measured. To measure the high-level input pulse width, set the rising edge to TC10CR<TC10S>. To measure the low-level input pulse width, set the falling edge to TC10CR<TC10S>.

When detecting the edge opposite to the trigger edge used to start counting after the timer starts, the up-counter captures the up-counter value into TC10DRB and generates an INTTC10 interrupt request. The up-counter is cleared at this time, and then restarts counting when detecting the trigger edge used to start counting.

- When TC10CR<MCAP10> is set to “0” (double-edge capture)

The cycle starting with either the high- or low-going input pulse can be measured. To measure the cycle starting with the high-going pulse, set the rising edge to TC10CR<TC10S>. To measure the cycle starting with the low-going pulse, set the falling edge to TC10CR<TC10S>.

When detecting the edge opposite to the trigger edge used to start counting after the timer starts, the up-counter captures the up-counter value into TC10DRB and generates an INTTC10 interrupt request. The up-counter continues counting up, and captures the up-counter value into TC10DRB and generates an INTTC10 interrupt request when detecting the trigger edge used to start counting. The up-counter is cleared at this time, and then continues counting.

Note 1: The captured value must be read from TC10DRB until the next trigger edge is detected. If not read, the captured value becomes a don't care. It is recommended to use a 16-bit access instruction to read the captured value from TC10DRB.

Note 2: For the single-edge capture, the counter after capturing the value stops at “1” until detecting the next edge. Therefore, the second captured value is “1” larger than the captured value immediately after counting starts.

Note 3: The first captured value after the timer starts may be read incorrectly, therefore, ignore the first captured value.

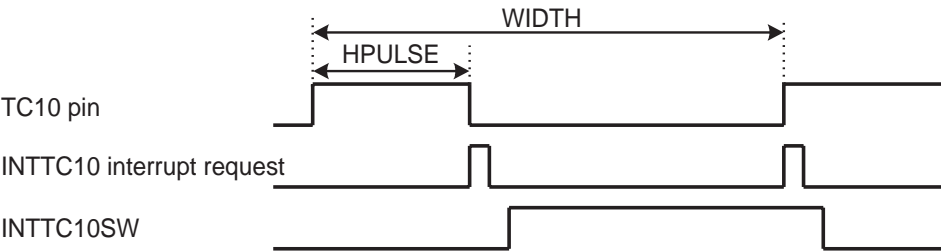
Example :Duty measurement (resolution  $f_c/2^7$  [Hz])

```

CLR      (INTTC10SW). 0      ; INTTC10 service switch initial setting
                                Address set to convert INTTC10SW at each INTTC10

LD       (TC10CR), 00000110B ; Sets the TC10 mode and source clock
DI       ; IMF= "0"
SET      (EIRL). 7          ; Enables INTTC10
EI       ; IMF= "1"
LD       (TC10CR), 00100110B ; Starts TC10 with an external trigger at MCAP10 = 0
:
PINTTC10: CPL      (INTTC10SW). 0      ; INTTC10 interrupt, inverts and tests INTTC10 service switch
JRS      F, SINTTC10
LD       A, (TC10DRBL)      ; Reads TC10DRB (High-level pulse width)
LD       W,(TC10DRBH)
LD       (HPULSE), WA       ; Stores high-level pulse width in RAM
RETI
SINTTC10: LD       A, (TC10DRBL)      ; Reads TC10DRB (Cycle)
LD       W,(TC10DRBH)
LD       (WIDTH), WA       ; Stores cycle in RAM
:
RETI     ; Duty calculation
:
VINTTC10: DW       PINTTC10          ; INTTC10 Interrupt vector

```





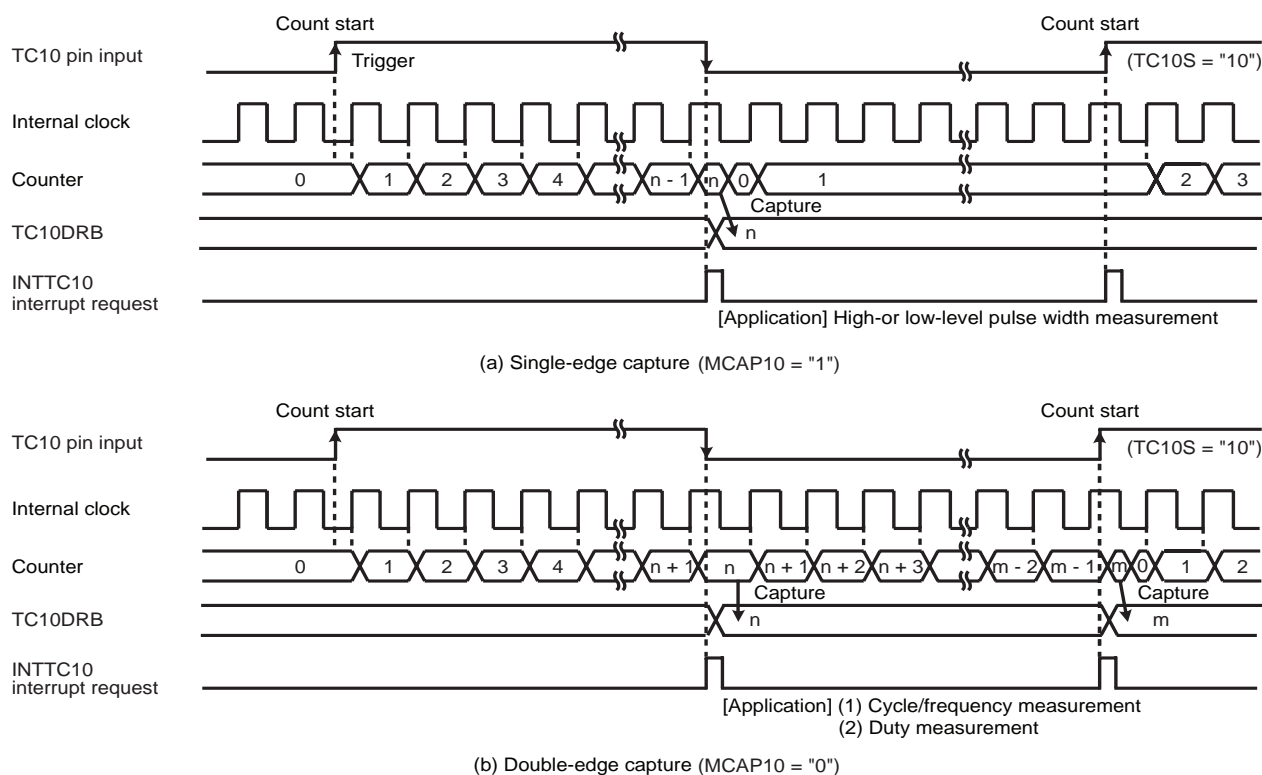


Figure 8-6 Pulse Width Measurement Mode

### 8.1.3.6 Programmable Pulse Generate (PPG) Output Mode

In the programmable pulse generation (PPG) mode, an arbitrary duty pulse is generated by counting performed in the internal clock. To start the timer, TC10CR<TC10S> specifies either the edge of the input pulse to the TC10 pin or the command start. TC10CR<MPPG10> specifies whether a duty pulse is produced continuously or not (one-shot pulse).

- When TC10CR<MPPG10> is set to “0” (Continuous pulse generation)

When a match between the up-counter and the TC10DRB value is detected after the timer starts, the level of the  $\overline{\text{PPG}}$  pin is inverted and an INTTC10 interrupt request is generated. The up-counter continues counting. When a match between the up-counter and the TC10DRA value is detected, the level of the  $\overline{\text{PPG}}$  pin is inverted and an INTTC10 interrupt request is generated. The up-counter is cleared at this time, and then continues counting and pulse generation.

When TC10S is cleared to “00” during PPG output, the  $\overline{\text{PPG}}$  pin retains the level immediately before the counter stops.

- When TC10CR<MPPG10> is set to “1” (One-shot pulse generation)

When a match between the up-counter and the TC10DRB value is detected after the timer starts, the level of the  $\overline{\text{PPG}}$  pin is inverted and an INTTC10 interrupt request is generated. The up-counter continues counting. When a match between the up-counter and the TC10DRA value is detected, the level of the  $\overline{\text{PPG}}$  pin is inverted and an INTTC10 interrupt request is generated. TC10CR<TC10S> is cleared to “00” automatically at this time, and the timer stops. The pulse generated by PPG retains the same level as that when the timer stops.

Since the output level of the  $\overline{\text{PPG}}$  pin can be set with TC10CR<TFF10> when the timer starts, a positive or negative pulse can be generated. Since the inverted level of the timer F/F1 output level is output to the  $\overline{\text{PPG}}$  pin, specify TC10CR<TFF10> to “0” to set the high level to the  $\overline{\text{PPG}}$  pin, and “1” to set the low level to the  $\overline{\text{PPG}}$  pin. Upon reset, the timer F/F1 is initialized to “0”.

Note 1: To change TC10DRA or TC10DRB during a run of the timer, set a value sufficiently larger than the count value of the counter. Setting a value smaller than the count value of the counter during a run of the timer may generate a pulse different from that specified.

Note 2: Do not change TC10CR<TFF10> during a run of the timer. TC10CR<TFF10> can be set correctly only at initialization (after reset). When the timer stops during PPG, TC10CR<TFF10> can not be set correctly from this point onward if the PPG output has the level which is inverted of the level when the timer starts. (Setting TC10CR<TFF10> specifies the timer F/F1 to the level inverted of the programmed value.) Therefore, the timer F/F1 needs to be initialized to ensure an arbitrary level of the PPG output. To initialize the timer F/F1, change TC10CR<TC10M> to the timer mode (it is not required to start the timer mode), and then set the PPG mode. Set TC10CR<TFF10> at this time.

Note 3: In the PPG mode, the following relationship must be satisfied.  
TC10DRA > TC10DRB

Note 4: Set TC10DRB after changing the mode of TC10M to the PPG mode.

Example :Generating a pulse which is high-going for 800  $\mu$ s and low-going for 200  $\mu$ s  
( $f_c = 16$  MHz)

```

Setting port
LD      (TC10CR), 10000111B    ; Sets the PPG mode, selects the source clock
LDW     (TC10DRA), 007DH       ; Sets the cycle ( $1 \text{ ms} \div 2^7/f_c \text{ ms} = 007DH$ )
LDW     (TC10DRB), 0019H       ; Sets the low-level pulse width ( $200 \mu\text{s} \div 2^7/f_c = 0019H$ )
LD      (TC10CR), 10010111B    ; Starts the timer

```

Example :After stopping PPG, setting the PPG pin to a high-level to restart PPG  
( $f_c = 16$  MHz)

```

Setting port
LD      (TC10CR), 10000111B    ; Sets the PPG mode, selects the source clock
LDW     (TC10DRA), 007DH       ; Sets the cycle ( $1 \text{ ms} \div 2^7/f_c \mu\text{s} = 007DH$ )
LDW     (TC10DRB), 0019H       ; Sets the low-level pulse width ( $200 \mu\text{s} \div 2^7/f_c = 0019H$ )
LD      (TC10CR), 10010111B    ; Starts the timer
:      :
LD      (TC10CR), 10000111B    ; Stops the timer
LD      (TC10CR), 10000100B    ; Sets the timer mode
LD      (TC10CR), 00000111B    ; Sets the PPG mode, TFF10 = 0
LD      (TC10CR), 00010111B    ; Starts the timer

```

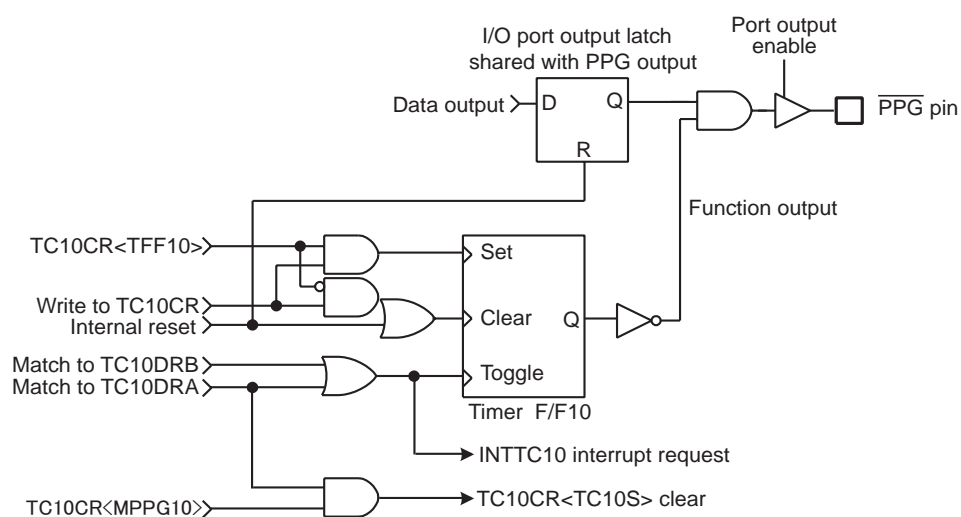


Figure 8-7  $\overline{\text{PPG}}$  Output

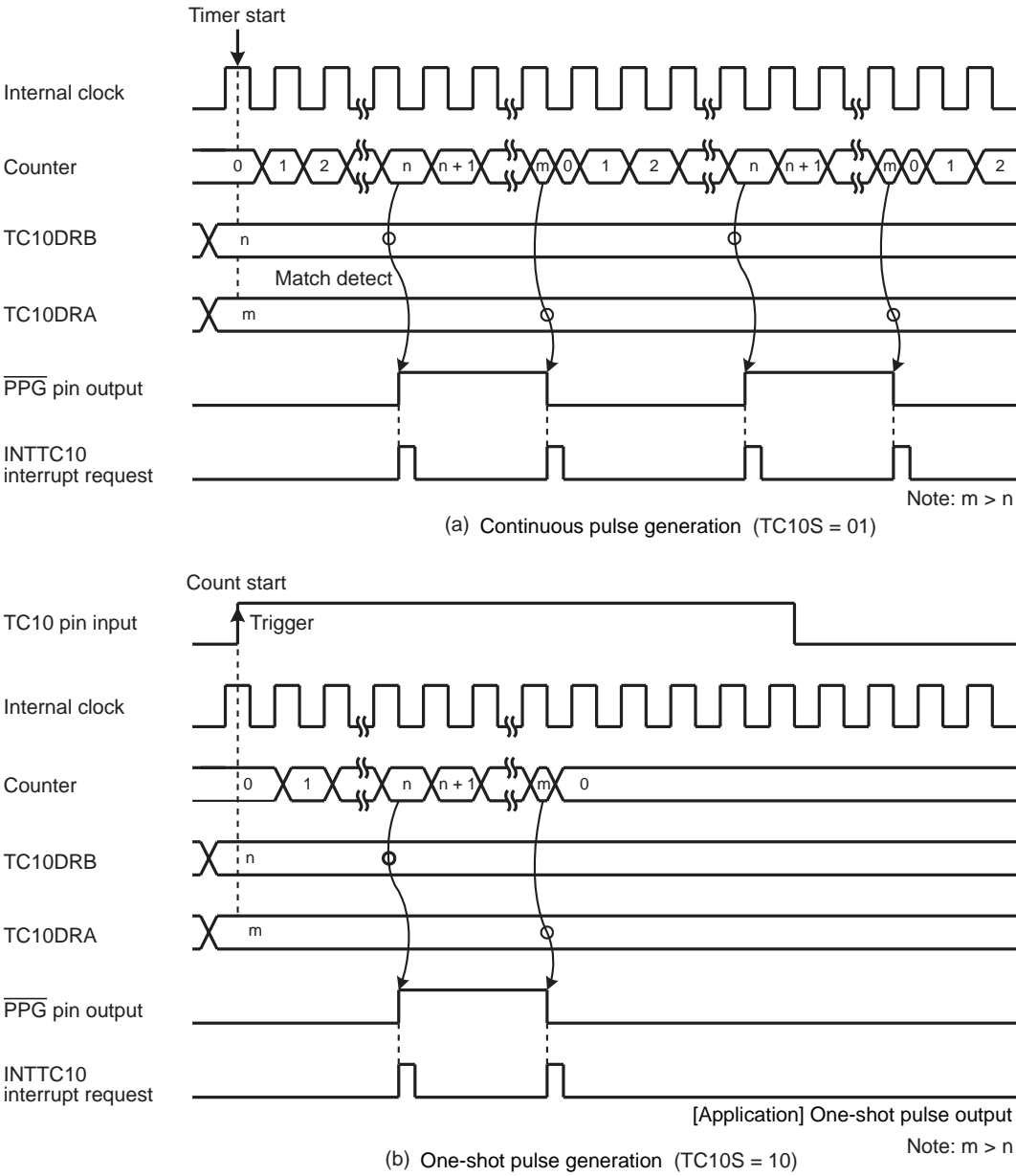
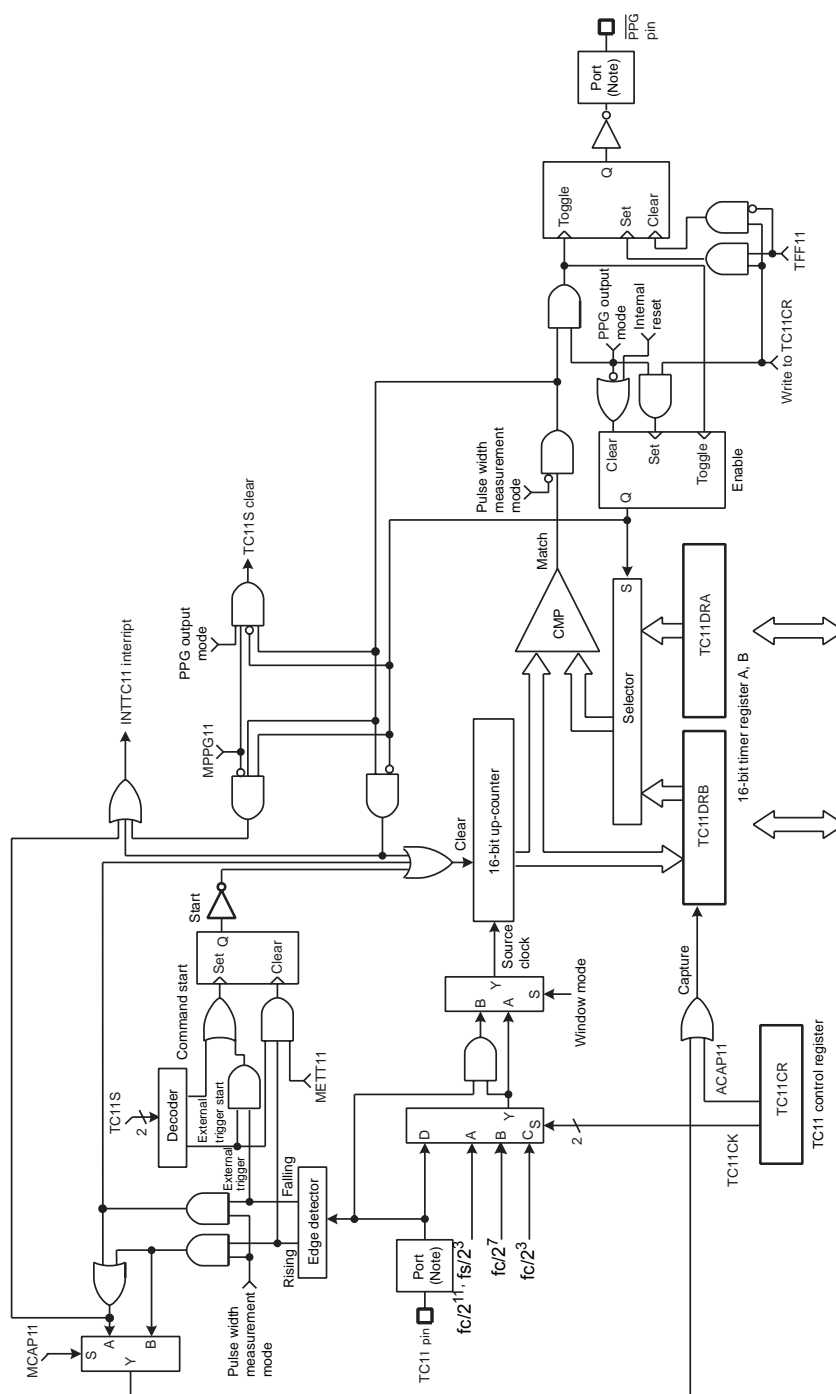


Figure 8-8 PPG Mode Timing Chart

## 8.2 16-Bit TimerCounter 11

### 8.2.1 Configuration



Note: Function I/O may not operate depending on I/O port setting. For more details, see the chapter "I/O Port".

Figure 8-9 TimerCounter 11 (TC11)

## 8.2.2 TimerCounter Control

The TimerCounter 11 is controlled by the TimerCounter 11 control register (TC11CR) and two 16-bit timer registers (TC11DRA and TC11DRB).

### Timer Register

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TC11DRA (0021H, 0020H)	TC11DRAH (0021H) (Initial value: 1111 1111 1111 1111)								TC11DRAL (0020H) Read/Write							
TC11DRB (0023H, 0022H)	TC11DRBH (0023H) (Initial value: 1111 1111 1111 1111)								TC11DRBL (0022H) Read/Write (Write enabled only in the PPG output mode)							

### TimerCounter 11 Control Register

	7	6	5	4	3	2	1	0	
TC11CR (0024H)	TFF11	ACAP11 MCAP11 METT11 MPPG11	TC11S		TC11CK		TC11M		Read/Write (Initial value: 0000 0000)

TFF11	Timer F/F11 control	0: Clear1: Set						R/W	
ACAP11	Auto capture control	0:Auto-capture disable1:Auto-capture enable						R/W	
MCAP11	Pulse width measurement mode control	0:Double edge capture1:Single edge capture							
METT11	External trigger timer mode control	0:Trigger start1:Trigger start and stop							
MPPG11	PPG output control	0:Continuous pulse generation1:One-shot							
TC11S	TC11 start control		Timer	Extrigger	Event	Window	Pulse	PPG	R/W
		00: Stop and counter clear	0	0	0	0	0	0	
		01: Command start	0	–	–	–	–	0	
		10: Rising edge start (Ex-trigger/Pulse/PPG) Rising edge count (Event) Positive logic count (Window)	–	0	0	0	0	0	
		11: Falling edge start (Ex-trigger/Pulse/PPG) Falling edge count (Event) Negative logic count (Window)	–	0	0	0	0	0	
TC11CK	TC11 source clock select [Hz]		NORMAL1/2, IDLE1/2 mode				Divider	SLOW, SLEEP mode	R/W
			DV7CK = 0		DV7CK = 1				
		00	fc/2 <sup>11</sup>		fs/2 <sup>3</sup>		DV9	fs/2 <sup>3</sup>	
		01	fc/2 <sup>7</sup>		fc/2 <sup>7</sup>		DV5	–	
		10	fc/2 <sup>3</sup>		fc/2 <sup>3</sup>		DV1	–	
		11	External clock (TC11 pin input)						
TC11M	TC11 operating mode select	00: Timer/external trigger timer/event counter mode 01: Window mode 10: Pulse width measurement mode 11: PPG (Programmable pulse generate) output mode						R/W	

Note 1: fc: High-frequency clock [Hz], fs: Low-frequency clock [Hz]

Note 2: The timer register consists of two shift registers. A value set in the timer register becomes valid at the rising edge of the first source clock pulse that occurs after the upper byte (TC11DRAH and TC11DRBH) is written. Therefore, write the lower

byte and the upper byte in this order (it is recommended to write the register with a 16-bit access instruction). Writing only the lower byte (TC11DRAL and TC11DRBL) does not enable the setting of the timer register.

Note 3: To set the mode, source clock, PPG output control and timer F/F control, write to TC11CR1 during TC11S=00. Set the timer F/F10 control until the first timer start after setting the PPG mode.

Note 4: Auto-capture can be used only in the timer, event counter, and window modes.

Note 5: To set the timer registers, the following relationship must be satisfied.  
 $TC11DRA > TC11DRB > 1$  (PPG output mode),  $TC11DRA > 1$  (other modes)

Note 6: Set TFF11 to "0" in the mode except PPG output mode.

Note 7: Set TC11DRB after setting TC11M to the PPG output mode.

Note 8: When the STOP mode is entered, the start control (TC11S) is cleared to "00" automatically, and the timer stops. After the STOP mode is exited, set the TC11S to use the timer counter again.

Note 9: Use the auto-capture function in the operative condition of TC11. A captured value may not be fixed if it's read after the execution of the timer stop or auto-capture disable. Read the capture value in a capture enabled condition.

Note 10: Since the up-counter value is captured into TC11DRB by the source clock of up-counter after setting TC11CR<ACAP11> to "1". Therefore, to read the captured value, wait at least one cycle of the internal source clock before reading TC11DRB for the first time.

## 8.2.3 Function

TimerCounter 11 has six types of operating modes: timer, external trigger timer, event counter, window, pulse width measurement, programmable pulse generator output modes.

### 8.2.3.1 Timer mode

In the timer mode, the up-counter counts up using the internal clock. When a match between the up-counter and the timer register 1A (TC11DRA) value is detected, an INTTC11 interrupt is generated and the up-counter is cleared. After being cleared, the up-counter restarts counting. Setting TC11CR<ACAP11> to "1" captures the up-counter value into the timer register 1B (TC11DRB) with the auto-capture function. Use the auto-capture function in the operative condition of TC11. A captured value may not be fixed if it's read after the execution of the timer stop or auto-capture disable. Read the capture value in a capture enabled condition. Since the up-counter value is captured into TC11DRB by the source clock of up-counter after setting TC11CR<ACAP11> to "1". Therefore, to read the captured value, wait at least one cycle of the internal source clock before reading TC11DRB for the first time.

Table 8-3 Internal Source Clock for TimerCounter 11 (Example:  $f_c = 16 \text{ MHz}$ ,  $f_s = 32.768 \text{ kHz}$ )

TC11CK	NORMAL1/2, IDLE1/2 mode				SLOW, SLEEP mode	
	DV7CK = 0		DV7CK = 1			
	Resolution [μs]	Maximum Time Setting [s]	Resolution [μs]	Maximum Time Setting [s]	Resolution [μs]	Maximum Time Set- ting [s]
00	128	8.39	244.14	16.0	244.14	16.0
01	8.0	0.524	8.0	0.524	—	—
10	0.5	32.77 m	0.5	32.77 m	—	—

Example 1 :Setting the timer mode with source clock  $fc/2^{11}$  [Hz] and generating an interrupt 1 second later  
 ( $fc = 16\text{ MHz}$ ,  $TBTCR<DV7CK> = \text{"0"}$ )

```

LDW      (TC11DRA), 1E84H      ; Sets the timer register ( $1\text{ s} \div 2^{11}/fc = 1E84H$ )

DI                               ; IMF= "0"

SET      (EIRL), 2             ; Enables INTTC11

EI                               ; IMF= "1"

LD       (TC11CR), 00000000B   ; Selects the source clock and mode

LD       (TC11CR), 00010000B   ; Starts TC11

```

Example 2 :Auto-capture

```

LD       (TC11CR), 01010000B   ; ACAP11 ← 1

:       :

LD       WA, (TC11DRB)          ; Reads the capture value

```

Note: Since the up-counter value is captured into TC11DRB by the source clock of up-counter after setting TC11CR<ACAP11> to "1". Therefore, to read the captured value, wait at least one cycle of the internal source clock before reading TC11DRB for the first time.

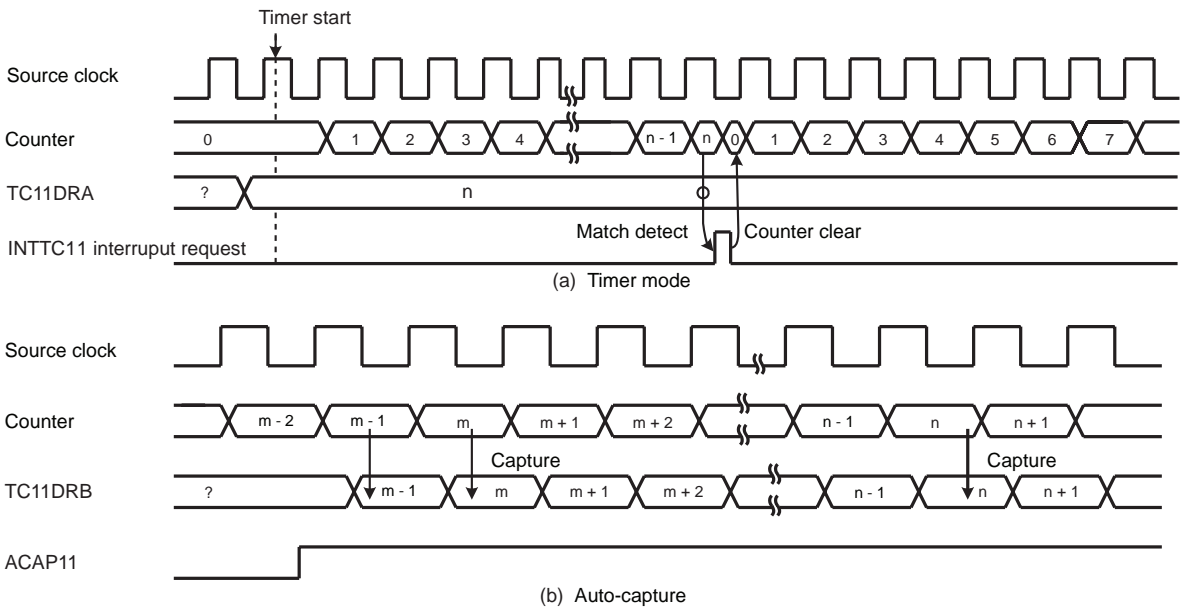


Figure 8-10 Timer Mode Timing Chart



### 8.2.3.2 External Trigger Timer Mode

In the external trigger timer mode, the up-counter starts counting by the input pulse triggering of the TC11 pin, and counts up at the edge of the internal clock. For the trigger edge used to start counting, either the rising or falling edge is defined in TC11CR<TC11S>.

- When TC11CR<METT11> is set to “1” (trigger start and stop)

When a match between the up-counter and the TC11DRA value is detected after the timer starts, the up-counter is cleared and halted and an INTTC11 interrupt request is generated.

If the edge opposite to trigger edge is detected before detecting a match between the up-counter and the TC11DRA, the up-counter is cleared and halted without generating an interrupt request. Therefore, this mode can be used to detect exceeding the specified pulse by interrupt.

After being halted, the up-counter restarts counting when the trigger edge is detected.

- When TC11CR<METT11> is set to “0” (trigger start)

When a match between the up-counter and the TC11DRA value is detected after the timer starts, the up-counter is cleared and halted and an INTTC11 interrupt request is generated.

The edge opposite to the trigger edge has no effect in count up. The trigger edge for the next counting is ignored if detecting it before detecting a match between the up-counter and the TC11DRA.

Since the TC11 pin input has the noise rejection, pulses of  $4/f_c$  [s] or less are rejected as noise. A pulse width of  $12/f_c$  [s] or more is required to ensure edge detection. The rejection circuit is turned off in the SLOW1/2 or SLEEP1/2 mode, but a pulse width of one machine cycle or more is required.

Example 1 :Generating an interrupt 1 ms after the rising edge of the input pulse to the TC11 pin  
( $f_c = 16$  MHz)

```
LDW      (TC11DRA), 007DH      ;  $1\text{ms} \div 2^7/f_c = 7\text{DH}$ 
DI                          ; IMF= "0"
SET      (EIRL). 2            ; Enables INTTC11 interrupt
EI                          ; IMF= "1"
LD       (TC11CR), 00000100B   ; Selects the source clock and mode
LD       (TC11CR), 00100100B   ; Starts TC11 external trigger, METT11 = 0
```

Example 2 :Generating an interrupt when the low-level pulse with 4 ms or more width is input to the TC11 pin  
( $f_c = 16$  MHz)

```
LDW      (TC11DRA), 01F4H      ;  $4\text{ms} \div 2^7/f_c = 1\text{F4H}$ 
DI                          ; IMF= "0"
SET      (EIRL). 2            ; Enables INTTC11 interrupt
EI                          ; IMF= "1"
LD       (TC11CR), 00000100B   ; Selects the source clock and mode
LD       (TC11CR), 01110100B   ; Starts TC11 external trigger, METT11 = 0
```

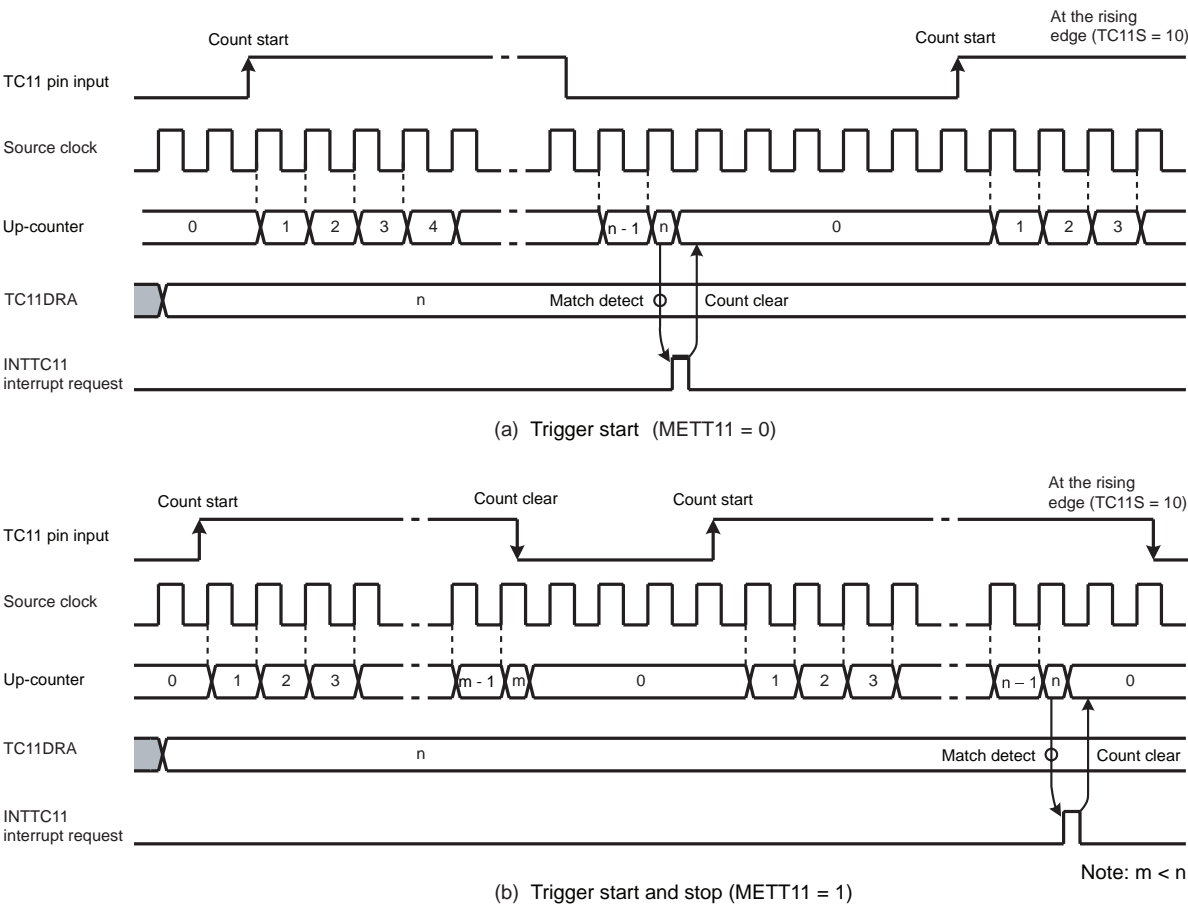


Figure 8-11 External Trigger Timer Mode Timing Chart

### 8.2.3.3 Event Counter Mode

In the event counter mode, the up-counter counts up at the edge of the input pulse to the TC11 pin. Either the rising or falling edge of the input pulse is selected as the count up edge in TC11CR<TC11S>.

When a match between the up-counter and the TC11DRA value is detected, an INTTC11 interrupt is generated and the up-counter is cleared. After being cleared, the up-counter restarts counting at each edge of the input pulse to the TC11 pin. Since a match between the up-counter and the value set to TC11DRA is detected at the edge opposite to the selected edge, an INTTC11 interrupt request is generated after a match of the value at the edge opposite to the selected edge.

Two or more machine cycles are required for the low-or high-level pulse input to the TC11 pin.

Setting TC11CR<ACAP11> to "1" captures the up-counter value into TC11DRB with the auto capture function. Use the auto-capture function in the operative condition of TC11. A captured value may not be fixed if it's read after the execution of the timer stop or auto-capture disable. Read the capture value in a capture enabled condition. Since the up-counter value is captured into TC11DRB by the source clock of up-counter after setting TC11CR<ACAP11> to "1". Therefore, to read the captured value, wait at least one cycle of the internal source clock before reading TC11DRB for the first time.

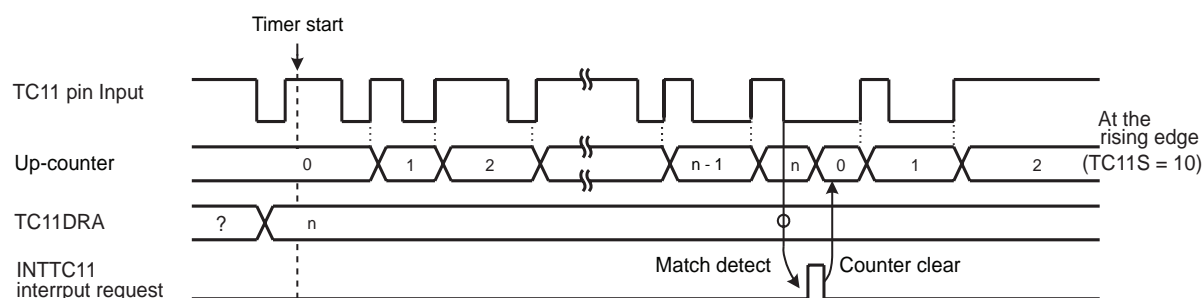


Figure 8-12 Event Counter Mode Timing Chart

Table 8-4 Input Pulse Width to TC11 Pin

	Minimum Pulse Width [s]	
	NORMAL1/2, IDLE1/2 Mode	SLOW1/2, SLEEP1/2 Mode
High-going	$2^3/f_c$	$2^3/f_s$
Low-going	$2^3/f_c$	$2^3/f_s$

8.2.3.4 Window Mode

In the window mode, the up-counter counts up at the rising edge of the pulse that is logical ANDed product of the input pulse to the TC11 pin (window pulse) and the internal source clock. Either the positive logic (count up during high-going pulse) or negative logic (count up during low-going pulse) can be selected.

When a match between the up-counter and the TC11DRA value is detected, an INTTC11 interrupt is generated and the up-counter is cleared.

Define the window pulse to the frequency which is sufficiently lower than the internal source clock programmed with TC11CR<TC11CK>.

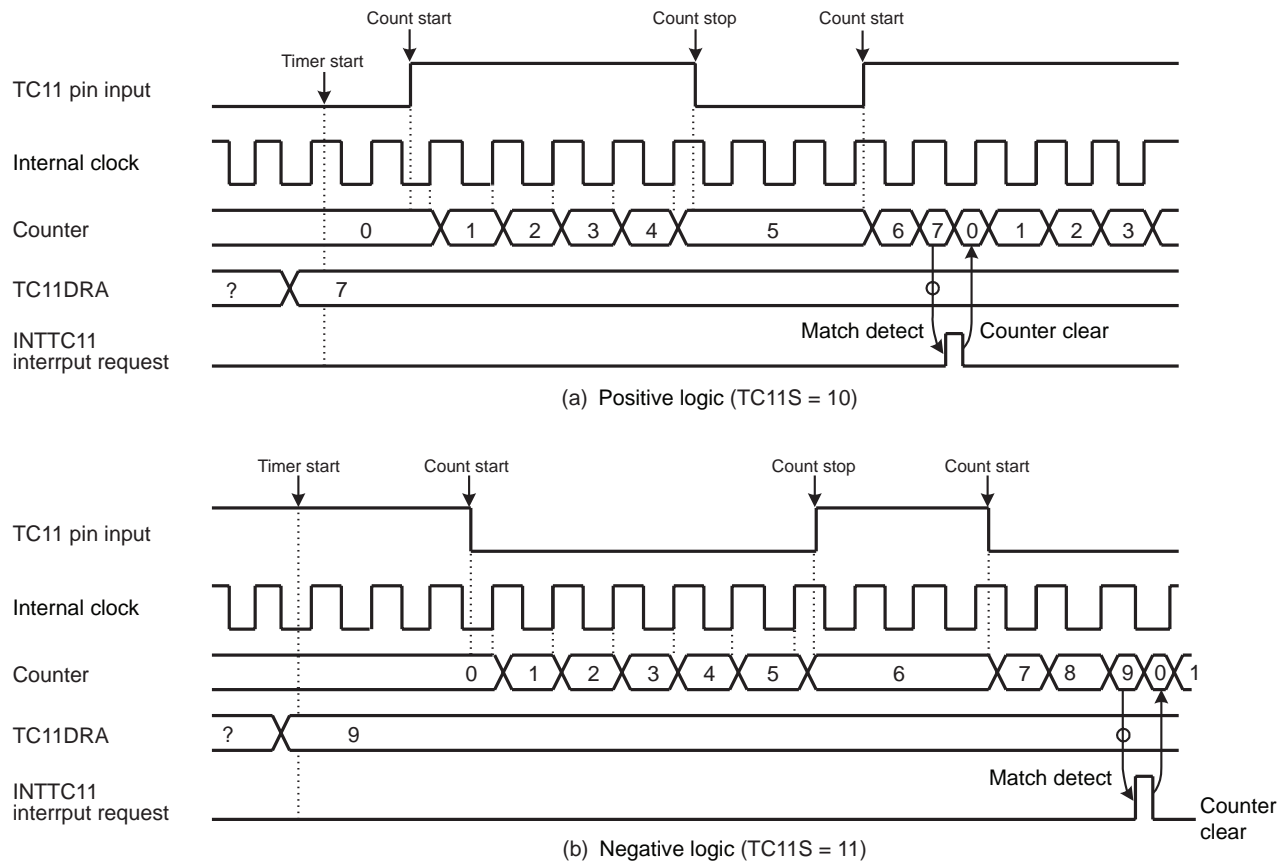


Figure 8-13 Window Mode Timing Chart

### 8.2.3.5 Pulse Width Measurement Mode

In the pulse width measurement mode, the up-counter starts counting by the input pulse triggering of the TC11 pin, and counts up at the edge of the internal clock. Either the rising or falling edge of the internal clock is selected as the trigger edge in TC11CR<TC11S>. Either the single- or double-edge capture is selected as the trigger edge in TC11CR<MCAP11>.

- When TC11CR<MCAP11> is set to “1” (single-edge capture)

Either high- or low-level input pulse width can be measured. To measure the high-level input pulse width, set the rising edge to TC11CR<TC11S>. To measure the low-level input pulse width, set the falling edge to TC11CR<TC11S>.

When detecting the edge opposite to the trigger edge used to start counting after the timer starts, the up-counter captures the up-counter value into TC11DRB and generates an INTTC11 interrupt request. The up-counter is cleared at this time, and then restarts counting when detecting the trigger edge used to start counting.

- When TC11CR<MCAP11> is set to “0” (double-edge capture)

The cycle starting with either the high- or low-going input pulse can be measured. To measure the cycle starting with the high-going pulse, set the rising edge to TC11CR<TC11S>. To measure the cycle starting with the low-going pulse, set the falling edge to TC11CR<TC11S>.

When detecting the edge opposite to the trigger edge used to start counting after the timer starts, the up-counter captures the up-counter value into TC11DRB and generates an INTTC11 interrupt request. The up-counter continues counting up, and captures the up-counter value into TC11DRB and generates an INTTC11 interrupt request when detecting the trigger edge used to start counting. The up-counter is cleared at this time, and then continues counting.

Note 1: The captured value must be read from TC11DRB until the next trigger edge is detected. If not read, the captured value becomes a don't care. It is recommended to use a 16-bit access instruction to read the captured value from TC11DRB.

Note 2: For the single-edge capture, the counter after capturing the value stops at “1” until detecting the next edge. Therefore, the second captured value is “1” larger than the captured value immediately after counting starts.

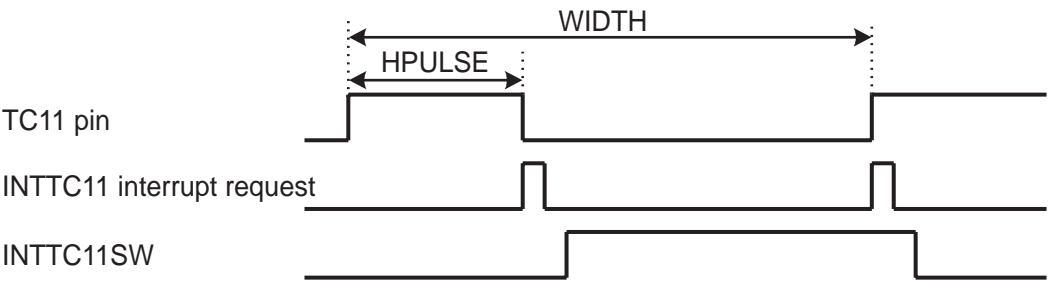
Note 3: The first captured value after the timer starts may be read incorrectly, therefore, ignore the first captured value.

Example :Duty measurement (resolution  $f_c/2^7$  [Hz])

```

CLR      (INTTC11SW). 0      ; INTTC11 service switch initial setting
                                Address set to convert INTTC11SW at each INTTC11

LD       (TC11CR), 00000110B ; Sets the TC11 mode and source clock
DI       ; IMF= "0"
SET      (EIRH). 7          ; Enables INTTC11
EI       ; IMF= "1"
LD       (TC11CR), 00100110B ; Starts TC11 with an external trigger at MCAP11 = 0
:
PINTTC11: CPL      (INTTC11SW). 0 ; INTTC11 interrupt, inverts and tests INTTC11 service switch
JRS      F, SINTTC11
LD       A, (TC11DRBL)        ; Reads TC11DRB (High-level pulse width)
LD       W,(TC11DRBH)
LD       (HPULSE), WA         ; Stores high-level pulse width in RAM
RETI
SINTTC11: LD       A, (TC11DRBL) ; Reads TC11DRB (Cycle)
LD       W,(TC11DRBH)
LD       (WIDTH), WA          ; Stores cycle in RAM
:
RETI      ; Duty calculation
:
VINTTC11: DW       PINTTC11     ; INTTC11 Interrupt vector
```



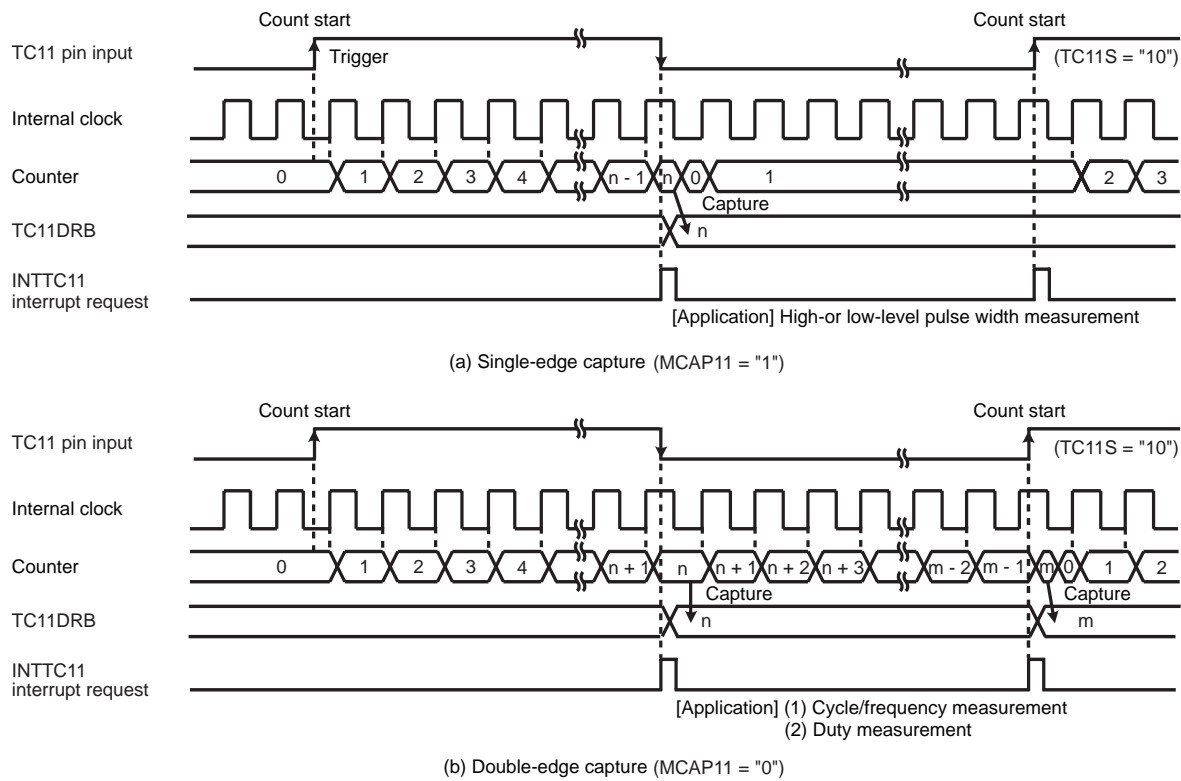


Figure 8-14 Pulse Width Measurement Mode

### 8.2.3.6 Programmable Pulse Generate (PPG) Output Mode

In the programmable pulse generation (PPG) mode, an arbitrary duty pulse is generated by counting performed in the internal clock. To start the timer, TC11CR<TC11S> specifies either the edge of the input pulse to the TC11 pin or the command start. TC11CR<MPPG11> specifies whether a duty pulse is produced continuously or not (one-shot pulse).

- When TC11CR<MPPG11> is set to “0” (Continuous pulse generation)

When a match between the up-counter and the TC11DRB value is detected after the timer starts, the level of the  $\overline{\text{PPG}}$  pin is inverted and an INTTC11 interrupt request is generated. The up-counter continues counting. When a match between the up-counter and the TC11DRA value is detected, the level of the  $\overline{\text{PPG}}$  pin is inverted and an INTTC11 interrupt request is generated. The up-counter is cleared at this time, and then continues counting and pulse generation.

When TC11S is cleared to “00” during PPG output, the  $\overline{\text{PPG}}$  pin retains the level immediately before the counter stops.

- When TC11CR<MPPG11> is set to “1” (One-shot pulse generation)

When a match between the up-counter and the TC11DRB value is detected after the timer starts, the level of the  $\overline{\text{PPG}}$  pin is inverted and an INTTC11 interrupt request is generated. The up-counter continues counting. When a match between the up-counter and the TC11DRA value is detected, the level of the  $\overline{\text{PPG}}$  pin is inverted and an INTTC11 interrupt request is generated. TC11CR<TC11S> is cleared to “00” automatically at this time, and the timer stops. The pulse generated by PPG retains the same level as that when the timer stops.

Since the output level of the  $\overline{\text{PPG}}$  pin can be set with TC11CR<TFF11> when the timer starts, a positive or negative pulse can be generated. Since the inverted level of the timer F/F1 output level is output to the  $\overline{\text{PPG}}$  pin, specify TC11CR<TFF11> to “0” to set the high level to the  $\overline{\text{PPG}}$  pin, and “1” to set the low level to the  $\overline{\text{PPG}}$  pin. Upon reset, the timer F/F1 is initialized to “0”.

Note 1: To change TC11DRA or TC11DRB during a run of the timer, set a value sufficiently larger than the count value of the counter. Setting a value smaller than the count value of the counter during a run of the timer may generate a pulse different from that specified.

Note 2: Do not change TC11CR<TFF11> during a run of the timer. TC11CR<TFF11> can be set correctly only at initialization (after reset). When the timer stops during PPG, TC11CR<TFF11> can not be set correctly from this point onward if the PPG output has the level which is inverted of the level when the timer starts. (Setting TC11CR<TFF11> specifies the timer F/F1 to the level inverted of the programmed value.) Therefore, the timer F/F1 needs to be initialized to ensure an arbitrary level of the PPG output. To initialize the timer F/F1, change TC11CR<TC11M> to the timer mode (it is not required to start the timer mode), and then set the PPG mode. Set TC11CR<TFF11> at this time.

Note 3: In the PPG mode, the following relationship must be satisfied.  
TC11DRA > TC11DRB

Note 4: Set TC11DRB after changing the mode of TC11M to the PPG mode.



Example :Generating a pulse which is high-going for 800  $\mu$ s and low-going for 200  $\mu$ s  
( $f_c = 16$  MHz)

```

Setting port
LD      (TC11CR), 10000111B    ; Sets the PPG mode, selects the source clock
LDW     (TC11DRA), 007DH       ; Sets the cycle ( $1 \text{ ms} \div 2^7/f_c \text{ ms} = 007DH$ )
LDW     (TC11DRB), 0019H       ; Sets the low-level pulse width ( $200 \mu\text{s} \div 2^7/f_c = 0019H$ )
LD      (TC11CR), 10010111B    ; Starts the timer

```

Example :After stopping PPG, setting the PPG pin to a high-level to restart PPG  
( $f_c = 16$  MHz)

```

Setting port
LD      (TC11CR), 10000111B    ; Sets the PPG mode, selects the source clock
LDW     (TC11DRA), 007DH       ; Sets the cycle ( $1 \text{ ms} \div 2^7/f_c \mu\text{s} = 007DH$ )
LDW     (TC11DRB), 0019H       ; Sets the low-level pulse width ( $200 \mu\text{s} \div 2^7/f_c = 0019H$ )
LD      (TC11CR), 10010111B    ; Starts the timer
:      :
LD      (TC11CR), 10000111B    ; Stops the timer
LD      (TC11CR), 10000100B    ; Sets the timer mode
LD      (TC11CR), 00000111B    ; Sets the PPG mode, TFF11 = 0
LD      (TC11CR), 00010111B    ; Starts the timer

```

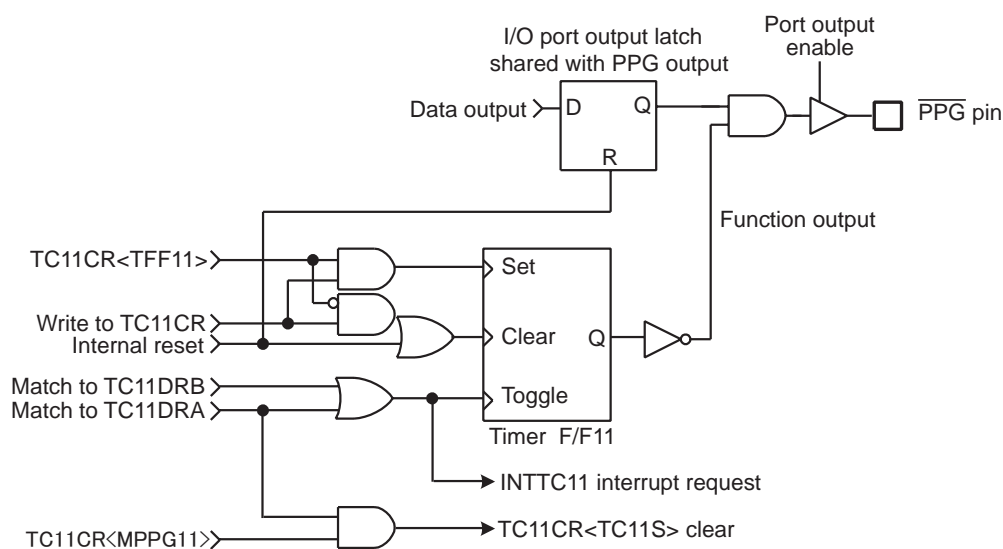
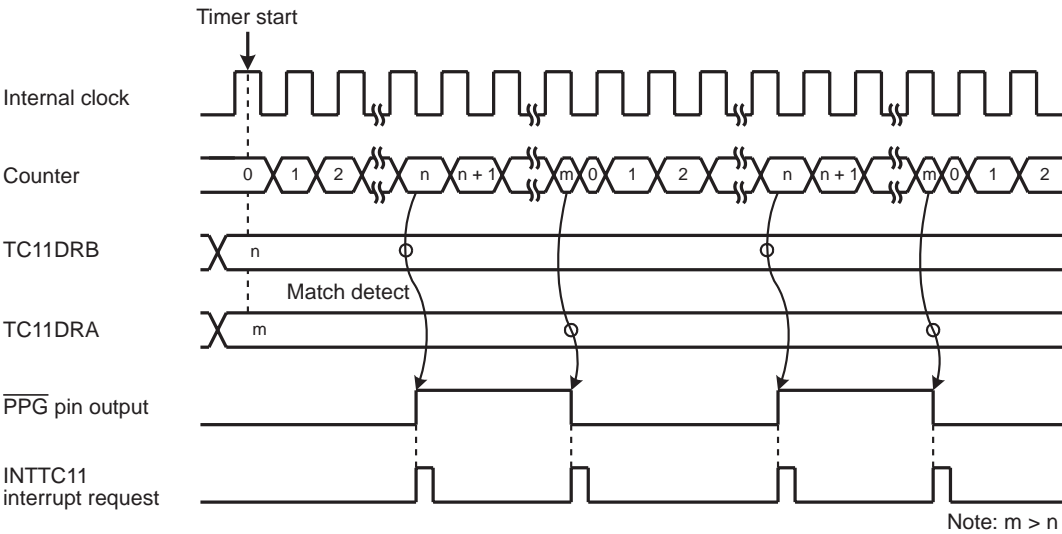
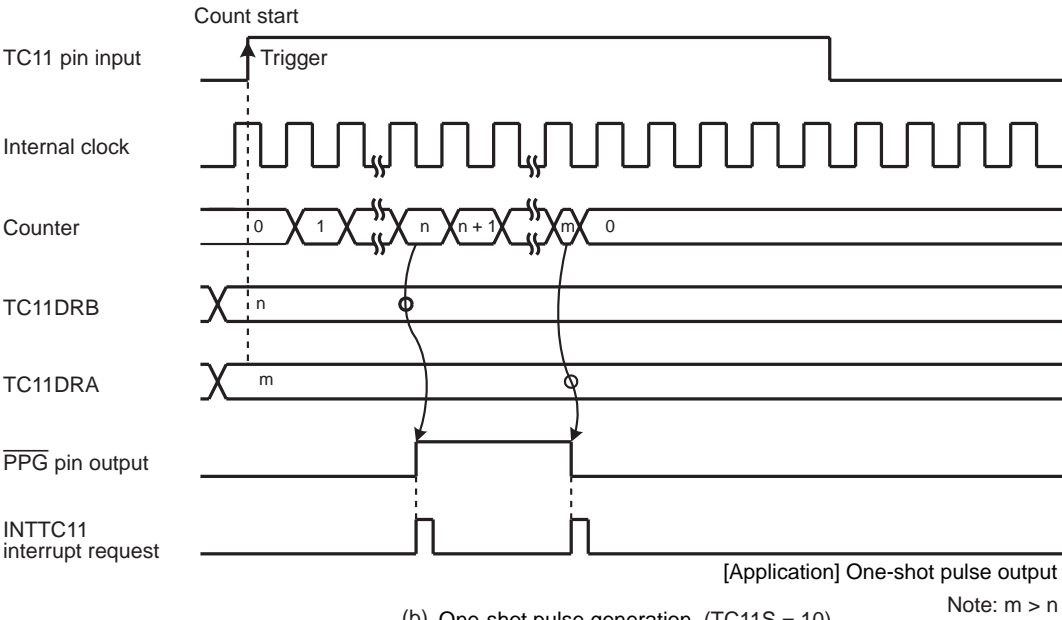


Figure 8-15 PPG Output



(a) Continuous pulse generation (TC11S = 01)



(b) One-shot pulse generation (TC11S = 10)

Figure 8-16 PPG Mode Timing Chart

## 9. 8-Bit TimerCounter (TC3, TC4)

### 9.1 Configuration

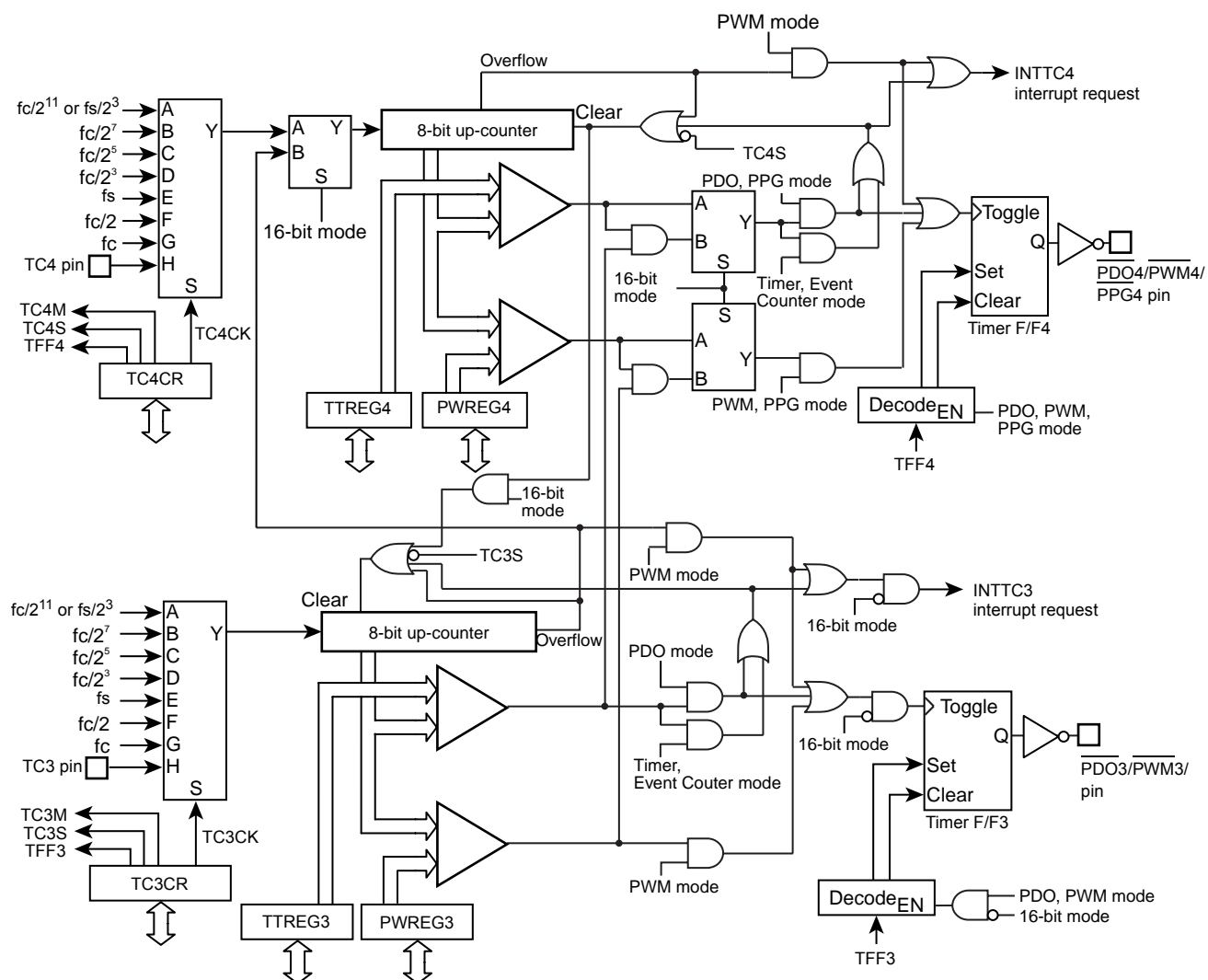


Figure 9-1 8-Bit TimerCounter 3, 4

## 9.2 TimerCounter Control

The TimerCounter 3 is controlled by the TimerCounter 3 control register (TC3CR) and two 8-bit timer registers (TTREG3, PWREG3).

### TimerCounter 3 Timer Register

TTREG3 (0015H) R/W	7	6	5	4	3	2	1	0	(Initial value: 1111 1111)

PWREG3 (0019H) R/W	7	6	5	4	3	2	1	0	(Initial value: 1111 1111)

Note 1: Do not change the timer register (TTREG3) setting while the timer is running.

Note 2: Do not change the timer register (PWREG3) setting in the operating mode except the 8-bit and 16-bit PWM modes while the timer is running.

### TimerCounter 3 Control Register

TC3CR (0009H)	7	6	5	4	3	2	1	0	(Initial value: 0000 0000)
	TFF3		TC3CK		TC3S		TC3M		

TFF3	Time F/F3 control	0: Clear 1: Set				R/W
TC3CK	Operating clock selection [Hz]		NORMAL1/2, IDLE1/2 mode		SLOW1/2 SLEEP1/2 mode	R/W
			DV7CK = 0	DV7CK = 1		
		000	fc/2 <sup>11</sup>	fs/2 <sup>3</sup>	fs/2 <sup>3</sup>	
		001	fc/2 <sup>7</sup>	fc/2 <sup>7</sup>	—	
		010	fc/2 <sup>5</sup>	fc/2 <sup>5</sup>	—	
		011	fc/2 <sup>3</sup>	fc/2 <sup>3</sup>	—	
		100	fs	fs	fs	
		101	fc/2	fc/2	—	
		110	fc	fc	fc (Note 8)	
		111	TC3 pin input			
TC3S	TC3 start control	0: Operation stop and counter clear 1: Operation start				R/W
TC3M	TC3M operating mode select	000: 8-bit timer/event counter mode 001: 8-bit programmable divider output (PDO) mode 010: 8-bit pulse width modulation (PWM) output mode 011: 16-bit mode (Each mode is selectable with TC4M.) 1**: Reserved				R/W

Note 1: fc: High-frequency clock [Hz] fs: Low-frequency clock[Hz]

Note 2: Do not change the TC3M, TC3CK and TFF3 settings while the timer is running.

Note 3: To stop the timer operation (TC3S= 1 → 0), do not change the TC3M, TC3CK and TFF3 settings. To start the timer operation (TC3S= 0 → 1), TC3M, TC3CK and TFF3 can be programmed.

Note 4: To use the TimerCounter in the 16-bit mode, set the operating mode by programming TC4CR<TC4M>, where TC3M must be fixed to 011.

Note 5: To use the TimerCounter in the 16-bit mode, select the source clock by programming TC3CK. Set the timer start control and timer F/F control by programming TC4CR<TC4S> and TC4CR<TFF4>, respectively.

Note 6: The operating clock settings are limited depending on the timer operating mode. For the detailed descriptions, see Table 9-1 and Table 9-2.

Note 7: The timer register settings are limited depending on the timer operating mode. For the detailed descriptions, see Table 9-3.

Note 8: The operating clock  $f_c$  in the SLOW or SLEEP mode can be used only as the high-frequency warm-up mode.

The TimerCounter 4 is controlled by the TimerCounter 4 control register (TC4CR) and two 8-bit timer registers (TTREG4 and PWREG4).

#### TimerCounter 4 Timer Register

TTREG4 (0016H) R/W	7	6	5	4	3	2	1	0	(Initial value: 1111 1111)

PWREG4 (001AH) R/W	7	6	5	4	3	2	1	0	(Initial value: 1111 1111)

Note 1: Do not change the timer register (TTREG4) setting while the timer is running.

Note 2: Do not change the timer register (PWREG4) setting in the operating mode except the 8-bit and 16-bit PWM modes while the timer is running.

#### TimerCounter 4 Control Register

TC4CR (000AH)	7	6	5	4	3	2	1	0	(Initial value: 0000 0000)
	TFF4	TC4CK			TC4S	TC4M			

TFF4	Timer F/F4 control	0: Clear 1: Set				R/W
TC4CK	Operating clock selection [Hz]		NORMAL 1/2, IDLE 1/2 mode		SLOW 1/2 SLEEP 1/2 mode	R/W
			DV7CK = 0	DV7CK = 1		
		000	$fc/2^{11}$	$fs/2^3$	$fs/2^3$	
		001	$fc/2^7$	$fc/2^7$	—	
		010	$fc/2^5$	$fc/2^5$	—	
		011	$fc/2^3$	$fc/2^3$	—	
		100	fs	fs	fs	
		101	$fc/2$	$fc/2$	—	
		110	fc	fc	—	
111	TC4 pin input					
TC4S	TC4 start control	0: Operation stop and counter clear 1: Operation start				R/W
TC4M	TC4M operating mode select	000: 8-bit timer/event counter mode 001: 8-bit programmable divider output (PDO) mode 010: 8-bit pulse width modulation (PWM) output mode 011: Reserved 100: 16-bit timer/event counter mode 101: Warm-up counter mode 110: 16-bit pulse width modulation (PWM) output mode 111: 16-bit PPG mode				R/W

Note 1: fc: High-frequency clock [Hz] fs: Low-frequency clock [Hz]

Note 2: Do not change the TC4M, TC4CK and TFF4 settings while the timer is running.

Note 3: To stop the timer operation (TC4S= 1 → 0), do not change the TC4M, TC4CK and TFF4 settings.  
To start the timer operation (TC4S= 0 → 1), TC4M, TC4CK and TFF4 can be programmed.

Note 4: When TC4M= 1\*\* (upper byte in the 16-bit mode), the source clock becomes the TC3 overflow signal regardless of the TC4CK setting.

Note 5: To use the TimerCounter in the 16-bit mode, select the operating mode by programming TC4M, where TC3CR<TC3M> must be set to 011.

Note 6: To the TimerCounter in the 16-bit mode, select the source clock by programming TC3CR<TC3CK>. Set the timer start control and timer F/F control by programming TC4S and TFF4, respectively.

Note 7: The operating clock settings are limited depending on the timer operating mode. For the detailed descriptions, see Table 9-1 and Table 9-2.

Note 8: The timer register settings are limited depending on the timer operating mode. For the detailed descriptions, see Table 9-3.

Table 9-1 Operating Mode and Selectable Source Clock (NORMAL1/2 and IDLE1/2 Modes)

Operating mode	$fc/2^{11}$ or $fs/2^3$	$fc/2^7$	$fc/2^5$	$fc/2^3$	fs	$fc/2$	fc	TC3 pin input	TC4 pin input
8-bit timer	O	O	O	O	—	—	—	—	—
8-bit event counter	—	—	—	—	—	—	—	O	O
8-bit PDO	O	O	O	O	—	—	—	—	—
8-bit PWM	O	O	O	O	O	O	O	—	—
16-bit timer	O	O	O	O	—	—	—	—	—
16-bit event counter	—	—	—	—	—	—	—	O	—
Warm-up counter	—	—	—	—	O	—	—	—	—
16-bit PWM	O	O	O	O	O	O	O	O	—
16-bit PPG	O	O	O	O	—	—	—	O	—

Note 1: For 16-bit operations (16-bit timer/event counter, warm-up counter, 16-bit PWM and 16-bit PPG), set its source clock on lower bit (TC3CK).

Note 2: O : Available source clock

Table 9-2 Operating Mode and Selectable Source Clock (SLOW1/2 and SLEEP1/2 Modes)

Operating mode	$fc/2^{11}$ or $fs/2^3$	$fc/2^7$	$fc/2^5$	$fc/2^3$	fs	$fc/2$	fc	TC3 pin input	TC4 pin input
8-bit timer	O	—	—	—	—	—	—	—	—
8-bit event counter	—	—	—	—	—	—	—	O	O
8-bit PDO	O	—	—	—	—	—	—	—	—
8-bit PWM	O	—	—	—	O	—	—	—	—
16-bit timer	O	—	—	—	—	—	—	—	—
16-bit event counter	—	—	—	—	—	—	—	O	—
Warm-up counter	—	—	—	—	—	—	O	—	—
16-bit PWM	O	—	—	—	O	—	—	O	—
16-bit PPG	O	—	—	—	—	—	—	O	—

Note1: For 16-bit operations (16-bit timer/event counter, warm-up counter, 16-bit PWM and 16-bit PPG), set its source clock on lower bit (TC3CK).

Note2: O : Available source clock

Table 9-3 Constraints on Register Values Being Compared

Operating mode	Register Value
8-bit timer/event counter	$1 \leq (TTREGn) \leq 255$
8-bit PDO	$1 \leq (TTREGn) \leq 255$
8-bit PWM	$2 \leq (PWREGn) \leq 254$
16-bit timer/event counter	$1 \leq (TTREG4, 3) \leq 65535$
Warm-up counter	$256 \leq (TTREG4, 3) \leq 65535$
16-bit PWM	$2 \leq (PWREG4, 3) \leq 65534$
16-bit PPG	$1 \leq (PWREG4, 3) < (TTREG4, 3) \leq 65535$ and $(PWREG4, 3) + 1 < (TTREG4, 3)$

Note: n = 3 to 4



## 9.3 Function

The TimerCounter 3 and 4 have the 8-bit timer, 8-bit event counter, 8-bit programmable divider output (PDO), 8-bit pulse width modulation (PWM) output modes. The TimerCounter 3 and 4 (TC3, 4) are cascadable to form a 16-bit timer. The 16-bit timer has the operating modes such as the 16-bit timer, 16-bit event counter, warm-up counter, 16-bit pulse width modulation (PWM) output and 16-bit programmable pulse generation (PPG) modes.

### 9.3.1 8-Bit Timer Mode (TC3 and 4)

In the timer mode, the up-counter counts up using the internal clock. When a match between the up-counter and the timer register  $j$  (TTREG $j$ ) value is detected, an INTTC $j$  interrupt is generated and the up-counter is cleared. After being cleared, the up-counter restarts counting.

Note 1: In the timer mode, fix TCjCR<TFFj> to 0. If not fixed, the  $\overline{PDOj}$ ,  $\overline{PWMj}$  and  $\overline{PPGj}$  pins may output pulses.

Note 2: In the timer mode, do not change the TTREG $j$  setting while the timer is running. Since TTREG $j$  is not in the shift register configuration in the timer mode, the new value programmed in TTREG $j$  is in effect immediately after the programming. Therefore, if TTREG $i$  is changed while the timer is running, an expected operation may not be obtained.

Note 3:  $j = 3, 4$

Table 9-4 Source Clock for TimerCounter 3, 4 (Internal Clock)

Source Clock			Resolution		Maximum Time Setting	
NORMAL1/2, IDLE1/2 mode		SLOW1/2, SLEEP1/2 mode	$f_c = 16 \text{ MHz}$	$f_s = 32.768 \text{ kHz}$	$f_c = 16 \text{ MHz}$	$f_s = 32.768 \text{ kHz}$
DV7CK = 0	DV7CK = 1					
$f_c/2^{11} \text{ [Hz]}$	$f_s/2^3 \text{ [Hz]}$	$f_s/2^3 \text{ [Hz]}$	128 $\mu\text{s}$	244.14 $\mu\text{s}$	32.6 ms	62.3 ms
$f_c/2^7$	$f_c/2^7$	—	8 $\mu\text{s}$	—	2.0 ms	—
$f_c/2^5$	$f_c/2^5$	—	2 $\mu\text{s}$	—	510 $\mu\text{s}$	—
$f_c/2^3$	$f_c/2^3$	—	500 ns	—	127.5 $\mu\text{s}$	—

Example :Setting the timer mode with source clock  $f_c/2^7 \text{ Hz}$  and generating an interrupt 80  $\mu\text{s}$  later (TimerCounter4,  $f_c = 16.0 \text{ MHz}$ )

```
LD      (TTREG4), 0AH      : Sets the timer register ( $80 \mu\text{s} \div 2^7 / f_c = 0AH$ ).
DI
SET     (EIRE). 5          : Enables INTTC4 interrupt.
EI
LD      (TC4CR), 00010000B : Sets the operating clock to  $f_c/2^7$ , and 8-bit timer mode.
LD      (TC4CR), 00011000B : Starts TC4.
```

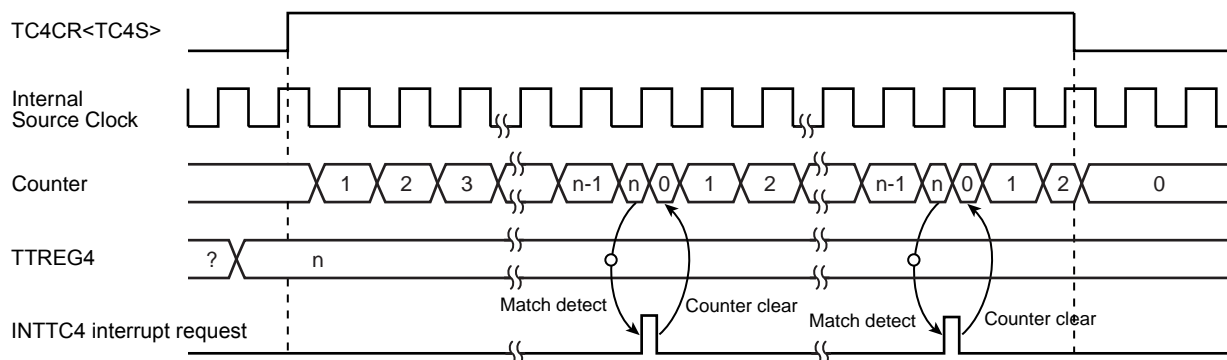


Figure 9-2 8-Bit Timer Mode Timing Chart (TC4)

### 9.3.2 8-Bit Event Counter Mode (TC3, 4)

In the 8-bit event counter mode, the up-counter counts up at the falling edge of the input pulse to the TCj pin. When a match between the up-counter and the TTREGj value is detected, an INTTCj interrupt is generated and the up-counter is cleared. After being cleared, the up-counter restarts counting at the falling edge of the input pulse to the TCj pin. Two machine cycles are required for the low- or high-level pulse input to the TCj pin. Therefore, a maximum frequency to be supplied is  $f_c/2^4$  Hz in the NORMAL1/2 or IDLE1/2 mode, and  $f_s/2^4$  Hz in the SLOW1/2 or SLEEP1/2 mode.

Note 1: In the event counter mode, fix TCjCR<TFFj> to 0. If not fixed, the  $\overline{PDOj}$ ,  $\overline{PWMj}$  and  $\overline{PPGj}$  pins may output pulses.

Note 2: In the event counter mode, do not change the TTREGj setting while the timer is running. Since TTREGj is not in the shift register configuration in the event counter mode, the new value programmed in TTREGj is in effect immediately after the programming. Therefore, if TTREGi is changed while the timer is running, an expected operation may not be obtained.

Note 3: j = 3, 4

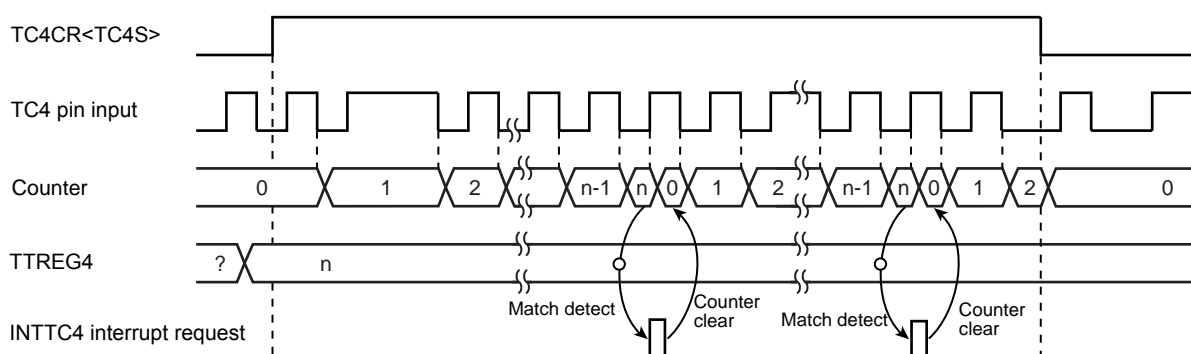


Figure 9-3 8-Bit Event Counter Mode Timing Chart (TC4)

### 9.3.3 8-Bit Programmable Divider Output (PDO) Mode (TC3, 4)

This mode is used to generate a pulse with a 50% duty cycle from the  $\overline{PDOj}$  pin.

In the PDO mode, the up-counter counts up using the internal clock. When a match between the up-counter and the TTREGj value is detected, the logic level output from the  $\overline{PDOj}$  pin is switched to the opposite state and the up-counter is cleared. The INTTCj interrupt request is generated at the time. The logic state opposite to the timer F/Fj logic level is output from the  $\overline{PDOj}$  pin. An arbitrary value can be set to the timer F/Fj by TCjCR<TFFj>. Upon reset, the timer F/Fj value is initialized to 0.

To use the programmable divider output, set the output latch of the I/O port to 1.

Example :Generating 1024 Hz pulse using TC4 ( $f_c = 16.0 \text{ MHz}$ )

Setting port

LD	(TTREG4), 3DH	: $1/1024 \div 2^7 / f_c \div 2 = 3DH$
LD	(TC4CR), 00010001B	: Sets the operating clock to $f_c/2^7$ , and 8-bit PDO mode.
LD	(TC4CR), 00011001B	: Starts TC4.

Note 1: In the programmable divider output mode, do not change the TTREGj setting while the timer is running. Since TTREGj is not in the shift register configuration in the programmable divider output mode, the new value programmed in TTREGj is in effect immediately after programming. Therefore, if TTREGi is changed while the timer is running, an expected operation may not be obtained.

Note 2: When the timer is stopped during PDO output, the  $\overline{PDOj}$  pin holds the output status when the timer is stopped. To change the output status, program TCjCR<TFFj> after the timer is stopped. Do not change the TCjCR<TFFj> setting upon stopping of the timer.

Example: Fixing the  $\overline{PDOj}$  pin to the high level when the TimerCounter is stopped

CLR (TCjCR).3: Stops the timer.

CLR (TCjCR).7: Sets the  $\overline{PDOj}$  pin to the high level.

Note 3: j = 3, 4

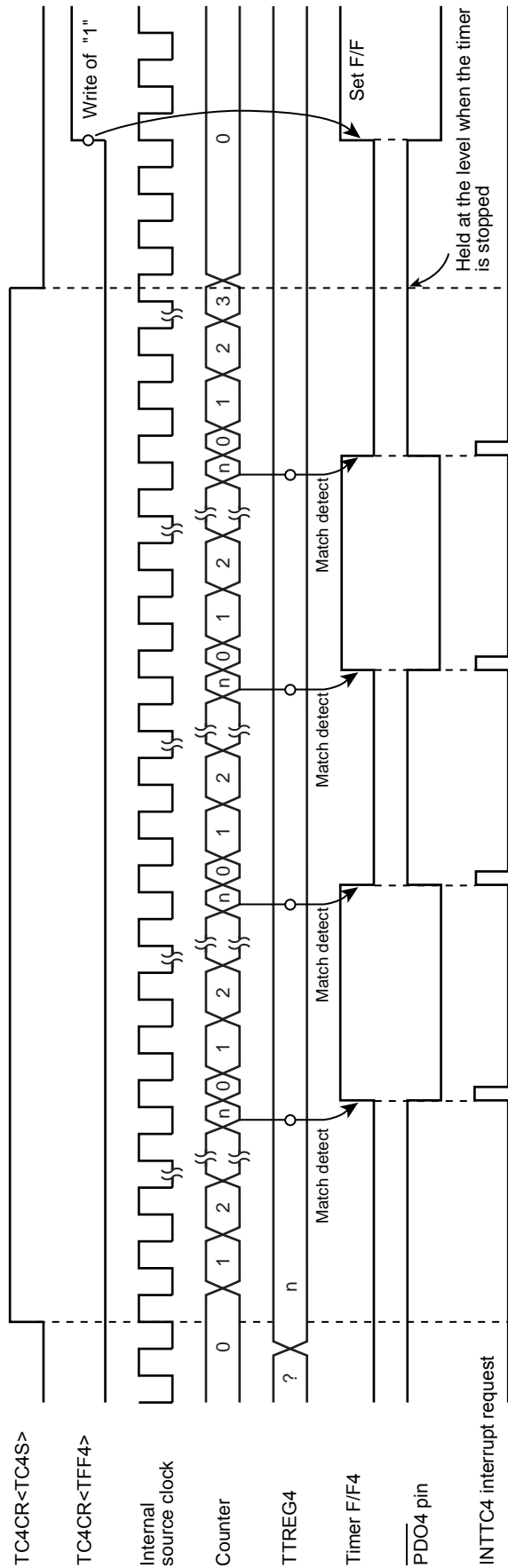


Figure 9-4 8-Bit PDO Mode Timing Chart (TC4)

### 9.3.4 8-Bit Pulse Width Modulation (PWM) Output Mode (TC3, 4)

This mode is used to generate a pulse-width modulated (PWM) signals with up to 8 bits of resolution. The up-counter counts up using the internal clock.

When a match between the up-counter and the PWREGj value is detected, the logic level output from the timer F/Fj is switched to the opposite state. The counter continues counting. The logic level output from the timer F/Fj is switched to the opposite state again by the up-counter overflow, and the counter is cleared. The INTTCj interrupt request is generated at this time.

Since the initial value can be set to the timer F/Fj by TCjCR<TFFj>, positive and negative pulses can be generated. Upon reset, the timer F/Fj is cleared to 0.

(The logic level output from the  $\overline{\text{PWMj}}$  pin is the opposite to the timer F/Fj logic level.)

Since PWREGj in the PWM mode is serially connected to the shift register, the value set to PWREGj can be changed while the timer is running. The value set to PWREGj during a run of the timer is shifted by the INTTCj interrupt request and loaded into PWREGj. While the timer is stopped, the value is shifted immediately after the programming of PWREGj. If executing the read instruction to PWREGj during PWM output, the value in the shift register is read, but not the value set in PWREGj. Therefore, after writing to PWREGj, the reading data of PWREGj is previous value until INTTCj is generated.

For the pin used for PWM output, the output latch of the I/O port must be set to 1.

Note 1: In the PWM mode, program the timer register PWREGj immediately after the INTTCj interrupt request is generated (normally in the INTTCj interrupt service routine.) If the programming of PWREGj and the interrupt request occur at the same time, an unstable value is shifted, that may result in generation of the pulse different from the programmed value until the next INTTCj interrupt request is generated.

Note 2: When the timer is stopped during PWM output, the  $\overline{\text{PWMj}}$  pin holds the output status when the timer is stopped. To change the output status, program TCjCR<TFFj> after the timer is stopped. Do not change the TCjCR<TFFj> upon stopping of the timer.

Example: Fixing the  $\overline{\text{PWMj}}$  pin to the high level when the TimerCounter is stopped

CLR (TCjCR).3: Stops the timer.

CLR (TCjCR).7: Sets the  $\overline{\text{PWMj}}$  pin to the high level.

Note 3: To enter the STOP mode during PWM output, stop the timer and then enter the STOP mode. If the STOP mode is entered without stopping the timer when fc, fc/2 or fs is selected as the source clock, a pulse is output from the  $\overline{\text{PWMj}}$  pin during the warm-up period time after exiting the STOP mode.

Note 4: j = 3, 4

Table 9-5 PWM Output Mode

Source Clock			Resolution		Repeated Cycle	
NORMAL1/2, IDLE1/2 mode		SLOW1/2, SLEEP1/2 mode	fc = 16 MHz	fs = 32.768 kHz	fc = 16 MHz	fs = 32.768 kHz
DV7CK = 0	DV7CK = 1					
$\text{fc}/2^{11}$ [Hz]	$\text{fs}/2^3$ [Hz]	$\text{fs}/2^3$ [Hz]	128 $\mu\text{s}$	244.14 $\mu\text{s}$	32.8 ms	62.5 ms
$\text{fc}/2^7$	$\text{fc}/2^7$	—	8 $\mu\text{s}$	—	2.05 ms	—
$\text{fc}/2^5$	$\text{fc}/2^5$	—	2 $\mu\text{s}$	—	512 $\mu\text{s}$	—
$\text{fc}/2^3$	$\text{fc}/2^3$	—	500 ns	—	128 $\mu\text{s}$	—
fs	fs	fs	30.5 $\mu\text{s}$	30.5 $\mu\text{s}$	7.81 ms	7.81 ms
$\text{fc}/2$	$\text{fc}/2$	—	125 ns	—	32 $\mu\text{s}$	—
fc	fc	—	62.5 ns	—	16 $\mu\text{s}$	—

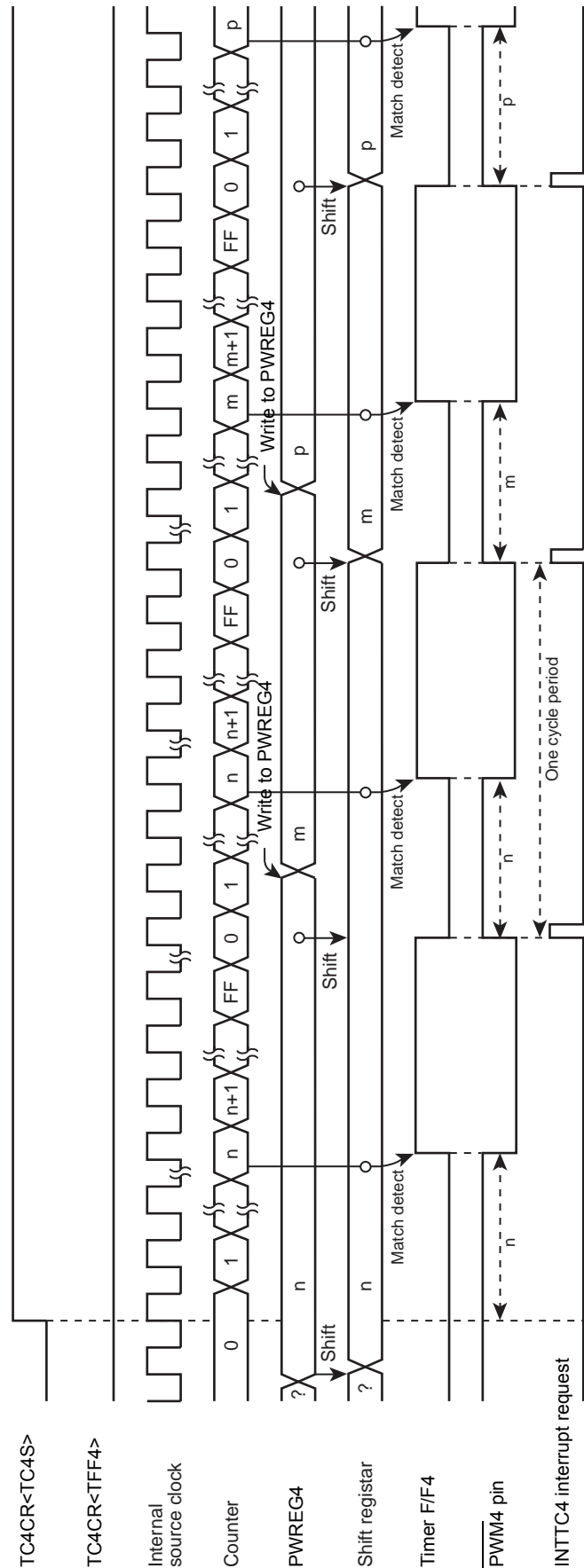


Figure 9-5 8-Bit PWM Mode Timing Chart (TC4)

9.3.5 16-Bit Timer Mode (TC3 and 4)

In the timer mode, the up-counter counts up using the internal clock. The TimerCounter 3 and 4 are cascaded to form a 16-bit timer.

When a match between the up-counter and the timer register (TTREG3, TTREG4) value is detected after the timer is started by setting TC4CR<TC4S> to 1, an INTTC4 interrupt is generated and the up-counter is cleared. After being cleared, the up-counter continues counting. Program the lower byte and upper byte in this order in the timer register. (Programming only the upper or lower byte should not be attempted.)

- Note 1: In the timer mode, fix TCjCR<TFFj> to 0. If not fixed, the  $\overline{PDOj}$ ,  $\overline{PWMj}$ , and  $\overline{PPGj}$  pins may output a pulse.
- Note 2: In the timer mode, do not change the TTREGj setting while the timer is running. Since TTREGj is not in the shift register configuration in the timer mode, the new value programmed in TTREGj is in effect immediately after programming of TTREGj. Therefore, if TTREGj is changed while the timer is running, an expected operation may not be obtained.
- Note 3: j = 3, 4

Table 9-6 Source Clock for 16-Bit Timer Mode

Source Clock			Resolution		Maximum Time Setting	
NORMAL1/2, IDLE1/2 mode		SLOW1/2, SLEEP1/2 mode	fc = 16 MHz	fs = 32.768 kHz	fc = 16 MHz	fs = 32.768 kHz
DV7CK = 0	DV7CK = 1					
fc/2 <sup>11</sup>	fs/2 <sup>3</sup>	fs/2 <sup>3</sup>	128 μs	244.14 μs	8.39 s	16 s
fc/2 <sup>7</sup>	fc/2 <sup>7</sup>	—	8 μs	—	524.3 ms	—
fc/2 <sup>5</sup>	fc/2 <sup>5</sup>	—	2 μs	—	131.1 ms	—
fc/2 <sup>3</sup>	fc/2 <sup>3</sup>	—	500 ns	—	32.8 ms	—

Example :Setting the timer mode with source clock fc/2<sup>7</sup> Hz, and generating an interrupt 300 ms later  
(fc = 16.0 MHz)

- LDW (TTREG3), 927CH : Sets the timer register (300 ms÷2<sup>7</sup>/fc = 927CH).
- DI
- SET (EIRE). 5 : Enables INTTC4 interrupt.
- EI
- LD (TC3CR), 13H :Sets the operating clock to fc/2<sup>7</sup>, and 16-bit timer mode (lower byte).
- LD (TC4CR), 04H : Sets the 16-bit timer mode (upper byte).
- LD (TC4CR), 0CH : Starts the timer.

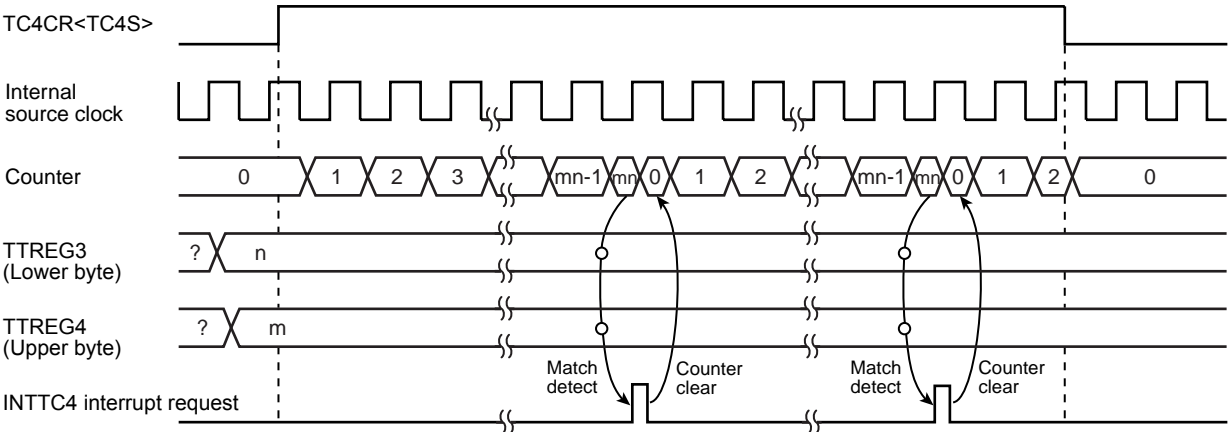


Figure 9-6 16-Bit Timer Mode Timing Chart (TC3 and TC4)

### 9.3.6 16-Bit Event Counter Mode (TC3 and 4)

In the event counter mode, the up-counter counts up at the falling edge to the TC3 pin. The TimerCounter 3 and 4 are cascable to form a 16-bit event counter.

When a match between the up-counter and the timer register (TTREG3, TTREG4) value is detected after the timer is started by setting TC4CR<TC4S> to 1, an INTTC4 interrupt is generated and the up-counter is cleared.

After being cleared, the up-counter restarts counting at the falling edge of the input pulse to the TC3 pin. Two machine cycles are required for the low- or high-level pulse input to the TC3 pin.

Therefore, a maximum frequency to be supplied is  $f_c/2^4$  Hz in the NORMAL1/2 or IDLE1/2 mode, and  $f_s/2^4$  in the SLOW1/2 or SLEEP1/2 mode. Program the lower byte (TTREG3), and upper byte (TTREG4) in this order in the timer register. (Programming only the upper or lower byte should not be attempted.)

Note 1: In the event counter mode, fix TCJCR<TFFj> to 0. If not fixed, the  $\overline{PDOj}$ ,  $\overline{PWMj}$  and  $\overline{PPGj}$  pins may output pulses.

Note 2: In the event counter mode, do not change the TTREGj setting while the timer is running. Since TTREGj is not in the shift register configuration in the event counter mode, the new value programmed in TTREGj is in effect immediately after the programming. Therefore, if TTREGj is changed while the timer is running, an expected operation may not be obtained.

Note 3: j = 3, 4

### 9.3.7 16-Bit Pulse Width Modulation (PWM) Output Mode (TC3 and 4)

This mode is used to generate a pulse-width modulated (PWM) signals with up to 16 bits of resolution. The TimerCounter 3 and 4 are cascable to form the 16-bit PWM signal generator.

The counter counts up using the internal clock or external clock.

When a match between the up-counter and the timer register (PWREG3, PWREG4) value is detected, the logic level output from the timer F/F4 is switched to the opposite state. The counter continues counting. The logic level output from the timer F/F4 is switched to the opposite state again by the counter overflow, and the counter is cleared. The INTTC4 interrupt is generated at this time.

Two machine cycles are required for the high- or low-level pulse input to the TC3 pin. Therefore, a maximum frequency to be supplied is  $f_c/2^4$  Hz in the NORMAL1/2 or IDLE1/2 mode, and  $f_s/2^4$  to in the SLOW1/2 or SLEEP1/2 mode.

Since the initial value can be set to the timer F/F4 by TC4CR<TFF4>, positive and negative pulses can be generated. Upon reset, the timer F/F4 is cleared to 0.

(The logic level output from the  $\overline{PWM4}$  pin is the opposite to the timer F/F4 logic level.)

Since PWREG4 and 3 in the PWM mode are serially connected to the shift register, the values set to PWREG4 and 3 can be changed while the timer is running. The values set to PWREG4 and 3 during a run of the timer are shifted by the INTTCj interrupt request and loaded into PWREG4 and 3. While the timer is stopped, the values are shifted immediately after the programming of PWREG4 and 3. Set the lower byte (PWREG3) and upper byte (PWREG4) in this order to program PWREG4 and 3. (Programming only the lower or upper byte of the register should not be attempted.)

If executing the read instruction to PWREG4 and 3 during PWM output, the values set in the shift register is read, but not the values set in PWREG4 and 3. Therefore, after writing to the PWREG4 and 3, reading data of PWREG4 and 3 is previous value until INTTC4 is generated.

For the pin used for PWM output, the output latch of the I/O port must be set to 1.

Note 1: In the PWM mode, program the timer register PWREG4 and 3 immediately after the INTTC4 interrupt request is generated (normally in the INTTC4 interrupt service routine.) If the programming of PWREGj and the interrupt request occur at the same time, an unstable value is shifted, that may result in generation of pulse different from the programmed value until the next INTTC4 interrupt request is generated.

Note 2: When the timer is stopped during PWM output, the  $\overline{PWM4}$  pin holds the output status when the timer is stopped. To change the output status, program TC4CR<TFF4> after the timer is stopped. Do not program TC4CR<TFF4> upon stopping of the timer.

Example: Fixing the  $\overline{PWM4}$  pin to the high level when the TimerCounter is stopped



CLR (TC4CR).3: Stops the timer.

CLR (TC4CR).7 : Sets the  $\overline{\text{PWM4}}$  pin to the high level.

Note 3: To enter the STOP mode, stop the timer and then enter the STOP mode. If the STOP mode is entered without stopping of the timer when  $f_c$ ,  $f_c/2$  or  $f_s$  is selected as the source clock, a pulse is output from the  $\overline{\text{PWM4}}$  pin during the warm-up period time after exiting the STOP mode.

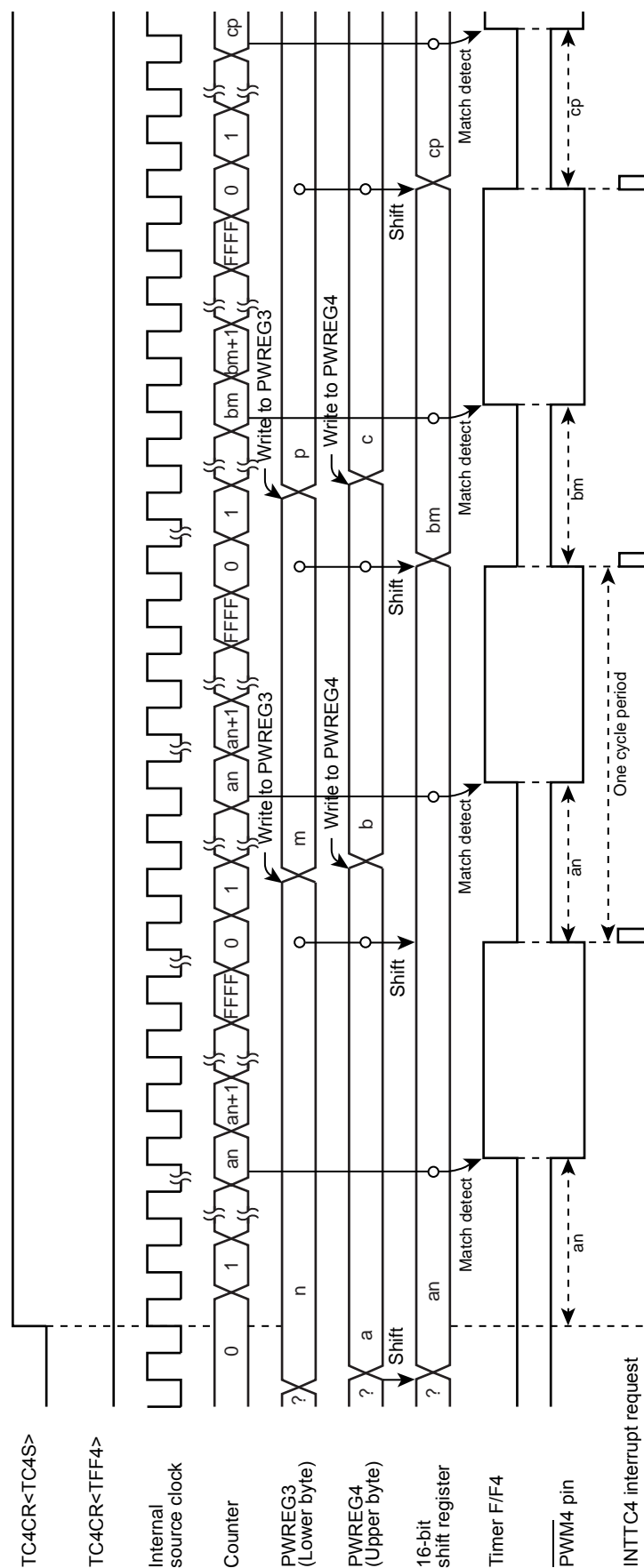
Table 9-7 16-Bit PWM Output Mode

Source Clock			Resolution		Repeated Cycle	
NORMAL1/2, IDLE1/2 mode		SLOW1/2, SLEEP1/2 mode	$f_c = 16 \text{ MHz}$	$f_s = 32.768 \text{ kHz}$	$f_c = 16 \text{ MHz}$	$f_s = 32.768 \text{ kHz}$
DV7CK = 0	DV7CK = 1					
$f_c/2^{11}$	$f_s/2^3 \text{ [Hz]}$	$f_s/2^3 \text{ [Hz]}$	128 $\mu\text{s}$	244.14 $\mu\text{s}$	8.39 s	16 s
$f_c/2^7$	$f_c/2^7$	—	8 $\mu\text{s}$	—	524.3 ms	—
$f_c/2^5$	$f_c/2^5$	—	2 $\mu\text{s}$	—	131.1 ms	—
$f_c/2^3$	$f_c/2^3$	—	500 ns	—	32.8 ms	—
$f_s$	$f_s$	$f_s$	30.5 $\mu\text{s}$	30.5 $\mu\text{s}$	2 s	2 s
$f_c/2$	$f_c/2$	—	125 ns	—	8.2 ms	—
$f_c$	$f_c$	—	62.5 ns	—	4.1 ms	—

Example :Generating a pulse with 1-ms high-level width and a period of 32.768 ms ( $f_c = 16.0 \text{ MHz}$ )

Setting ports

LDW	(PWREG3), 07D0H	: Sets the pulse width.
LD	(TC3CR), 33H	: Sets the operating clock to $f_c/2^3$ , and 16-bit PWM output mode (lower byte).
LD	(TC4CR), 056H	: Sets TFF4 to the initial value 0, and 16-bit PWM signal generation mode (upper byte).
LD	(TC4CR), 05EH	: Starts the timer.



### 9.3.8 16-Bit Programmable Pulse Generate (PPG) Output Mode (TC3 and 4)

This mode is used to generate pulses with up to 16-bits of resolution. The timer counter 3 and 4 are cascaded to enter the 16-bit PPG mode.

The counter counts up using the internal clock or external clock. When a match between the up-counter and the timer register (PWREG3, PWREG4) value is detected, the logic level output from the timer F/F4 is switched to the opposite state. The counter continues counting. The logic level output from the timer F/F4 is switched to the opposite state again when a match between the up-counter and the timer register (TTREG3, TTREG4) value is detected, and the counter is cleared. The INTTC4 interrupt is generated at this time.

Two machine cycles are required for the high- or low-level pulse input to the TC3 pin. Therefore, a maximum frequency to be supplied is  $f_c/2^4$  Hz in the NORMAL1/2 or IDLE1/2 mode, and  $f_s/2^4$  to in the SLOW1/2 or SLEEP1/2 mode.

Since the initial value can be set to the timer F/F4 by TC4CR<TFF4>, positive and negative pulses can be generated. Upon reset, the timer F/F4 is cleared to 0.

(The logic level output from the  $\overline{\text{PPG4}}$  pin is the opposite to the timer F/F4.)

Set the lower byte and upper byte in this order to program the timer register. (TTREG3 → TTREG4, PWREG3 → PWREG4) (Programming only the upper or lower byte should not be attempted.)

For PPG output, set the output latch of the I/O port to 1.

Example :Generating a pulse with 1-ms high-level width and a period of 16.385 ms ( $f_c = 16.0$  MHz)

Setting ports		
LDW	(PWREG3), 07D0H	: Sets the pulse width.
LDW	(TTREG3), 8002H	: Sets the cycle period.
LD	(TC3CR), 33H	: Sets the operating clock to $f_c/2^3$ , and 16-bit PPG mode (lower byte).
LD	(TC4CR), 057H	: Sets TFF4 to the initial value 0, and 16-bit PPG mode (upper byte).
LD	(TC4CR), 05FH	: Starts the timer.

Note 1: In the PPG mode, do not change the PWREGi and TTREGi settings while the timer is running. Since PWREGi and TTREGi are not in the shift register configuration in the PPG mode, the new values programmed in PWREGi and TTREGi are in effect immediately after programming PWREGi and TTREGi. Therefore, if PWREGi and TTREGi are changed while the timer is running, an expected operation may not be obtained.

Note 2: When the timer is stopped during PPG output, the  $\overline{\text{PPG4}}$  pin holds the output status when the timer is stopped. To change the output status, program TC4CR<TFF4> after the timer is stopped. Do not change TC4CR<TFF4> upon stopping of the timer.

Example: Fixing the  $\overline{\text{PPG4}}$  pin to the high level when the TimerCounter is stopped

CLR (TC4CR).3: Stops the timer

CLR (TC4CR).7: Sets the  $\overline{\text{PPG4}}$  pin to the high level

Note 3: i = 3, 4

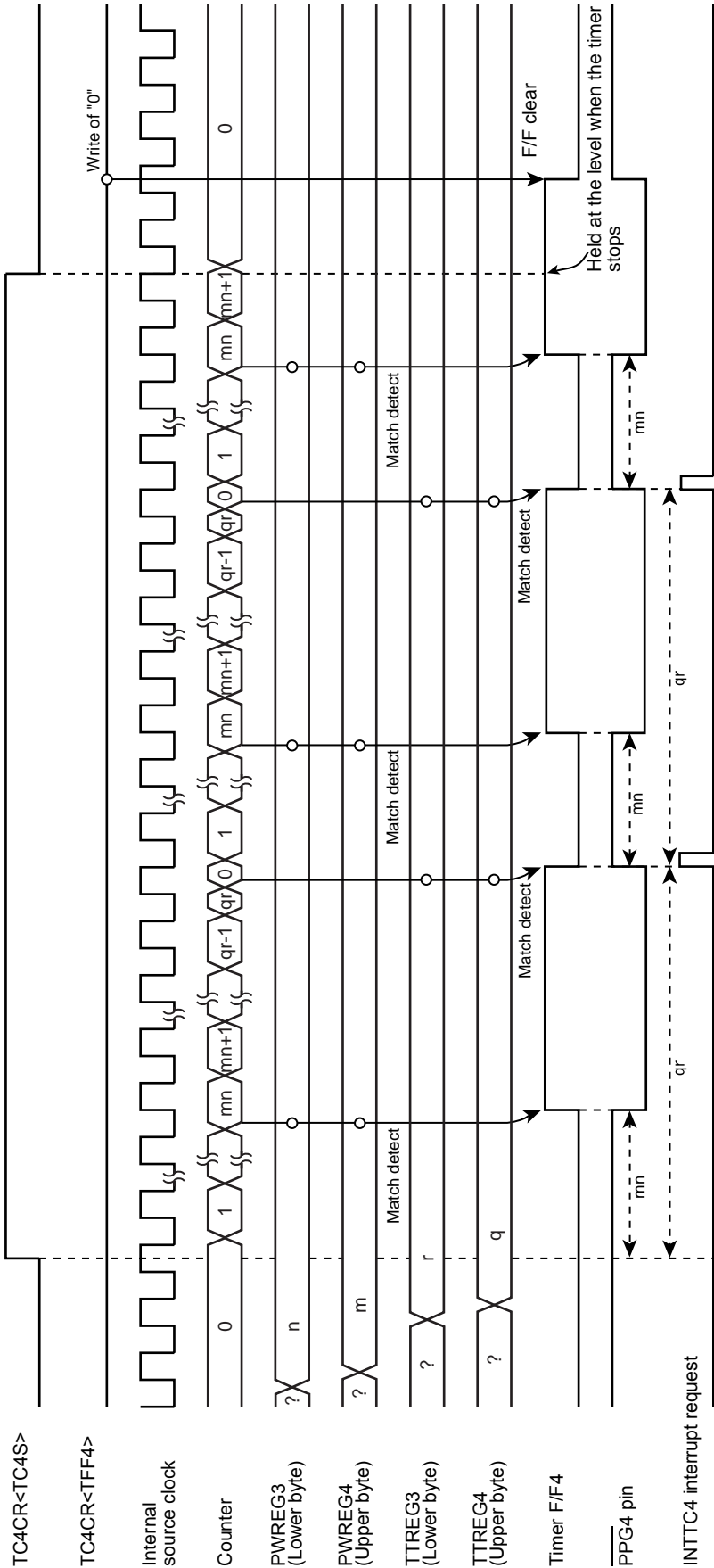


Figure 9-8 16-Bit PPG Mode Timing Chart (TC3 and TC4)

### 9.3.9 Warm-Up Counter Mode

In this mode, the warm-up period time is obtained to assure oscillation stability when the system clocking is switched between the high-frequency and low-frequency. The timer counter 3 and 4 are cascadable to form a 16-bit TimerCounter. The warm-up counter mode has two types of mode; switching from the high-frequency to low-frequency, and vice-versa.

Note 1: In the warm-up counter mode, fix TCiCR<TFFi> to 0. If not fixed, the  $\overline{PD\bar{O}i}$ ,  $\overline{PWMi}$  and  $\overline{PPGi}$  pins may output pulses.

Note 2: In the warm-up counter mode, only upper 8 bits of the timer register TTREG4 and 3 are used for match detection and lower 8 bits are not used.

Note 3: i = 3, 4

#### 9.3.9.1 Low-Frequency Warm-up Counter Mode (NORMAL1 → NORMAL2 → SLOW2 → SLOW1)

In this mode, the warm-up period time from a stop of the low-frequency clock fs to oscillation stability is obtained. Before starting the timer, set SYSCR2<XTEN> to 1 to oscillate the low-frequency clock. When a match between the up-counter and the timer register (TTREG4, 3) value is detected after the timer is started by setting TC4CR<TC4S> to 1, the counter is cleared by generating the INTTC4 interrupt request. After stopping the timer in the INTTC4 interrupt service routine, set SYSCR2<SYSCK> to 1 to switch the system clock from the high-frequency to low-frequency, and then clear of SYSCR2<XEN> to 0 to stop the high-frequency clock.

Table 9-8 Setting Time of Low-Frequency Warm-Up Counter Mode (fs = 32.768 kHz)

Minimum Time Setting (TTREG4, 3 = 0100H)	Maximum Time Setting (TTREG4, 3 = FF00H)
7.81 ms	1.99 s

Example :After checking low-frequency clock oscillation stability with TC4 and 3, switching to the SLOW1 mode

	SET	(SYSCR2).6	: SYSCR2<XTEN> ← 1
	LD	(TC3CR), 43H	: Sets TFF3=0, source clock fs, and 16-bit mode.
	LD	(TC4CR), 05H	: Sets TFF4=0, and warm-up counter mode.
	LD	(TTREG3), 8000H	: Sets the warm-up time. (The warm-up time depends on the oscillator characteristic.)
	DI		: IMF ← 0
	SET	(EIRE). 5	: Enables the INTTC4.
	EI		: IMF ← 1
	SET	(TC4CR).3	: Starts TC4 and 3.
	:	:	
PINTTC4:	CLR	(TC4CR).3	: Stops TC4 and 3.
	SET	(SYSCR2).5	: SYSCR2<SYSCK> ← 1 (Switches the system clock to the low-frequency clock.)
	CLR	(SYSCR2).7	: SYSCR2<XEN> ← 0 (Stops the high-frequency clock.)
	RETI		
	:	:	
VINTTC4:	DW	PINTTC4	: INTTC4 vector table

9.3.9.2 High-Frequency Warm-Up Counter Mode  
(SLOW1 → SLOW2 → NORMAL2 → NORMAL1)

In this mode, the warm-up period time from a stop of the high-frequency clock *fc* to the oscillation stability is obtained. Before starting the timer, set SYSCR2<XEN> to 1 to oscillate the high-frequency clock. When a match between the up-counter and the timer register (TTREG4, 3) value is detected after the timer is started by setting TC4CR<TC4S> to 1, the counter is cleared by generating the INTTC4 interrupt request. After stopping the timer in the INTTC4 interrupt service routine, clear SYSCR2<SYSCK> to 0 to switch the system clock from the low-frequency to high-frequency, and then SYSCR2<XTEN> to 0 to stop the low-frequency clock.

Table 9-9 Setting Time in High-Frequency Warm-Up Counter Mode

Minimum time Setting (TTREG4, 3 = 0100H)	Maximum time Setting (TTREG4, 3 = FF00H)
16 μs	4.08 ms

Example :After checking high-frequency clock oscillation stability with TC4 and 3, switching to the NORMAL1 mode

	SET	(SYSCR2).7	: SYSCR2<XEN> ← 1
	LD	(TC3CR), 63H	: Sets TFF3=0, source clock <i>fc</i> , and 16-bit mode.
	LD	(TC4CR), 05H	: Sets TFF4=0, and warm-up counter mode.
	LD	(TTREG3), 0F800H	: Sets the warm-up time. (The warm-up time depends on the oscillator characteristic.)
	DI		: IMF ← 0
	SET	(EIRE). 5	: Enables the INTTC4.
	EI		: IMF ← 1
	SET	(TC4CR).3	: Starts the TC4 and 3.
	:	:	
PINTTC4:	CLR	(TC4CR).3	: Stops the TC4 and 3.
	CLR	(SYSCR2).5	: SYSCR2<SYSCK> ← 0 (Switches the system clock to the high-frequency clock.)
	CLR	(SYSCR2).6	: SYSCR2<XTEN> ← 0 (Stops the low-frequency clock.)
	RETI		
	:	:	
VINTTC4:	DW	PINTTC4	: INTTC4 vector table

## 10. 8-Bit TimerCounter (TC5, TC6)

### 10.1 Configuration

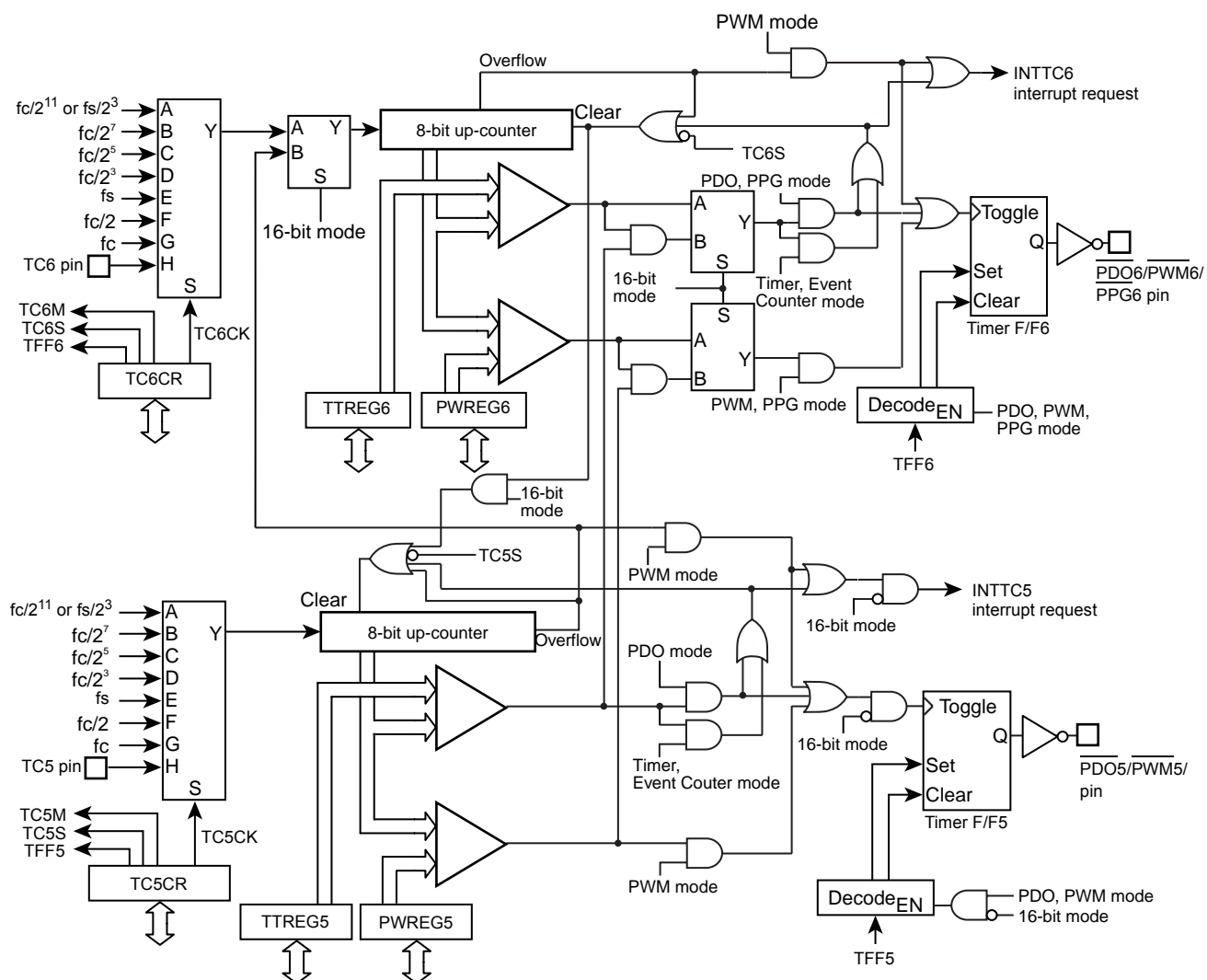


Figure 10-1 8-Bit TimerCounter 5, 6

## 10.2 TimerCounter Control

The TimerCounter 5 is controlled by the TimerCounter 5 control register (TC5CR) and two 8-bit timer registers (TTREG5, PWREG5).

### TimerCounter 5 Timer Register

TTREG5 (0017H) R/W	7	6	5	4	3	2	1	0	(Initial value: 1111 1111)

PWREG5 (001BH) R/W	7	6	5	4	3	2	1	0	(Initial value: 1111 1111)

Note 1: Do not change the timer register (TTREG5) setting while the timer is running.

Note 2: Do not change the timer register (PWREG5) setting in the operating mode except the 8-bit and 16-bit PWM modes while the timer is running.

### TimerCounter 5 Control Register

TC5CR (000BH)	7	6	5	4	3	2	1	0	(Initial value: 0000 0000)
	TFF5	TC5CK			TC5S	TC5M			

TFF5	Time F/F5 control	0: Clear 1: Set				R/W
TC5CK	Operating clock selection [Hz]		NORMAL1/2, IDLE1/2 mode		SLOW1/2 SLEEP1/2 mode	R/W
			DV7CK = 0	DV7CK = 1		
		000	fc/2 <sup>11</sup>	fs/2 <sup>3</sup>	fs/2 <sup>3</sup>	
		001	fc/2 <sup>7</sup>	fc/2 <sup>7</sup>	—	
		010	fc/2 <sup>5</sup>	fc/2 <sup>5</sup>	—	
		011	fc/2 <sup>3</sup>	fc/2 <sup>3</sup>	—	
		100	fs	fs	fs	
		101	fc/2	fc/2	—	
		110	fc	fc	fc (Note 8)	
		111	TC5 pin input			
TC5S	TC5 start control	0: Operation stop and counter clear 1: Operation start				R/W
TC5M	TC5M operating mode select	000: 8-bit timer/event counter mode 001: 8-bit programmable divider output (PDO) mode 010: 8-bit pulse width modulation (PWM) output mode 011: 16-bit mode (Each mode is selectable with TC6M.) 1**: Reserved				R/W

Note 1: fc: High-frequency clock [Hz] fs: Low-frequency clock[Hz]

Note 2: Do not change the TC5M, TC5CK and TFF5 settings while the timer is running.

Note 3: To stop the timer operation (TC5S= 1 → 0), do not change the TC5M, TC5CK and TFF5 settings. To start the timer operation (TC5S= 0 → 1), TC5M, TC5CK and TFF5 can be programmed.

Note 4: To use the TimerCounter in the 16-bit mode, set the operating mode by programming TC6CR<TC6M>, where TC5M must be fixed to 011.

Note 5: To use the TimerCounter in the 16-bit mode, select the source clock by programming TC5CK. Set the timer start control and timer F/F control by programming TC6CR<TC6S> and TC6CR<TFF6>, respectively.

Note 6: The operating clock settings are limited depending on the timer operating mode. For the detailed descriptions, see Table 10-1 and Table 10-2.



Note 7: The timer register settings are limited depending on the timer operating mode. For the detailed descriptions, see Table 10-3.

Note 8: The operating clock  $f_c$  in the SLOW or SLEEP mode can be used only as the high-frequency warm-up mode.

The TimerCounter 6 is controlled by the TimerCounter 6 control register (TC6CR) and two 8-bit timer registers (TTREG6 and PWREG6).

### TimerCounter 6 Timer Register

TTREG6 (0018H) R/W	7	6	5	4	3	2	1	0	(Initial value: 1111 1111)

PWREG6 (001CH) R/W	7	6	5	4	3	2	1	0	(Initial value: 1111 1111)

Note 1: Do not change the timer register (TTREG6) setting while the timer is running.

Note 2: Do not change the timer register (PWREG6) setting in the operating mode except the 8-bit and 16-bit PWM modes while the timer is running.

### TimerCounter 6 Control Register

TC6CR (000CH)	7	6	5	4	3	2	1	0	(Initial value: 0000 0000)
	TFF6	TC6CK			TC6S	TC6M			

TFF6	Timer F/F6 control	0: Clear 1: Set				R/W
TC6CK	Operating clock selection [Hz]		NORMAL1/2, IDLE1/2 mode		SLOW1/2 SLEEP1/2 mode	R/W
			DV7CK = 0	DV7CK = 1		
		000	fc/2 <sup>11</sup>	fs/2 <sup>3</sup>	fs/2 <sup>3</sup>	
		001	fc/2 <sup>7</sup>	fc/2 <sup>7</sup>	—	
		010	fc/2 <sup>5</sup>	fc/2 <sup>5</sup>	—	
		011	fc/2 <sup>3</sup>	fc/2 <sup>3</sup>	—	
		100	fs	fs	fs	
		101	fc/2	fc/2	—	
		110	fc	fc	—	
		111	TC6 pin input			
TC6S	TC6 start control	0: Operation stop and counter clear 1: Operation start				R/W
TC6M	TC6M operating mode select	000: 8-bit timer/event counter mode 001: 8-bit programmable divider output (PDO) mode 010: 8-bit pulse width modulation (PWM) output mode 011: Reserved 100: 16-bit timer/event counter mode 101: Warm-up counter mode 110: 16-bit pulse width modulation (PWM) output mode 111: 16-bit PPG mode				R/W

Note 1: fc: High-frequency clock [Hz] fs: Low-frequency clock [Hz]

Note 2: Do not change the TC6M, TC6CK and TFF6 settings while the timer is running.

Note 3: To stop the timer operation (TC6S= 1 → 0), do not change the TC6M, TC6CK and TFF6 settings.  
To start the timer operation (TC6S= 0 → 1), TC6M, TC6CK and TFF6 can be programmed.

Note 4: When TC6M= 1\*\* (upper byte in the 16-bit mode), the source clock becomes the TC5 overflow signal regardless of the TC6CK setting.

Note 5: To use the TimerCounter in the 16-bit mode, select the operating mode by programming TC6M, where TC5CR<TC5M> must be set to 011.

Note 6: To the TimerCounter in the 16-bit mode, select the source clock by programming TC5CR<TC5CK>. Set the timer start control and timer F/F control by programming TC6S and TFF6, respectively.

Note 7: The operating clock settings are limited depending on the timer operating mode. For the detailed descriptions, see Table 10-1 and Table 10-2.

Note 8: The timer register settings are limited depending on the timer operating mode. For the detailed descriptions, see Table 10-3.

Table 10-1 Operating Mode and Selectable Source Clock (NORMAL1/2 and IDLE1/2 Modes)

Operating mode	$fc/2^{11}$ or $fs/2^3$	$fc/2^7$	$fc/2^5$	$fc/2^3$	fs	$fc/2$	fc	TC5 pin input	TC6 pin input
8-bit timer	O	O	O	O	—	—	—	—	—
8-bit event counter	—	—	—	—	—	—	—	O	O
8-bit PDO	O	O	O	O	—	—	—	—	—
8-bit PWM	O	O	O	O	O	O	O	—	—
16-bit timer	O	O	O	O	—	—	—	—	—
16-bit event counter	—	—	—	—	—	—	—	O	—
Warm-up counter	—	—	—	—	O	—	—	—	—
16-bit PWM	O	O	O	O	O	O	O	O	—
16-bit PPG	O	O	O	O	—	—	—	O	—

Note 1: For 16-bit operations (16-bit timer/event counter, warm-up counter, 16-bit PWM and 16-bit PPG), set its source clock on lower bit (TC5CK).

Note 2: O : Available source clock

Table 10-2 Operating Mode and Selectable Source Clock (SLOW1/2 and SLEEP1/2 Modes)

Operating mode	$fc/2^{11}$ or $fs/2^3$	$fc/2^7$	$fc/2^5$	$fc/2^3$	fs	$fc/2$	fc	TC5 pin input	TC6 pin input
8-bit timer	O	—	—	—	—	—	—	—	—
8-bit event counter	—	—	—	—	—	—	—	O	O
8-bit PDO	O	—	—	—	—	—	—	—	—
8-bit PWM	O	—	—	—	O	—	—	—	—
16-bit timer	O	—	—	—	—	—	—	—	—
16-bit event counter	—	—	—	—	—	—	—	O	—
Warm-up counter	—	—	—	—	—	—	O	—	—
16-bit PWM	O	—	—	—	O	—	—	O	—
16-bit PPG	O	—	—	—	—	—	—	O	—

Note1: For 16-bit operations (16-bit timer/event counter, warm-up counter, 16-bit PWM and 16-bit PPG), set its source clock on lower bit (TC5CK).

Note2: O : Available source clock

Table 10-3 Constraints on Register Values Being Compared

Operating mode	Register Value
8-bit timer/event counter	$1 \leq (TTREGn) \leq 255$
8-bit PDO	$1 \leq (TTREGn) \leq 255$
8-bit PWM	$2 \leq (PWREGn) \leq 254$
16-bit timer/event counter	$1 \leq (TTREG6, 5) \leq 65535$
Warm-up counter	$256 \leq (TTREG6, 5) \leq 65535$
16-bit PWM	$2 \leq (PWREG6, 5) \leq 65534$
16-bit PPG	$1 \leq (PWREG6, 5) < (TTREG6, 5) \leq 65535$ and $(PWREG6, 5) + 1 < (TTREG6, 5)$

Note: n = 5 to 6

## 10.3 Function

The TimerCounter 5 and 6 have the 8-bit timer, 8-bit event counter, 8-bit programmable divider output (PDO), 8-bit pulse width modulation (PWM) output modes. The TimerCounter 5 and 6 (TC5, 6) are cascadable to form a 16-bit timer. The 16-bit timer has the operating modes such as the 16-bit timer, 16-bit event counter, warm-up counter, 16-bit pulse width modulation (PWM) output and 16-bit programmable pulse generation (PPG) modes.

### 10.3.1 8-Bit Timer Mode (TC5 and 6)

In the timer mode, the up-counter counts up using the internal clock. When a match between the up-counter and the timer register  $j$  (TTREG $j$ ) value is detected, an INTTC $j$  interrupt is generated and the up-counter is cleared. After being cleared, the up-counter restarts counting.

Note 1: In the timer mode, fix TCjCR<TFFj> to 0. If not fixed, the  $\overline{PDOj}$ ,  $\overline{PWMj}$  and  $\overline{PPGj}$  pins may output pulses.

Note 2: In the timer mode, do not change the TTREG $j$  setting while the timer is running. Since TTREG $j$  is not in the shift register configuration in the timer mode, the new value programmed in TTREG $j$  is in effect immediately after the programming. Therefore, if TTREG $i$  is changed while the timer is running, an expected operation may not be obtained.

Note 3:  $j = 5, 6$

Table 10-4 Source Clock for TimerCounter 5, 6 (Internal Clock)

Source Clock			Resolution		Maximum Time Setting	
NORMAL1/2, IDLE1/2 mode		SLOW1/2, SLEEP1/2 mode	$f_c = 16 \text{ MHz}$	$f_s = 32.768 \text{ kHz}$	$f_c = 16 \text{ MHz}$	$f_s = 32.768 \text{ kHz}$
DV7CK = 0	DV7CK = 1					
$f_c/2^{11} \text{ [Hz]}$	$f_s/2^3 \text{ [Hz]}$	$f_s/2^3 \text{ [Hz]}$	128 $\mu\text{s}$	244.14 $\mu\text{s}$	32.6 ms	62.3 ms
$f_c/2^7$	$f_c/2^7$	—	8 $\mu\text{s}$	—	2.0 ms	—
$f_c/2^5$	$f_c/2^5$	—	2 $\mu\text{s}$	—	510 $\mu\text{s}$	—
$f_c/2^3$	$f_c/2^3$	—	500 ns	—	127.5 $\mu\text{s}$	—

Example :Setting the timer mode with source clock  $f_c/2^7 \text{ Hz}$  and generating an interrupt 80  $\mu\text{s}$  later (TimerCounter6,  $f_c = 16.0 \text{ MHz}$ )

```
LD      (TTREG6), 0AH      : Sets the timer register ( $80 \mu\text{s} \div 2^7 / f_c = 0AH$ ).
DI
SET     (EIRD), 0          : Enables INTTC6 interrupt.
EI
LD      (TC6CR), 00010000B : Sets the operating clock to  $f_c/2^7$ , and 8-bit timer mode.
LD      (TC6CR), 00011000B : Starts TC6.
```

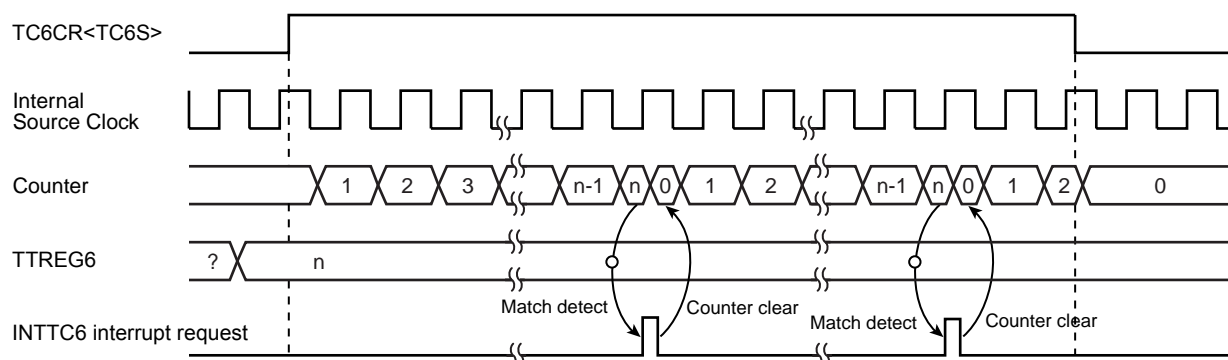


Figure 10-2 8-Bit Timer Mode Timing Chart (TC6)

### 10.3.2 8-Bit Event Counter Mode (TC5, 6)

In the 8-bit event counter mode, the up-counter counts up at the falling edge of the input pulse to the TCj pin. When a match between the up-counter and the TTREGj value is detected, an INTTCj interrupt is generated and the up-counter is cleared. After being cleared, the up-counter restarts counting at the falling edge of the input pulse to the TCj pin. Two machine cycles are required for the low- or high-level pulse input to the TCj pin. Therefore, a maximum frequency to be supplied is  $f_c/2^4$  Hz in the NORMAL1/2 or IDLE1/2 mode, and  $f_s/2^4$  Hz in the SLOW1/2 or SLEEP1/2 mode.

Note 1: In the event counter mode, fix TCjCR<TFFj> to 0. If not fixed, the  $\overline{PDOj}$ ,  $PWMj$  and  $\overline{PPGj}$  pins may output pulses.

Note 2: In the event counter mode, do not change the TTREGj setting while the timer is running. Since TTREGj is not in the shift register configuration in the event counter mode, the new value programmed in TTREGj is in effect immediately after the programming. Therefore, if TTREGi is changed while the timer is running, an expected operation may not be obtained.

Note 3: j = 5, 6

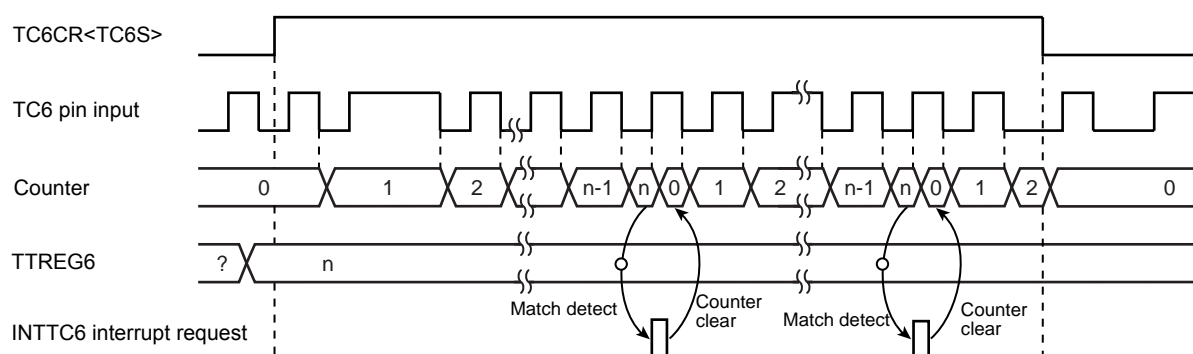


Figure 10-3 8-Bit Event Counter Mode Timing Chart (TC6)

### 10.3.3 8-Bit Programmable Divider Output (PDO) Mode (TC5, 6)

This mode is used to generate a pulse with a 50% duty cycle from the  $\overline{PDOj}$  pin.

In the PDO mode, the up-counter counts up using the internal clock. When a match between the up-counter and the TTREGj value is detected, the logic level output from the  $\overline{PDOj}$  pin is switched to the opposite state and the up-counter is cleared. The INTTCj interrupt request is generated at the time. The logic state opposite to the timer F/Fj logic level is output from the  $\overline{PDOj}$  pin. An arbitrary value can be set to the timer F/Fj by TCjCR<TFFj>. Upon reset, the timer F/Fj value is initialized to 0.

To use the programmable divider output, set the output latch of the I/O port to 1.

Example :Generating 1024 Hz pulse using TC6 (fc = 16.0 MHz)

Setting port

LD	(TTREG6), 3DH	: $1/1024 \div 2^7 / fc \div 2 = 3DH$
LD	(TC6CR), 00010001B	: Sets the operating clock to $fc/2^7$ , and 8-bit PDO mode.
LD	(TC6CR), 00011001B	: Starts TC6.

Note 1: In the programmable divider output mode, do not change the TTREGj setting while the timer is running. Since TTREGj is not in the shift register configuration in the programmable divider output mode, the new value programmed in TTREGj is in effect immediately after programming. Therefore, if TTREGi is changed while the timer is running, an expected operation may not be obtained.

Note 2: When the timer is stopped during PDO output, the  $\overline{PDOj}$  pin holds the output status when the timer is stopped. To change the output status, program TCjCR<TFFj> after the timer is stopped. Do not change the TCjCR<TFFj> setting upon stopping of the timer.

Example: Fixing the  $\overline{PDOj}$  pin to the high level when the TimerCounter is stopped

CLR (TCjCR).3: Stops the timer.

CLR (TCjCR).7: Sets the  $\overline{PDOj}$  pin to the high level.

Note 3: j = 5, 6

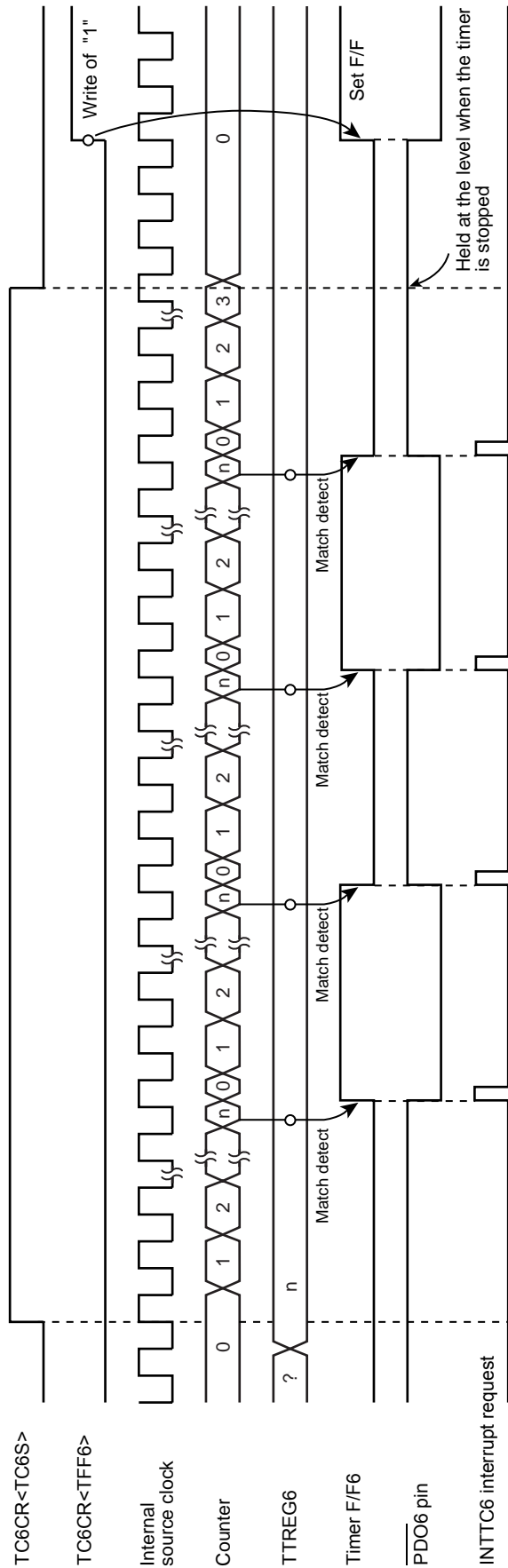


Figure 10-4 8-Bit PDO Mode Timing Chart (TC6)



### 10.3.4 8-Bit Pulse Width Modulation (PWM) Output Mode (TC5, 6)

This mode is used to generate a pulse-width modulated (PWM) signals with up to 8 bits of resolution. The up-counter counts up using the internal clock.

When a match between the up-counter and the PWREGj value is detected, the logic level output from the timer F/Fj is switched to the opposite state. The counter continues counting. The logic level output from the timer F/Fj is switched to the opposite state again by the up-counter overflow, and the counter is cleared. The INTTCj interrupt request is generated at this time.

Since the initial value can be set to the timer F/Fj by TCjCR<TFFj>, positive and negative pulses can be generated. Upon reset, the timer F/Fj is cleared to 0.

(The logic level output from the  $\overline{\text{PWMj}}$  pin is the opposite to the timer F/Fj logic level.)

Since PWREGj in the PWM mode is serially connected to the shift register, the value set to PWREGj can be changed while the timer is running. The value set to PWREGj during a run of the timer is shifted by the INTTCj interrupt request and loaded into PWREGj. While the timer is stopped, the value is shifted immediately after the programming of PWREGj. If executing the read instruction to PWREGj during PWM output, the value in the shift register is read, but not the value set in PWREGj. Therefore, after writing to PWREGj, the reading data of PWREGj is previous value until INTTCj is generated.

For the pin used for PWM output, the output latch of the I/O port must be set to 1.

Note 1: In the PWM mode, program the timer register PWREGj immediately after the INTTCj interrupt request is generated (normally in the INTTCj interrupt service routine.) If the programming of PWREGj and the interrupt request occur at the same time, an unstable value is shifted, that may result in generation of the pulse different from the programmed value until the next INTTCj interrupt request is generated.

Note 2: When the timer is stopped during PWM output, the  $\overline{\text{PWMj}}$  pin holds the output status when the timer is stopped. To change the output status, program TCjCR<TFFj> after the timer is stopped. Do not change the TCjCR<TFFj> upon stopping of the timer.

Example: Fixing the  $\overline{\text{PWMj}}$  pin to the high level when the TimerCounter is stopped

CLR (TCjCR).3: Stops the timer.

CLR (TCjCR).7: Sets the  $\overline{\text{PWMj}}$  pin to the high level.

Note 3: To enter the STOP mode during PWM output, stop the timer and then enter the STOP mode. If the STOP mode is entered without stopping the timer when fc, fc/2 or fs is selected as the source clock, a pulse is output from the  $\overline{\text{PWMj}}$  pin during the warm-up period time after exiting the STOP mode.

Note 4: j = 5, 6

Table 10-5 PWM Output Mode

Source Clock			Resolution		Repeated Cycle	
NORMAL1/2, IDLE1/2 mode		SLOW1/2, SLEEP1/2 mode	fc = 16 MHz	fs = 32.768 kHz	fc = 16 MHz	fs = 32.768 kHz
DV7CK = 0	DV7CK = 1					
$fc/2^{11}$ [Hz]	$fs/2^3$ [Hz]	$fs/2^3$ [Hz]	128 $\mu$ s	244.14 $\mu$ s	32.8 ms	62.5 ms
$fc/2^7$	$fc/2^7$	—	8 $\mu$ s	—	2.05 ms	—
$fc/2^5$	$fc/2^5$	—	2 $\mu$ s	—	512 $\mu$ s	—
$fc/2^3$	$fc/2^3$	—	500 ns	—	128 $\mu$ s	—
fs	fs	fs	30.5 $\mu$ s	30.5 $\mu$ s	7.81 ms	7.81 ms
fc/2	fc/2	—	125 ns	—	32 $\mu$ s	—
fc	fc	—	62.5 ns	—	16 $\mu$ s	—

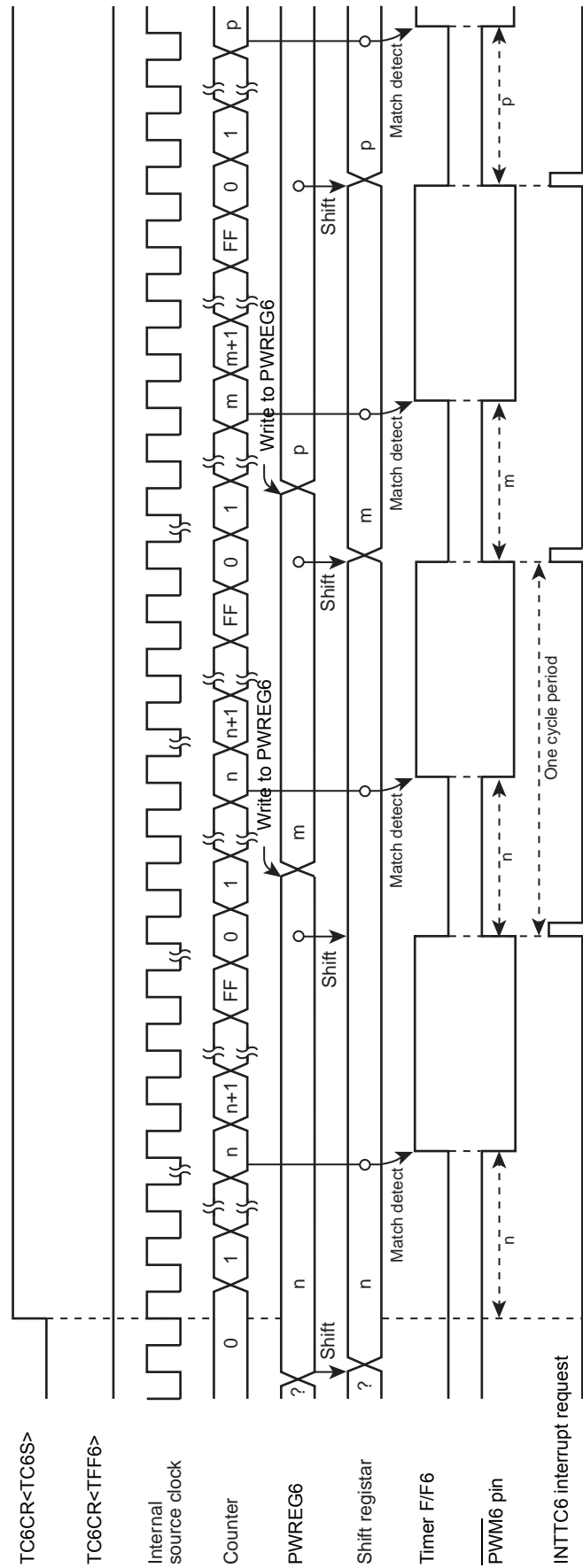


Figure 10-5 8-Bit PWM Mode Timing Chart (TC6)

10.3.5 16-Bit Timer Mode (TC5 and 6)

In the timer mode, the up-counter counts up using the internal clock. The TimerCounter 5 and 6 are cascadable to form a 16-bit timer.

When a match between the up-counter and the timer register (TTREG5, TTREG6) value is detected after the timer is started by setting TC6CR<TC6S> to 1, an INTTC6 interrupt is generated and the up-counter is cleared. After being cleared, the up-counter continues counting. Program the lower byte and upper byte in this order in the timer register. (Programming only the upper or lower byte should not be attempted.)

- Note 1: In the timer mode, fix TCjCR<TFFj> to 0. If not fixed, the  $\overline{PDOj}$ ,  $\overline{PWMj}$ , and  $\overline{PPGj}$  pins may output a pulse.
- Note 2: In the timer mode, do not change the TTREGj setting while the timer is running. Since TTREGj is not in the shift register configuration in the timer mode, the new value programmed in TTREGj is in effect immediately after programming of TTREGj. Therefore, if TTREGj is changed while the timer is running, an expected operation may not be obtained.
- Note 3: j = 5, 6

Table 10-6 Source Clock for 16-Bit Timer Mode

Source Clock			Resolution		Maximum Time Setting	
NORMAL1/2, IDLE1/2 mode		SLOW1/2, SLEEP1/2 mode	fc = 16 MHz	fs = 32.768 kHz	fc = 16 MHz	fs = 32.768 kHz
DV7CK = 0	DV7CK = 1					
fc/2 <sup>11</sup>	fs/2 <sup>3</sup>	fs/2 <sup>3</sup>	128 μs	244.14 μs	8.39 s	16 s
fc/2 <sup>7</sup>	fc/2 <sup>7</sup>	—	8 μs	—	524.3 ms	—
fc/2 <sup>5</sup>	fc/2 <sup>5</sup>	—	2 μs	—	131.1 ms	—
fc/2 <sup>3</sup>	fc/2 <sup>3</sup>	—	500 ns	—	32.8 ms	—

Example :Setting the timer mode with source clock fc/2<sup>7</sup> Hz, and generating an interrupt 300 ms later  
(fc = 16.0 MHz)

- LDW      (TTREG5), 927CH      : Sets the timer register (300 ms÷2<sup>7</sup>/fc = 927CH).
- DI
- SET      (EIRD). 0      : Enables INTTC6 interrupt.
- EI
- LD      (TC5CR), 13H      :Sets the operating clock to fc/2<sup>7</sup>, and 16-bit timer mode (lower byte).
- LD      (TC6CR), 04H      : Sets the 16-bit timer mode (upper byte).
- LD      (TC6CR), 0CH      : Starts the timer.

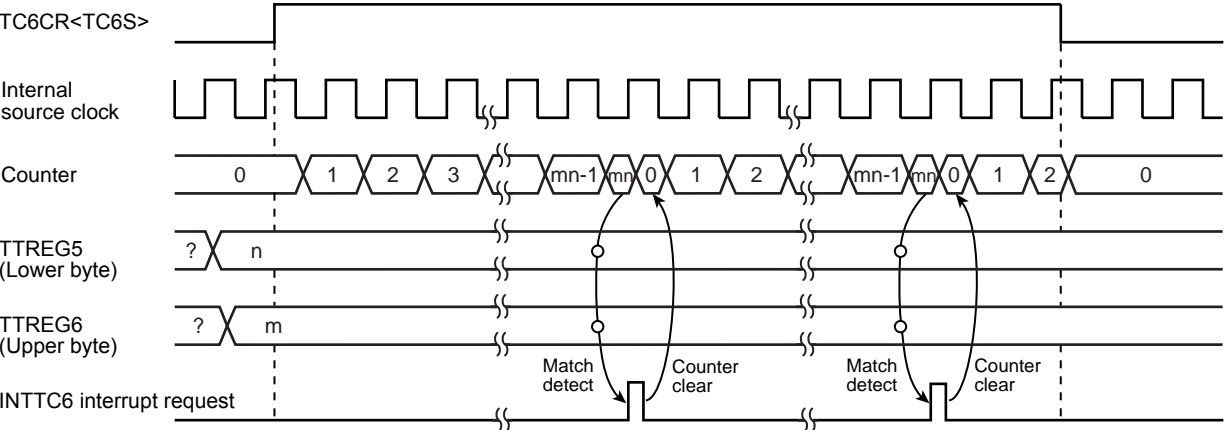


Figure 10-6 16-Bit Timer Mode Timing Chart (TC5 and TC6)

### 10.3.6 16-Bit Event Counter Mode (TC5 and 6)

In the event counter mode, the up-counter counts up at the falling edge to the TC5 pin. The TimerCounter 5 and 6 are cascadable to form a 16-bit event counter.

When a match between the up-counter and the timer register (TTREG5, TTREG6) value is detected after the timer is started by setting TC6CR<TC6S> to 1, an INTTC6 interrupt is generated and the up-counter is cleared.

After being cleared, the up-counter restarts counting at the falling edge of the input pulse to the TC5 pin. Two machine cycles are required for the low- or high-level pulse input to the TC5 pin.

Therefore, a maximum frequency to be supplied is  $f_c/2^4$  Hz in the NORMAL1/2 or IDLE1/2 mode, and  $f_s/2^4$  in the SLOW1/2 or SLEEP1/2 mode. Program the lower byte (TTREG5), and upper byte (TTREG6) in this order in the timer register. (Programming only the upper or lower byte should not be attempted.)

Note 1: In the event counter mode, fix TCjCR<TFFj> to 0. If not fixed, the  $\overline{PDOj}$ ,  $\overline{PWMj}$  and  $\overline{PPGj}$  pins may output pulses.

Note 2: In the event counter mode, do not change the TTREGj setting while the timer is running. Since TTREGj is not in the shift register configuration in the event counter mode, the new value programmed in TTREGj is in effect immediately after the programming. Therefore, if TTREGj is changed while the timer is running, an expected operation may not be obtained.

Note 3: j = 5, 6

### 10.3.7 16-Bit Pulse Width Modulation (PWM) Output Mode (TC5 and 6)

This mode is used to generate a pulse-width modulated (PWM) signals with up to 16 bits of resolution. The TimerCounter 5 and 6 are cascadable to form the 16-bit PWM signal generator.

The counter counts up using the internal clock or external clock.

When a match between the up-counter and the timer register (PWREG5, PWREG6) value is detected, the logic level output from the timer F/F6 is switched to the opposite state. The counter continues counting. The logic level output from the timer F/F6 is switched to the opposite state again by the counter overflow, and the counter is cleared. The INTTC6 interrupt is generated at this time.

Two machine cycles are required for the high- or low-level pulse input to the TC5 pin. Therefore, a maximum frequency to be supplied is  $f_c/2^4$  Hz in the NORMAL1/2 or IDLE1/2 mode, and  $f_s/2^4$  to in the SLOW1/2 or SLEEP1/2 mode.

Since the initial value can be set to the timer F/F6 by TC6CR<TFF6>, positive and negative pulses can be generated. Upon reset, the timer F/F6 is cleared to 0.

(The logic level output from the  $\overline{PWM6}$  pin is the opposite to the timer F/F6 logic level.)

Since PWREG6 and 5 in the PWM mode are serially connected to the shift register, the values set to PWREG6 and 5 can be changed while the timer is running. The values set to PWREG6 and 5 during a run of the timer are shifted by the INTTCj interrupt request and loaded into PWREG6 and 5. While the timer is stopped, the values are shifted immediately after the programming of PWREG6 and 5. Set the lower byte (PWREG5) and upper byte (PWREG6) in this order to program PWREG6 and 5. (Programming only the lower or upper byte of the register should not be attempted.)

If executing the read instruction to PWREG6 and 5 during PWM output, the values set in the shift register is read, but not the values set in PWREG6 and 5. Therefore, after writing to the PWREG6 and 5, reading data of PWREG6 and 5 is previous value until INTTC6 is generated.

For the pin used for PWM output, the output latch of the I/O port must be set to 1.

Note 1: In the PWM mode, program the timer register PWREG6 and 5 immediately after the INTTC6 interrupt request is generated (normally in the INTTC6 interrupt service routine.) If the programming of PWREGj and the interrupt request occur at the same time, an unstable value is shifted, that may result in generation of pulse different from the programmed value until the next INTTC6 interrupt request is generated.

Note 2: When the timer is stopped during PWM output, the  $\overline{PWM6}$  pin holds the output status when the timer is stopped. To change the output status, program TC6CR<TFF6> after the timer is stopped. Do not program TC6CR<TFF6> upon stopping of the timer.

Example: Fixing the  $\overline{PWM6}$  pin to the high level when the TimerCounter is stopped

CLR (TC6CR).3: Stops the timer.

CLR (TC6CR).7 : Sets the  $\overline{\text{PWM6}}$  pin to the high level.

Note 3: To enter the STOP mode, stop the timer and then enter the STOP mode. If the STOP mode is entered without stopping of the timer when  $f_c$ ,  $f_c/2$  or  $f_s$  is selected as the source clock, a pulse is output from the  $\overline{\text{PWM6}}$  pin during the warm-up period time after exiting the STOP mode.

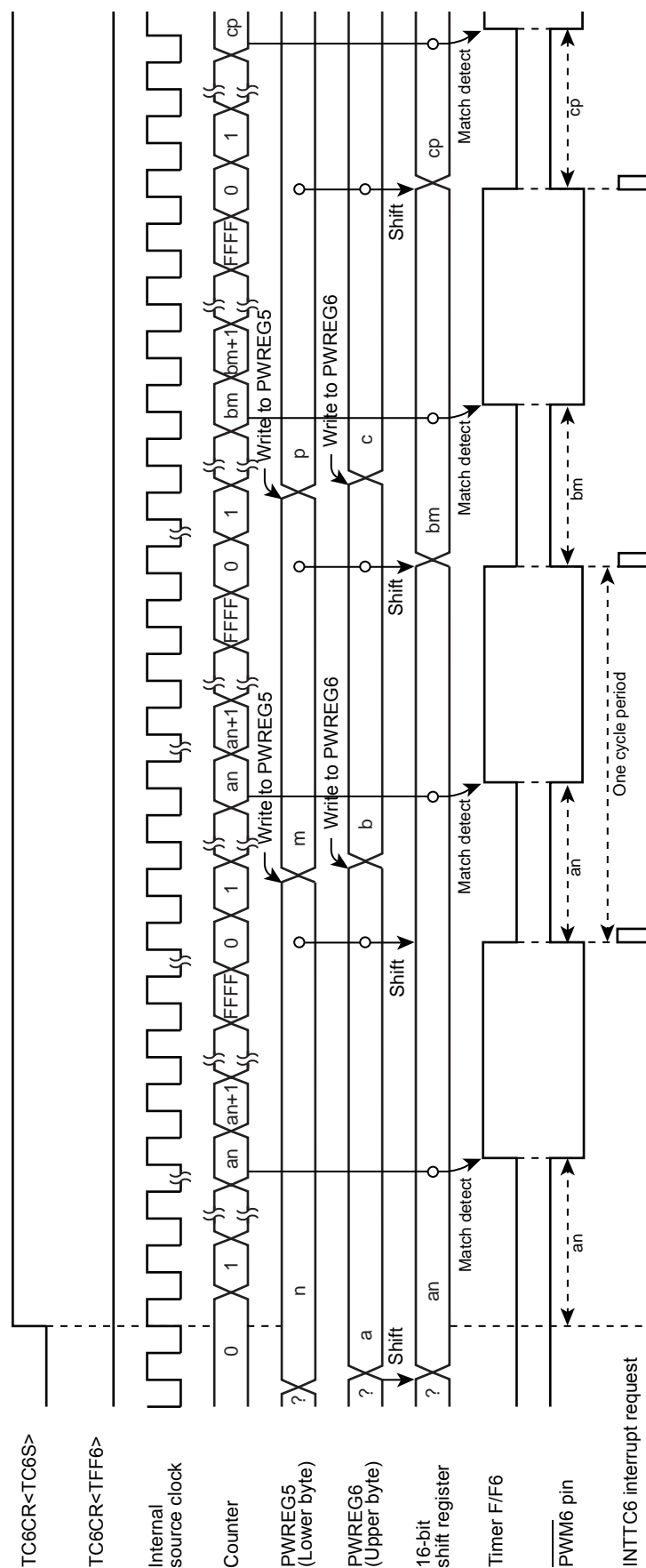
Table 10-7 16-Bit PWM Output Mode

Source Clock			Resolution		Repeated Cycle	
NORMAL1/2, IDLE1/2 mode		SLOW1/2, SLEEP1/2 mode	$f_c = 16 \text{ MHz}$	$f_s = 32.768 \text{ kHz}$	$f_c = 16 \text{ MHz}$	$f_s = 32.768 \text{ kHz}$
DV7CK = 0	DV7CK = 1					
$f_c/2^{11}$	$f_s/2^3 \text{ [Hz]}$	$f_s/2^3 \text{ [Hz]}$	128 $\mu\text{s}$	244.14 $\mu\text{s}$	8.39 s	16 s
$f_c/2^7$	$f_c/2^7$	—	8 $\mu\text{s}$	—	524.3 ms	—
$f_c/2^5$	$f_c/2^5$	—	2 $\mu\text{s}$	—	131.1 ms	—
$f_c/2^3$	$f_c/2^3$	—	500 ns	—	32.8 ms	—
$f_s$	$f_s$	$f_s$	30.5 $\mu\text{s}$	30.5 $\mu\text{s}$	2 s	2 s
$f_c/2$	$f_c/2$	—	125 ns	—	8.2 ms	—
$f_c$	$f_c$	—	62.5 ns	—	4.1 ms	—

Example :Generating a pulse with 1-ms high-level width and a period of 32.768 ms ( $f_c = 16.0 \text{ MHz}$ )

Setting ports

LDW	(PWREG5), 07D0H	: Sets the pulse width.
LD	(TC5CR), 33H	: Sets the operating clock to $f_c/2^3$ , and 16-bit PWM output mode (lower byte).
LD	(TC6CR), 056H	: Sets TFF6 to the initial value 0, and 16-bit PWM signal generation mode (upper byte).
LD	(TC6CR), 05EH	: Starts the timer.



### 10.3.8 16-Bit Programmable Pulse Generate (PPG) Output Mode (TC5 and 6)

This mode is used to generate pulses with up to 16-bits of resolution. The timer counter 5 and 6 are cascaded to enter the 16-bit PPG mode.

The counter counts up using the internal clock or external clock. When a match between the up-counter and the timer register (PWREG5, PWREG6) value is detected, the logic level output from the timer F/F6 is switched to the opposite state. The counter continues counting. The logic level output from the timer F/F6 is switched to the opposite state again when a match between the up-counter and the timer register (TTREG5, TTREG6) value is detected, and the counter is cleared. The INTTC6 interrupt is generated at this time.

Two machine cycles are required for the high- or low-level pulse input to the TC5 pin. Therefore, a maximum frequency to be supplied is  $f_c/2^4$  Hz in the NORMAL1/2 or IDLE1/2 mode, and  $f_s/2^4$  to in the SLOW1/2 or SLEEP1/2 mode.

Since the initial value can be set to the timer F/F6 by TC6CR<TFF6>, positive and negative pulses can be generated. Upon reset, the timer F/F6 is cleared to 0.

(The logic level output from the  $\overline{\text{PPG6}}$  pin is the opposite to the timer F/F6.)

Set the lower byte and upper byte in this order to program the timer register. (TTREG5 → TTREG6, PWREG5 → PWREG6) (Programming only the upper or lower byte should not be attempted.)

For PPG output, set the output latch of the I/O port to 1.

Example :Generating a pulse with 1-ms high-level width and a period of 16.385 ms ( $f_c = 16.0$  MHz)

Setting ports		
LDW	(PWREG5), 07D0H	: Sets the pulse width.
LDW	(TTREG5), 8002H	: Sets the cycle period.
LD	(TC5CR), 33H	: Sets the operating clock to $f_c/2^3$ , and 16-bit PPG mode (lower byte).
LD	(TC6CR), 057H	: Sets TFF6 to the initial value 0, and 16-bit PPG mode (upper byte).
LD	(TC6CR), 05FH	: Starts the timer.

Note 1: In the PPG mode, do not change the PWREGi and TTREGi settings while the timer is running. Since PWREGi and TTREGi are not in the shift register configuration in the PPG mode, the new values programmed in PWREGi and TTREGi are in effect immediately after programming PWREGi and TTREGi. Therefore, if PWREGi and TTREGi are changed while the timer is running, an expected operation may not be obtained.

Note 2: When the timer is stopped during PPG output, the  $\overline{\text{PPG6}}$  pin holds the output status when the timer is stopped. To change the output status, program TC6CR<TFF6> after the timer is stopped. Do not change TC6CR<TFF6> upon stopping of the timer.

Example: Fixing the  $\overline{\text{PPG6}}$  pin to the high level when the TimerCounter is stopped

CLR (TC6CR).3: Stops the timer

CLR (TC6CR).7: Sets the  $\overline{\text{PPG6}}$  pin to the high level

Note 3: i = 5, 6

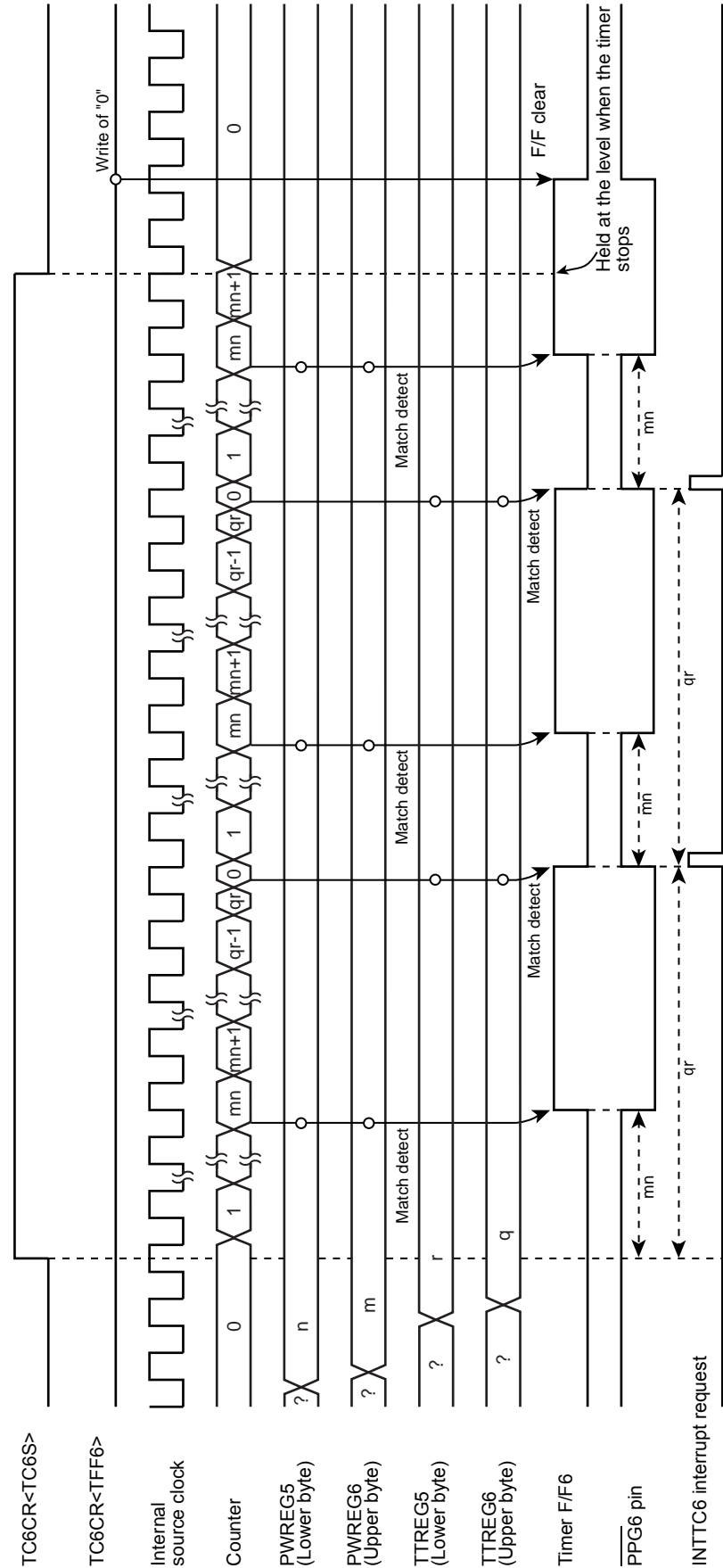


Figure 10-8 16-Bit PPG Mode Timing Chart (TC5 and TC6)



### 10.3.9 Warm-Up Counter Mode

In this mode, the warm-up period time is obtained to assure oscillation stability when the system clocking is switched between the high-frequency and low-frequency. The timer counter 5 and 6 are cascadable to form a 16-bit TimerCounter. The warm-up counter mode has two types of mode; switching from the high-frequency to low-frequency, and vice-versa.

Note 1: In the warm-up counter mode, fix TCiCR<TFFi> to 0. If not fixed, the  $\overline{PD\bar{O}i}$ ,  $\overline{PWMi}$  and  $\overline{PPGi}$  pins may output pulses.

Note 2: In the warm-up counter mode, only upper 8 bits of the timer register TTREG6 and 5 are used for match detection and lower 8 bits are not used.

Note 3: i = 5, 6

#### 10.3.9.1 Low-Frequency Warm-up Counter Mode (NORMAL1 → NORMAL2 → SLOW2 → SLOW1)

In this mode, the warm-up period time from a stop of the low-frequency clock fs to oscillation stability is obtained. Before starting the timer, set SYSCR2<XTEN> to 1 to oscillate the low-frequency clock. When a match between the up-counter and the timer register (TTREG6, 5) value is detected after the timer is started by setting TC6CR<TC6S> to 1, the counter is cleared by generating the INTTC6 interrupt request. After stopping the timer in the INTTC6 interrupt service routine, set SYSCR2<SYSCK> to 1 to switch the system clock from the high-frequency to low-frequency, and then clear of SYSCR2<XEN> to 0 to stop the high-frequency clock.

Table 10-8 Setting Time of Low-Frequency Warm-Up Counter Mode (fs = 32.768 kHz)

Minimum Time Setting (TTREG6, 5 = 0100H)	Maximum Time Setting (TTREG6, 5 = FF00H)
7.81 ms	1.99 s

Example :After checking low-frequency clock oscillation stability with TC6 and 5, switching to the SLOW1 mode

	SET	(SYSCR2).6	: SYSCR2<XTEN> ← 1
	LD	(TC5CR), 43H	: Sets TFF5=0, source clock fs, and 16-bit mode.
	LD	(TC6CR), 05H	: Sets TFF6=0, and warm-up counter mode.
	LD	(TTREG5), 8000H	: Sets the warm-up time. (The warm-up time depends on the oscillator characteristic.)
	DI		: IMF ← 0
	SET	(EIRD). 0	: Enables the INTTC6.
	EI		: IMF ← 1
	SET	(TC6CR).3	: Starts TC6 and 5.
	:	:	
PINTTC6:	CLR	(TC6CR).3	: Stops TC6 and 5.
	SET	(SYSCR2).5	: SYSCR2<SYSCK> ← 1 (Switches the system clock to the low-frequency clock.)
	CLR	(SYSCR2).7	: SYSCR2<XEN> ← 0 (Stops the high-frequency clock.)
	RETI		
	:	:	
VINTTC6:	DW	PINTTC6	: INTTC6 vector table

10.3.9.2 High-Frequency Warm-Up Counter Mode  
(SLOW1 → SLOW2 → NORMAL2 → NORMAL1)

In this mode, the warm-up period time from a stop of the high-frequency clock *fc* to the oscillation stability is obtained. Before starting the timer, set SYSCR2<XEN> to 1 to oscillate the high-frequency clock. When a match between the up-counter and the timer register (TTREG6, 5) value is detected after the timer is started by setting TC6CR<TC6S> to 1, the counter is cleared by generating the INTTC6 interrupt request. After stopping the timer in the INTTC6 interrupt service routine, clear SYSCR2<SYSCK> to 0 to switch the system clock from the low-frequency to high-frequency, and then SYSCR2<XTEN> to 0 to stop the low-frequency clock.

Table 10-9 Setting Time in High-Frequency Warm-Up Counter Mode

Minimum time Setting (TTREG6, 5 = 0100H)	Maximum time Setting (TTREG6, 5 = FF00H)
16 μs	4.08 ms

Example :After checking high-frequency clock oscillation stability with TC6 and 5, switching to the NORMAL1 mode

	SET	(SYSCR2).7	: SYSCR2<XEN> ← 1
	LD	(TC5CR), 63H	: Sets TFF5=0, source clock <i>fc</i> , and 16-bit mode.
	LD	(TC6CR), 05H	: Sets TFF6=0, and warm-up counter mode.
	LD	(TTREG5), 0F800H	: Sets the warm-up time. (The warm-up time depends on the oscillator characteristic.)
	DI		: IMF ← 0
	SET	(EIRD). 0	: Enables the INTTC6.
	EI		: IMF ← 1
	SET	(TC6CR).3	: Starts the TC6 and 5.
	:	:	
PINTTC6:	CLR	(TC6CR).3	: Stops the TC6 and 5.
	CLR	(SYSCR2).5	: SYSCR2<SYSCK> ← 0 (Switches the system clock to the high-frequency clock.)
	CLR	(SYSCR2).6	: SYSCR2<XTEN> ← 0 (Stops the low-frequency clock.)
	RETI		
	:	:	
VINTTC6:	DW	PINTTC6	: INTTC6 vector table

## 11. Synchronous Serial Interface (SIO)

The TMP86FS28DFG has a clocked-synchronous 8-bit serial interface. Serial interface has an 8-byte transmit and receive data buffer that can automatically and continuously transfer up to 64 bits of data.

Serial interface is connected to outside peripheral devices via SO, SI, SCK port.

### 11.1 Configuration

SIO control / status register

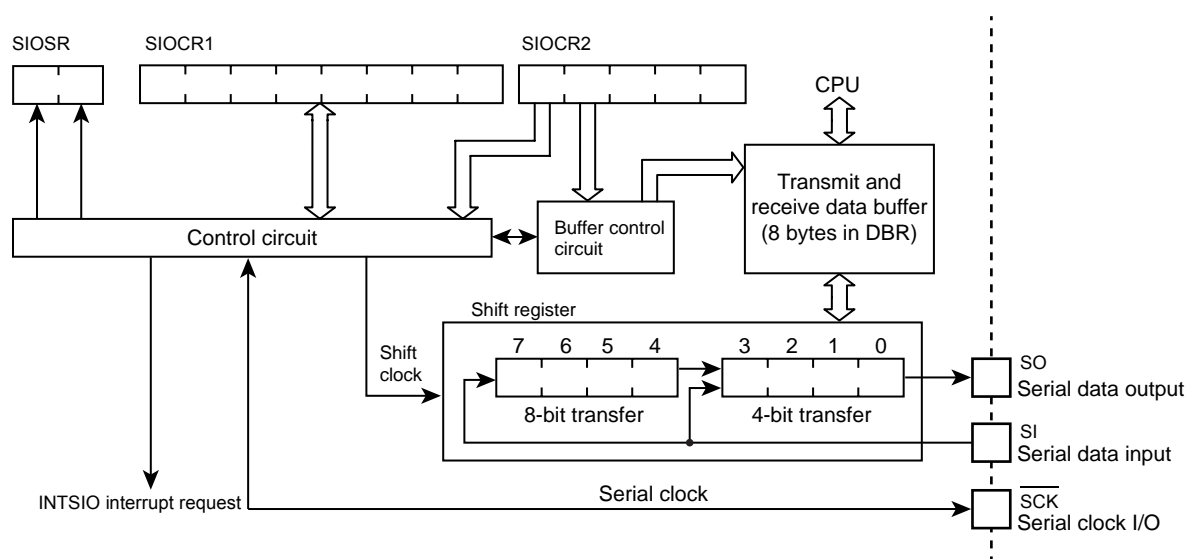


Figure 11-1 Serial Interface

11.2 Control

The serial interface is controlled by SIO control registers (SIOCR1/SIOCR2). The serial interface status can be determined by reading SIO status register (SIOSR).

The transmit and receive data buffer is controlled by the SIOCR2<BUF>. The data buffer is assigned to address 0F60H to 0F67H for SIO in the DBR area, and can continuously transfer up to 8 words (bytes or nibbles) at one time. When the specified number of words has been transferred, a buffer empty (in the transmit mode) or a buffer full (in the receive mode or transmit/receive mode) interrupt (INTSIO) is generated.

When the internal clock is used as the serial clock in the 8-bit receive mode and the 8-bit transmit/receive mode, a fixed interval wait can be applied to the serial clock for each word transferred. Four different wait times can be selected with SIOCR2<WAIT>.

SIO Control Register 1

SIOCR1	7	6	5	4	3	2	1	0	
(0F68H)	SIOS	SIOINH	SIOM			SCK			(Initial value: 0000 0000)

SIOS	Indicate transfer start / stop	0: Stop 1: Start			Write only	
SIOINH	Continue / abort transfer	0: Continuously transfer 1: Abort transfer (Automatically cleared after abort)				
SIOM	Transfer mode select	000: 8-bit transmit mode 010: 4-bit transmit mode 100: 8-bit transmit / receive mode 101: 8-bit receive mode 110: 4-bit receive mode Except the above: Reserved				
SCK	Serial clock select		NORMAL1/2, IDLE1/2 mode		SLOW1/2 SLEEP1/2 mode	Write only
			DV7CK = 0	DV7CK = 1		
		000	$fc/2^{13}$	$fs/2^5$	$fs/2^5$	
		001	$fc/2^8$	$fc/2^8$	-	
		010	$fc/2^7$	$fc/2^7$	-	
		011	$fc/2^6$	$fc/2^6$	-	
		100	$fc/2^5$	$fc/2^5$	-	
		101	$fc/2^4$	$fc/2^4$	-	
		110	Reserved			
111	External clock ( Input from SCK pin )					

- Note 1: fc; High-frequency clock [Hz], fs; Low-frequency clock [Hz]  
Note 2: Set SIOS to "0" and SIOINH to "1" when setting the transfer mode or serial clock.  
Note 3: SIOCR1 is write-only register, which cannot access any of in read-modify-write instruction such as bit operate, etc.

SIO Control Register 2

SIOCR2	7	6	5	4	3	2	1	0	
(0F69H)				WAIT		BUF			(Initial value: ***0 0000)

WAIT	Wait control	Always sets "00" except 8-bit transmit / receive mode. 00: $T_f = T_D$ (Non wait) 01: $T_f = 2T_D$ (Wait) 10: $T_f = 4T_D$ (Wait) 11: $T_f = 8T_D$ (Wait)	Write only
BUF	Number of transfer words (Buffer address in use)	000: 1 word transfer 0F60H 001: 2 words transfer 0F60H ~ 0F61H 010: 3 words transfer 0F60H ~ 0F62H 011: 4 words transfer 0F60H ~ 0F63H 100: 5 words transfer 0F60H ~ 0F64H 101: 6 words transfer 0F60H ~ 0F65H 110: 7 words transfer 0F60H ~ 0F66 H 111: 8 words transfer 0F60H ~ 0F67H	

- Note 1: The lower 4 bits of each buffer are used during 4-bit transfers. Zeros (0) are stored to the upper 4bits when receiving.
- Note 2: Transmitting starts at the lowest address. Received data are also stored starting from the lowest address to the highest address. ( The first buffer address transmitted is 0F60H ).
- Note 3: The value to be loaded to BUF is held after transfer is completed.
- Note 4: SIOCR2 must be set when the serial interface is stopped (SIOF = 0).
- Note 5: \*: Don't care
- Note 6: SIOCR2 is write-only register, which cannot access any of in read-modify-write instruction such as bit operate, etc.

SIO Status Register

SIOSR	7	6	5	4	3	2	1	0
(0F69H)	SIOF	SEF						

SIOF	Serial transfer operating status monitor	0: Transfer terminated 1: Transfer in process	Read only
SEF	Shift operating status monitor	0: Shift operation terminated 1: Shift operation in process	

- Note 1:  $T_f$ : Frame time,  $T_D$ : Data transfer time
- Note 2: After SIOS is cleared to "0", SIOF is cleared to "0" at the termination of transfer or the setting of SIOINH to "1".

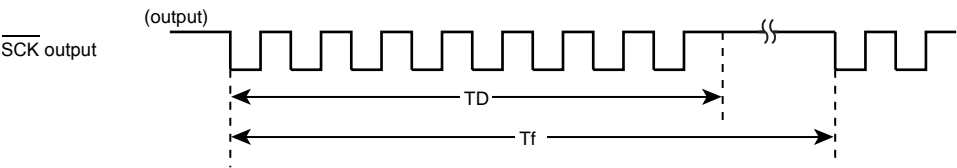


Figure 11-2 Frame time ( $T_f$ ) and Data transfer time ( $T_D$ )

11.3 Serial clock

11.3.1 Clock source

Internal clock or external clock for the source clock is selected by SIOCR1<SCK>.

11.3.1.1 Internal clock

Any of six frequencies can be selected. The serial clock is output to the outside on the SCK pin. The SCK pin goes high when transfer starts.

When data writing (in the transmit mode) or reading (in the receive mode or the transmit/receive mode) cannot keep up with the serial clock rate, there is a wait function that automatically stops the serial clock and holds the next shift operation until the read/write processing is completed.

Table 11-1 Serial Clock Rate

	NORMAL 1/2, IDLE1/2 mode				SLOW1/2, SLEEP1/2 mode	
	DV7CK = 0		DV7CK = 1			
SCK	Clock	Baud Rate	Clock	Baud Rate	Clock	Baud Rate
000	$f_c/2^{13}$	1.91 Kbps	$f_s/2^5$	1024 bps	$f_s/2^5$	1024 bps
001	$f_c/2^8$	61.04 Kbps	$f_c/2^8$	61.04 Kbps	-	-
010	$f_c/2^7$	122.07 Kbps	$f_c/2^7$	122.07 Kbps	-	-
011	$f_c/2^6$	244.14 Kbps	$f_c/2^6$	244.14 Kbps	-	-
100	$f_c/2^5$	488.28 Kbps	$f_c/2^5$	488.28 Kbps	-	-
101	$f_c/2^4$	976.56 Kbps	$f_c/2^4$	976.56 Kbps	-	-
110	-	-	-	-	-	-
111	External	External	External	External	External	External

Note: 1 Kbit = 1024 bit ( $f_c$  = 16 MHz,  $f_s$  = 32.768 kHz)

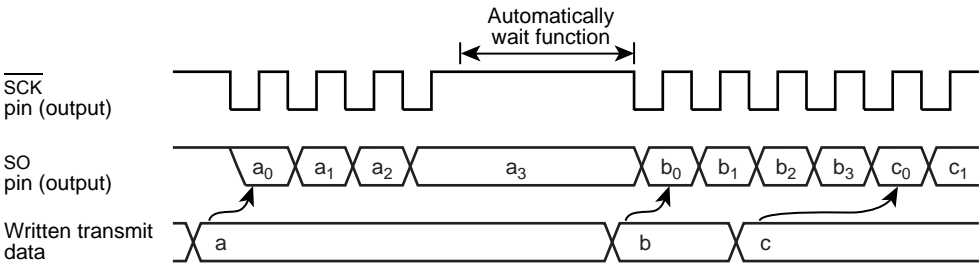


Figure 11-3 Automatic Wait Function (at 4-bit transmit mode)

11.3.1.2 External clock

An external clock connected to the SCK pin is used as the serial clock. In this case, output latch of this port should be set to "1". To ensure shifting, a pulse width of at least 4 machine cycles is required. This pulse is needed for the shift operation to execute certainly. Actually, there is necessary processing time for interrupting, writing, and reading. The minimum pulse is determined by setting the mode and the program. Therefore, maximum transfer frequency will be 488.3K bit/sec (at  $f_c$ =16MHz).

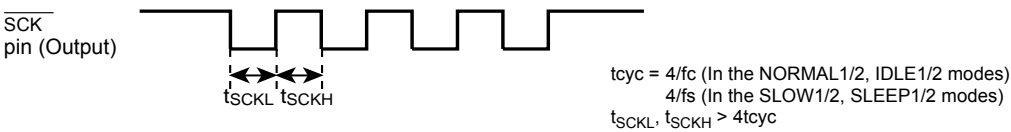


Figure 11-4 External clock pulse width

### 11.3.2 Shift edge

The leading edge is used to transmit, and the trailing edge is used to receive.

#### 11.3.2.1 Leading edge

Transmitted data are shifted on the leading edge of the serial clock (falling edge of the  $\overline{\text{SCK}}$  pin input/output).

#### 11.3.2.2 Trailing edge

Received data are shifted on the trailing edge of the serial clock (rising edge of the  $\overline{\text{SCK}}$  pin input/output).

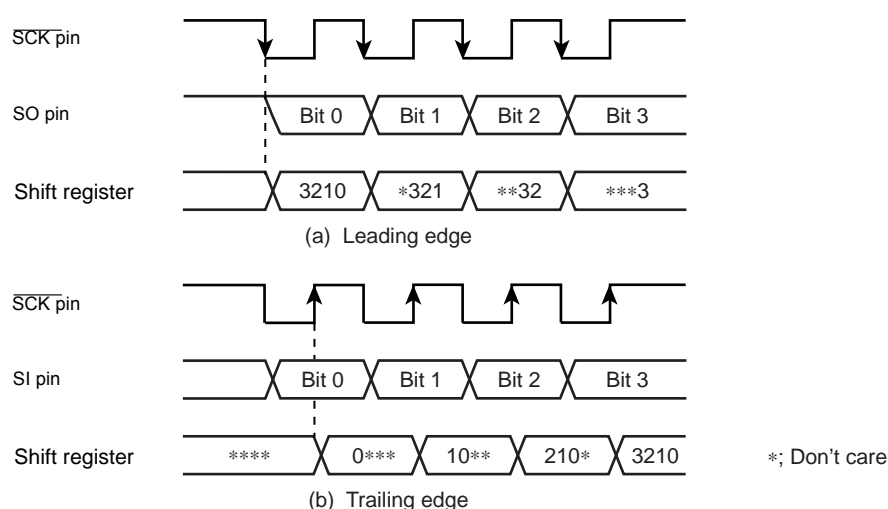


Figure 11-5 Shift edge

## 11.4 Number of bits to transfer

Either 4-bit or 8-bit serial transfer can be selected. When 4-bit serial transfer is selected, only the lower 4 bits of the transmit/receive data buffer register are used. The upper 4 bits are cleared to “0” when receiving. The data is transferred in sequence starting at the least significant bit (LSB).

## 11.5 Number of words to transfer

Up to 8 words consisting of 4 bits of data (4-bit serial transfer) or 8 bits (8-bit serial transfer) of data can be transferred continuously. The number of words to be transferred can be selected by  $\text{SIOCR2} \langle \text{BUF} \rangle$ .

An INTSIO interrupt is generated when the specified number of words has been transferred. If the number of words is to be changed during transfer, the serial interface must be stopped before making the change. The number of words can be changed during automatic-wait operation of an internal clock. In this case, the serial interface is not required to be stopped.

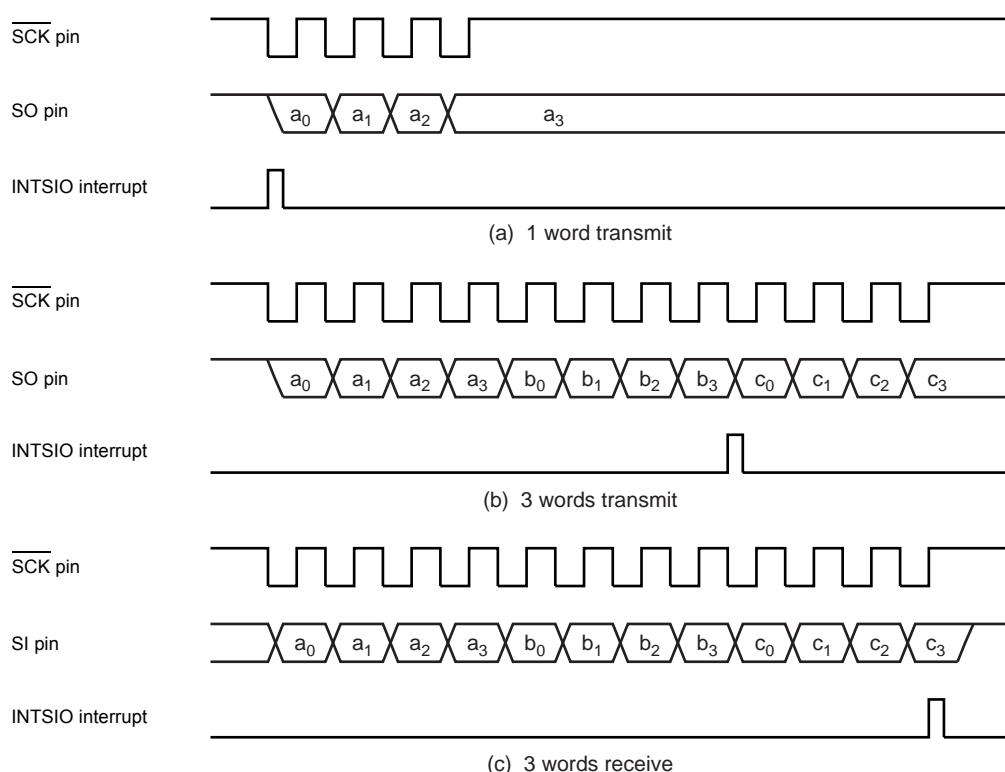


Figure 11-6 Number of words to transfer (Example: 1word = 4bit)

## 11.6 Transfer Mode

SIOCR1<SIOM> is used to select the transmit, receive, or transmit/receive mode.

### 11.6.1 4-bit and 8-bit transfer modes

In these modes, firstly set the SIO control register to the transmit mode, and then write first transmit data (number of transfer words to be transferred) to the data buffer registers (DBR).

After the data are written, the transmission is started by setting SIOCR1<SIOS> to “1”. The data are then output sequentially to the SO pin in synchronous with the serial clock, starting with the least significant bit (LSB). As soon as the LSB has been output, the data are transferred from the data buffer register to the shift register. When the final data bit has been transferred and the data buffer register is empty, an INTSIO (Buffer empty) interrupt is generated to request the next transmitted data.

When the internal clock is used, the serial clock will stop and an automatic-wait will be initiated if the next transmitted data are not loaded to the data buffer register by the time the number of data words specified with the SIOCR2<BUF> has been transmitted. Writing even one word of data cancels the automatic-wait; therefore, when transmitting two or more words, always write the next word before transmission of the previous word is completed.

**Note:** Automatic waits are also canceled by writing to a DBR not being used as a transmit data buffer register; therefore, during SIO do not use such DBR for other applications. For example, when 3 words are transmitted, do not use the DBR of the remained 5 words.

When an external clock is used, the data must be written to the data buffer register before shifting next data. Thus, the transfer speed is determined by the maximum delay time from the generation of the interrupt request to writing of the data to the data buffer register by the interrupt service program.

The transmission is ended by clearing SIOCR1<SIOS> to “0” or setting SIOCR1<SIOINH> to “1” in buffer empty interrupt service program.



SIOCR1<SIOS> is cleared, the operation will end after all bits of words are transmitted.

That the transmission has ended can be determined from the status of SIOSR<SIOF> because SIOSR<SIOF> is cleared to “0” when a transfer is completed.

When SIOCR1<SIOINH> is set, the transmission is immediately ended and SIOSR<SIOF> is cleared to “0”.

When an external clock is used, it is also necessary to clear SIOCR1<SIOS> to “0” before shifting the next data; If SIOCR1<SIOS> is not cleared before shift out, dummy data will be transmitted and the operation will end.

If it is necessary to change the number of words, SIOCR1<SIOS> should be cleared to “0”, then SIOCR2<BUF> must be rewritten after confirming that SIOSR<SIOF> has been cleared to “0”.

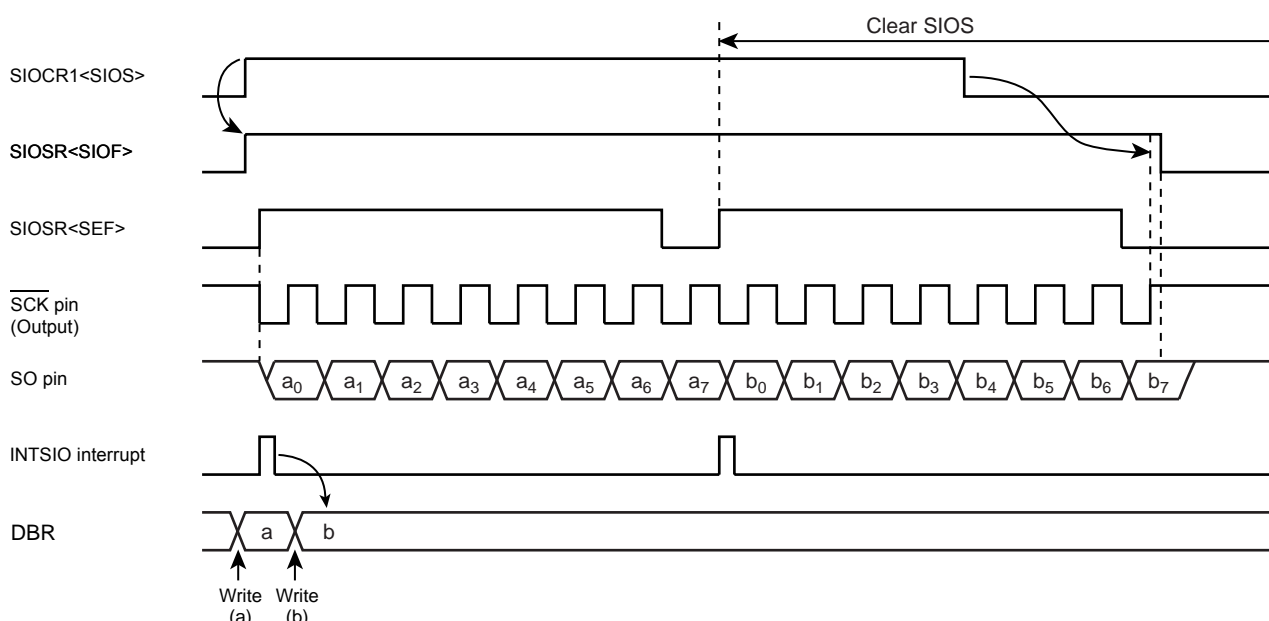


Figure 11-7 Transfer Mode (Example: 8bit, 1word transfer, Internal clock)

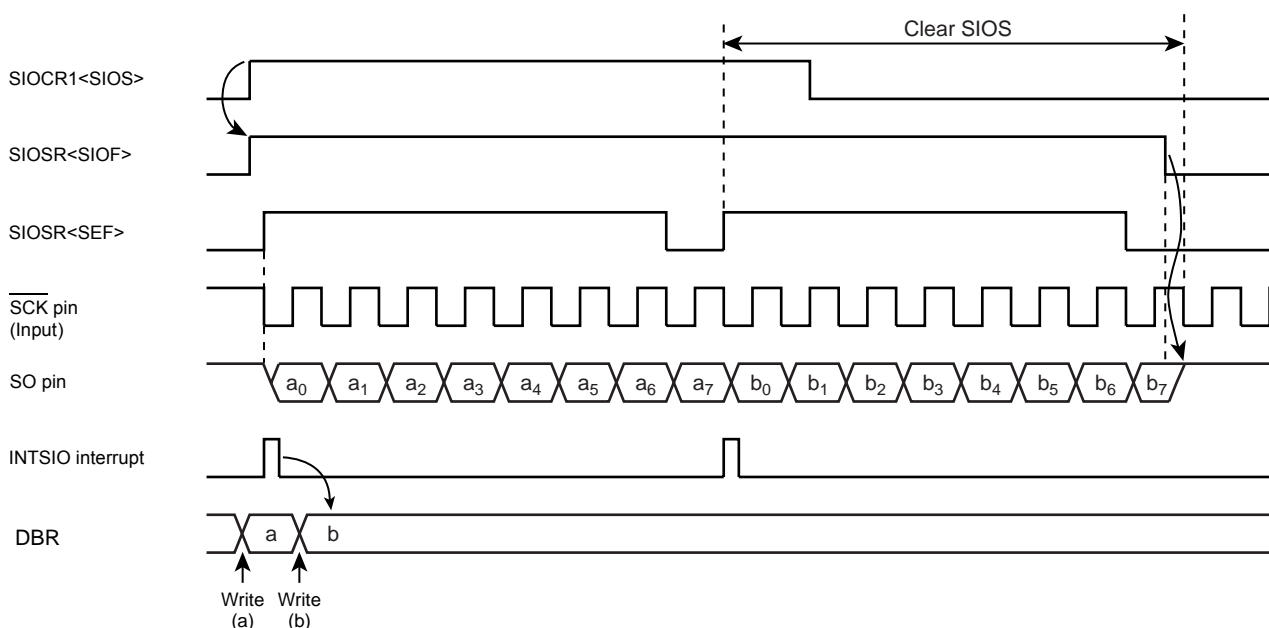


Figure 11-8 Transfer Mode (Example: 8bit, 1word transfer, External clock)

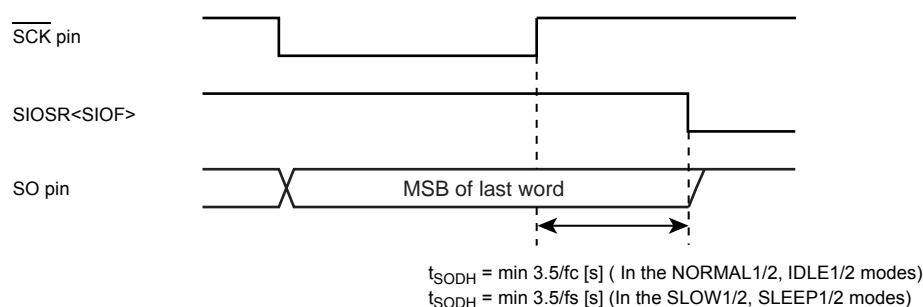


Figure 11-9 Transmitted Data Hold Time at End of Transfer

### 11.6.2 4-bit and 8-bit receive modes

After setting the control registers to the receive mode, set SIOCR1<SIOS> to “1” to enable receiving. The data are then transferred to the shift register via the SI pin in synchronous with the serial clock. When one word of data has been received, it is transferred from the shift register to the data buffer register (DBR). When the number of words specified with the SIOCR2<BUF> has been received, an INTSIO (Buffer full) interrupt is generated to request that these data be read out. The data are then read from the data buffer registers by the interrupt service program.

When the internal clock is used, and the previous data are not read from the data buffer register before the next data are received, the serial clock will stop and an automatic-wait will be initiated until the data are read. A wait will not be initiated if even one data word has been read.

Note: Waits are also canceled by reading a DBR not being used as a received data buffer register is read; therefore, during SIO do not use such DBR for other applications.

When an external clock is used, the shift operation is synchronized with the external clock; therefore, the previous data are read before the next data are transferred to the data buffer register. If the previous data have not been read, the next data will not be transferred to the data buffer register and the receiving of any more data will be canceled. When an external clock is used, the maximum transfer speed is determined by the delay between the time when the interrupt request is generated and when the data received have been read.

The receiving is ended by clearing SIOCR1<SIOS> to “0” or setting SIOCR1<SIOINH> to “1” in buffer full interrupt service program.

When SIOCR1<SIOS> is cleared, the current data are transferred to the buffer. After SIOCR1<SIOS> cleared, the receiving is ended at the time that the final bit of the data has been received. That the receiving has ended can be determined from the status of SIOSR<SIOF>. SIOSR<SIOF> is cleared to “0” when the receiving is ended. After confirmed the receiving termination, the final receiving data is read. When SIOCR1<SIOINH> is set, the receiving is immediately ended and SIOSR<SIOF> is cleared to “0”. (The received data is ignored, and it is not required to be read out.)

If it is necessary to change the number of words in external clock operation, SIOCR1<SIOS> should be cleared to “0” then SIOCR2<BUF> must be rewritten after confirming that SIOSR<SIOF> has been cleared to “0”. If it is necessary to change the number of words in internal clock, during automatic-wait operation which occurs after completion of data receiving, SIOCR2<BUF> must be rewritten before the received data is read out.

Note: The buffer contents are lost when the transfer mode is switched. If it should become necessary to switch the transfer mode, end receiving by clearing SIOCR1<SIOS> to “0”, read the last data and then switch the transfer mode.

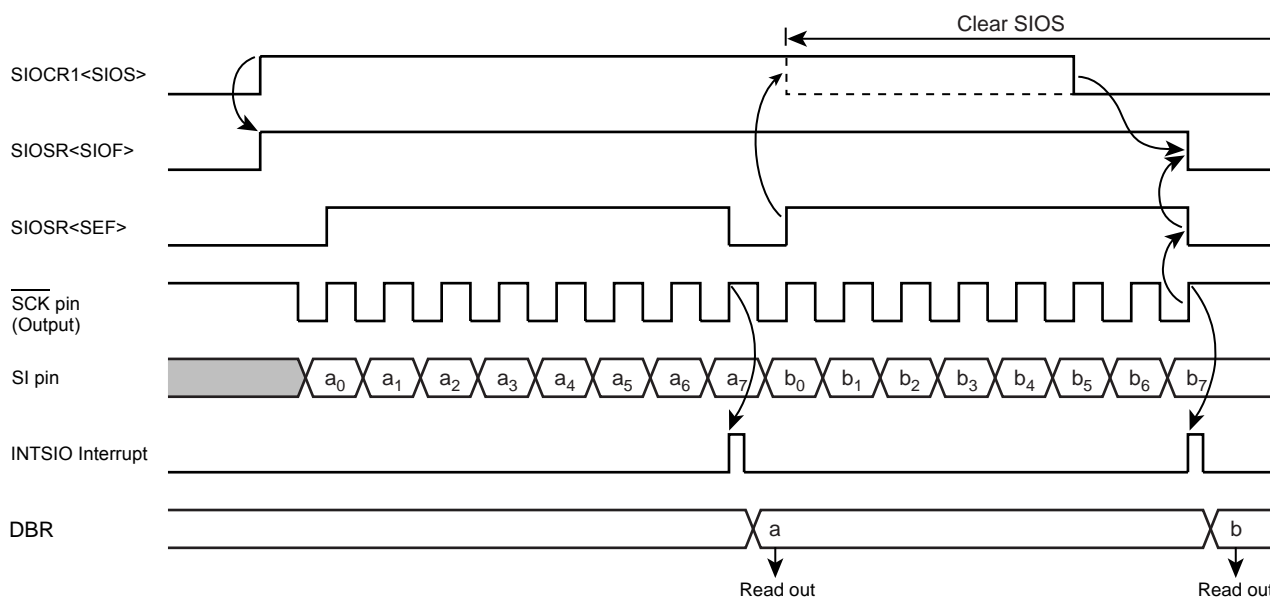


Figure 11-10 Receive Mode (Example: 8bit, 1word transfer, Internal clock)

### 11.6.3 8-bit transfer / receive mode

After setting the SIO control register to the 8-bit transmit/receive mode, write the data to be transmitted first to the data buffer registers (DBR). After that, enable the transmit/receive by setting SIOCR1<SIOS> to “1”. When transmitting, the data are output from the SO pin at leading edges of the serial clock. When receiving, the data are input to the SI pin at the trailing edges of the serial clock. When the all receive is enabled, 8-bit data are transferred from the shift register to the data buffer register. An INTSIO interrupt is generated when the number of data words specified with the SIOCR2<BUF> has been transferred. Usually, read the receive data from the buffer register in the interrupt service. The data buffer register is used for both transmitting and receiving; therefore, always write the data to be transmitted after reading the all received data.

When the internal clock is used, a wait is initiated until the received data are read and the next transfer data are written. A wait will not be initiated if even one transfer data word has been written.

When an external clock is used, the shift operation is synchronized with the external clock; therefore, it is necessary to read the received data and write the data to be transmitted next before starting the next shift operation. When an external clock is used, the transfer speed is determined by the maximum delay between generation of an interrupt request and the received data are read and the data to be transmitted next are written.

The transmit/receive operation is ended by clearing SIOCR1<SIOS> to “0” or setting SIOCR1<SIOINH> to “1” in INTSIO interrupt service program.

When SIOCR1<SIOS> is cleared, the current data are transferred to the buffer. After SIOCR1<SIOS> cleared, the transmitting/receiving is ended at the time that the final bit of the data has been transmitted.

That the transmitting/receiving has ended can be determined from the status of SIOSR<SIOF>. SIOSR<SIOF> is cleared to “0” when the transmitting/receiving is ended.

When SIOCR1<SIOINH> is set, the transmit/receive operation is immediately ended and SIOSR<SIOF> is cleared to “0”.

If it is necessary to change the number of words in external clock operation, SIOCR1<SIOS> should be cleared to “0”, then SIOCR2<BUF> must be rewritten after confirming that SIOSR<SIOF> has been cleared to “0”.

If it is necessary to change the number of words in internal clock, during automatic-wait operation which occurs after completion of transmit/receive operation, SIOCR2<BUF> must be rewritten before reading and writing of the receive/transmit data.

Note: The buffer contents are lost when the transfer mode is switched. If it should become necessary to switch the transfer mode, end receiving by clearing SIOCR1<SIOS> to "0", read the last data and then switch the transfer mode.

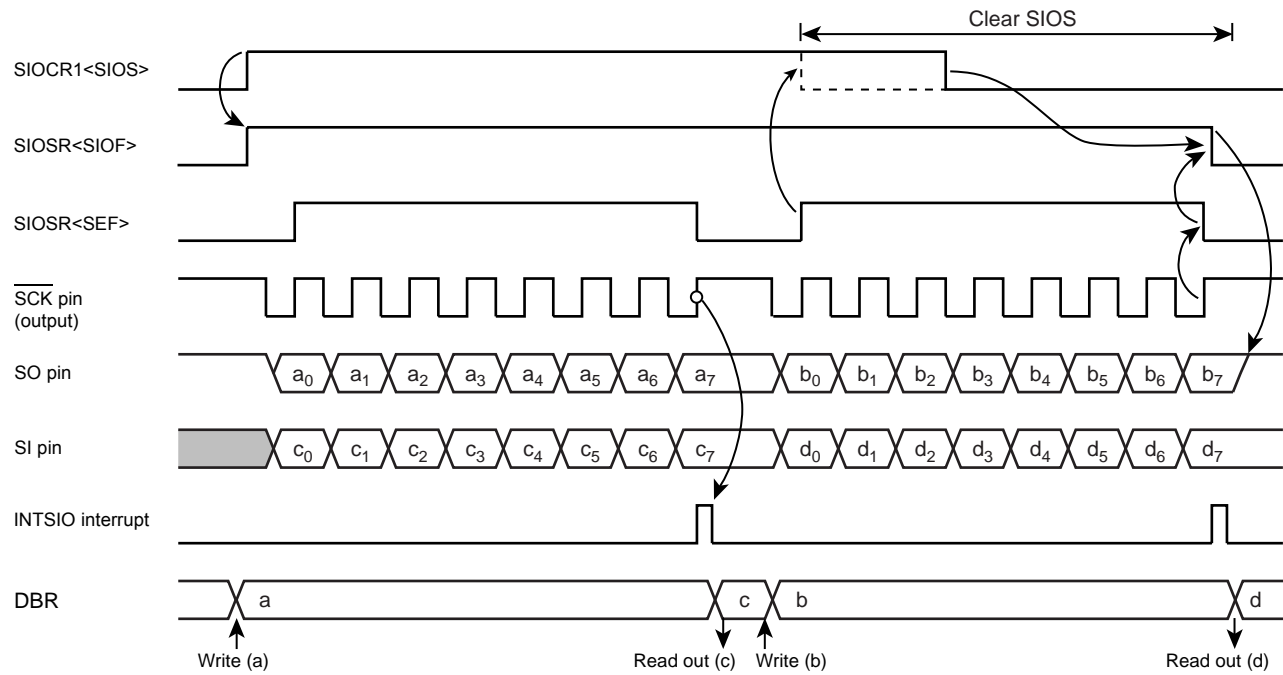


Figure 11-11 Transfer / Receive Mode (Example: 8bit, 1word transfer, Internal clock)

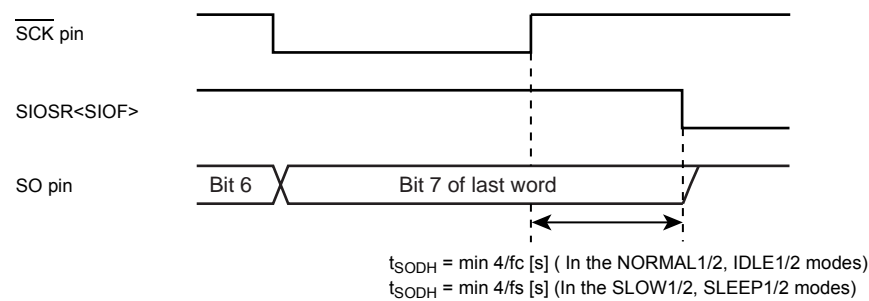


Figure 11-12 Transmitted Data Hold Time at End of Transfer / Receive

## 12. Asynchronous Serial interface (UART1 )

### 12.1 Configuration

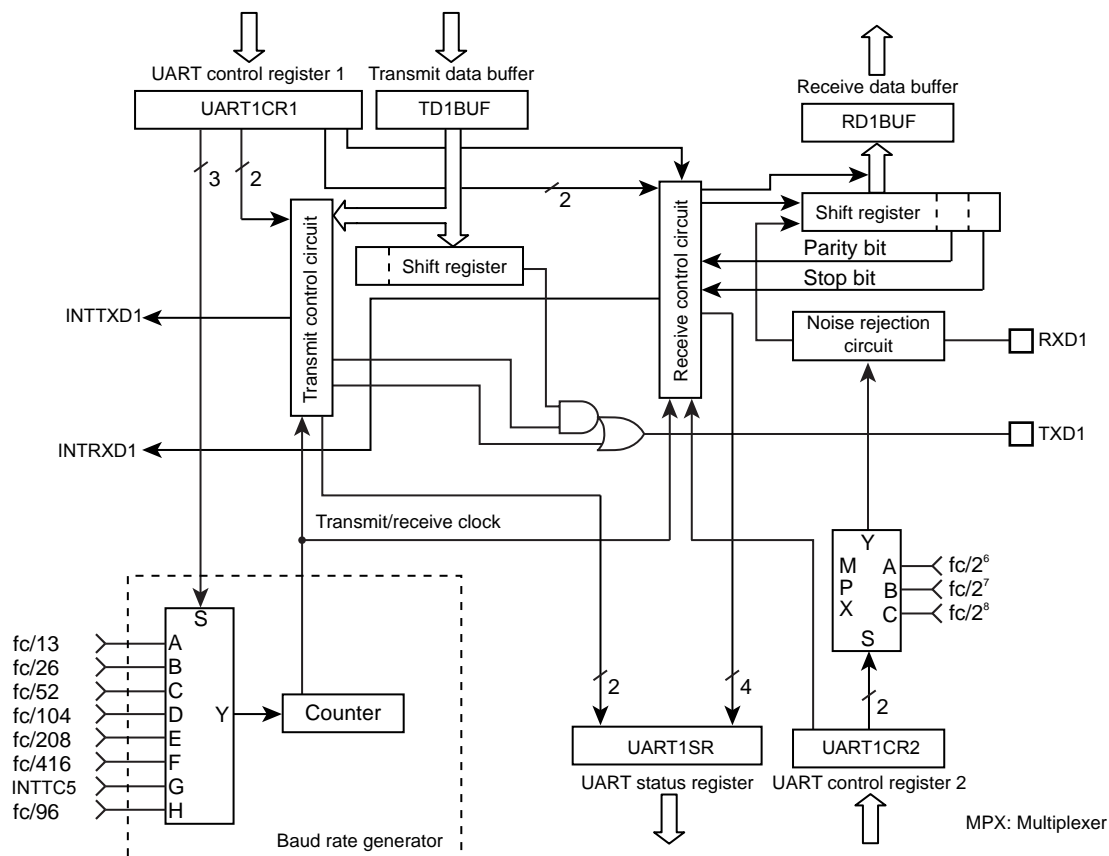


Figure 12-1 UART1 (Asynchronous Serial Interface)

12.2 Control

UART1 is controlled by the UART1 Control Registers (UART1CR1, UART1CR2). The operating status can be monitored using the UART status register (UART1SR).

UART1 Control Register1

UART1CR1 (0FE8H)	7	6	5	4	3	2	1	0	
	TXE	RXE	STBT	EVEN	PE	BRG			(Initial value: 0000 0000)

TXE	Transfer operation	0: Disable 1: Enable	Write only
RXE	Receive operation	0: Disable 1: Enable	
STBT	Transmit stop bit length	0: 1 bit 1: 2 bits	
EVEN	Even-numbered parity	0: Odd-numbered parity 1: Even-numbered parity	
PE	Parity addition	0: No parity 1: Parity	
BRG	Transmit clock select	000: fc/13 [Hz] 001: fc/26 010: fc/52 011: fc/104 100: fc/208 101: fc/416 110: TC5 ( Input INTTC5) 111: fc/96	

Note 1: When operations are disabled by setting TXE and RXE bit to “0”, the setting becomes valid when data transmit or receive complete. When the transmit data is stored in the transmit data buffer, the data are not transmitted. Even if data transmit is enabled, until new data are written to the transmit data buffer, the current data are not transmitted.

Note 2: The transmit clock and the parity are common to transmit and receive.

Note 3: UART1CR1<RXE> and UART1CR1<TXE> should be set to “0” before UART1CR1<BRG> is changed.

UART1 Control Register2

UART1CR2 (0FE9H)	7	6	5	4	3	2	1	0	
						RXDNC	STOPBR		(Initial value: **** *000)

RXDNC	Selection of RXD input noise rejection time	00: No noise rejection (Hysteresis input) 01: Rejects pulses shorter than 31/fc [s] as noise 10: Rejects pulses shorter than 63/fc [s] as noise 11: Rejects pulses shorter than 127/fc [s] as noise	Write only
STOPBR	Receive stop bit length	0: 1 bit 1: 2 bits	

Note: When UART1CR2<RXDNC> = “01”, pulses longer than 96/fc [s] are always regarded as signals; when UART1CR2<RXDNC> = “10”, longer than 192/fc [s]; and when UART1CR2<RXDNC> = “11”, longer than 384/fc [s].

## UART1 Status Register

UART1SR (0FE8H)	7	6	5	4	3	2	1	0	
	PERR	FERR	OERR	RBFL	TEND	TBEP			(Initial value: 0000 11**)

PERR	Parity error flag	0: No parity error 1: Parity error	Read only
FERR	Framing error flag	0: No framing error 1: Framing error	
OERR	Overrun error flag	0: No overrun error 1: Overrun error	
RBFL	Receive data buffer full flag	0: Receive data buffer empty 1: Receive data buffer full	
TEND	Transmit end flag	0: On transmitting 1: Transmit end	
TBEP	Transmit data buffer empty flag	0: Transmit data buffer full (Transmit data writing is finished) 1: Transmit data buffer empty	

Note: When an INTTXD is generated, TBEP flag is set to "1" automatically.

## UART1 Receive Data Buffer

RD1BUF (0FEAH)	7	6	5	4	3	2	1	0	Read only
									(Initial value: 0000 0000)

## UART1 Transmit Data Buffer

TD1BUF (0FEAH)	7	6	5	4	3	2	1	0	Write only
									(Initial value: 0000 0000)

12.3 Transfer Data Format

In UART1, an one-bit start bit (Low level), stop bit (Bit length selectable at high level, by UART1CR1<STBT>), and parity (Select parity in UART1CR1<PE>; even- or odd-numbered parity by UART1CR1<EVEN>) are added to the transfer data. The transfer data formats are shown as follows.

PE	STBT	Frame Length										
		1	2	3		8	9	10	11	12		
0	0											
0	1											
1	0											
1	1											

Figure 12-2 Transfer Data Format

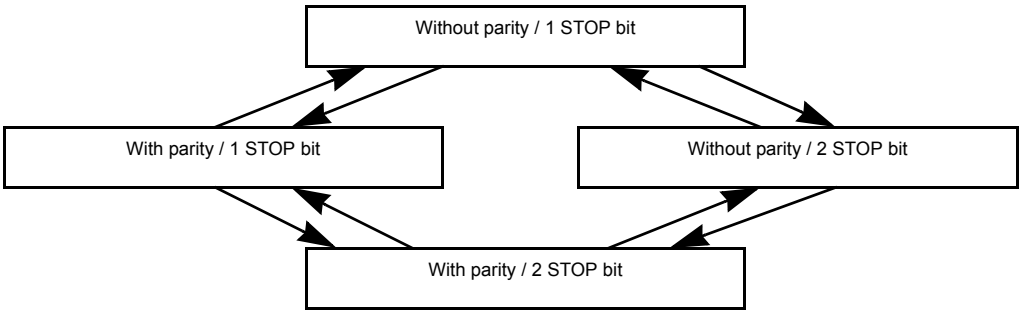


Figure 12-3 Caution on Changing Transfer Data Format

Note: In order to switch the transfer data format, perform transmit operations in the above Figure 12-3 sequence except for the initial setting.



12.4 Transfer Rate

The baud rate of UART1 is set of UART1CR1<BRG>. The example of the baud rate are shown as follows.

Table 12-1 Transfer Rate (Example)

BRG	Source Clock		
	16 MHz	8 MHz	4 MHz
000	76800 [baud]	38400 [baud]	19200 [baud]
001	38400	19200	9600
010	19200	9600	4800
011	9600	4800	2400
100	4800	2400	1200
101	2400	1200	600

When TC5 is used as the UART1 transfer rate (when UART1CR1<BRG> = “110”), the transfer clock and transfer rate are determined as follows:

Transfer clock [Hz] = TC5 source clock [Hz] / TTREG5 setting value

Transfer Rate [baud] = Transfer clock [Hz] / 16

12.5 Data Sampling Method

The UART1 receiver keeps sampling input using the clock selected by UART1CR1<BRG> until a start bit is detected in RXD1 pin input. RT clock starts detecting “L” level of the RXD1 pin. Once a start bit is detected, the start bit, data bits, stop bit(s), and parity bit are sampled at three times of RT7, RT8, and RT9 during one receiver clock interval (RT clock). (RT0 is the position where the bit supposedly starts.) Bit is determined according to majority rule (The data are the same twice or more out of three samplings).

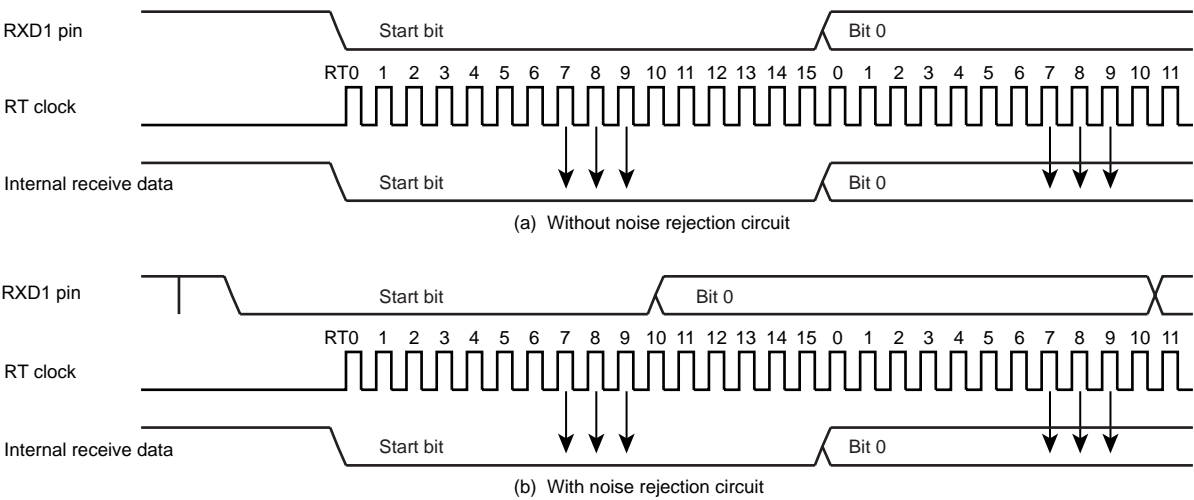


Figure 12-4 Data Sampling Method

## 12.6 STOP Bit Length

Select a transmit stop bit length (1 bit or 2 bits) by UART1CR1<STBT>.

## 12.7 Parity

Set parity / no parity by UART1CR1<PE> and set parity type (Odd- or Even-numbered) by UART1CR1<EVEN>.

## 12.8 Transmit/Receive Operation

### 12.8.1 Data Transmit Operation

Set UART1CR1<TXE> to “1”. Read UART1SR to check UART1SR<TBEP> = “1”, then write data in TD1BUF (Transmit data buffer). Writing data in TD1BUF zero-clears UART1SR<TBEP>, transfers the data to the transmit shift register and the data are sequentially output from the TXD1 pin. The data output include a one-bit start bit, stop bits whose number is specified in UART1CR1<STBT> and a parity bit if parity addition is specified. Select the data transfer baud rate using UART1CR1<BRG>. When data transmit starts, transmit buffer empty flag UART1SR<TBEP> is set to “1” and an INTTXD1 interrupt is generated.

While UART1CR1<TXE> = “0” and from when “1” is written to UART1CR1<TXE> to when send data are written to TD1BUF, the TXD1 pin is fixed at high level.

When transmitting data, first read UART1SR, then write data in TD1BUF. Otherwise, UART1SR<TBEP> is not zero-cleared and transmit does not start.

### 12.8.2 Data Receive Operation

Set UART1CR1<RXE> to “1”. When data are received via the RXD1 pin, the receive data are transferred to RD1BUF (Receive data buffer). At this time, the data transmitted includes a start bit and stop bit(s) and a parity bit if parity addition is specified. When stop bit(s) are received, data only are extracted and transferred to RD1BUF (Receive data buffer). Then the receive buffer full flag UART1SR<RBFL> is set and an INTRXD1 interrupt is generated. Select the data transfer baud rate using UART1CR1<BRG>.

If an overrun error (OERR) occurs when data are received, the data are not transferred to RD1BUF (Receive data buffer) but discarded; data in the RD1BUF are not affected.

Note: When a receive operation is disabled by setting UART1CR1<RXE> bit to “0”, the setting becomes valid when data receive is completed. However, if a framing error occurs in data receive, the receive-disabling setting may not become valid. If a framing error occurs, be sure to perform a re-receive operation.

12.9 Status Flag

12.9.1 Parity Error

When parity determined using the receive data bits differs from the received parity bit, the parity error flag UART1SR<PERR> is set to “1”. The UART1SR<PERR> is cleared to “0” when the RD1BUF is read after reading the UART1SR.

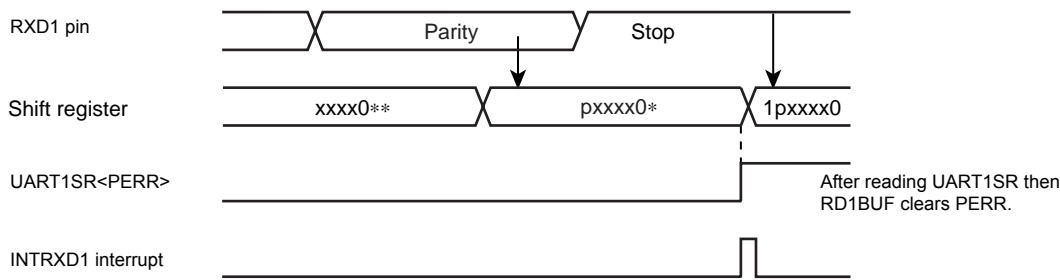


Figure 12-5 Generation of Parity Error

12.9.2 Framing Error

When “0” is sampled as the stop bit in the receive data, framing error flag UART1SR<FERR> is set to “1”. The UART1SR<FERR> is cleared to “0” when the RD1BUF is read after reading the UART1SR.

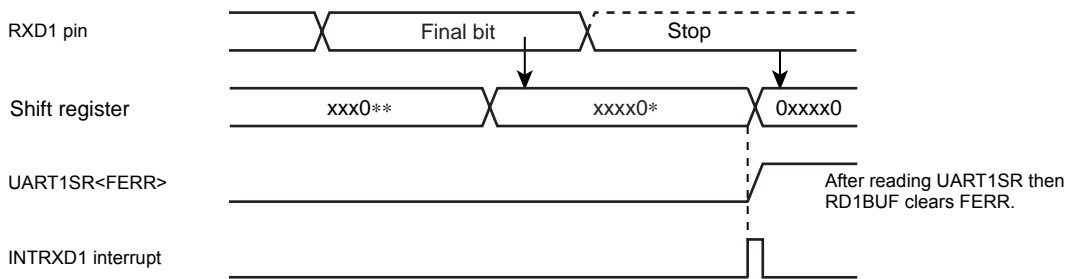


Figure 12-6 Generation of Framing Error

12.9.3 Overrun Error

When all bits in the next data are received while unread data are still in RD1BUF, overrun error flag UART1SR<OERR> is set to “1”. In this case, the receive data is discarded; data in RD1BUF are not affected. The UART1SR<OERR> is cleared to “0” when the RD1BUF is read after reading the UART1SR.

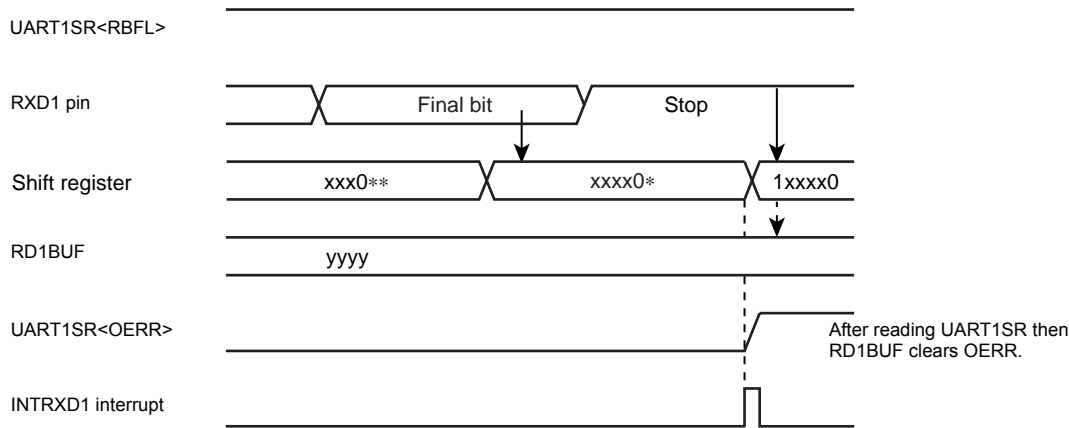


Figure 12-7 Generation of Overrun Error

Note: Receive operations are disabled until the overrun error flag UART1SR<OERR> is cleared.

12.9.4 Receive Data Buffer Full

Loading the received data in RD1BUF sets receive data buffer full flag UART1SR<RBFL> to "1". The UART1SR<RBFL> is cleared to "0" when the RD1BUF is read after reading the UART1SR.

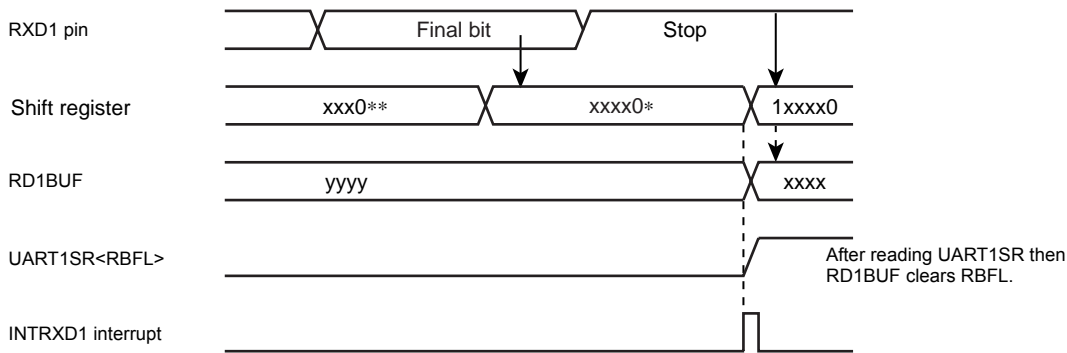


Figure 12-8 Generation of Receive Data Buffer Full

Note: If the overrun error flag UART1SR<OERR> is set during the period between reading the UART1SR and reading the RD1BUF, it cannot be cleared by only reading the RD1BUF. Therefore, after reading the RD1BUF, read the UART1SR again to check whether or not the overrun error flag which should have been cleared still remains set.

12.9.5 Transmit Data Buffer Empty

When no data is in the transmit buffer TD1BUF, that is, when data in TD1BUF are transferred to the transmit shift register and data transmit starts, transmit data buffer empty flag UART1SR<TBEP> is set to "1". The UART1SR<TBEP> is cleared to "0" when the TD1BUF is written after reading the UART1SR.

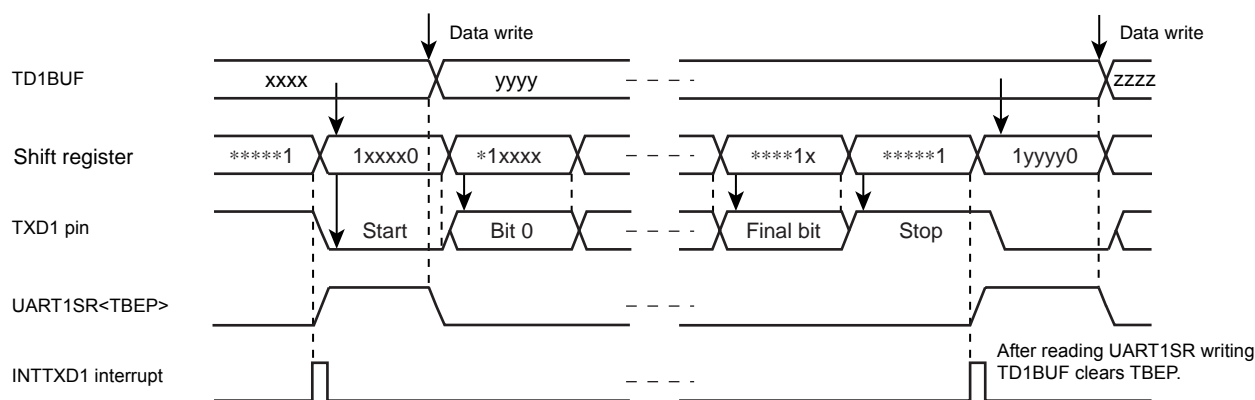


Figure 12-9 Generation of Transmit Data Buffer Empty

12.9.6 Transmit End Flag

When data are transmitted and no data is in TD1BUF (UART1SR<TBEP> = “1”), transmit end flag UART1SR<TEND> is set to “1”. The UART1SR<TEND> is cleared to “0” when the data transmit is started after writing the TD1BUF.

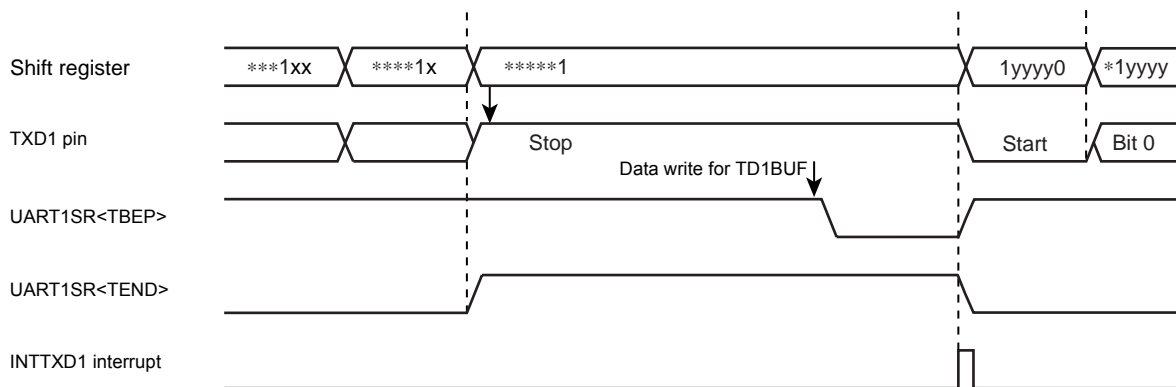


Figure 12-10 Generation of Transmit End Flag and Transmit Data Buffer Empty



## 13. Asynchronous Serial interface (UART0 )

### 13.1 Configuration

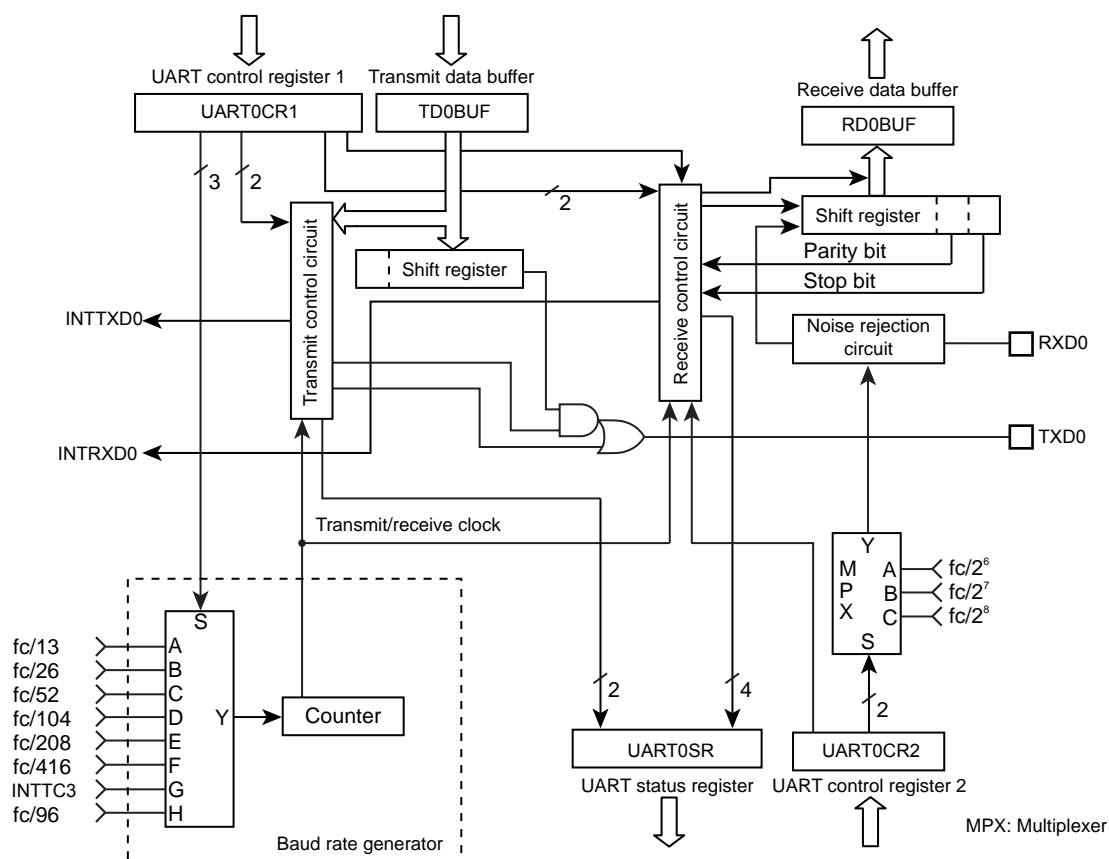


Figure 13-1 UART0 (Asynchronous Serial Interface)

13.2 Control

UART0 is controlled by the UART0 Control Registers (UART0CR1, UART0CR2). The operating status can be monitored using the UART status register (UART0SR).

UART0 Control Register1

UART0CR1 (0FE5H)	7	6	5	4	3	2	1	0	
	TXE	RXE	STBT	EVEN	PE	BRG			(Initial value: 0000 0000)

TXE	Transfer operation	0: Disable 1: Enable	Write only
RXE	Receive operation	0: Disable 1: Enable	
STBT	Transmit stop bit length	0: 1 bit 1: 2 bits	
EVEN	Even-numbered parity	0: Odd-numbered parity 1: Even-numbered parity	
PE	Parity addition	0: No parity 1: Parity	
BRG	Transmit clock select	000: fc/13 [Hz] 001: fc/26 010: fc/52 011: fc/104 100: fc/208 101: fc/416 110: TC3 ( Input INTTC3) 111: fc/96	

Note 1: When operations are disabled by setting TXE and RXE bit to “0”, the setting becomes valid when data transmit or receive complete. When the transmit data is stored in the transmit data buffer, the data are not transmitted. Even if data transmit is enabled, until new data are written to the transmit data buffer, the current data are not transmitted.

Note 2: The transmit clock and the parity are common to transmit and receive.

Note 3: UART0CR1<RXE> and UART0CR1<TXE> should be set to “0” before UART0CR1<BRG> is changed.

UART0 Control Register2

UART0CR2 (0FE6H)	7	6	5	4	3	2	1	0	
						RXDNC	STOPBR		(Initial value: **** *000)

RXDNC	Selection of RXD input noise rejection time	00: No noise rejection (Hysteresis input) 01: Rejects pulses shorter than 31/fc [s] as noise 10: Rejects pulses shorter than 63/fc [s] as noise 11: Rejects pulses shorter than 127/fc [s] as noise	Write only
STOPBR	Receive stop bit length	0: 1 bit 1: 2 bits	

Note: When UART0CR2<RXDNC> = “01”, pulses longer than 96/fc [s] are always regarded as signals; when UART0CR2<RXDNC> = “10”, longer than 192/fc [s]; and when UART0CR2<RXDNC> = “11”, longer than 384/fc [s].



## UART0 Status Register

UART0SR (0FE5H)	7	6	5	4	3	2	1	0	
	PERR	FERR	OERR	RBFL	TEND	TBEP			(Initial value: 0000 11**)

PERR	Parity error flag	0: No parity error 1: Parity error	Read only
FERR	Framing error flag	0: No framing error 1: Framing error	
OERR	Overrun error flag	0: No overrun error 1: Overrun error	
RBFL	Receive data buffer full flag	0: Receive data buffer empty 1: Receive data buffer full	
TEND	Transmit end flag	0: On transmitting 1: Transmit end	
TBEP	Transmit data buffer empty flag	0: Transmit data buffer full (Transmit data writing is finished) 1: Transmit data buffer empty	

Note: When an INTTXD is generated, TBEP flag is set to "1" automatically.

## UART0 Receive Data Buffer

RD0BUF (0FE7H)	7	6	5	4	3	2	1	0	Read only
									(Initial value: 0000 0000)

## UART0 Transmit Data Buffer

TD0BUF (0FE7H)	7	6	5	4	3	2	1	0	Write only
									(Initial value: 0000 0000)

13.3 Transfer Data Format

In UART0, an one-bit start bit (Low level), stop bit (Bit length selectable at high level, by UART0CR1<STBT>), and parity (Select parity in UART0CR1<PE>; even- or odd-numbered parity by UART0CR1<EVEN>) are added to the transfer data. The transfer data formats are shown as follows.





PE	STBT	Frame Length											
		1	2	3		8	9	10	11	12			
0	0												
0	1												
1	0												
1	1												

Figure 13-2 Transfer Data Format

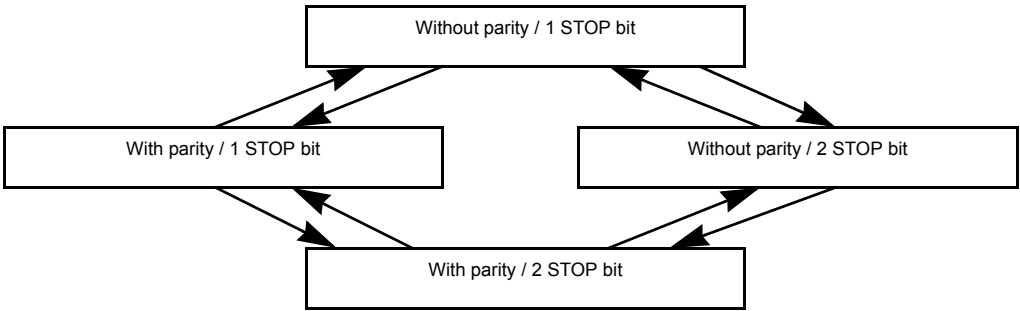


Figure 13-3 Caution on Changing Transfer Data Format

Note: In order to switch the transfer data format, perform transmit operations in the above Figure 13-3 sequence except for the initial setting.

## 13.4 Transfer Rate

The baud rate of UART0 is set of UART0CR1<BRG>. The example of the baud rate are shown as follows.

Table 13-1 Transfer Rate (Example)

BRG	Source Clock		
	16 MHz	8 MHz	4 MHz
000	76800 [baud]	38400 [baud]	19200 [baud]
001	38400	19200	9600
010	19200	9600	4800
011	9600	4800	2400
100	4800	2400	1200
101	2400	1200	600

When TC3 is used as the UART0 transfer rate (when UART0CR1<BRG> = “110”), the transfer clock and transfer rate are determined as follows:

$$\text{Transfer clock [Hz]} = \text{TC3 source clock [Hz]} / \text{TTREG3 setting value}$$

$$\text{Transfer Rate [baud]} = \text{Transfer clock [Hz]} / 16$$

## 13.5 Data Sampling Method

The UART0 receiver keeps sampling input using the clock selected by UART0CR1<BRG> until a start bit is detected in RXD0 pin input. RT clock starts detecting “L” level of the RXD0 pin. Once a start bit is detected, the start bit, data bits, stop bit(s), and parity bit are sampled at three times of RT7, RT8, and RT9 during one receiver clock interval (RT clock). (RT0 is the position where the bit supposedly starts.) Bit is determined according to majority rule (The data are the same twice or more out of three samplings).

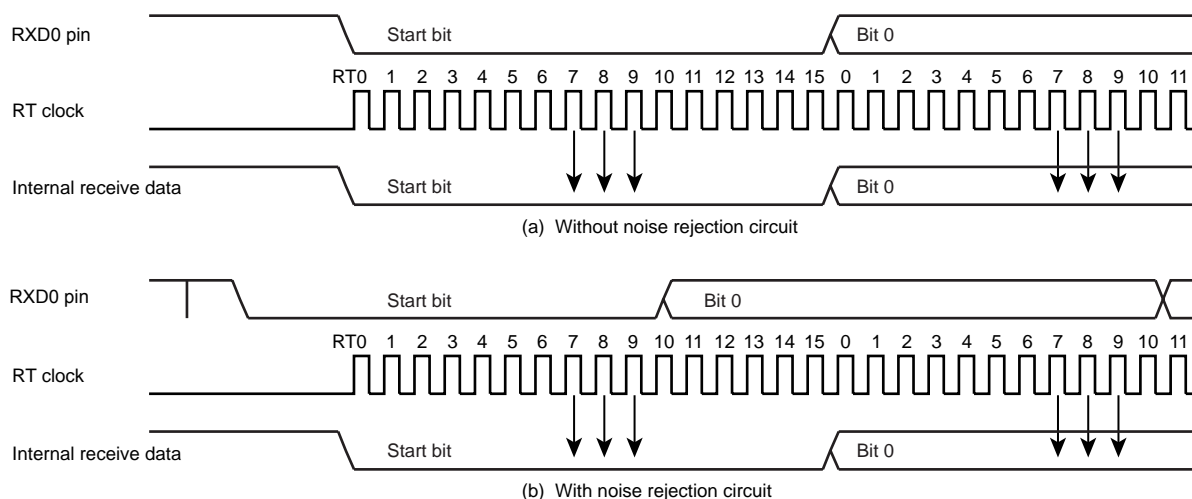


Figure 13-4 Data Sampling Method

## 13.6 STOP Bit Length

Select a transmit stop bit length (1 bit or 2 bits) by UART0CR1<STBT>.

## 13.7 Parity

Set parity / no parity by UART0CR1<PE> and set parity type (Odd- or Even-numbered) by UART0CR1<EVEN>.

## 13.8 Transmit/Receive Operation

### 13.8.1 Data Transmit Operation

Set UART0CR1<TXE> to “1”. Read UART0SR to check UART0SR<TBEP> = “1”, then write data in TD0BUF (Transmit data buffer). Writing data in TD0BUF zero-clears UART0SR<TBEP>, transfers the data to the transmit shift register and the data are sequentially output from the TXD0 pin. The data output include a one-bit start bit, stop bits whose number is specified in UART0CR1<STBT> and a parity bit if parity addition is specified. Select the data transfer baud rate using UART0CR1<BRG>. When data transmit starts, transmit buffer empty flag UART0SR<TBEP> is set to “1” and an INTTXD0 interrupt is generated.

While UART0CR1<TXE> = “0” and from when “1” is written to UART0CR1<TXE> to when send data are written to TD0BUF, the TXD0 pin is fixed at high level.

When transmitting data, first read UART0SR, then write data in TD0BUF. Otherwise, UART0SR<TBEP> is not zero-cleared and transmit does not start.

### 13.8.2 Data Receive Operation

Set UART0CR1<RXE> to “1”. When data are received via the RXD0 pin, the receive data are transferred to RD0BUF (Receive data buffer). At this time, the data transmitted includes a start bit and stop bit(s) and a parity bit if parity addition is specified. When stop bit(s) are received, data only are extracted and transferred to RD0BUF (Receive data buffer). Then the receive buffer full flag UART0SR<RBFL> is set and an INTRXD0 interrupt is generated. Select the data transfer baud rate using UART0CR1<BRG>.

If an overrun error (OERR) occurs when data are received, the data are not transferred to RD0BUF (Receive data buffer) but discarded; data in the RD0BUF are not affected.

Note: When a receive operation is disabled by setting UART0CR1<RXE> bit to “0”, the setting becomes valid when data receive is completed. However, if a framing error occurs in data receive, the receive-disabling setting may not become valid. If a framing error occurs, be sure to perform a re-receive operation.

## 13.9 Status Flag

### 13.9.1 Parity Error

When parity determined using the receive data bits differs from the received parity bit, the parity error flag UART0SR<PERR> is set to “1”. The UART0SR<PERR> is cleared to “0” when the RD0BUF is read after reading the UART0SR.

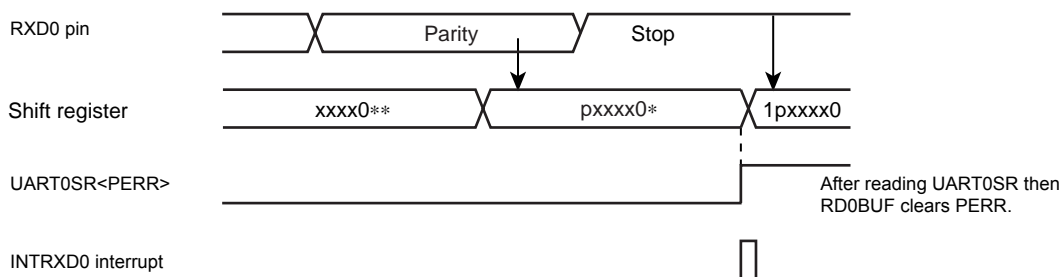


Figure 13-5 Generation of Parity Error

### 13.9.2 Framing Error

When “0” is sampled as the stop bit in the receive data, framing error flag UART0SR<FERR> is set to “1”. The UART0SR<FERR> is cleared to “0” when the RD0BUF is read after reading the UART0SR.

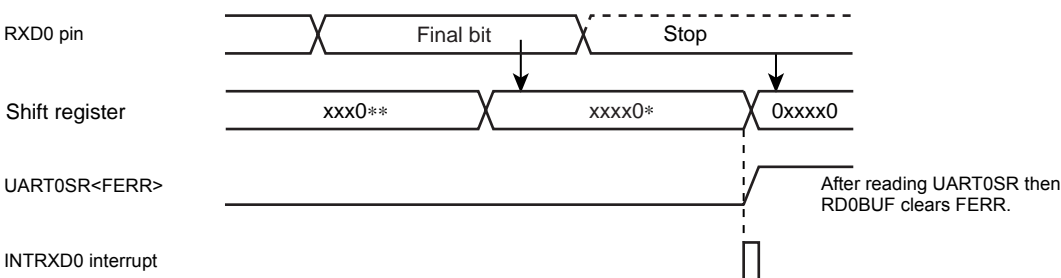


Figure 13-6 Generation of Framing Error

### 13.9.3 Overrun Error

When all bits in the next data are received while unread data are still in RD0BUF, overrun error flag UART0SR<OERR> is set to “1”. In this case, the receive data is discarded; data in RD0BUF are not affected. The UART0SR<OERR> is cleared to “0” when the RD0BUF is read after reading the UART0SR.

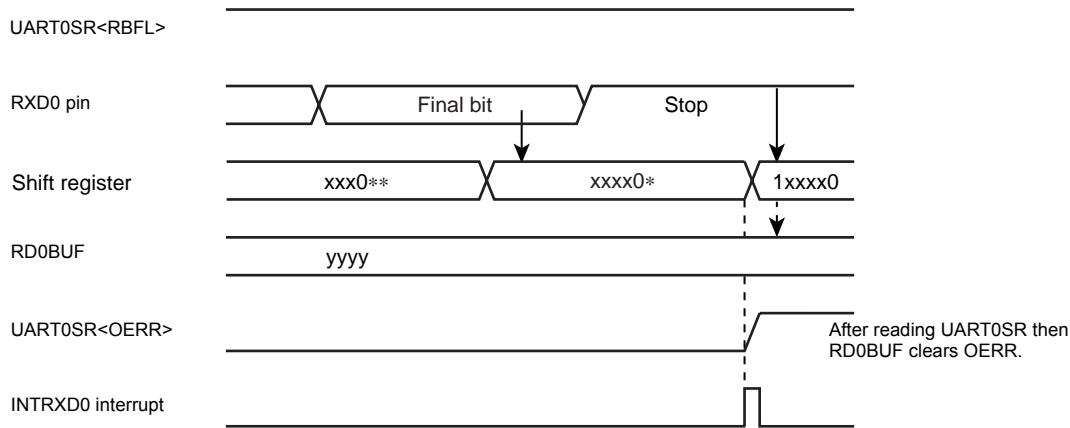


Figure 13-7 Generation of Overrun Error

Note: Receive operations are disabled until the overrun error flag UART0SR<OERR> is cleared.

13.9.4 Receive Data Buffer Full

Loading the received data in RD0BUF sets receive data buffer full flag UART0SR<RBFL> to "1". The UART0SR<RBFL> is cleared to "0" when the RD0BUF is read after reading the UART0SR.

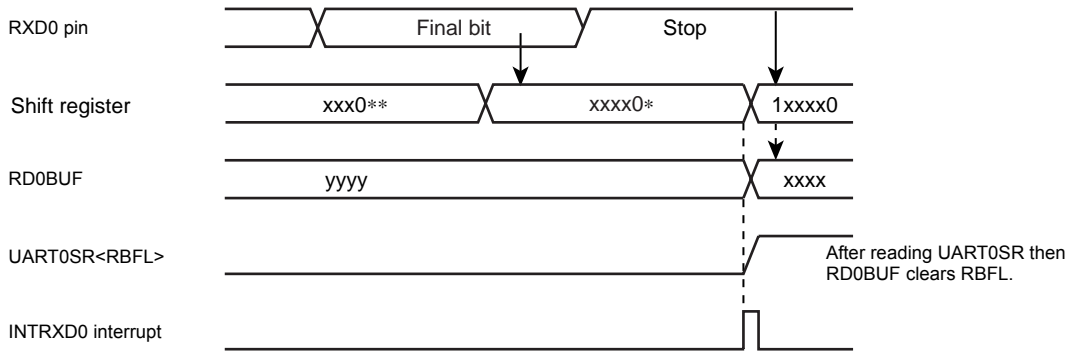


Figure 13-8 Generation of Receive Data Buffer Full

Note: If the overrun error flag UART0SR<OERR> is set during the period between reading the UART0SR and reading the RD0BUF, it cannot be cleared by only reading the RD0BUF. Therefore, after reading the RD0BUF, read the UART0SR again to check whether or not the overrun error flag which should have been cleared still remains set.

13.9.5 Transmit Data Buffer Empty

When no data is in the transmit buffer TD0BUF, that is, when data in TD0BUF are transferred to the transmit shift register and data transmit starts, transmit data buffer empty flag UART0SR<TBEP> is set to "1". The UART0SR<TBEP> is cleared to "0" when the TD0BUF is written after reading the UART0SR.

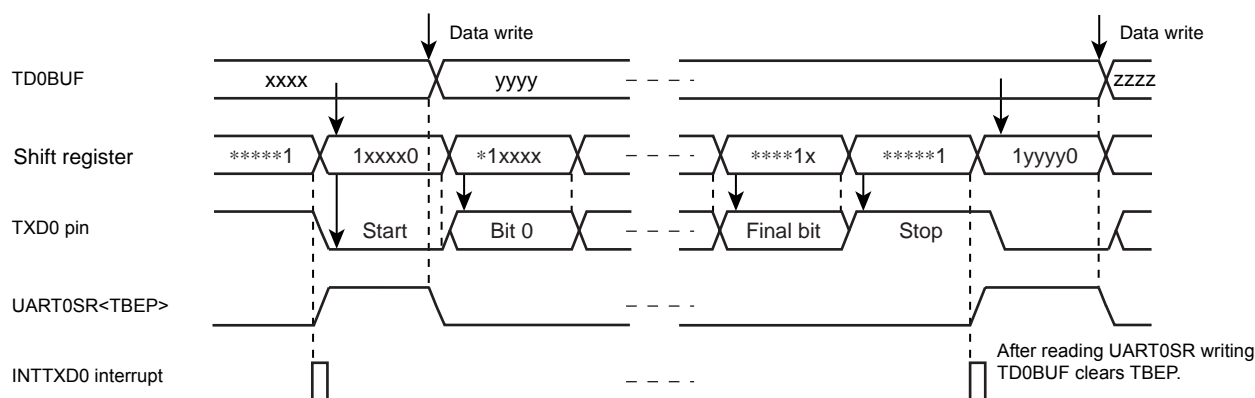


Figure 13-9 Generation of Transmit Data Buffer Empty

13.9.6 Transmit End Flag

When data are transmitted and no data is in TD0BUF (UART0SR<TBEP> = “1”), transmit end flag UART0SR<TEND> is set to “1”. The UART0SR<TEND> is cleared to “0” when the data transmit is started after writing the TD0BUF.

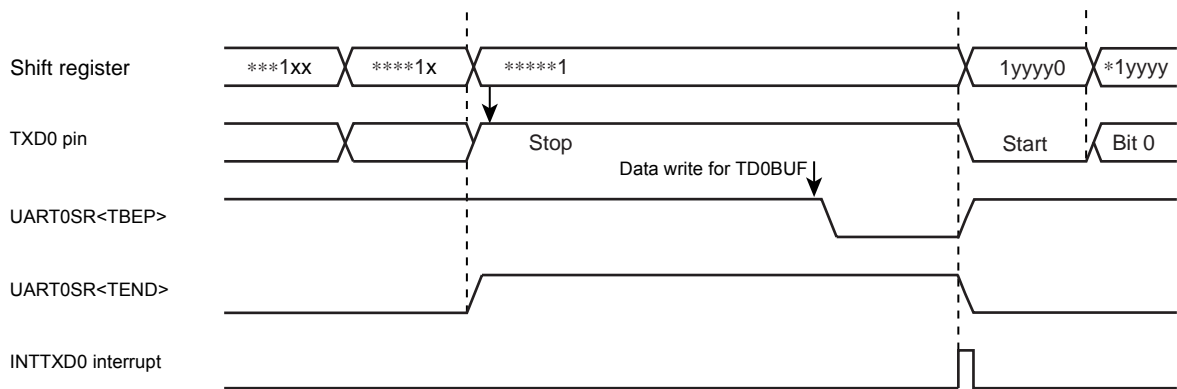


Figure 13-10 Generation of Transmit End Flag and Transmit Data Buffer Empty





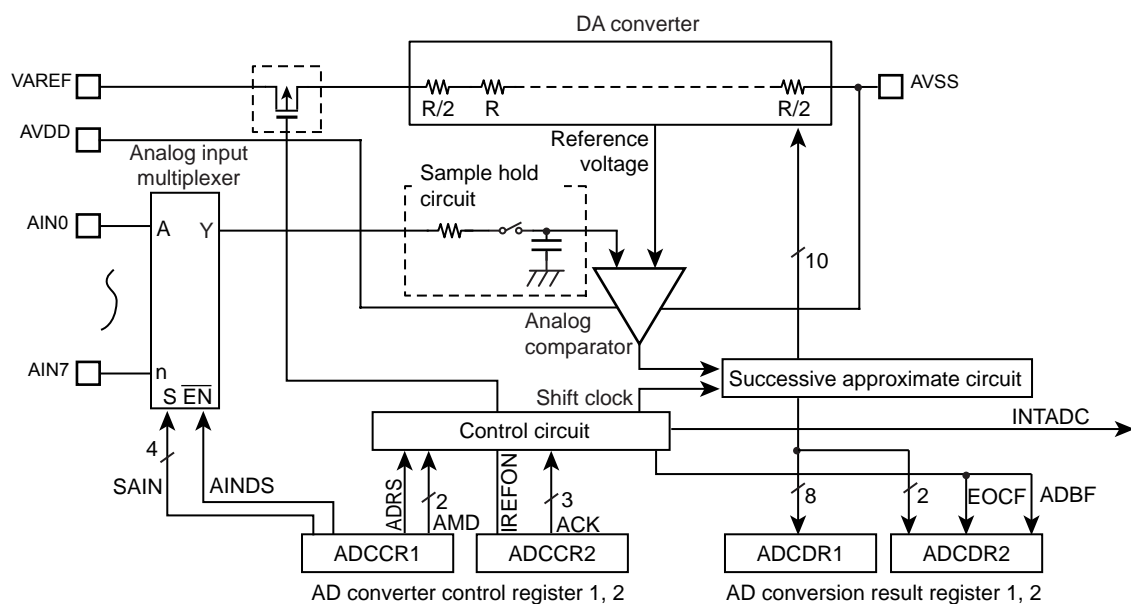
## 14. 10-bit AD Converter (ADC)

The TMP86FS28DFG have a 10-bit successive approximation type AD converter.

### 14.1 Configuration

The circuit configuration of the 10-bit AD converter is shown in Figure 14-1.

It consists of control register ADCCR1 and ADCCR2, converted value register ADCDR1 and ADCDR2, a DA converter, a sample-hold circuit, a comparator, and a successive comparison circuit.



Note: Before using AD converter, set appropriate value to I/O port register combining a analog input port. For details, see the section on "I/O ports".

Figure 14-1 10-bit AD Converter

## 14.2 Register configuration

The AD converter consists of the following four registers:

1. AD converter control register 1 (ADCCR1)  
This register selects the analog channels and operation mode (Software start or repeat) in which to perform AD conversion and controls the AD converter as it starts operating.
2. AD converter control register 2 (ADCCR2)  
This register selects the AD conversion time and controls the connection of the DA converter (Ladder resistor network).
3. AD converted value register 1 (ADCDR1)  
This register used to store the digital value fter being converted by the AD converter.
4. AD converted value register 2 (ADCDR2)  
This register monitors the operating status of the AD converter.

### AD Converter Control Register 1

ADCCR1 (0FE2H)	7	6	5	4	3	2	1	0	
	ADRS	AMD		AINDS	SAIN				(Initial value: 0001 0000)

ADRS	AD conversion start	0: - 1: AD conversion start	R/W
AMD	AD operating mode	00: AD operation disable 01: Software start mode 10: Reserved 11: Repeat mode	
AINDS	Analog input control	0: Analog input enable 1: Analog input disable	
SAIN	Analog input channel select	0000: AIN0 0001: AIN1 0010: AIN2 0011: AIN3 0100: AIN4 0101: AIN5 0110: AIN6 0111: AIN7 1000: Reserved 1001: Reserved 1010: Reserved 1011: Reserved 1100: Reserved 1101: Reserved 1110: Reserved 1111: Reserved	

- Note 1: Select analog input channel during AD converter stops (ADCDR2<ADBF> = "0").
- Note 2: When the analog input channel is all use disabling, the ADCCR1<AINDS> should be set to "1".
- Note 3: During conversion, Do not perform port output instruction to maintain a precision for all of the pins because analog input port use as general input port. And for port near to analog input, Do not input intense signaling of change.
- Note 4: The ADCCR1<ADRS> is automatically cleared to "0" after starting conversion.
- Note 5: Do not set ADCCR1<ADRS> newly again during AD conversion. Before setting ADCCR1<ADRS> newly again, check ADCDR2<EOCF> to see that the conversion is completed or wait until the interrupt signal (INTADC) is generated (e.g., interrupt handling routine).
- Note 6: After STOP or SLOW/SLEEP mode are started, AD converter control register1 (ADCCR1) is all initialized and no data can be written in this register. Therefore, to use AD converter again, set the ADCCR1 newly after returning to NORMAL1 or NORMAL2 mode.

## AD Converter Control Register 2

ADCCR2 (0FE3H)	7	6	5	4	3	2	1	0	
			IREFON	"1"		ACK		"0"	(Initial value: **0* 000*)

IREFON	DA converter (Ladder resistor) connection control	0: Connected only during AD conversion 1: Always connected	R/W
ACK	AD conversion time select (Refer to the following table about the conversion time)	000: 39/fc 001: Reserved 010: 78/fc 011: 156/fc 100: 312/fc 101: 624/fc 110: 1248/fc 111: Reserved	

Note 1: Always set bit0 in ADCCR2 to "0" and set bit4 in ADCCR2 to "1".

Note 2: When a read instruction for ADCCR2, bit6 to 7 in ADCCR2 read in as undefined data.

Note 3: After STOP or SLOW/SLEEP mode are started, AD converter control register2 (ADCCR2) is all initialized and no data can be written in this register. Therefore, to use AD converter again, set the ADCCR2 newly after returning to NORMAL1 or NORMAL2 mode.

Table 14-1 ACK setting and Conversion time

Condition ACK	Conversion time	16 MHz	8 MHz	4 MHz	2 MHz	10 MHz	5 MHz	2.5 MHz
000	39/fc	-	-	-	19.5 $\mu$ s	-	-	15.6 $\mu$ s
001	Reserved							
010	78/fc	-	-	19.5 $\mu$ s	39.0 $\mu$ s	-	15.6 $\mu$ s	31.2 $\mu$ s
011	156/fc	-	19.5 $\mu$ s	39.0 $\mu$ s	78.0 $\mu$ s	15.6 $\mu$ s	31.2 $\mu$ s	62.4 $\mu$ s
100	312/fc	19.5 $\mu$ s	39.0 $\mu$ s	78.0 $\mu$ s	156.0 $\mu$ s	31.2 $\mu$ s	62.4 $\mu$ s	124.8 $\mu$ s
101	624/fc	39.0 $\mu$ s	78.0 $\mu$ s	156.0 $\mu$ s	-	62.4 $\mu$ s	124.8 $\mu$ s	-
110	1248/fc	78.0 $\mu$ s	156.0 $\mu$ s	-	-	124.8 $\mu$ s	-	-
111	Reserved							

Note 1: Setting for "-" in the above table are inhibited. fc: High Frequency oscillation clock [Hz]

Note 2: Set conversion time setting should be kept more than the following time by Analog reference voltage (VAREF) .

- VAREF = 4.5 to 5.5 V      15.6  $\mu$ s and more
- VAREF = 2.7 to 5.5 V      31.2  $\mu$ s and more

## AD Converted value Register 1

ADCDR1 (0FE1H)	7	6	5	4	3	2	1	0	
	AD09	AD08	AD07	AD06	AD05	AD04	AD03	AD02	(Initial value: 0000 0000)

## AD Converted value Register 2

ADCDR2 (0FE0H)	7	6	5	4	3	2	1	0	
	AD01	AD00	EOCF	ADBF					(Initial value: 0000 ****)

---

EOCF	AD conversion end flag	0: Before or during conversion 1: Conversion completed	Read only
ADBF	AD conversion BUSY flag	0: During stop of AD conversion 1: During AD conversion	

Note 1: The ADCDR2<EOCF> is cleared to "0" when reading the ADCDR1. Therefore, the AD conversion result should be read to ADCDR2 more first than ADCDR1.

Note 2: The ADCDR2<ADBF> is set to "1" when AD conversion starts, and cleared to "0" when AD conversion finished. It also is cleared upon entering STOP mode or SLOW mode .

Note 3: If a read instruction is executed for ADCDR2, read data of bit3 to bit0 are unstable.

## 14.3 Function

### 14.3.1 Software Start Mode

After setting ADCCR1<AMD> to “01” (software start mode), set ADCCR1<ADRS> to “1”. AD conversion of the voltage at the analog input pin specified by ADCCR1<SAIN> is thereby started.

After completion of the AD conversion, the conversion result is stored in AD converted value registers (ADCDR1, ADCDR2) and at the same time ADCDR2<EOCF> is set to 1, the AD conversion finished interrupt (INTADC) is generated.

ADRS is automatically cleared after AD conversion has started. Do not set ADCCR1<ADRS> newly again (Restart) during AD conversion. Before setting ADRS newly again, check ADCDR2<EOCF> to see that the conversion is completed or wait until the interrupt signal (INTADC) is generated (e.g., interrupt handling routine).

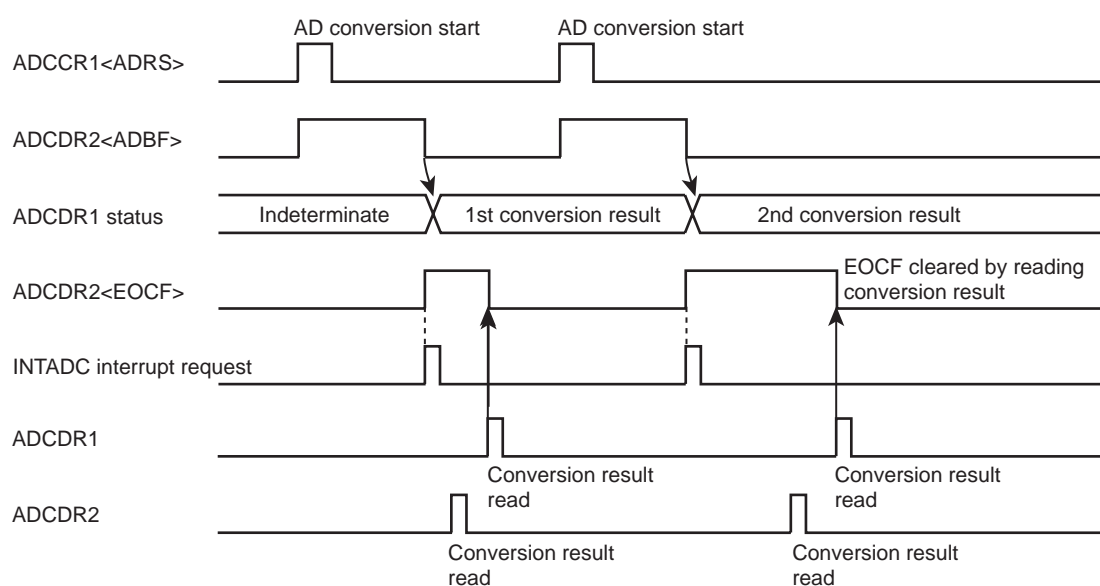


Figure 14-2 Software Start Mode

### 14.3.2 Repeat Mode

AD conversion of the voltage at the analog input pin specified by ADCCR1<SAIN> is performed repeatedly. In this mode, AD conversion is started by setting ADCCR1<ADRS> to “1” after setting ADCCR1<AMD> to “11” (Repeat mode).

After completion of the AD conversion, the conversion result is stored in AD converted value registers (ADCDR1, ADCDR2) and at the same time ADCDR2<EOCF> is set to 1, the AD conversion finished interrupt (INTADC) is generated.

In repeat mode, each time one AD conversion is completed, the next AD conversion is started. To stop AD conversion, set ADCCR1<AMD> to “00” (Disable mode) by writing 0s. The AD convert operation is stopped immediately. The converted value at this time is not stored in the AD converted value register.

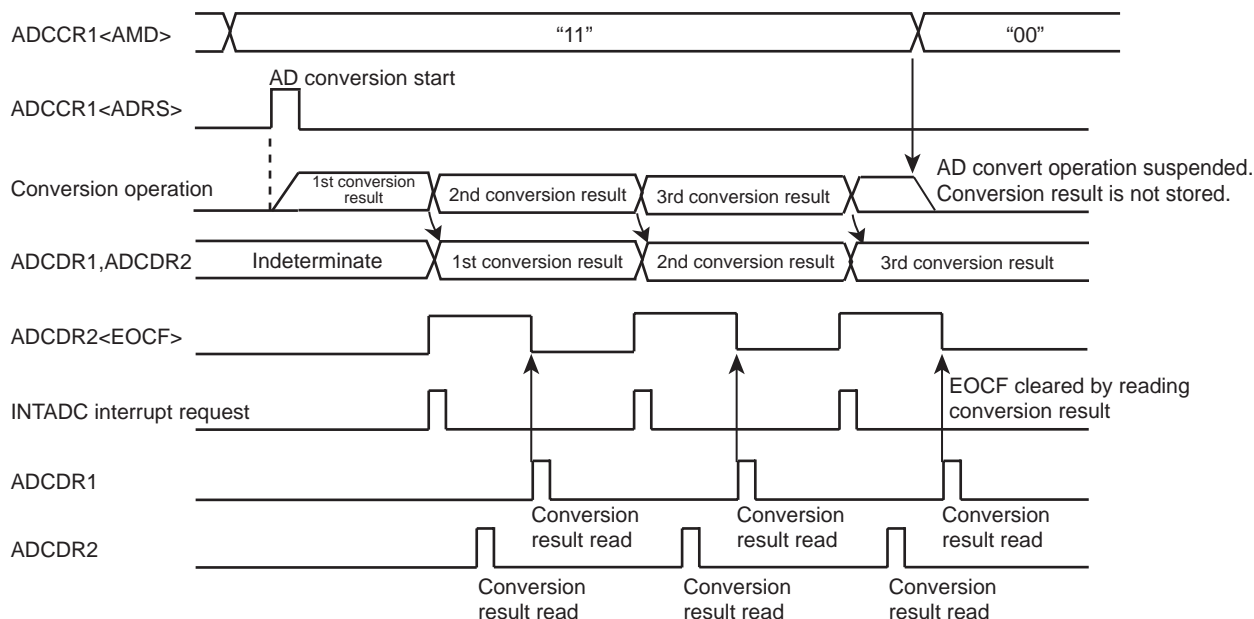


Figure 14-3 Repeat Mode

### 14.3.3 Register Setting

- Set up the AD converter control register 1 (ADCCR1) as follows:
  - Choose the channel to AD convert using AD input channel select (SAIN).
  - Specify analog input enable for analog input control (AINDS).
  - Specify AMD for the AD converter control operation mode (software or repeat mode).
- Set up the AD converter control register 2 (ADCCR2) as follows:
  - Set the AD conversion time using AD conversion time (ACK). For details on how to set the conversion time, refer to Figure 14-1 and AD converter control register 2.
  - Choose IREFON for DA converter control.
- After setting up (1) and (2) above, set AD conversion start (ADRS) of AD converter control register 1 (ADCCR1) to "1". If software start mode has been selected, AD conversion starts immediately.
- After an elapse of the specified AD conversion time, the AD converted value is stored in AD converted value register 1 (ADCDR1) and the AD conversion finished flag (EOCF) of AD converted value register 2 (ADCDR2) is set to "1", upon which time AD conversion interrupt INTADC is generated.
- EOCF is cleared to "0" by a read of the conversion result. However, if reconverted before a register read, although EOCF is cleared the previous conversion result is retained until the next conversion is completed.

Example :After selecting the conversion time 19.5  $\mu$ s at 16 MHz and the analog input channel AIN3 pin, perform AD conversion once. After checking EOCF, read the converted value, store the lower 2 bits in address 0009EH and store the upper 8 bits in address 0009FH in RAM. The operation mode is software start mode.

```

: (port setting)      : ;Set port register appropriately before setting AD
                        : converter registers.
:                    : (Refer to section I/O port in details)
LD      (ADCCR1) , 00100011B ; Select AIN3
LD      (ADCCR2) , 11011000B ;Select conversion time(312/fc) and operation
                                mode
SLOOP : SET      (ADCCR1) . 7 ; ADRS = 1(AD conversion start)
        TEST     (ADCCR2) . 5 ; EOCF= 1 ?
        JRS      T, SLOOP
        LD      A , (ADCCR2) ; Read result data
        LD      (9EH) , A
        LD      A , (ADCCR1) ; Read result data
        LD      (9FH), A
```



14.4 STOP/SLOW Modes during AD Conversion

When standby mode (STOP or SLOW mode) is entered forcibly during AD conversion, the AD convert operation is suspended and the AD converter is initialized (ADCCR1 and ADCCR2 are initialized to initial value). Also, the conversion result is indeterminate. (Conversion results up to the previous operation are cleared, so be sure to read the conversion results before entering standby mode (STOP or SLOW mode).) When restored from standby mode (STOP or SLOW mode), AD conversion is not automatically restarted, so it is necessary to restart AD conversion. Note that since the analog reference voltage is automatically disconnected, there is no possibility of current flowing into the analog reference voltage.





## 14.6 Precautions about AD Converter

### 14.6.1 Analog input pin voltage range

Make sure the analog input pins (AIN0 to AIN7) are used at voltages within VAREF to AVSS. If any voltage outside this range is applied to one of the analog input pins, the converted value on that pin becomes uncertain. The other analog input pins also are affected by that.

### 14.6.2 Analog input shared pins

The analog input pins (AIN0 to AIN7) are shared with input/output ports. When using any of the analog inputs to execute AD conversion, do not execute input/output instructions for all other ports. This is necessary to prevent the accuracy of AD conversion from degrading. Not only these analog input shared pins, some other pins may also be affected by noise arising from input/output to and from adjacent pins.

### 14.6.3 Noise Countermeasure

The internal equivalent circuit of the analog input pins is shown in Figure 14-5. The higher the output impedance of the analog input source, more easily they are susceptible to noise. Therefore, make sure the output impedance of the signal source in your design is 5 k $\Omega$  or less. Toshiba also recommends attaching a capacitor external to the chip.

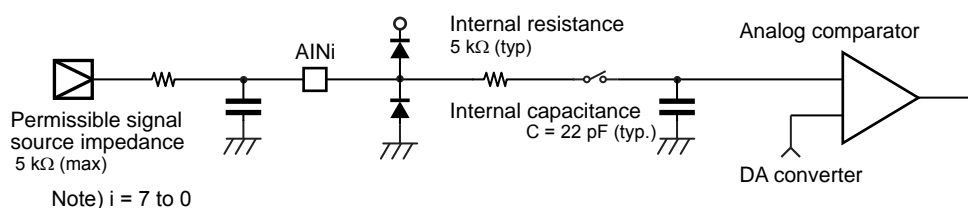


Figure 14-5 Analog Input Equivalent Circuit and Example of Input Pin Processing





Also, each level of the STOP2 to STOP5 pins can be confirmed by reading corresponding I/O port data register, check all STOP2 to STOP5 pins "H" that is enabled by STOPPCR before the STOP mode is started (Note2,3).

Note 1: When the STOP mode released by the edge release mode (SYSCR1<RELM> = "0"), inhibit input from STOP2 to STOP5 pins by Key-on Wakeup Control Register (STOPPCR) or must be set "H" level into STOP2 to STOP5 pins that are available input during STOP mode.

Note 2: When the  $\overline{\text{STOP}}$  pin input is high or STOP2 to STOP5 pins input which is enabled by STOPPCR is low, executing an instruction which starts STOP mode will not place in STOP mode but instead will immediately start the release sequence (Warm up).

Note 3: The input circuit of Key-on Wakeup input and Port input is separated, so each input voltage threshold value is different. Therefore, a value comes from port input before STOP mode start may be different from a value which is detected by Key-on Wakeup input (Figure 15-2).

Note 4:  $\overline{\text{STOP}}$  pin doesn't have the control register such as STOPPCR, so when STOP mode is released by STOP2 to STOP5 pins,  $\overline{\text{STOP}}$  pin also should be used as STOP mode release function.

Note 5: In STOP mode, Key-on Wakeup pin which is enabled as input mode (for releasing STOP mode) by Key-on Wakeup Control Register (STOPPCR) may generate the penetration current, so the said pin must be disabled AD conversion input (analog voltage input).

Note 6: When the STOP mode is released by STOP2 to STOP5 pins, the level of  $\overline{\text{STOP}}$  pin should hold "L" level (Figure 15-3).

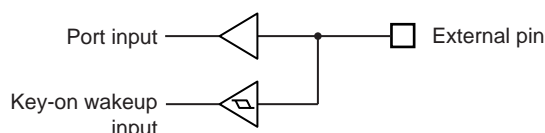


Figure 15-2 Key-on Wakeup Input and Port Input

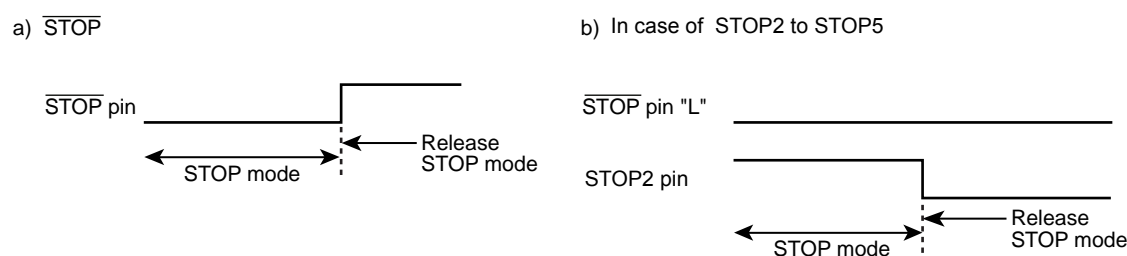


Figure 15-3 Priority of  $\overline{\text{STOP}}$  pin and STOP2 to STOP5 pins

Table 15-1 Release level (edge) of STOP mode

Pin name	Release level (edge)	
	SYSCR1<RELM>="1" (Note2)	SYSCR1<RELM>="0"
$\overline{\text{STOP}}$	"H" level	Rising edge
STOP2	"L" level	Don't use (Note1)
STOP3	"L" level	Don't use (Note1)
STOP4	"L" level	Don't use (Note1)
STOP5	"L" level	Don't use (Note1)

## 16. LCD Driver

The TMP86FS28DFG has a driver and control circuit to directly drive the liquid crystal device (LCD). The pins to be connected to LCD are as follows:

1. Segment output port 40 pins (SEG39 to SEG0)
2. Common output port 4 pins (COM3 to COM0)

In addition, C0, C1, V1, V2, V3 pin are provided for the LCD driver's booster circuit.

The devices that can be directly driven is selectable from LCD of the following drive methods:

1. 1/4 Duty (1/3 Bias) LCD Max 160 Segments(8 segments × 20 digits)
2. 1/3 Duty (1/3 Bias) LCD Max 120 Segments(8 segments × 15 digits)
3. 1/2 Duty (1/2 Bias) LCD Max 80 Segments(8 segments × 10 digits)
4. Static LCD Max 40 Segments(8 segments × 5 digits)

### 16.1 Configuration

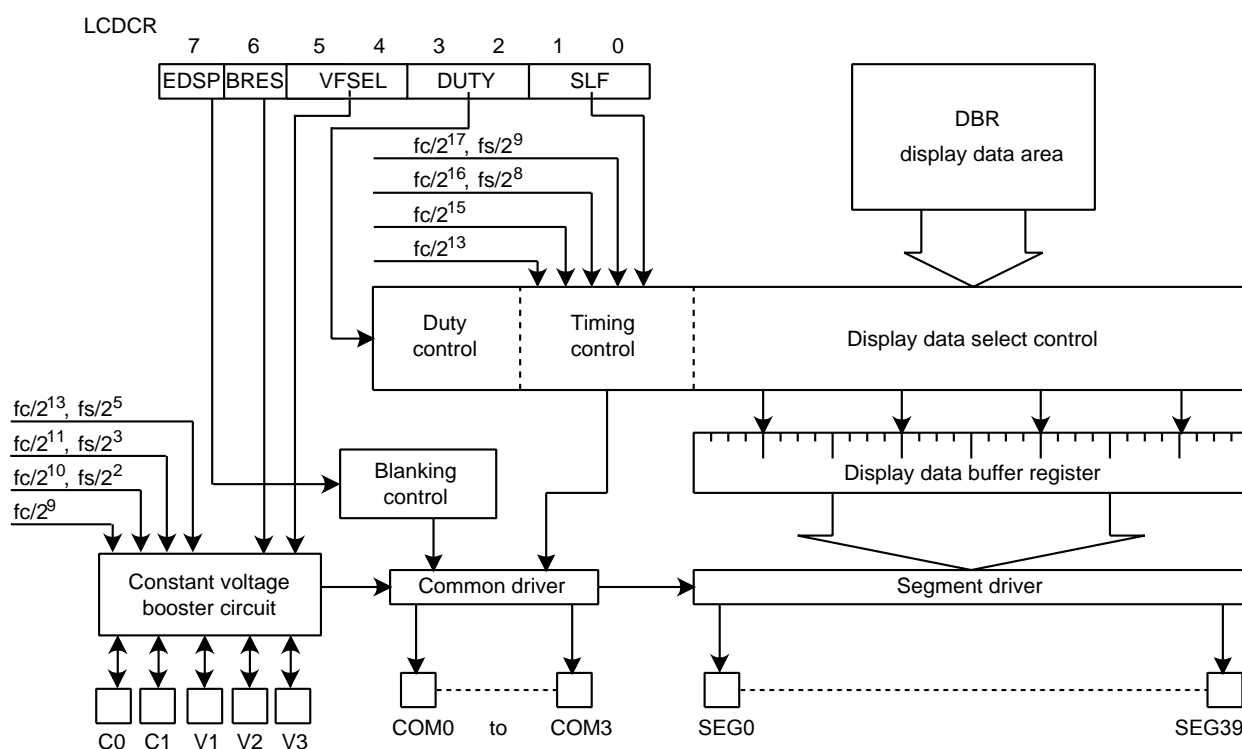


Figure 16-1 LCD Driver

Note: The LCD driver incorporates a dedicated divider circuit. Therefore, the break function of a debugger (development tool) will not stop LCD driver output.

## 16.2 Control

The LCD driver is controlled using the LCD control register (LCDCR). The LCD driver's display is enabled using the EDSP.

## LCD Driver Control Register

LCDCR (0FD9H)	7	6	5	4	3	2	1	0	
	EDSP	BRES	VFSEL		DUTY		SLF		(Initial value: 0000 0000)

EDSP	LCD Display Control	0: Blanking 1: Enables LCD display (Blanking is released)			R/W	
BRES	Booster circuit control	0: Disable (use divider resistance) 1: Enable				
VFSEL	Selection of boost frequency		NORMAL 1/2, IDLE/1/2 mode			SLOW1/2, SLEEP0/1/2 mode
			DV7CK = 0	DV7CK = 1		
		00	$fc/2^{13}$	$fs/2^5$		$fs/2^5$
		01	$fc/2^{11}$	$fs/2^3$		$fs/2^3$
		10	$fc/2^{10}$	$fs/2^2$		$fs/2^2$
		11	$fc/2^9$	$fc/2^9$		—
DUTY	Selection of driving methods	00: 1/4 Duty (1/3 Bias) 01: 1/3 Duty (1/3 Bias) 10: 1/2 Duty (1/2 Bias) 11: Static				
SLF	Selection of LCD frame frequency		NORMAL 1/2, IDLE/1/2 mode			SLOW1/2, SLEEP0/1/2 mode
			DV7CK = 0	DV7CK = 1		
		00	$fc/2^{17}$	$fs/2^9$		$fs/2^9$
		01	$fc/2^{16}$	$fs/28$		$fs/2^8$
		10	$fc/2^{15}$	$fc/2^{15}$		—
		11	$fc/2^{13}$	$fc/2^{13}$		—

Note 1: When <BRES>(Booster circuit control) is set to "0",  $V_{DD} \geq V_3 \geq V_2 \geq V_1 \geq V_{SS}$  should be satisfied.

When <BRES> is set to "1",  $5.5 [V] \geq V_3 \geq V_{DD}$  should be satisfied.

If these conditions are not satisfied, it not only affects the quality of LCD display but also may damage the device due to over voltage of the port.

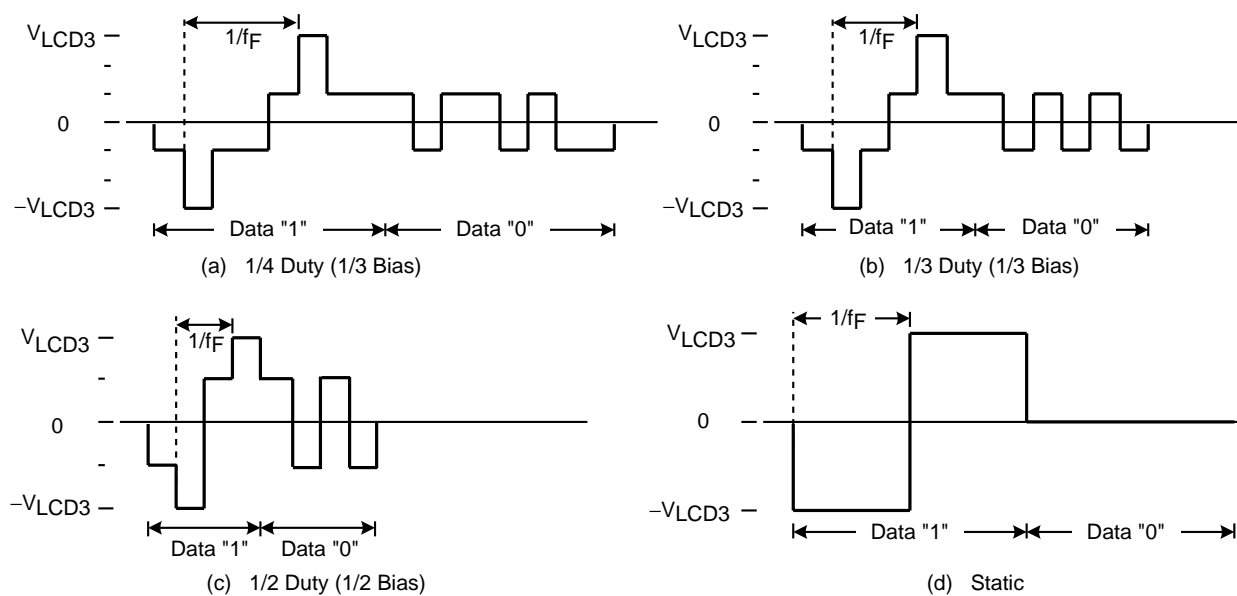
Note 2: When used as the booster circuit, bias should be composed to 1/3. Therefore, do not set LCDCR<DUTY> to "10" or "11" when the booster circuit is enable.

Note 3: Do not set SLF to "10" or "11" in SLOW1/2 modes.

Note 4: Do not set VFSEL to "11" SLOW1/2 modes.

### 16.2.1 LCD driving methods

As for LCD driving method, 4 types can be selected by LCDCR<DUTY>. The driving method is initialized in the initial program according to the LCD used.



Note 1:  $f_F$ : Frame frequency

Note 2:  $V_{LCD3}$ : LCD drive voltage

Figure 16-2 LCD Drive Waveform (COM-SEG pins)

## 16.2.2 Frame frequency

Frame frequency ( $f_F$ ) is set according to driving method and base frequency as shown in the following Table 16-1. The base frequency is selected by LCDCCR<SLF> according to the frequency  $f_c$  and  $f_s$  of the basic clock to be used.

Table 16-1 Setting of LCD Frame Frequency

(a) At the single clock mode. At the dual clock mode (DV7CK = 0).

SLF	Base frequency [Hz]	Frame frequency [Hz]			
		1/4 Duty	1/3 Duty	1/2 Duty	Static
00	$\frac{f_c}{2^{17}}$	$\frac{f_c}{2^{17}}$	$\frac{4}{3} \cdot \frac{f_c}{2^{17}}$	$\frac{4}{2} \cdot \frac{f_c}{2^{17}}$	$\frac{f_c}{2^{17}}$
	( $f_c = 16$ MHz)	122	163	244	122
	( $f_c = 8$ MHz)	61	81	122	61
01	$\frac{f_c}{2^{16}}$	$\frac{f_c}{2^{16}}$	$\frac{4}{3} \cdot \frac{f_c}{2^{16}}$	$\frac{4}{2} \cdot \frac{f_c}{2^{16}}$	$\frac{f_c}{2^{16}}$
	( $f_c = 8$ MHz)	122	163	244	122
	( $f_c = 4$ MHz)	61	81	122	61
10	$\frac{f_c}{2^{15}}$	$\frac{f_c}{2^{15}}$	$\frac{4}{3} \cdot \frac{f_c}{2^{15}}$	$\frac{4}{2} \cdot \frac{f_c}{2^{15}}$	$\frac{f_c}{2^{15}}$
	( $f_c = 4$ MHz)	122	163	244	122
	( $f_c = 2$ MHz)	61	81	122	61
11	$\frac{f_c}{2^{13}}$	$\frac{f_c}{2^{13}}$	$\frac{4}{3} \cdot \frac{f_c}{2^{13}}$	$\frac{4}{2} \cdot \frac{f_c}{2^{13}}$	$\frac{f_c}{2^{13}}$
	( $f_c = 1$ MHz)	122	163	244	122

Note:  $f_c$ : High-frequency clock [Hz]

Table 16-2

(b) At the dual clock mode (DV7CK = 1 or SYSCK = 1)

SLF	Base frequency [Hz]	Frame frequency [Hz]			
		1/4 Duty	1/3 Duty	1/2 Duty	Static
00	$\frac{f_s}{2^9}$	$\frac{f_s}{2^9}$	$\frac{4}{3} \cdot \frac{f_s}{2^9}$	$\frac{4}{2} \cdot \frac{f_s}{2^9}$	$\frac{f_s}{2^9}$
	( $f_s = 32.768$ kHz)	64	85	128	64
01	$\frac{f_s}{2^8}$	$\frac{f_s}{2^8}$	$\frac{4}{3} \cdot \frac{f_s}{2^8}$	$\frac{4}{2} \cdot \frac{f_s}{2^8}$	$\frac{f_s}{2^8}$
	( $f_s = 32.768$ kHz)	128	171	256	128

Note:  $f_s$ : Low-frequency clock [Hz]



### 16.2.3 Driving method for LCD driver

In the TMP86FS28DFG, LCD driving voltages can be generated using either an internal booster circuit or an external resistor divider. This selection is made in LCDCR<BRES>.

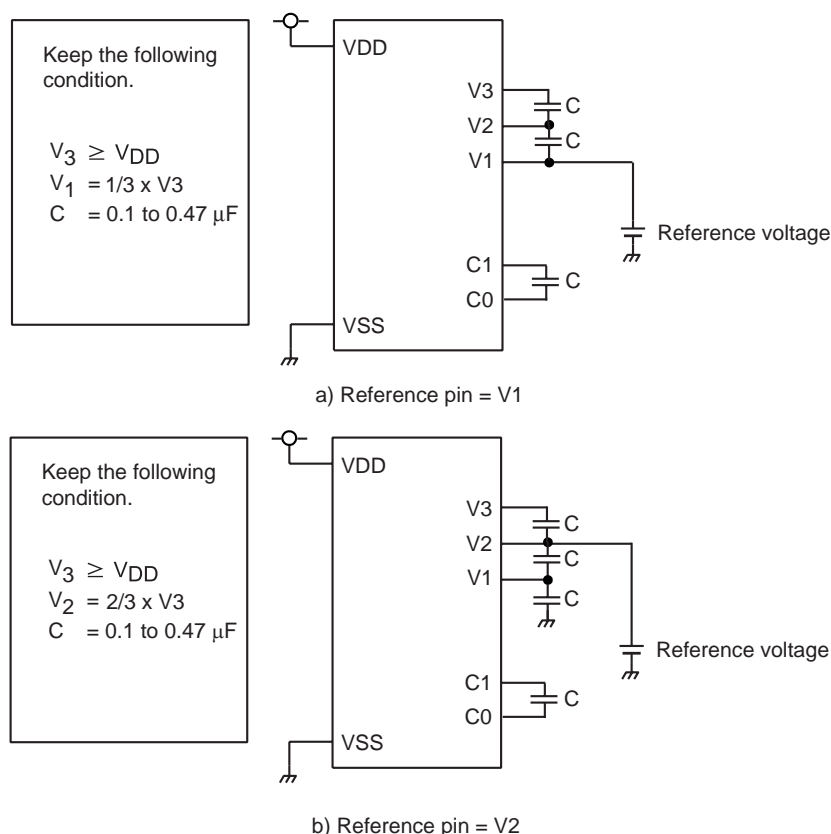
#### 16.2.3.1 When using the booster circuit (LCDCR<BRES>="1")

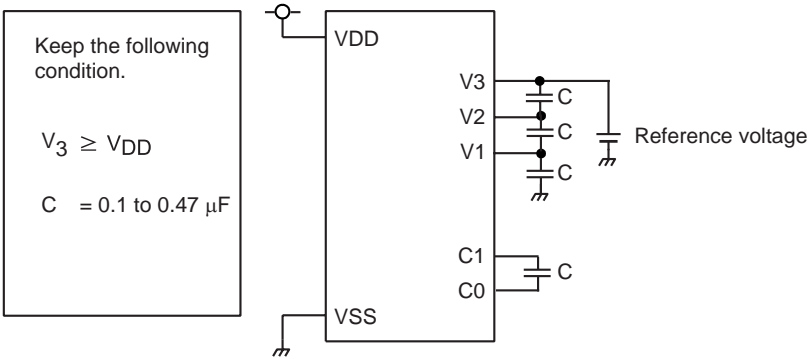
When the reference voltage is connected to the V1 pin, the booster circuit boosts the reference voltage twofold (V2) or threefold (V3) to generate the output voltages for segment/common signals. When the reference voltage is connected to the V2 pin, it is reduced to 1/2 (V1) or boosted to 3/2 (V3). When the reference voltage is connected to the V3 pin, it is reduced to 1/3 (V1) or 2/3 (V2).

LCDCR<VFSEL> is used to select the reference frequency in the booster circuit. The faster the boosting frequency, the higher the segment/common drive capability, but power consumption is increased. Conversely, the slower the boosting frequency, the lower the segment/common drive capability, but power consumption is reduced. If the drive capability is insufficient, the LCD may not be displayed clearly. Therefore, select an optimum boosting frequency for the LCD panel to be used.

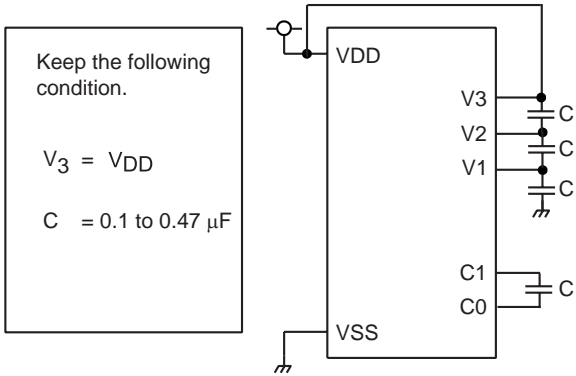
Table 16-3 shows the V3 pin current capacity and boosting frequency.

Note: When used as the booster circuit, bias should be composed to 1/3. Therefore, do not set LCDCR<DUTY> to "10" or "11" when the booster circuit is enable (LCDCR<BRES>="1").





c) Reference pin = V3



d) Reference pin = V3

- Note 1: When the TMP86FS28DFG uses the booster circuit to drive the LCD, the power supply and capacitor for the booster circuit should be connected as shown above.
- Note 2: When the reference voltage is connected to a pin other than V1, add a capacitor between V1 and GND.
- Note 3: The connection examples shown above are different from those shown in the datasheets of the previous version. Since the above connection method enhances the boosting characteristics, it is recommended that new boards be designed using the above connection method. (Using the existing connection method does not affect LCD display.)

Figure 16-3 Connection Examples When Using the Booster Circuit (LCDCR<BRES> = "1")

Table 16-3 V3 Pin Current Capacity and Boosting Frequency (typ.)

VFSEL	Boosting frequency	fc = 16 MHz	fc = 8 MHz	fc = 4 MHz	fc = 32.768 MHz
00	fc/2 <sup>13</sup> or fs/2 <sup>5</sup>	−37 mV/ μA	−80 mV/ μA	−138 mV/ μA	−76 mV/ μA
01	fc/2 <sup>11</sup> or fs/2 <sup>3</sup>	−19 mV/ μA	−24 mV/ μA	−37 mV/ μA	−23 mV/ μA
10	fc/2 <sup>10</sup> or fs/2 <sup>2</sup>	−17 mV/ μA	−19 mV/ μA	−24 mV/ μA	−18 mV/ μA
11	fc/2 <sup>9</sup>	−16 mV/ μA	−17 mV/ μA	−19 mV/ μA	—

- Note 1: The current capacity is the amount of voltage that falls per 1μA.
- Note 2: The boosting frequency should be selected depending on your LCD panel.
- Note 3: For the reference pin V1 or V2, a current capacity ten times larger than the above is recommended to ensure stable operation.
- For example, when the boosting frequency is fc/2<sup>9</sup> (at fc = 8 MHz), −1.7 mV/ μA or more is recommended for the current capacity of the reference pin V1.

16.2.3.2 When using an external resistor divider (LCDCR<BRES>="0")

When an external resistor divider is used, the voltage of an external power supply is divided and input on V1, V2, and V3 to generate the output voltages for segment/common signals.

The smaller the external resistor value, the higher the segment/common drive capability, but power consumption is increased. Conversely, the larger the external resistor value, the lower the segment/common drive capability, but power consumption is reduced. If the drive capability is insufficient, the LCD may not be displayed clearly. Therefore, select an optimum resistor value for the LCD panel to be used.

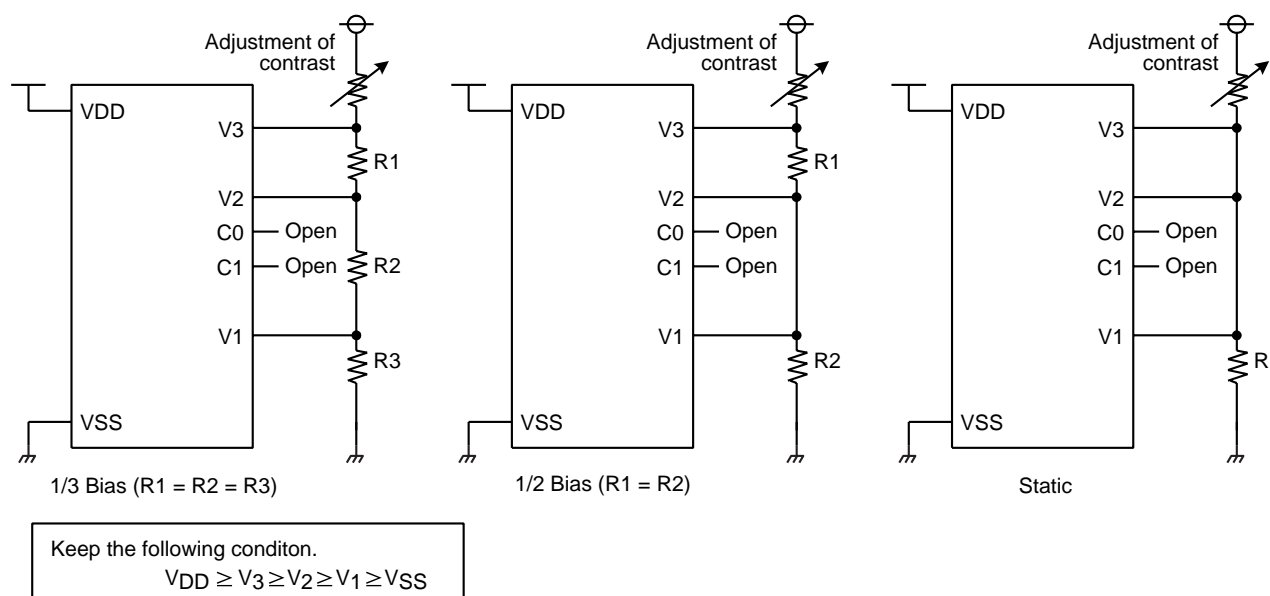


Figure 16-4 Connection Examples When Using an External Resistor Divider  
 (LCDCR<BRES> = "0")

## 16.3 LCD Display Operation

### 16.3.1 Display data setting

Display data is stored to the display data area (assigned to address 0FC0H to 0FD3H, 20bytes) in the DBR. The display data which are stored in the display data area is automatically read out and sent to the LCD driver by the hardware. The LCD driver generates the segment signal and common signal according to the display data and driving method. Therefore, display patterns can be changed by only over writing the contents of display data area by the program. Table 16-5 shows the correspondence between the display data area and SEG/COM pins.

LCD light when display data is "1" and turn off when "0". According to the driving method of LCD, the number of pixels which can be driven becomes different, and the number of bits in the display data area which is used to store display data also becomes different.

Therefore, the bits which are not used to store display data as well as the data buffer which corresponds to the addresses not connected to LCD can be used to store general user process data (see Table 16-4).

Note: The display data memory contents become unstable when the power supply is turned on; therefore, the display data memory should be initialized by an initiation routine.

Table 16-4 Driving Method and Bit for Display Data

Driving methods	Bit 7/3	Bit 6/2	Bit 5/1	Bit 4/0
1/4 Duty	COM3	COM2	COM1	COM0
1/3 Duty	—	COM2	COM1	COM0
1/2 Duty	—	—	COM1	COM0
Static	—	—	—	COM0

Note: –: This bit is not used for display data

Table 16-5 LCD Display Data Area (DBR)

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0FC0H	SEG1				SEG0			
0FC1H	SEG3				SEG2			
0FC2H	SEG5				SEG4			
0FC3H	SEG7				SEG6			
0FC4H	SEG9				SEG8			
0FC5H	SEG11				SEG10			
0FC6H	SEG13				SEG12			
0FC7H	SEG15				SEG14			
0FC8H	SEG17				SEG16			
0FC9H	SEG19				SEG18			
0FCAH	SEG21				SEG20			
0FCBH	SEG23				SEG22			
0FCH	SEG25				SEG24			
0FCDH	SEG27				SEG26			
0FCEH	SEG29				SEG28			
0FCFH	SEG31				SEG30			
0FD0H	SEG33				SEG32			
0FD1H	SEG35				SEG34			
0FD2H	SEG37				SEG36			
0FD3H	SEG39				SEG38			
	COM3	COM2	COM1	COM0	COM3	COM2	COM1	COM0

### 16.3.2 Blanking

Blanking is enabled when EDSP is cleared to “0”.

Blanking turns off LCD through outputting a GND level to SEG/COM pin.

When in STOP mode, EDSP is cleared to “0” and automatically blanked. To redisplay ICD after exiting STOP mode, it is necessary to set EDSP back to “1”.

Note: During reset, the LCD common outputs are fixed “0” level. But the multiplex terminal of input/output port and LCD segment output becomes high impedance. Therefore, when the reset input is long remarkably, ghost problem may appear in LCD display.

# 16.4 Control Method of LCD Driver

## 16.4.1 Initial setting

Figure 16-5 shows the flowchart of initialization.

Example : To operate a 1/4 duty LCD of 40 segments  $\times$  4 com-mons at frame frequency  $fc/2^{16}$  [Hz], and booster frequency  $fc/2^{13}$  [Hz]

LD	(LCDCR), 01000001B	; Sets LCD driving method and frame frequency. Boost frequency
LD	(P*LCR), 0FFH	; Sets segment output control register. (*; Port No.)
:	:	
:	:	; Sets the initial value of display data.
LD	(LCDCR), 11000001B	; Display enable

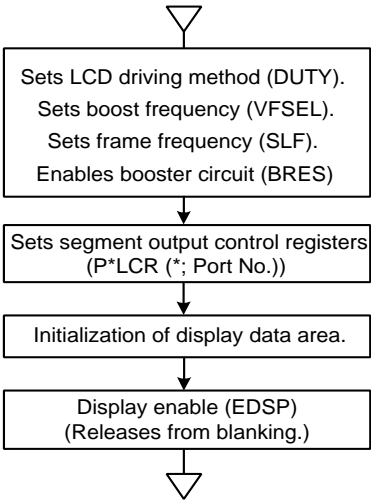


Figure 16-5 Initial Setting of LCD Driver

## 16.4.2 Store of display data

Generally, display data are prepared as fixed data in program memory (ROM) and stored in display data area by load command.

Example :To display using 1/4 duty LCD a numerical value which corresponds to the LCD data stored in data memory at address 80H (when pins COM and SEG are connected to LCD as in Figure 16-6), display data become as shown in Table 16-6.

```
LD      A, (80H)
ADD     A, TABLE-$-7
LD      HL, 0F80H
LD      W, (PC + A)
LD      (HL), W
RET

TABLE:  DB      11011111B, 00000110B,
              11100011B, 10100111B,
              00110110B, 10110101B,
              11110101B, 00010111B,
              11110111B, 10110111B
```

Note: DB is a byte data difinition instruction.



Figure 16-6 Example of COM, SEG Pin Connection (1/4 Duty)

Table 16-6 Example of Display Data (1/4 Duty)

No.	display	Display data	No.	display	Display data
0		11011111	5		10110101
1		00000110	6		11110101
2		11100011	7		00000111
3		10100111	8		11110111
4		00110110	9		10110111

Example 2: Table 16-6 shows an example of display data which are displayed using 1/2 duty LCD in the same way as Table 16-7. The connection between pins COM and SEG are the same as shown in Figure 16-7.

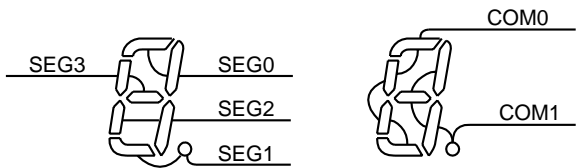


Figure 16-7 Example of COM, SEG Pin Connection

Table 16-7 Example of Display Data (1/2 Duty)

Number	Display data		Number	Display data	
	High order address	Low order address		High order address	Low order address
0	**01**11	**01**11	5	**11**10	**01**01
1	**00**10	**00**10	6	**11**11	**01**01
2	**10**01	**01**11	7	**01**10	**00**11
3	**10**10	**01**11	8	**11**11	**01**11
4	**11**10	**00**10	9	**11**10	**01**11

Note: \*: Don't care

### 16.4.3 Example of LCD drive output

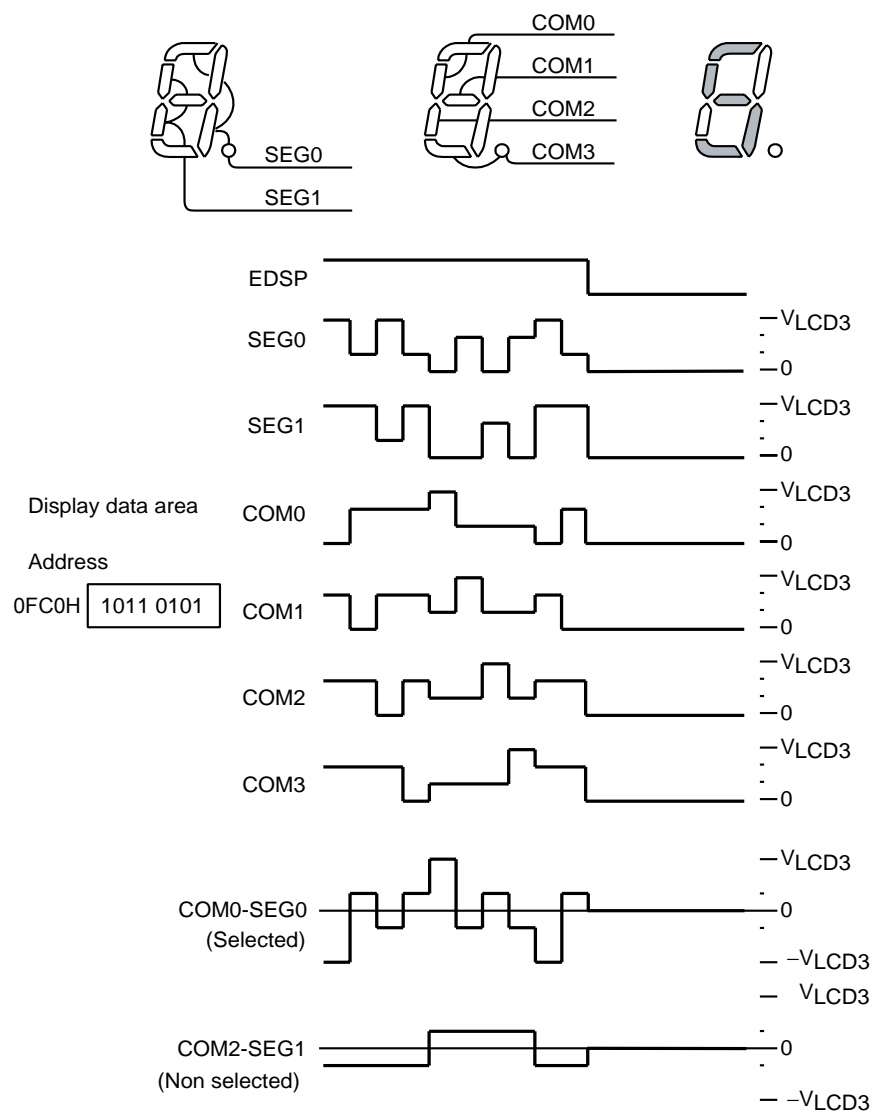


Figure 16-8 1/4 Duty (1/3 bias) Drive



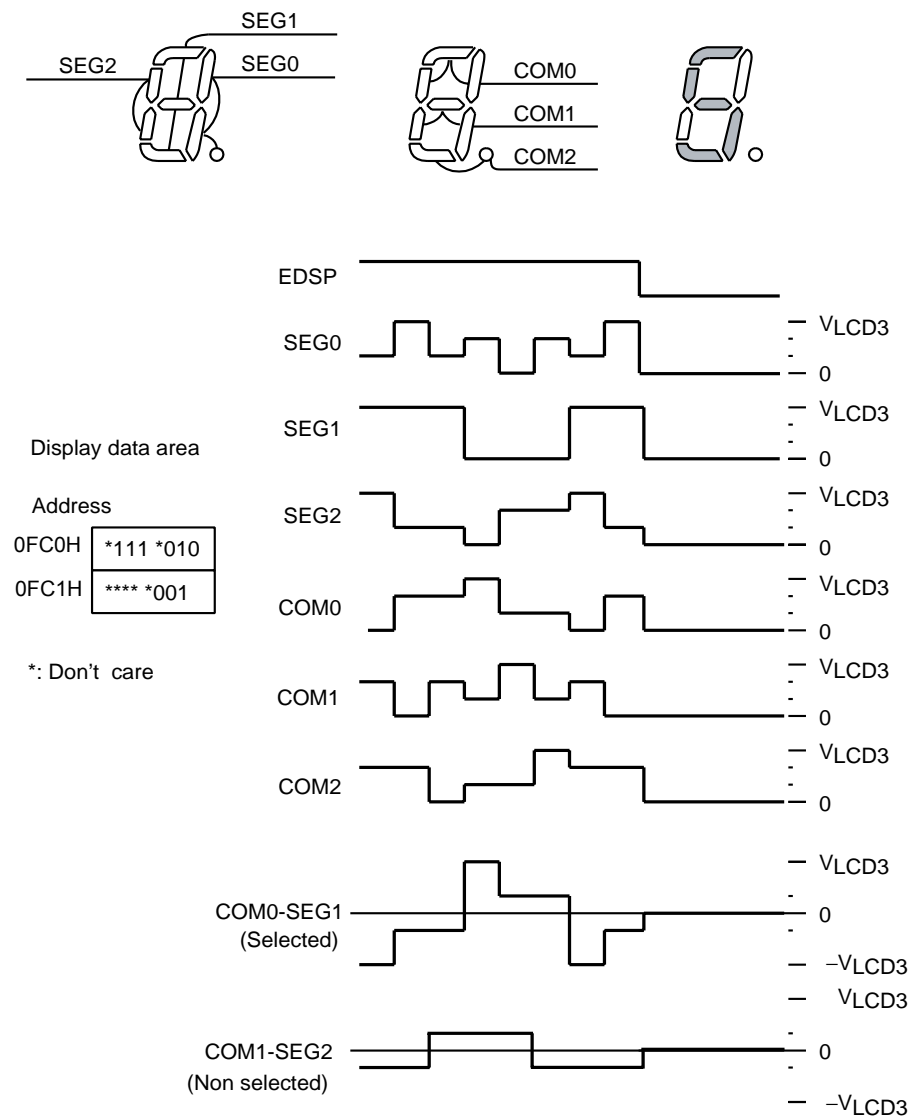


Figure 16-9 1/3 Duty (1/3 bias) Drive

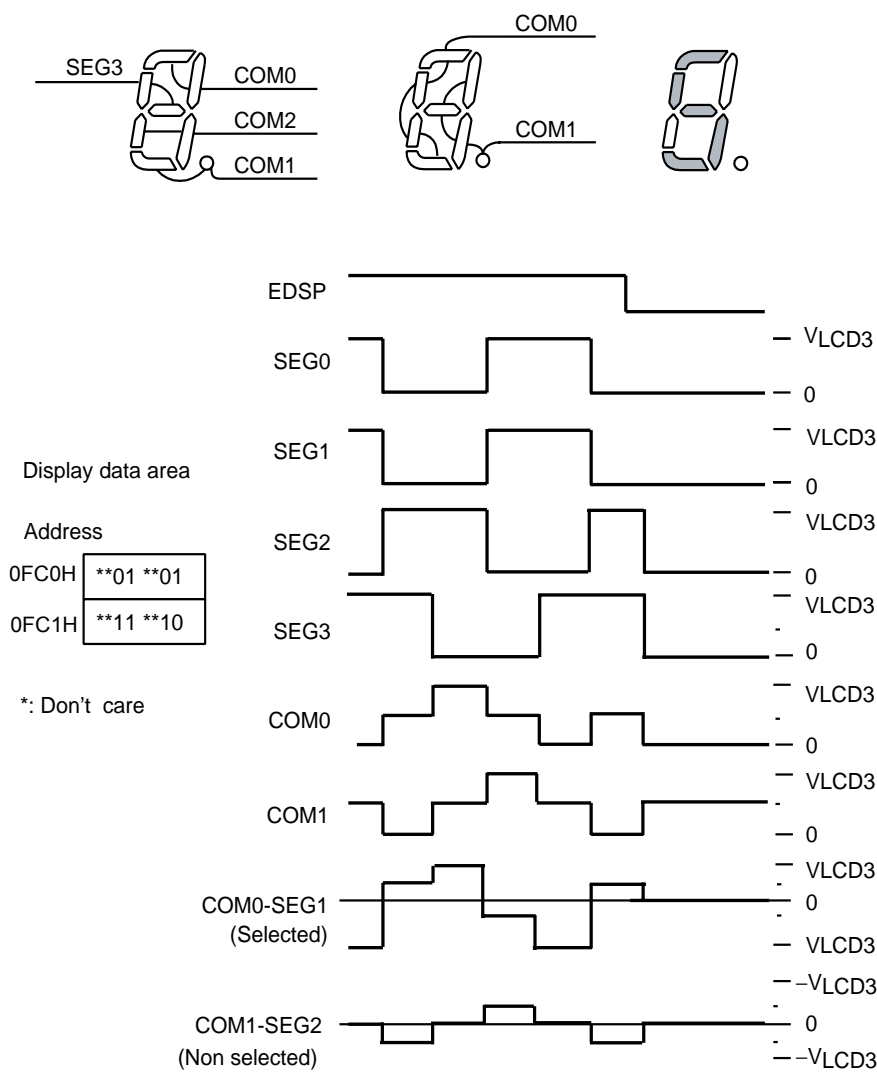


Figure 16-10 1/2 Duty (1/2 bias) Drive

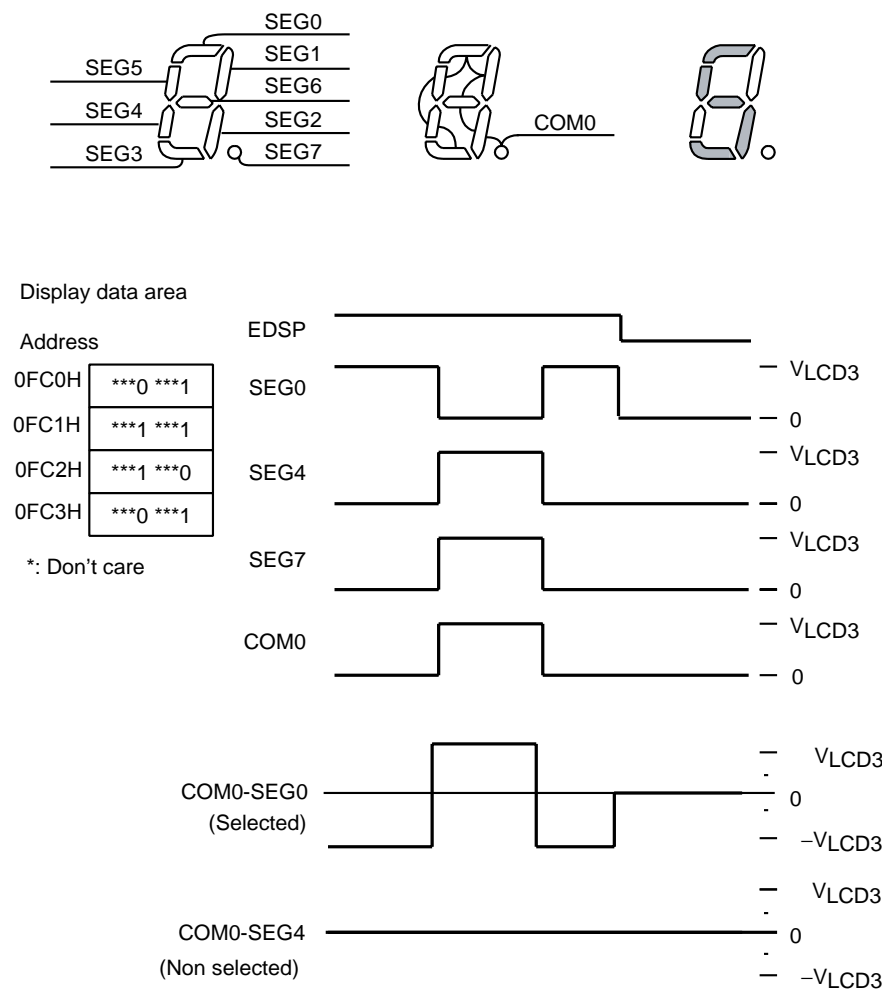


Figure 16-11 Static Drive



## 17. Flash Memory

TMP86FS28DFG has 61440byte flash memory (address: 1000H to FFFFH). The write and erase operations to the flash memory are controlled in the following three types of mode.

- MCU mode

The flash memory is accessed by the CPU control in the MCU mode. This mode is used for software bug correction and firmware change after shipment of the device since the write operation to the flash memory is available by retaining the application behavior.

- Serial PROM mode

The flash memory is accessed by the CPU control in the serial PROM mode. Use of the serial interface (UART) enables the flash memory to be controlled by the small number of pins. TMP86FS28DFG in the serial PROM mode supports on-board programming which enables users to program flash memory after the microcontroller is mounted on a user board.

- Parallel PROM mode

The parallel PROM mode allows the flash memory to be accessed as a stand-alone flash memory by the program writer provided by the third party. High-speed access to the flash memory is available by controlling address and data signals directly. For the support of the program writer, please ask Toshiba sales representative.

In the MCU and serial PROM modes, the flash memory control register (FLSCR) is used for flash memory control. This chapter describes how to access the flash memory using the flash memory control register (FLSCR) in the MCU and serial PROM modes.

## 17.1 Flash Memory Control

The flash memory is controlled via the flash memory control register (FLSCR) and flash memory standby control register (FLSSTB).

### Flash Memory Control Register

FLSCR	7	6	5	4	3	2	1	0	
(0FAFH)	FLSMD				BANKSEL				(Initial value : 1100 1***)

FLSMD	Flash memory command sequence execution control	1100: Disable command sequence execution 0011: Enable command sequence execution Others: Reserved	R/W
BANKSEL	Flash memory bank select control (Serial PROM mode only)	0: Select BANK0 1: Select BANK1	R/W

Note 1: The command sequence of the flash memory can be executed only when FLSMD="0011B". In other cases, any attempts to execute the command sequence are ineffective.

Note 2: FLSMD must be set to either "1100B" or "0011B".

Note 3: BANKSEL is effective only in the serial PROM mode. In the MCU mode, the flash memory is always accessed with actual addresses (1000-FFFFH) regardless of BANKSEL.

Note 4: Bits 2 through 0 in FLSCR are always read as don't care.

### Flash Memory Standby Control Register

FLSSTB	7	6	5	4	3	2	1	0	
(0FADH)								FSTB	(Initial value : **** **0)

FSTB	Flash memory standby control	0: Disable the standby function. 1: Enable the standby function.	Write only
------	------------------------------	---	------------

Note 1: When FSTB is set to 1, do not execute the read/write instruction to the flash memory because there is a possibility that the expected data is not read or the program is not operated correctly. If executing the read/write instruction, FSTB is initialized to 0 automatically.

Note 2: If an interrupt is issued when FSTB is set to 1, FSTB is initialized to 0 automatically and then the vector area of the flash memory is read.

Note 3: If the IDLE0/1/2, SLEEP0/1/2 or STOP mode is activated when FSTB is set to 1, FSTB is initialized to 0 automatically. In the IDLE0/1/2, SLEEP0/1/2 or STOP mode, the standby function operates regardless of FSTB setting.

#### 17.1.1 Flash Memory Command Sequence Execution Control (FLSCR<FLSMD>)

The flash memory can be protected from inadvertent write due to program error or microcontroller misoperation. This write protection feature is realized by disabling flash memory command sequence execution via the flash memory control register (write protect). To enable command sequence execution, set FLSCR<FLSMD> to "0011B". To disable command sequence execution, set FLSCR<FLSMD> to "1100B". After reset, FLSCR<FLSMD> is initialized to "1100B" to disable command sequence execution. Normally, FLSCR<FLSMD> should be set to "1100B" except when the flash memory needs to be written or erased.

#### 17.1.2 Flash Memory Bank Select Control (FLSCR<BANKSEL>)

In the serial PROM mode, a 2-kbyte BOOTROM is mapped to addresses 7800H-7FFFH and the flash memory is mapped to 2 banks at 8000H-FFFFH. Flash memory addresses 1000H-7FFFH are mapped to 9000H-FFFFH as BANK0, and flash memory addresses 8000H-FFFFH are mapped to 8000H-FFFFH as BANK1. FLSCR<BANKSEL> is used to switch between these banks. For example, to access the flash memory address 7000H, set FLSCR<BANKSEL> to "0" and then access F000H. To access the flash memory address 9000H, set FLSCR<BANKSEL> to "1" and then access 9000H.

In the MCU mode, the flash memory is accessed with actual addresses at 1000H-FFFFH. In this case, FLSCR<BANKSEL> is ineffective (i.e., its value has no effect on other operations).

Table 17-1 Flash Memory Access

Operating Mode	FLSCR <BANKSEL>	Access Area	Specified Address
MCU mode	Don't care	1000H-FFFFH	
Serial PROM mode	0 (BANK0)	1000H-7FFFH	9000H-FFFFH
	1 (BANK1)	8000H-FFFFH	

### 17.1.3 Flash Memory Standby Control (FLSSTB<FSTB>)

Low power consumption is enabled by cutting off the steady-state current of the flash memory. In the IDLE0/1/2, SLEEP0/1/2 or STOP mode, the steady-state current of the flash memory is cut off automatically.

When the program is executed in the RAM area (without accessing the flash memory) in the NORMAL 1/2 or SLOW1/2 mode, the current can be cut off by the control of the register. To cut off the steady-state current of the flash memory, set FLSSTB<FSTB> to “1” by the control program in the RAM area. The procedures for controlling the FLSSTB register are explained below.

(Steps 1 and 2 are controlled by the program in the flash memory, and steps 3 through 8 are controlled by the write control program executed in the RAM area.)

1. Transfer the control program of the FLSSTB register to the RAM area.
2. Jump to the RAM area.
3. Disable (DI) the interrupt master enable flag (IMF = “0”).
4. Set FLSSTB<FSTB> to “1”.
5. Execute the user program.
6. Repeat step 5 until the return request to the flash memory is detected.
7. Set FLSSTB<FSTB> to “0”.
8. Jump to the flash memory area.

Note 1: The standby function is not operated by setting FLSSTB<FSTB> with the program in the flash memory. You must set FLSSTB<FSTB> by the program in the RAM area.

Note 2: To use the standby function by setting FLSSTB<FSTB> to “1” with the program in the RAM area, FLSSTB<FSTB> must be set to “0” by the program in the RAM area before returning the program control to the flash memory. If the program control is returned to the flash memory with FLSSTB<FSTB> set to “1”, the program may misoperate and run out of control.

## 17.2 Command Sequence

The command sequence in the MCU and the serial PROM modes consists of six commands (JEDEC compatible), as shown in Table 17-2. Addresses specified in the command sequence are recognized with the lower 12 bits (excluding BA, SA, and FF7FH used for read protection). The upper 4 bits are used to specify the flash memory area, as shown in Table 17-3.

Table 17-2 Command Sequence

	Command Sequence	1st Bus Write Cycle		2nd Bus Write Cycle		3rd Bus Write Cycle		4th Bus Write Cycle		5th Bus Write Cycle		6th Bus Write Cycle	
		Address	Data	Address	Data	Address	Data	Address	Data	Address	Data	Address	Data
1	Byte program	555H	AAH	AAAH	55H	555H	A0H	BA (Note 1)	Data (Note 1)	-	-	-	-
2	Sector Erase (4-kbyte Erase)	555H	AAH	AAAH	55H	555H	80H	555H	AAH	AAAH	55H	SA (Note 2)	30H
3	Chip Erase (All Erase)	555H	AAH	AAAH	55H	555H	80H	555H	AAH	AAAH	55H	555H	10H
4	Product ID Entry	555H	AAH	AAAH	55H	555H	90H	-	-	-	-	-	-
5	Product ID Exit	XXH	F0H	-	-	-	-	-	-	-	-	-	-
	Product ID Exit	555H	AAH	AAAH	55H	555H	F0H	-	-	-	-	-	-
6	Read Protect	555H	AAH	AAAH	55H	555H	A5H	FF7FH	00H	-	-	-	-

Note 1: Set the address and data to be written.

Note 2: The area to be erased is specified with the upper 4 bits of the address.

Table 17-3 Address Specification in the Command Sequence

Operating Mode	FLSCR <BANKSEL>	Specified Address
MCU mode	Don't care	1***H-F***H
Serial PROM mode	0 (BANK0)	9***H-F***H
	1 (BANK1)	8***H-F***H

### 17.2.1 Byte Program

This command writes the flash memory for each byte unit. The addresses and data to be written are specified in the 4th bus write cycle. Each byte can be programmed in a maximum of 40  $\mu$ s. The next command sequence cannot be executed until the write operation is completed. To check the completion of the write operation, perform read operations repeatedly until the same data is read twice from the same address in the flash memory. During the write operation, any consecutive attempts to read from the same address is reversed bit 6 of the data (toggling between 0 and 1).

Note: To rewrite data to Flash memory addresses at which data (including FFH) is already written, make sure to erase the existing data by "sector erase" or "chip erase" before rewriting data.

### 17.2.2 Sector Erase (4-kbyte Erase)

This command erases the flash memory in units of 4 kbytes. The flash memory area to be erased is specified by the upper 4 bits of the 6th bus write cycle address. For example, in the MCU mode, to erase 4 kbytes from 7000H to 7FFFH, specify one of the addresses in 7000H-7FFFH as the 6th bus write cycle. In the serial PROM mode, to erase 4 kbytes from 7000H to 7FFFH, set FLSCR<BANKSEL> to "0" and then specify one of the addresses in F000H-FFFFH as the 6th bus write cycle. The sector erase command is effective only in the MCU and serial PROM modes, and it cannot be used in the parallel PROM mode.



A maximum of 30 ms is required to erase 4 kbytes. The next command sequence cannot be executed until the erase operation is completed. To check the completion of the erase operation, perform read operations repeatedly for data polling until the same data is read twice from the same address in the flash memory. During the erase operation, any consecutive attempts to read from the same address is reversed bit 6 of the data (toggling between 0 and 1).

### 17.2.3 Chip Erase (All Erase)

This command erases the entire flash memory in approximately 30 ms. The next command sequence cannot be executed until the erase operation is completed. To check the completion of the erase operation, perform read operations repeatedly for data polling until the same data is read twice from the same address in the flash memory. During the erase operation, any consecutive attempts to read from the same address is reversed bit 6 of the data (toggling between 0 and 1). After the chip is erased, all bytes contain FFH.

### 17.2.4 Product ID Entry

This command activates the Product ID mode. In the Product ID mode, the vendor ID, the flash ID, and the read protection status can be read from the flash memory.

Table 17-4 Values To Be Read in the Product ID Mode

Address	Meaning	Read Value
F000H	Vendor ID	98H
F001H	Flash macro ID	41H
F002H	Flash size	0EH: 60 kbytes 0BH: 48 kbytes 07H: 32 kbytes 05H: 24 kbytes 03H: 16 kbytes 01H: 8 kbytes 00H: 4 kbytes
FF7FH	Read protection status	FFH: Read protection disabled Other than FFH: Read protection enabled

Note: The value at address F002H (flash size) depends on the size of flash memory incorporated in each product. For example, if the product has 60-kbyte flash memory, "0EH" is read from address F002H.

### 17.2.5 Product ID Exit

This command is used to exit the Product ID mode.

### 17.2.6 Read Protect

This command enables the read protection setting in the flash memory. When the read protection is enabled, the flash memory cannot be read in the parallel PROM mode. In the serial PROM mode, the flash write command cannot be executed.

To enable the read protection setting in the serial PROM mode, set FLSCR<BANKSEL> to "1" before executing the read protect command sequence. To disable the read protection setting, it is necessary to execute the chip erase command sequence. Whether or not the read protection is enabled can be checked by reading FF7FH in the Product ID mode. For details, see Table 17-4.

It takes a maximum of 40  $\mu$ s to set read protection in the flash memory. The next command sequence cannot be executed until this operation is completed. To check the completion of the read protect operation, perform read operations repeatedly for data polling until the same data is read twice from the same address in the flash memory. During the read protect operation, any attempts to read from the same address is reversed bit 6 of the data (toggling between 0 and 1).

### 17.3 Toggle Bit (D6)

After the byte program, chip erase, and read protect command sequence is executed, any consecutive attempts to read from the same address is reversed bit 6 (D6) of the data (toggling between 0 and 1) until the operation is completed. Therefore, this toggle bit provides a software mechanism to check the completion of each operation. Usually perform read operations repeatedly for data polling until the same data is read twice from the same address in the flash memory. After the byte program, chip erase, or read protect command sequence is executed, the initial read of the toggle bit always produces a "1".

## 17.4 Access to the Flash Memory Area

When the write, erase and read protections are set in the flash memory, read and fetch operations cannot be performed in the entire flash memory area. Therefore, to perform these operations in the entire flash memory area, access to the flash memory area by the control program in the BOOTROM or RAM area. (The flash memory program cannot write to the flash memory.) The serial PROM or MCU mode is used to run the control program in the BOOTROM or RAM area.

Note 1: The flash memory can be written or read for each byte unit. Erase operations can be performed either in the entire area or in units of 4 kbytes, whereas read operations can be performed by an one transfer instruction. However, the command sequence method is adopted for write and erase operations, requiring several-byte transfer instructions for each operation.

Note 2: To rewrite data to Flash memory addresses at which data (including FFH) is already written, make sure to erase the existing data by "sector erase" or "chip erase" before rewriting data.

### 17.4.1 Flash Memory Control in the Serial PROM Mode

The serial PROM mode is used to access to the flash memory by the control program provided in the BOOTROM area. Since almost of all operations relating to access to the flash memory can be controlled simply by the communication data of the serial interface (UART), these functions are transparent to the user. For the details of the serial PROM mode, see "Serial PROM Mode."

## 17.4.2 Flash Memory Control in the MCU mode

In the MCU mode, write operations are performed by executing the control program in the RAM area. Before execution of the control program, copy the control program into the RAM area or obtain it from the external using the communication pin. The procedures to execute the control program in the RAM area in the MCU mode are described below.

### 17.4.2.1 How to write to the flash memory by executing a user write control program in the RAM area (in the MCU mode)

(Steps 1 and 2 are controlled by the program in the flash memory, and steps 3 through 11 are controlled by the control program in the RAM area.)

1. Transfer the write control program to the RAM area.
2. Jump to the RAM area.
3. Disable (DI) the interrupt master enable flag (IMF←"0").
4. Disable the watchdog timer, if it is used.
5. Set FLSCR<FLSMD> to "0011B" (to enable command sequence execution).
6. Execute the erase command sequence.
7. Read the same flash memory address twice.  
(Repeat step 7 until the same data is read by two consecutive read operations.)
8. Execute the write command sequence. (It is not required to specify the bank to be written.)
9. Read the same flash memory address twice.  
(Repeat step 9 until the same data is read by two consecutive read operations.)
10. Set FLSCR<FLSMD> to "1100B" (to disable command sequence execution).
11. Jump to the flash memory area.

Note 1: Before writing to the flash memory in the RAM area, disable interrupts by setting the interrupt master enable flag (IMF) to "0". Usually disable interrupts by executing the DI instruction at the head of the write control program in the RAM area.

Note 2: When writing to the flash memory, do not intentionally use non-maskable interrupts (the watchdog timer must be disabled if it is used). If a non-maskable interrupt occurs while the flash memory is being written, unexpected data is read from the flash memory (interrupt vector), resulting in malfunction of the microcontroller.

Example :After sector erasure (E000H-EFFFH), the program in the RAM area writes data 3FH to address E000H.

```

DI                                     : Disable interrupts (IMF←"0")

LD      (WDTCR2),4EH                  : Clear the WDT binary counter.

LDW     (WDTCR1),0B101H               : Disable the WDT.

LD      (FLSCR),0011_1000B           : Enable command sequence execution.

LD      IX,0F555H

LD      IY,0FAAAH

LD      HL,0E000H

; ##### Flash Memory Sector Erase Process #####

LD      (IX),0AAH                     : 1st bus write cycle

LD      (IY),55H                     : 2nd bus write cycle

LD      (IX),80H                     : 3rd bus write cycle

LD      (IX),0AAH                     : 4th bus write cycle

LD      (IY),55H                     : 5th bus write cycle

LD      (HL),30H                     : 6th bus write cycle

sLOOP1: LD      W,(IX)

CMP     W,(IX)

JR      NZ,sLOOP1                    : Loop until the same value is read.

; ##### Flash Memory Write Process #####

LD      (IX),0AAH                     : 1st bus write cycle

LD      (IY),55H                     : 2nd bus write cycle

LD      (IX),0A0H                     : 3rd bus write cycle

LD      (HL),3FH                     : 4th bus write cycle, (1000H)=3FH

sLOOP2: LD      W,(HL)

CMP     W,(HL)

JR      NZ,sLOOP2                    : Loop until the same value is read.

LD      (FLSCR),1100_1000B           : Disable command sequence execution.

JP      XXXXH                        : Jump to the flash memory area.

```

Example :This write control program reads data from address F000H and stores it to 98H in the RAM area.

```

LD      A,(0F000H)                   : Read data from address F000H.

LD      (98H),A                      : Store data to address 98H.

```



## 18. Serial PROM Mode

### 18.1 Outline

The TMP86FS28DFG has a 2048 byte BOOTROM (Mask ROM) for programming to flash memory. The BOOTROM is available in the serial PROM mode, and controlled by TEST, BOOT and RESET pins. Communication is performed via UART. The serial PROM mode has six types of operating mode: Flash memory writing, Flash memory SUM output, Product ID code output, Flash memory status output, Flash memory erasing and Flash memory read protection setting. Memory address mapping in the serial PROM mode differs from that in the MCU mode. Figure 18-1 shows memory address mapping in the serial PROM mode.

Note: TMP86FS28DFG doesn't support RAM loader mode. (The RAM loader mode can't be used in TMP86FS28DFG.)

Table 18-1 Operating Range in the Serial PROM Mode

Parameter	Min	Max	Unit
Power supply	4.5	5.5	V
High frequency (Note)	2	16	MHz

Note: Though included in above operating range, some of high frequencies are not supported in the serial PROM mode. For details, refer to "Table 18-5".

### 18.2 Memory Mapping

The Figure 18-1 shows memory mapping in the Serial PROM mode and MCU mode.

In the serial PROM mode, the BOOTROM (Mask ROM) is mapped in addresses from 7800H to 7FFFH. The flash memory is divided into two banks for mapping. Figure 18-1

To use the Flash memory writing command (30H), specify the flash memory addresses from 1000H to FFFFH, that is the same addresses in the MCU mode, because the BOOTROM changes the flash memory address.

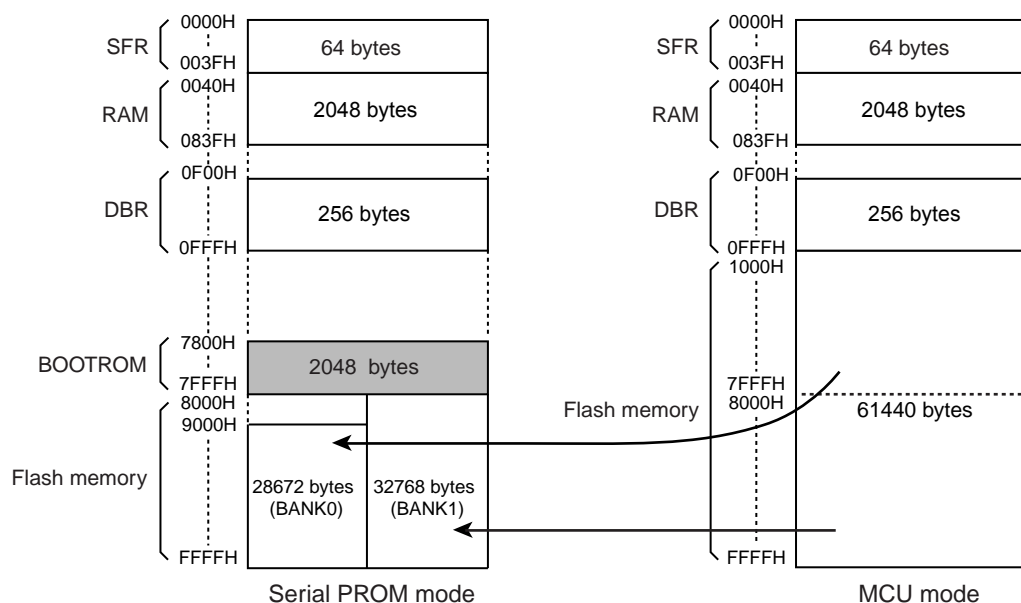



Figure 18-1 Memory Address Maps

## 18.3 Serial PROM Mode Setting

### 18.3.1 Serial PROM Mode Control Pins

To execute on-board programming, activate the serial PROM mode. Table 18-2 shows pin setting to activate the serial PROM mode.

Table 18-2 Serial PROM Mode Setting

Pin	Setting
TEST pin	High
BOOT/RXD1 pin	High
$\overline{\text{RESET}}$ pin	

Note: The BOOT pin is shared with the UART communication pin (RXD1 pin) in the serial PROM mode. This pin is used as UART communication pin after activating serial PROM mode

### 18.3.2 Pin Function

In the serial PROM mode, TXD1 (P35) and RXD1 (P34) are used as a serial interface pin.

Table 18-3 Pin Function in the Serial PROM Mode

Pin Name (Serial PROM Mode)	Input/ Output	Function	Pin Name (MCU Mode)
TXD1	Output	Serial data output	P35
BOOT/RXD1	Input/Input	Serial PROM mode control/Serial data input	P34
$\overline{\text{RESET}}$	Input	Serial PROM mode control	$\overline{\text{RESET}}$
TEST	Input	Fixed to high	TEST
VDD, AVDD	Power supply	4.5 to 5.5 V	
VSS, AVSS	Power supply	0 V	
VAREF	Power supply	Leave open or apply input reference voltage.	
I/O ports except P35, P34	I/O	These ports are in the high-impedance state in the serial PROM mode. The input level is fixed to the port inputs with a hardware feature to prevent overlap current. (The port inputs are invalid.)	
COM3 to COM0	Output	Low output in the serial PROM mode	
C0, C1, V3 to V1	-	Connect to a capacitor (resistance), or leave open.	
XIN	Input	Self-oscillate with an oscillator.	(Note 2)
XOUT	Output		

Note 1: During on-board programming with other parts mounted on a user board, be careful not to affect these communication control pins.

Note 2: Operating range of high frequency in serial PROM mode is 2 MHz to 16 MHz.



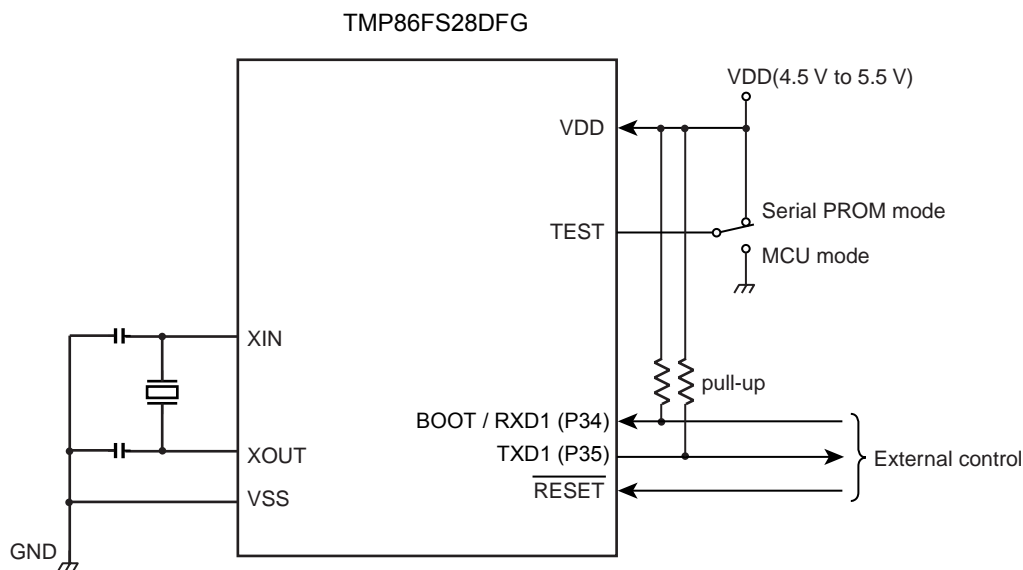


Figure 18-2 Serial PROM Mode Pin Setting

Note 1: For connection of other pins, refer to " Table 18-3 Pin Function in the Serial PROM Mode ".

### 18.3.3 Example Connection for On-Board Writing

Figure 18-3 shows an example connection to perform on-board writing.

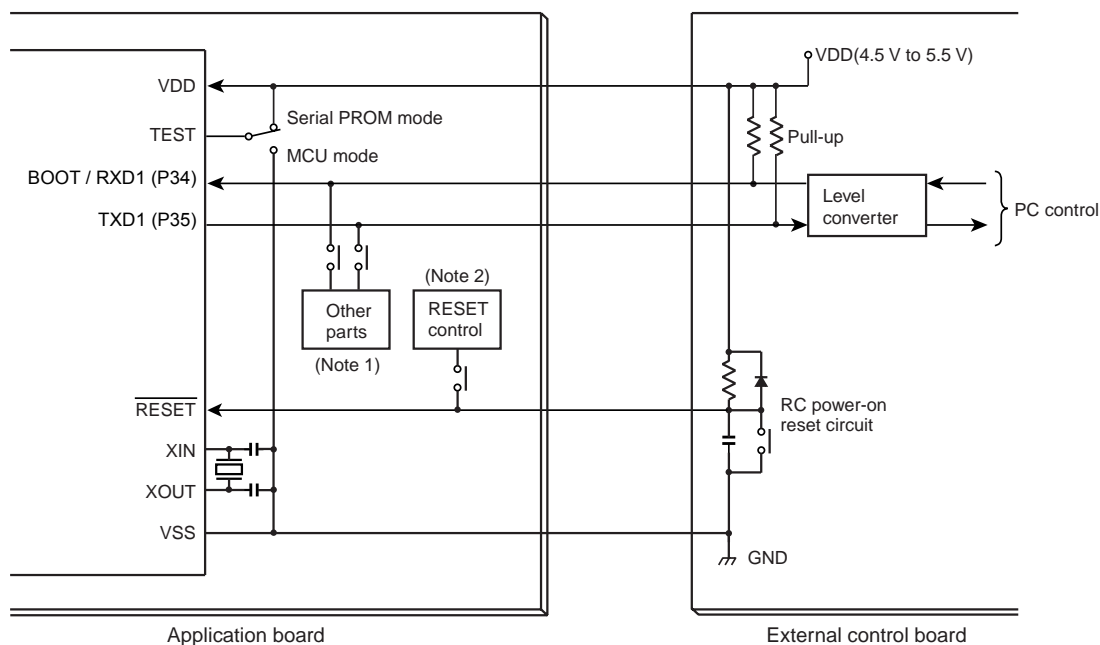


Figure 18-3 Example Connection for On-Board Writing

Note 1: When other parts on the application board effect the UART communication in the serial PROM mode, isolate these pins by a jumper or switch.

Note 2: When the reset control circuit on the application board effects activation of the serial PROM mode, isolate the pin by a jumper or switch.

Note 3: For connection of other pins, refer to " Table 18-3 Pin Function in the Serial PROM Mode ".

### 18.3.4 Activating the Serial PROM Mode

The following is a procedure to activate the serial PROM mode. " Figure 18-4 Serial PROM Mode Timing " shows a serial PROM mode timing.

1. Supply power to the VDD pin.
2. Set the  $\overline{\text{RESET}}$  pin to low.
3. Set the TEST pin and BOOT/RXD1 pins to high.
4. Wait until the power supply and clock oscillation stabilize.
5. Set the  $\overline{\text{RESET}}$  pin to high.
6. Input the matching data (5AH) to the BOOT/RXD1 pin after setup sequence. For details of the setup timing, refer to " 18.15 UART Timing ".

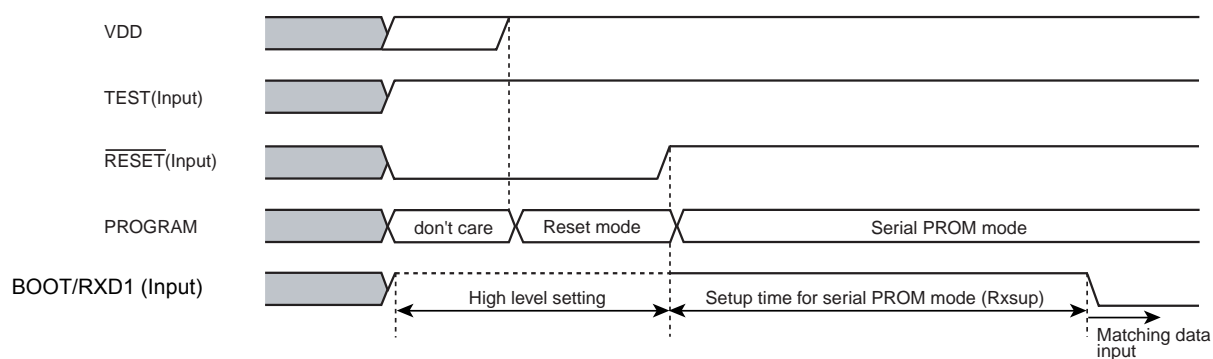


Figure 18-4 Serial PROM Mode Timing

## 18.4 Interface Specifications for UART

The following shows the UART communication format used in the serial PROM mode.

To perform on-board programming, the communication format of the write controller must also be set in the same manner.

The default baud rate is 9600 bps regardless of operating frequency of the microcontroller. The baud rate can be modified by transmitting the baud rate modification data shown in Table 1-4 to TMP86FS28DFG. The Table 18-5 shows an operating frequency and baud rate. The frequencies which are not described in Table 18-5 can not be used.

- Baud rate (Default): 9600 bps
- Data length: 8 bits
- Parity addition: None
- Stop bit: 1 bit

Table 18-4 Baud Rate Modification Data

Baud rate modification data	04H	05H	06H	07H	0AH	18H	28H
Baud rate (bps)	76800	62500	57600	38400	31250	19200	9600

Table 18-5 Operating Frequency and Baud Rate in the Serial PROM Mode

(Note 3)	Reference Baud Rate (bps)		76800		62500		57600		38400		31250		19200		9600	
	Baud Rate Modification Data		04H		05H		06H		07H		0AH		18H		28H	
	Ref. Frequency (MHz)	Rating (MHz)	Baud rate (bps)	(%)	(bps)	(%)	(bps)	(%)	(bps)	(%)	(bps)	(%)	(bps)	(%)	(bps)	(%)
1	2	1.91 to 2.10	-	-	-	-	-	-	-	-	-	-	-	-	9615	+0.16
2	4	3.82 to 4.19	-	-	-	-	-	-	-	-	31250	0.00	19231	+0.16	9615	+0.16
	4.19	3.82 to 4.19	-	-	-	-	-	-	-	-	32734	+4.75	20144	+4.92	10072	+4.92
3	4.9152	4.70 to 5.16	-	-	-	-	-	-	38400	0.00	-	-	19200	0.00	9600	0.00
	5	4.70 to 5.16	-	-	-	-	-	-	39063	+1.73	-	-	19531	+1.73	9766	+1.73
4	6	5.87 to 6.45	-	-	-	-	-	-	-	-	-	-	-	-	9375	-2.34
	6.144	5.87 to 6.45	-	-	-	-	-	-	-	-	-	-	-	-	9600	0.00
5	7.3728	7.05 to 7.74	-	-	-	-	57600	0.00	-	-	-	-	19200	0.00	9600	0.00
6	8	7.64 to 8.39	-	-	62500	0.00	-	-	38462	+0.16	31250	0.00	19231	+0.16	9615	+0.16
7	9.8304	9.40 to 10.32	76800	0.00	-	-	-	-	38400	0.00	-	-	19200	0.00	9600	0.00
	10	9.40 to 10.32	78125	+1.73	-	-	-	-	39063	+1.73	-	-	19531	+1.73	9766	+1.73
8	12	11.75 to 12.90	-	-	-	-	57692	+0.16	-	-	31250	0.00	18750	-2.34	9375	-2.34
	12.288	11.75 to 12.90	-	-	-	-	59077	+2.56	-	-	32000	+2.40	19200	0.00	9600	0.00
	12.5	11.75 to 12.90	-	-	60096	-3.85	60096	+4.33	-	-	30048	-3.85	19531	+1.73	9766	+1.73
9	14.7456	14.10 to 15.48	-	-	-	-	57600	0.00	38400	0.00	-	-	19200	0.00	9600	0.00
10	16	15.27 to 16.77	76923	+0.16	62500	0.00	-	-	38462	+0.16	31250	0.00	19231	+0.16	9615	+0.16

Note 1: "Ref. Frequency" and "Rating" show frequencies available in the serial PROM mode. Though the frequency is supported in the serial PROM mode, the serial PROM mode may not be activated correctly due to the frequency difference in the external controller (such as personal computer) and oscillator, and load capacitance of communication pins.

Note 2: It is recommended that the total frequency difference is within  $\pm 3\%$  so that auto detection is performed correctly by the reference frequency.

Note 3: The external controller must transmit the matching data (5AH) repeatedly till the auto detection of baud rate is performed. This number indicates the number of times the matching data is transmitted for each frequency.

## 18.5 Operation Command

The eight commands shown in Table 18-6 are used in the serial PROM mode. After reset release, the TMP86FS28DFG waits for the matching data (5AH).

Table 18-6 Operation Command in the Serial PROM Mode

Command Data	Operating Mode	Description
5AH	Setup	Matching data. Execute this command after releasing the reset.
F0H	Flash memory erasing	Erases the flash memory area (address 1000H to FFFFH).
30H	Flash memory writing	Writes to the flash memory area (address 1000H to FFFFH).
90H	Flash memory SUM output	Outputs the 2-byte checksum upper byte and lower byte in this order for the entire area of the flash memory (address 1000H to FFFFH).
C0H	Product ID code output	Outputs the product ID code (13-byte data).
C3H	Flash memory status output	Outputs the status code (7-byte data) such as the read protection condition.
FAH	Flash memory read protection setting	Enables the read protection.

Note 1: TMP86FS28DFG doesn't support RAM loader mode.

## 18.6 Operation Mode

The serial PROM mode has six types of modes, that are (1) Flash memory erasing, (2) Flash memory writing, (3) Flash memory SUM output, (4) Product ID code output, (5) Flash memory status output and (6) Flash memory read protection setting modes. Description of each mode is shown below.

1. Flash memory erasing mode  
The flash memory is erased by the chip erase (erasing an entire flash area) or sector erase (erasing sectors in 4-kbyte units). The erased area is filled with FFH. When the read protection is enabled, the sector erase in the flash erasing mode can not be performed. To disable the read protection, perform the chip erase. Before erasing the flash memory, TMP86FS28DFG checks the passwords except a blank product. If the password is not matched, the flash memory erasing mode is not activated.
2. Flash memory writing mode  
Data is written to the specified flash memory address for each byte unit. The external controller must transmit the write data in the Intel Hex format (Binary). If no error is encountered till the end record, TMP86FS28DFG calculates the checksum for the entire flash memory area (1000H to FFFFH), and returns the obtained result to the external controller. When the read protection is enabled, the flash memory writing mode is not activated. In this case, perform the chip erase command beforehand in the flash memory erasing mode. Before activating the flash memory writing mode, TMP86FS28DFG checks the password except a blank product. If the password is not matched, flash memory writing mode is not activated.
3. Flash memory SUM output mode  
The checksum is calculated for the entire flash memory area (1000H to FFFFH), and the result is returned to the external controller. Since the BOOTROM does not support the operation command to read the flash memory, use this checksum to identify programs when managing revisions of application programs.
4. Product ID code output  
The code used to identify the product is output. The code to be output consists of 13-byte data, which includes the information indicating the area of the ROM incorporated in the product. The external controller reads this code, and recognizes the product to write.  
(In the case of TMP86FS28DFG, the addresses from 1000H to FFFFH become the ROM area.)
5. Flash memory status output mode  
The status of the area from FFE0H to FFFFH, and the read protection condition are output as 7-byte code. The external controller reads this code to recognize the flash memory status.
6. Flash memory read protection setting mode  
This mode disables reading the flash memory data in parallel PROM mode. In the serial PROM mode, the flash memory writing mode is disabled. To disable the flash memory read protection, perform the chip erase in the flash memory erasing mode.

### 18.6.1 Flash Memory Erasing Mode (Operating command: F0H)

Table 18-7 shows the flash memory erasing mode.

Table 18-7 Flash Memory Erasing Mode

	Transfer Byte	Transfer Data from the External Controller to TMP86FS28DFG	Baud Rate	Transfer Data from TMP86FS28DFG to the External Controller
BOOT ROM	1st byte 2nd byte	Matching data (5AH) -	9600 bps 9600 bps	- (Automatic baud rate adjustment) OK: Echo back data (5AH) Error: No data transmitted
	3rd byte 4th byte	Baud rate change data (Table 18-4) -	9600 bps 9600 bps	- OK: Echo back data Error: A1H × 3, A3H × 3, 62H × 3 (Note 1)
	5th byte 6th byte	Operation command data (F0H) -	Modified baud rate Modified baud rate	- OK: Echo back data (F0H) Error: A1H × 3, A3H × 3, 63H × 3 (Note 1)
	7th byte 8th byte	Password count storage address bit 15 to 08 (Note 4, 5)	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	9th byte 10th byte	Password count storage address bit 07 to 00 (Note 4, 5)	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	11th byte 12th byte	Password comparison start address bit 15 to 08 (Note 4, 5)	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	13th byte 14th byte	Password comparison start address bit 07 to 00 (Note 4, 5)	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	15th byte : m'th byte	Password string (Note 4, 5) -	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	n'th - 2 byte	Erase area specification (Note 2)	Modified baud rate	-
	n'th - 1 byte	-	Modified baud rate	OK: Checksum (Upper byte) (Note 3) Error: Nothing transmitted
	n'th byte	-	Modified baud rate	OK: Checksum (Lower byte) (Note 3) Error: Nothing transmitted
	n'th + 1 byte	(Wait for the next operation command data)	Modified baud rate	-

Note 1: "xxH × 3" indicates that the device enters the halt condition after transmitting 3 bytes of xxh.

Note 2: Refer to " 18.13 Specifying the Erasure Area ".

Note 3: Refer to " 18.8 Checksum (SUM) ".

Note 4: Refer to " 18.10 Passwords ".

Note 5: Do not transmit the password string for a blank product.

Note 6: When a password error occurs, TMP86FS28DFG stops UART communication and enters the halt mode. Therefore, when a password error occurs, initialize TMP86FS28DFG by the RESET pin and reactivate the serial PROM mode.

Note 7: If an error occurs during transfer of a password address or a password string, TMP86FS28DFG stops UART communication and enters the halt condition. Therefore, when a password error occurs, initialize TMP86FS28DFG by the RESET pin and reactivate the serial PROM mode.

#### Description of the flash memory erasing mode

1. The 1st through 4th bytes of the transmitted and received data contain the same data as in the flash memory writing mode.

2. The 5th byte of the received data contains the command data in the flash memory erasing mode (F0H).
3. When the 5th byte of the received data contains the operation command data shown in Table 18-6, the device echoes back the value which is the same data in the 6th byte position of the received data (in this case, F0H). If the 5th byte of the received data does not contain the operation command data, the device enters the halt condition after sending 3 bytes of the operation command error code (63H).
4. The 7th thorough m'th bytes of the transmitted and received data contain the same data as in the flash memory writing mode. In the case of a blank product, do not transmit a password string. (Do not transmit a dummy password string.)
5. The n'th - 2 byte contains the erasure area specification data. The upper 4 bits and lower 4 bits specify the start address and end address of the erasure area, respectively. For the detailed description, see "1.13 Specifying the Erasure Area".
6. The n'th - 1 byte and n'th byte contain the upper and lower bytes of the checksum, respectively. For how to calculate the checksum, refer to "1.8 Checksum (SUM)". Checksum is calculated unless a receiving error or Intel Hex format error occurs. After sending the end record, the external controller judges whether the transmission is completed correctly by receiving the checksum sent by the device.
7. After sending the checksum, the device waits for the next operation command data.

## 18.6.2 Flash Memory Writing Mode (Operation command: 30H)

Table 18-8 shows flash memory writing mode process.

Table 18-8 Flash Memory Writing Mode Process

	Transfer Byte	Transfer Data from External Controller to TMP86FS28DFG	Baud Rate	Transfer Data from TMP86FS28DFG to External Controller
BOOT ROM	1st byte 2nd byte	Matching data (5Ah) -	9600 bps 9600 bps	- (Automatic baud rate adjustment) OK: Echo back data (5AH) Error: Nothing transmitted
	3rd byte 4th byte	Baud rate modification data (See Table 18-4) -	9600 bps 9600 bps	- OK: Echo back data Error: A1H × 3, A3H × 3, 62H × 3 (Note 1)
	5th byte 6th byte	Operation command data (30H) -	Modified baud rate Modified baud rate	- OK: Echo back data (30H) Error: A1H × 3, A3H × 3, 63H × 3 (Note 1)
	7th byte 8th byte	Password count storage address bit 15 to 08 (Note 4)	Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	9th byte 10th byte	Password count storage address bit 07 to 00 (Note 4)	Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	11th byte 12th byte	Password comparison start address bit 15 to 08 (Note 4)	Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	13th byte 14th byte	Password comparison start address bit 07 to 00 (Note 4)	Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	15th byte : m'th byte	Password string (Note 5) -	Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	m'th + 1 byte : n'th - 2 byte	Intel Hex format (binary) (Note 2)	Modified baud rate	- -
	n'th - 1 byte	-	Modified baud rate	OK: SUM (Upper byte) (Note 3) Error: Nothing transmitted
	n'th byte	-	Modified baud rate	OK: SUM (Lower byte) (Note 3) Error: Nothing transmitted
	n'th + 1 byte	(Wait state for the next operation command data)	Modified baud rate	-

Note 1: "xxH × 3" indicates that the device enters the halt condition after sending 3 bytes of xxH. For details, refer to " 18.7 Error Code ".

Note 2: Refer to " 18.9 Intel Hex Format (Binary) ".

Note 3: Refer to " 18.8 Checksum (SUM) ".

Note 4: Refer to " 18.10 Passwords ".

Note 5: If addresses from FFE0H to FFFFH are filled with "FFH", the passwords are not compared because the device is considered as a blank product. Transmitting a password string is not required. Even in the case of a blank product, it is required to specify the password count storage address and the password comparison start address. Transmit these data from the external controller. If a password error occurs due to incorrect password count storage address or password comparison start address, TMP86FS28DFG stops UART communication and enters the halt condition. Therefore, when a password error occurs, initialize TMP86FS28DFG by the  $\overline{\text{RESET}}$  pin and reactivate the serial ROM mode.

Note 6: If the read protection is enabled or a password error occurs, TMP86FS28DFG stops UART communication and enters the halt condition. In this case, initialize TMP86FS28DFG by the  $\overline{\text{RESET}}$  pin and reactivate the serial ROM mode.

Note 7: If an error occurs during the reception of a password address or a password string, TMP86FS28DFG stops UART communication and enters the halt condition. In this case, initialize TMP86FS28DFG by the  $\overline{\text{RESET}}$  pin and reactivate the serial PROM mode.



## Description of the flash memory writing mode

1. The 1st byte of the received data contains the matching data. When the serial PROM mode is activated, TMP86FS28DFG (hereafter called device), waits to receive the matching data (5AH). Upon reception of the matching data, the device automatically adjusts the UART's initial baud rate to 9600 bps.
2. When receiving the matching data (5AH), the device transmits an echo back data (5AH) as the second byte data to the external controller. If the device can not recognize the matching data, it does not transmit the echo back data and waits for the matching data again with automatic baud rate adjustment. Therefore, the external controller should transmit the matching data repeatedly till the device transmits an echo back data. The transmission repetition count varies depending on the frequency of device. For details, refer to Table 18-5.
3. The 3rd byte of the received data contains the baud rate modification data. The five types of baud rate modification data shown in Table 18-4 are available. Even if baud rate is not modified, the external controller should transmit the initial baud rate data (28H: 9600 bps).
4. Only when the 3rd byte of the received data contains the baud rate modification data corresponding to the device's operating frequency, the device echoes back data the value which is the same data in the 4th byte position of the received data. After the echo back data is transmitted, baud rate modification becomes effective. If the 3rd byte of the received data does not contain the baud rate modification data, the device enters the halts condition after sending 3 bytes of baud rate modification error code (62H).
5. The 5th byte of the received data contains the command data (30H) to write the flash memory.
6. When the 5th byte of the received data contains the operation command data shown in Table 1-6, the device echoes back the value which is the same data in the 6th byte position of the received data (in this case, 30H). If the 5th byte of the received data does not contain the operation command data, the device enters the halt condition after sending 3 bytes of the operation command error code (63H).
7. The 7th byte contains the data for 15 to 8 bits of the password count storage address. When the data received with the 7th byte has no receiving error, the device does not send any data. If a receiving error or password error occurs, the device does not send any data and enters the halt condition.
8. The 9th byte contains the data for 7 to 0 bits of the password count storage address. When the data received with the 9th byte has no receiving error, the device does not send any data. If a receiving error or password error occurs, the device does not send any data and enters the halt condition.
9. The 11th byte contains the data for 15 to 8 bits of the password comparison start address. When the data received with the 11th byte has no receiving error, the device does not send any data. If a receiving error or password error occurs, the device does not send any data and enters the halt condition.
10. The 13th byte contains the data for 7 to 0 bits of the password comparison start address. When the data received with the 13th byte has no receiving error, the device does not send any data. If a receiving error or password error occurs, the device does not send any data and enters the halt condition.
11. The 15th through m'th bytes contain the password data. The number of passwords becomes the data (N) stored in the password count storage address. The external password data is compared with N-byte data from the address specified by the password comparison start address. The external controller should send N-byte password data to the device. If the passwords do not match, the device enters the halt condition without returning an error code to the external controller. If the addresses from FFE0H to FFFFH are filled with "FFH", the passwords are not compared because the device is considered as a blank product.
12. The m'th + 1 through n'th - 2 bytes of the received data contain the binary data in the Intel Hex format. No received data is echoed back to the external controller. After receiving the start mark (3AH for ":" in the Intel Hex format), the device starts data record reception. Therefore, the received data except 3AH is ignored until the start mark is received. After receiving the start mark, the device receives the data record, that consists of data length, address, record type, write data and checksum. Since the device starts checksum calculation after receiving an end record, the external controller should wait for the checksum after sending the end record. If a receiving error or Intel Hex format error occurs, the device enters the halts condition without returning an error code to the external controller.
13. The n'th - 1 and n'th bytes contain the checksum upper and lower bytes. For details on how to calculate the SUM, refer to "18.8 Checksum (SUM)". The checksum is calculated only when the end record is detected and no receiving error or Intel Hex format error occurs. After sending the end

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record, the external controller judges whether the transmission is completed correctly by receiving the checksum sent by the device.

14. After transmitting the checksum, the device waits for the next operation command data.

Note 1: Do not write only the address from FFE0H to FFFFH when all flash memory data is the same. If only these area are written, the subsequent operation can not be executed due to password error.

Note 2: To rewrite data to Flash memory addresses at which data (including FFH) is already written, make sure to erase the existing data by "sector erase" or "chip erase" before rewriting data.

### 18.6.3 Flash Memory SUM Output Mode (Operation Command: 90H)

Table 18-9 shows flash memory SUM output mode process.

Table 18-9 Flash Memory SUM Output Process

	Transfer Bytes	Transfer Data from External Controller to TMP86FS28DFG	Baud Rate	Transfer Data from TMP86FS28DFG to External Controller
BOOT ROM	1st byte 2nd byte	Matching data (5AH) -	9600 bps 9600 bps	- (Automatic baud rate adjustment) OK: Echo back data (5AH) Error: Nothing transmitted
	3rd byte 4th byte	Baud rate modification data (See Table 18-4) -	9600 bps 9600 bps	- OK: Echo back data Error: A1H × 3, A3H × 3, 62H × 3 (Note 1)
	5th byte 6th byte	Operation command data (90H) -	Modified baud rate Modified baud rate	- OK: Echo back data (90H) Error: A1H × 3, A3H × 3, 63H × 3 (Note 1)
	7th byte	-	Modified baud rate	OK: SUM (Upper byte) (Note 2) Error: Nothing transmitted
	8th byte	-	Modified baud rate	OK: SUM (Lower byte) (Note 2) Error: Nothing transmitted
	9th byte	(Wait for the next operation command data)	Modified baud rate	-

Note 1: "xxH × 3" indicates that the device enters the halt condition after sending 3 bytes of xxH. For details, refer to " 18.7 Error Code ".

Note 2: Refer to " 18.8 Checksum (SUM) ".

#### Description of the flash memory SUM output mode

1. The 1st through 4th bytes of the transmitted and received data contains the same data as in the flash memory writing mode.
2. The 5th byte of the received data contains the command data in the flash memory SUM output mode (90H).
3. When the 5th byte of the received data contains the operation command data shown in Table 1-6, the device echoes back the value which is the same data in the 6th byte position of the received data (in this case, 90H). If the 5th byte of the received data does not contain the operation command data, the device enters the halt condition after transmitting 3 bytes of operation command error code (63H).
4. The 7th and the 8th bytes contain the upper and lower bits of the checksum, respectively. For how to calculate the checksum, refer to " 18.8 Checksum (SUM) ".
5. After sending the checksum, the device waits for the next operation command data.

### 18.6.4 Product ID Code Output Mode (Operation Command: C0H)

Table 18-10 shows product ID code output mode process.

Table 18-10 Product ID Code Output Process

	Transfer Bytes	Transfer Data from External Controller to TMP86FS28DFG	Baud Rate	Transfer Data from TMP86FS28DFG to External Controller	
BOOT ROM	1st byte 2nd byte	Matching data (5AH) -	9600 bps 9600 bps	- (Automatic baud rate adjustment) OK: Echo back data (5AH) Error: Nothing transmitted	
	3rd byte 4th byte	Baud rate modification data (See Table 18-4) -	9600 bps 9600 bps	-  OK: Echo back data Error: A1H × 3, A3H × 3, 62H × 3 (Note 1)	
	5th byte 6th byte	Operation command data (C0H) -	Modified baud rate Modified baud rate	- OK: Echo back data (C0H) Error: A1H × 3, A3H × 3, 63H × 3 (Note 1)	
	7th byte		Modified baud rate	3AH	Start mark
	8th byte		Modified baud rate	0AH	The number of transfer data (from 9th to 18th bytes)
	9th byte		Modified baud rate	02H	Length of address (2 bytes)
	10th byte		Modified baud rate	1DH	Reserved data
	11th byte		Modified baud rate	00H	Reserved data
	12th byte		Modified baud rate	00H	Reserved data
	13th byte		Modified baud rate	00H	Reserved data
	14th byte		Modified baud rate	01H	ROM block count (1 block)
	15th byte		Modified baud rate	10H	First address of ROM (Upper byte)
	16th byte		Modified baud rate	00H	First address of ROM (Lower byte)
	17th byte		Modified baud rate	FFH	End address of ROM (Upper byte)
	18th byte		Modified baud rate	FFH	End address of ROM (Lower byte)
	19th byte		Modified baud rate	D2H	Checksum of transferred data (9th through 18th byte)
	20th byte	(Wait for the next operation command data)	Modified baud rate	-	

Note: "xxH × 3" indicates that the device enters the halt condition after sending 3 bytes of xxH. For details, refer to " 18.7 Error Code ".

#### Description of Product ID code output mode

1. The 1st through 4th bytes of the transmitted and received data contain the same data as in the flash memory writing mode.
2. The 5th byte of the received data contains the product ID code output mode command data (C0H).
3. When the 5th byte contains the operation command data shown in Table 18-6, the device echoes back the value which is the same data in the 6th byte position of the received data (in this case, C0H). If the 5th byte data does not contain the operation command data, the device enters the halt condition after sending 3 bytes of operation command error code (63H).
4. The 9th through 19th bytes contain the product ID code. For details, refer to " 18.11 Product ID Code ".

5. After sending the checksum, the device waits for the next operation command data.



## 18.6.5 Flash Memory Status Output Mode (Operation Command: C3H)

Table 18-11 shows Flash memory status output mode process.

Table 18-11 Flash Memory Status Output Mode Process

	Transfer Bytes	Transfer Data from External Controller to TMP86FS28DFG	Baud Rate	Transfer Data from TMP86FS28DFG to External Controller	
BOOT ROM	1st byte 2nd byte	Matching data (5AH) -	9600 bps 9600 bps	- (Automatic baud rate adjustment) OK: Echo back data (5AH) Error: Nothing transmitted	
	3rd byte 4th byte	Baud rate modification data (See Table 18-4) -	9600 bps 9600 bps	- OK: Echo back data Error: A1H × 3, A3H × 3, 62H × 3 (Note 1)	
	5th byte 6th byte	Operation command data (C3H) -	Modified baud rate Modified baud rate	- OK: Echo back data (C3H) Error: A1H × 3, A3H × 3, 63H × 3 (Note 1)	
	7th byte		Modified baud rate	3AH	Start mark
	8th byte		Modified baud rate	04H	Byte count (from 9th to 12th byte)
	9th byte		Modified baud rate	00H to 03H	Status code 1
	10th byte		Modified baud rate	00H	Reserved data
	11th byte		Modified baud rate	00H	Reserved data
	12th byte		Modified baud rate	00H	Reserved data
	13th byte		Modified baud rate	Checksum 2's complement for the sum of 9th through 12th bytes 9th byte    Checksum 00H:       00H 01H:       FFH 02H:       FEH 03H:       FDH	
	14th byte	(Wait for the next operation command data)	Modified baud rate	-	

Note 1: "xxH × 3" indicates that the device enters the halt condition after sending 3 bytes of xxH. For details, refer to " 18.7 Error Code ".

Note 2: For the details on status code 1, refer to " 18.12 Flash Memory Status Code ".

## Description of Flash memory status output mode

1. The 1st through 4th bytes of the transmitted and received data contain the same data as in the Flash memory writing mode.
2. The 5th byte of the received data contains the flash memory status output mode command data (C3H).
3. When the 5th byte contains the operation command data shown in Table 18-6, the device echoes back the value which is the same data in the 6th byte position of the received data (in this case, C3H). If the 5th byte does not contain the operation command data, the device enters the halt condition after sending 3 bytes of operation command error code (63H).
4. The 9th through 13th bytes contain the status code. For details on the status code, refer to " 18.12 Flash Memory Status Code ".
5. After sending the status code, the device waits for the next operation command data.

## 18.6.6 Flash Memory Read Protection Setting Mode (Operation Command: FAH)

Table 18-12 shows Flash memory read protection setting mode process.

Table 18-12 Flash Memory Read Protection Setting Mode Process

	Transfer Bytes	Transfer Data from External Controller to TMP86FS28DFG	Baud Rate	Transfer Data from TMP86FS28DFG to External Controller
BOOT ROM	1st byte 2nd byte	Matching data (5AH) -	9600 bps 9600 bps	- (Automatic baud rate adjustment) OK: Echo back data (5AH) Error: Nothing transmitted
	3rd byte 4th byte	Baud rate modification data (See Table 18-4) -	9600 bps 9600 bps	- OK: Echo back data Error: A1H × 3, A3H × 3, 62H × 3 (Note 1)
	5th byte 6th byte	Operation command data (FAH) -	Modified baud rate Modified baud rate	- OK: Echo back data (FAH) Error: A1H × 3, A3H × 3, 63H × 3 (Note 1)
	7th byte 8th byte	Password count storage address 15 to 08 (Note 2)	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	9th byte 10th byte	Password count storage address 07 to 00 (Note 2)	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	11th byte 12th byte	Password comparison start address 15 to 08 (Note 2)	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	13th byte 14th byte	Password comparison start address 07 to 00 (Note 2)	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	15th byte : m'th byte	Password string (Note 2) -	Modified baud rate Modified baud rate	- OK: Nothing transmitted Error: Nothing transmitted
	n'th byte	-	Modified baud rate	OK: FBH (Note 3) Error: Nothing transmitted
	n'+1th byte	(Wait for the next operation command data)	Modified baud rate	-

Note 1: "xxH × 3" indicates that the device enters the halt condition after sending 3 bytes of xxH. For details, refer to " 18.7 Error Code ".

Note 2: Refer to " 18.10 Passwords ".

Note 3: If the read protection is enabled for a blank product or a password error occurs for a non-blank product, TMP86FS28DFG stops UART communication and enters the halt mode. In this case, initialize TMP86FS28DFG by the  $\overline{\text{RESET}}$  pin and reactivate the serial PROM mode.

Note 4: If an error occurs during reception of a password address or a password string, TMP86FS28DFG stops UART communication and enters the halt mode. In this case, initialize TMP86FS28DFG by the  $\overline{\text{RESET}}$  pin and reactivate the serial PROM mode.

### Description of the Flash memory read protection setting mode

1. The 1st through 4th bytes of the transmitted and received data contain the same data as in the Flash memory writing mode.
2. The 5th byte of the received data contains the command data in the flash memory status output mode (FAH).
3. When the 5th byte of the received data contains the operation command data shown in Table 1-6, the device echoes back the value which is the same data in the 6th byte position of the received data (in

this case, FAH). If the 5th byte does not contain the operation command data, the device enters the halt condition after transmitting 3 bytes of operation command error code (63H).

4. The 7th through m'th bytes of the transmitted and received data contain the same data as in the flash memory writing mode.
5. The n'th byte contains the status to be transmitted to the external controller in the case of the successful read protection.



## 18.7 Error Code

When detecting an error, the device transmits the error code to the external controller, as shown in Table 18-13.

Table 18-13 Error Code

Transmit Data	Meaning of Error Data
62H, 62H, 62H	Baud rate modification error.
63H, 63H, 63H	Operation command error.
A1H, A1H, A1H	Framing error in the received data.
A3H, A3H, A3H	Overrun error in the received data.

Note: If a password error occurs, TMP86FS28DFG does not transmit an error code.

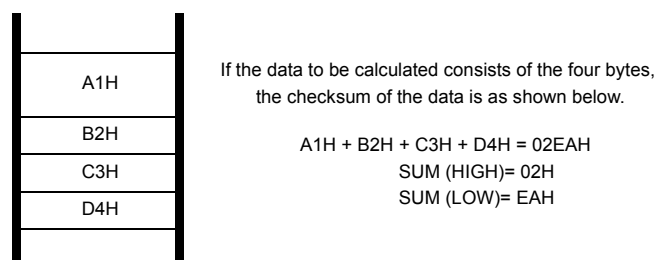
## 18.8 Checksum (SUM)

### 18.8.1 Calculation Method

The checksum (SUM) is calculated with the sum of all bytes, and the obtained result is returned as a word.

The data is read for each byte unit and the calculated result is returned as a word.

Example:



The checksum which is transmitted by executing the flash memory write command or flash memory SUM output command is calculated in the manner, as shown above.

18.8.2 Calculation data

The data used to calculate the checksum is listed in Table 18-14.

Table 18-14 Checksum Calculation Data

Operating Mode	Calculation Data	Description
Flash memory writing mode	Data in the entire area of the flash memory	Even when a part of the flash memory is written, the checksum of the entire flash memory area (1000H to FFFH) is calculated. The data length, address, record type and checksum in Intel Hex format are not included in the checksum.
Flash memory SUM output mode		
Product ID Code Output mode	9th through 18th bytes of the transferred data	For details, refer to " 18.11 Product ID Code ".
Flash Memory Status Output mode	9th through 12th bytes of the transferred data	For details, refer to " 18.12 Flash Memory Status Code "
Flash Memory Erasing mode	All data in the erased area of the flash memory (the whole or part of the flash memory)	When the sector erase is executed, only the erased area is used to calculate the checksum. In the case of the chip erase, an entire area of the flash memory is used.

## 18.9 Intel Hex Format (Binary)

1. After receiving the checksum of a data record, the device waits for the start mark (3AH “:”) of the next data record. After receiving the checksum of a data record, the device ignores the data except 3AH transmitted by the external controller.
2. After transmitting the checksum of end record, the external controller must transmit nothing, and wait for the 2-byte receive data (upper and lower bytes of the checksum).
3. If a receiving error or Intel Hex format error occurs, the device enters the halt condition without returning an error code to the external controller. The Intel Hex format error occurs in the following case:

When the record type is not 00H, 01H, or 02H

When a checksum error occurs

When the data length of an extended record (record type = 02H) is not 02H

When the device receives the data record after receiving an extended record (record type = 02H) with extended address of 1000H or larger.

When the data length of the end record (record type = 01H) is not 00H

## 18.10 Passwords

The consecutive eight or more-byte data in the flash memory area can be specified to the password. TMP86FS28DFG compares the data string specified to the password with the password string transmitted from the external controller. The area in which passwords can be specified is located at addresses 1000H to FF9FH. The area from FFA0H to FFFFH can not be specified as the passwords area.

If addresses from FFE0H through FFFFH are filled with “FFH”, the passwords are not compared because the product is considered as a blank product. Even in this case, the password count storage addresses and password comparison start address must be specified. Table 18-15 shows the password setting in the blank product and non-blank product.

Table 18-15 Password Setting in the Blank Product and Non-Blank Product

Password	Blank Product (Note 1)	Non-Blank Product
PNSA (Password count storage address)	$1000H \leq PNSA \leq FF9FH$	$1000H \leq PNSA \leq FF9FH$
PCSA (Password comparison start address)	$1000H \leq PCSA \leq FF9FH$	$1000H \leq PCSA \leq FFA0 - N$
N (Password count)	*	$8 \leq N$
Password string setting	Not required (Note 5)	Required (Note 2)

Note 1: When addresses from FFE0H through FFFFH are filled with “FFH”, the product is recognized as a blank product.

Note 2: The data including the same consecutive data (three or more bytes) can not be used as a password. (This causes a password error data. TMP86FS28DFG transmits no data and enters the halt condition.)

Note 3: \*: Don't care.

Note 4: When the above condition is not met, a password error occurs. If a password error occurs, the device enters the halt condition without returning the error code.

Note 5: In the flash memory writing mode, the blank product receives the Intel Hex format data immediately after receiving PCSA without receiving password strings. In this case, the subsequent processing is performed correctly because the blank product ignores the data except the start mark (3AH “:”) as the Intel Hex format data, even if the external controller transmits the dummy password string. However, if the dummy password string contains “3AH”, it is detected as the start mark erroneously. The microcontroller enters the halt mode. If this causes the problem, do not transmit the dummy password strings.

Note 6: In the flash memory erasing mode, the external controller must not transmit the password string for the blank product.

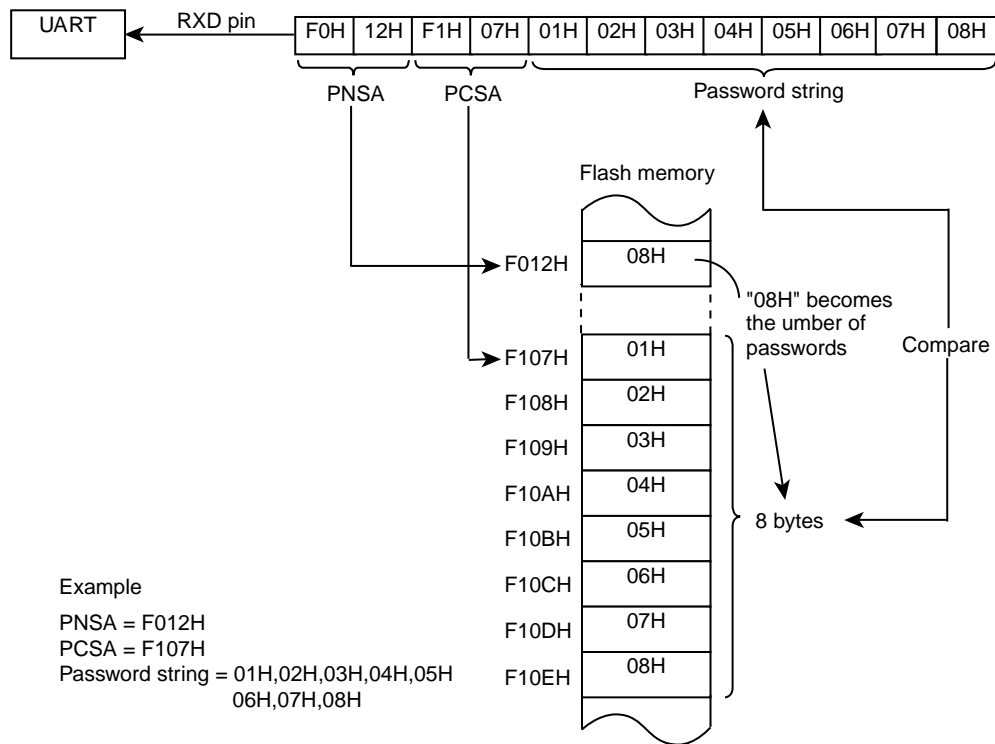


Figure 18-5 Password Comparison

18.10.1Password String

The password string transmitted from the external controller is compared with the specified data in the flash memory. When the password string is not matched to the data in the flash memory, the device enters the halt condition due to the password error.

18.10.2Handling of Password Error

If a password error occurs, the device enters the halt condition. In this case, reset the device to reactivate the serial PROM mode.

18.10.3Password Management during Program Development

If a program is modified many times in the development stage, confusion may arise as to the password. Therefore, it is recommended to use a fixed password in the program development stage.

Example :Specify PNSA to F000H, and the password string to 8 bytes from address F001H (PCSA becomes F001H.)

Password Section code abs = 0F000H

DB	08H	: PNSA definition
DB	"CODE1234"	: Password string definition

18.11Product ID Code

The product ID code is the 13-byte data containing the start address and the end address of ROM. Table 18-16 shows the product ID code format.

Table 18-16 Product ID Code Format

Data	Description	In the Case of TMP86FS28DFG
1st	Start Mark (3AH)	3AH
2nd	The number of transfer data (10 bytes from 3rd to 12th byte)	0AH
3rd	Address length (2 bytes)	02H
4th	Reserved data	1DH
5th	Reserved data	00H
6th	Reserved data	00H
7th	Reserved data	00H
8th	ROM block count	01H
9th	The first address of ROM (Upper byte)	10H
10th	The first address of ROM (Lower byte)	00H
11th	The end address of ROM (Upper byte)	FFH
12th	The end address of ROM (Lower byte)	FFH
13th	Checksum of the transferred data (2's compliment for the sum of 3rd through 12th bytes)	D2H

18.12Flash Memory Status Code

The flash memory status code is the 7-byte data including the read protection status and the status of the data from FFE0H to FFFFH. Table 18-17 shows the flash memory status code.

Table 18-17 Flash Memory Status Code

Data	Description	In the Case of TMP86FS28DFG
1st	Start mark	3AH
2nd	Transferred data count (3rd through 6th byte)	04H
3rd	Status code	00H to 03H (See figure below)
4th	Reserved data	00H
5th	Reserved data	00H
6th	Reserved data	00H
7th	Checksum of the transferred data (2's compliment for the sum of 3rd through 6th data)	3rd byte      checksum 00H          00H 01H          FFH 02H          FEH 03H          FDH

Status Code 1

7	6	5	4	3	2	1	0	
						RPENA	BLANK	(Initial Value: 0000 00**)

RPENA	Flash memory read protection status	0:	Read protection is disabled.
		1:	Read protection is enabled.
BLANK	The status from FFE0H to FFFFH.	0:	All data is FFH in the area from FFE0H to FFFFH.
		1:	The value except FFH is included in the area from FFE0H to FFFFH.

Some operation commands are limited by the flash memory status code 1. If the read protection is enabled, flash memory writing mode command can not be executed. Erase all flash memory before executing these command.

RPENA	BLANK	Flash Memory Writing Mode	Flash memory SUM Output Mode	Product ID Code Output Mode	Flash Memory Status Output Mode	Flash Memory Erasing Mode		Read Protection Setting Mode
						Chip Erase	Sector Erase	
0	0	m	m	m	m	m		×
0	1	Pass	m	m	m	Pass		Pass
1	0	×	m	m	m	m	×	×
1	1	×	m	m	m	Pass	×	Pass

Note: m: The command can be executed.

Pass: The command can be executed with a password.

×: The command can not be executed.

(After echoing the command back to the external controller, TMP86FS28DFG stops UART communication and enters the halt condition.)

# 18.13 Specifying the Erasure Area

In the flash memory erasing mode, the erasure area of the flash memory is specified by n–2 byte data.

The start address of an erasure area is specified by ERASTA, and the end address is specified by ERAEND.

If ERASTA is equal to or smaller than ERAEND, the sector erase (erasure in 4 kbyte units) is executed. Executing the sector erase while the read protection is enabled results in an infinite loop.

If ERASTA is larger than ERAEND, the chip erase (erasure of an entire flash memory area) is executed and the read protection is disabled. Therefore, execute the chip erase (not sector erase) to disable the read protection.

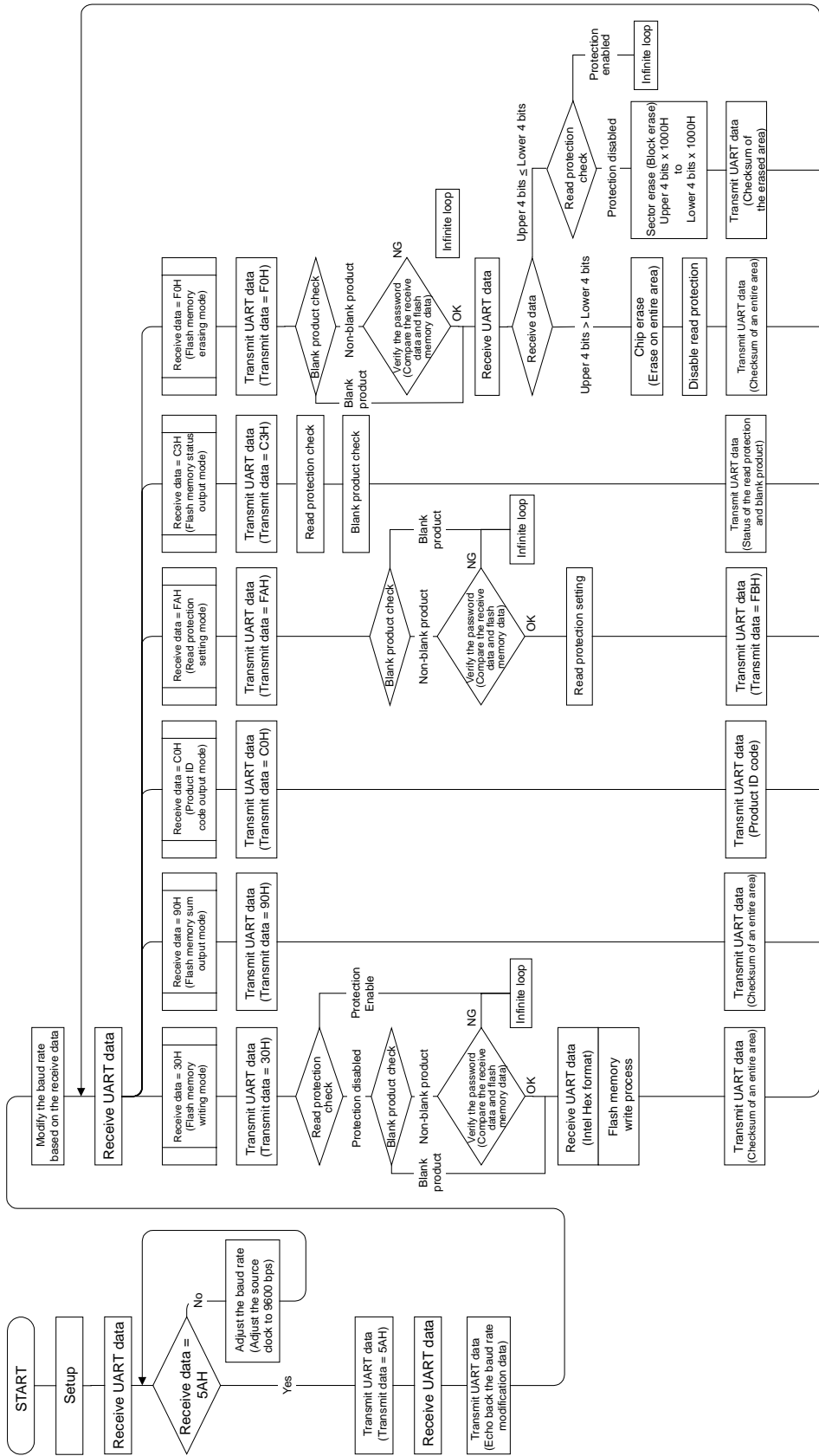
Erasure Area Specification Data (n–2 byte data)

7	6	5	4	3	2	1	0
ERASTA				ERAEND			

ERASTA	The start address of the erasure area	0000: from 0000H 0001: from 1000H 0010: from 2000H 0011: from 3000H 0100: from 4000H 0101: from 5000H 0110: from 6000H 0111: from 7000H 1000: from 8000H 1001: from 9000H 1010: from A000H 1011: from B000H 1100: from C000H 1101: from D000H 1110: from E000H 1111: from F000H
ERAEND	The end address of the erasure area	0000: to 0FFFH 0001: to 1FFFH 0010: to 2FFFH 0011: to 3FFFH 0100: to 4FFFH 0101: to 5FFFH 0110: to 6FFFH 0111: to 7FFFH 1000: to 8FFFH 1001: to 9FFFH 1010: to AFFFH 1011: to BFFFH 1100: to CFFFH 1101: to DFFFH 1110: to EFFFH 1111: to FFFFH

Note: When the sector erase is executed for the area containing no flash cell, TMP86FS28DFG stops the UART communication and enters the halt condition.

18.14Flowchart





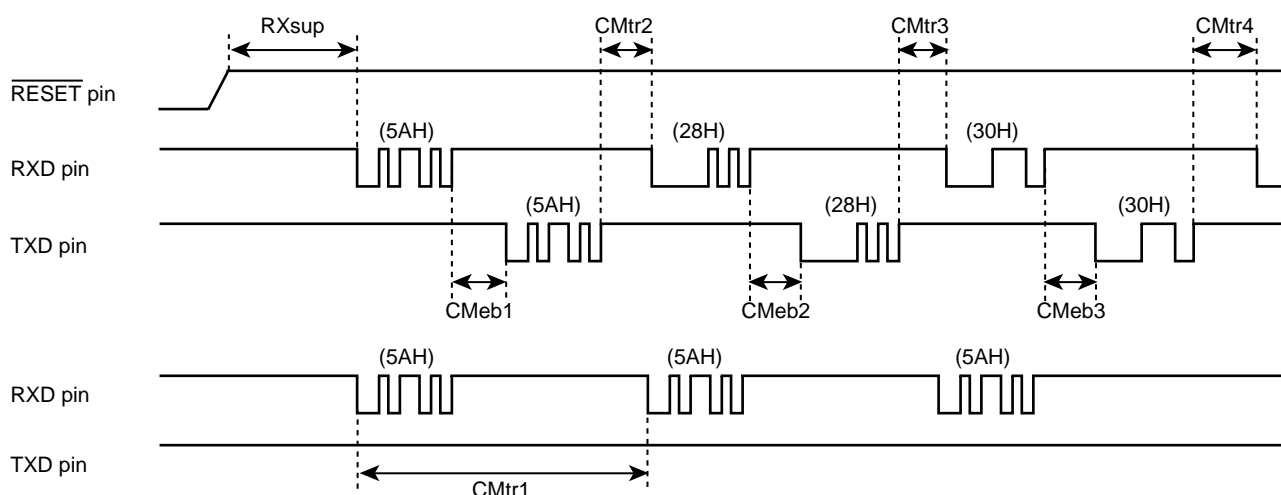
## 18.15UART Timing

Table 18-18 UART Timing-1 (VDD = 4.5 to 5.5 V, fc = 2 to 16 MHz, Topr = -10 to 40°C)

Parameter	Symbol	Clock Frequency (fc)	Minimum Required Time	
			At fc = 2 MHz	At fc = 16 MHz
Time from matching data reception to the echo back	CMeb1	Approx. 930	465 $\mu$ s	58.1 $\mu$ s
Time from baud rate modification data reception to the echo back	CMeb2	Approx. 980	490 $\mu$ s	61.3 $\mu$ s
Time from operation command reception to the echo back	CMeb3	Approx. 800	400 $\mu$ s	50 $\mu$ s
Checksum calculation time	CKsm	Approx. 7864500	3.93 s	491.5 $\mu$ s
Erase time of an entire flash memory	CEall	-	30 ms	30 ms
Erase time for a sector of a flash memory (in 4-kbyte units)	CEsec	-	15 ms	15 ms

Table 18-19 UART Timing-2 (VDD = 4.5 to 5.5 V, fc = 2 to 16 MHz, Topr = -10 to 40°C)

Parameter	Symbol	Clock Frequency (fc)	Minimum Required Time	
			At fc = 2 MHz	At fc = 16 MHz
Time from the reset release to the acceptance of start bit of RXD pin	RXsup	2100	1.05 ms	131.3 ms
Matching data transmission interval	CMtr1	28500	14.2 ms	1.78 ms
Time from the echo back of matching data to the acceptance of baud rate modification data	CMtr2	380	190 $\mu$ s	23.8 $\mu$ s
Time from the echo back of baud rate modification data to the acceptance of an operation command	CMtr3	650	325 $\mu$ s	40.6 $\mu$ s
Time from the echo back of operation command to the acceptance of password count storage addresses (Upper byte)	CMtr4	800	400 $\mu$ s	50 $\mu$ s





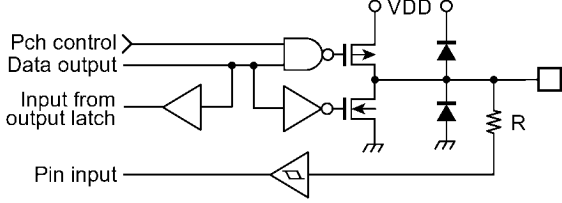
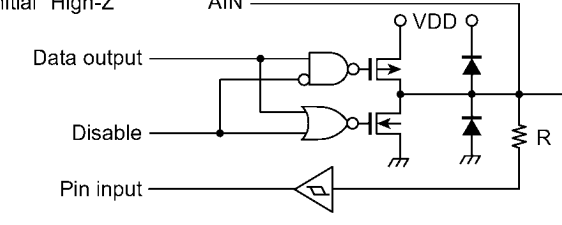
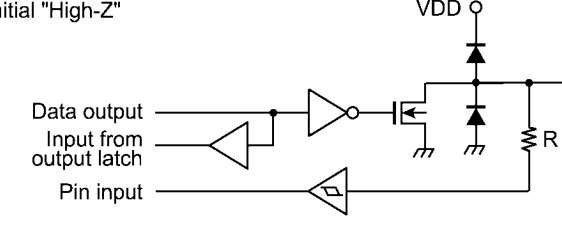
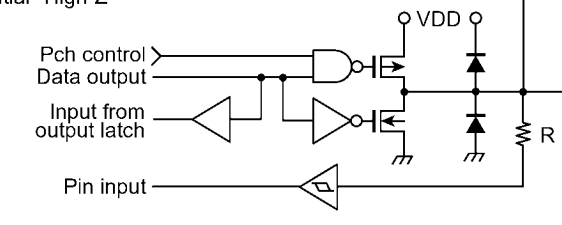
## 19.1 Control Pins

The input/output circuitries of the TMP86FS28DFG control pins are shown below.

Control Pin	I/O	Input/Output Circuitry	Remarks
XIN XOUT	Input Output		Resonator connecting pins (high-frequency) $R_f = 1.2 \text{ M}\Omega$ (typ.) $R_O = 0.5 \text{ k}\Omega$ (typ.)
XTIN XTOUT	Input Output		Resonator connecting pins (Low-frequency) $R_f = 6 \text{ M}\Omega$ (typ.) $R_O = 220 \text{ k}\Omega$ (typ.)
$\overline{\text{RESET}}$	Input		Hysteresis input Pull-up resistor $R_{IN} = 220 \text{ k}\Omega$ (typ.)
TEST	Input		Without pull-down resistor $R = 1 \text{ k}\Omega$ (typ.) Fix the TEST pin at low-level in MCU mode.

Note: The TEST pin of the TMP86FS28 does not have a pull-down resistor. Fix the TEST pin at low-level in MCU mode.

19.2 Input/Output Ports

Port	I/O	Input/Output Circuitry	Remarks
P0,P3	Input Output	<p>Initial "High-Z"</p> 	Sink open drain output or C-MOS output Hysteresis input R = 100 Ω (typ.)
P1	Input Output	<p>Initial "High-Z"</p> 	Tri-state I/O Hysteresis input AIN input R = 100 W (typ.)
P2	Input Output	<p>Initial "High-Z"</p> 	Sink open drain output Hysteresis input R = 100 Ω (typ.)
P4,P5,P6,P7,P8	Input Output	<p>Initial "High-Z"</p> 	Sink open drain output or C-MOS output Hysteresis input R = 100 Ω (typ.)  LCD segment output

## 20. Electrical Characteristics

### 20.1 Absolute Maximum Ratings

The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

( $V_{SS} = 0\text{ V}$ )

Parameter	Symbol	Pins	Ratings	Unit
Supply voltage	$V_{DD}$		-0.3 to 6.5	V
Input voltage	$V_{IN}$		-0.3 to $V_{DD} + 0.3$	
Output voltage	$V_{OUT}$		-0.3 to $V_{DD} + 0.3$	
Output current (Per 1 pin)	$I_{OL1}$	P0,P1,P2,P3,P4,P5,P6,P7,P8 ports	3.2	mA
	$I_{OH1}$	P0,P1,P3,P4,P5,P6,P7,P8 ports	-1.8	
Output current (Total)	$\Sigma I_{OL1}$	P0,P1,P2,P3,P4,P5,P6,P7,P8 ports	80	
	$\Sigma I_{OH1}$	P0,P1,P3,P4,P5,P6,P7,P8 ports	-30	
Power dissipation [ $T_{opr} = 85^{\circ}\text{C}$ ]	$P_D$		350	mW
Soldering temperature (Time)	$T_{sld}$		260 (10 s)	$^{\circ}\text{C}$
Storage temperature	$T_{stg}$		-55 to 125	
Operating temperature	$T_{opr}$		-40 to 85	

## 20.2 Operating Condition

The Operating Conditions show the conditions under which the device be used in order for it to operate normally while maintaining its quality. If the device is used outside the range of Operating Conditions (power supply voltage, operating temperature range, or AC/DC rated values), it may operate erratically. Therefore, when designing your application equipment, always make sure its intended working conditions will not exceed the range of Operating Conditions.

### 20.2.1 MCU mode (Flash Programming or erasing)

(V<sub>SS</sub> = 0 V, Topr = -10 to 40°C)

Parameter	Symbol	Pins	Ratings	Min	Max	Unit
Supply voltage	V <sub>DD</sub>		NORMAL1, 2 modes	4.5	5.5	V
Input high level	V <sub>IH1</sub>	Except hysteresis input	V <sub>DD</sub> ≥ 4.5 V	V <sub>DD</sub> × 0.70	V <sub>DD</sub>	
	V <sub>IH2</sub>	Hysteresis input		V <sub>DD</sub> × 0.75		
Input low level	V <sub>IL1</sub>	Except hysteresis input	V <sub>DD</sub> ≥ 4.5 V	0	V <sub>DD</sub> × 0.30	
	V <sub>IL2</sub>	Hysteresis input			V <sub>DD</sub> × 0.25	
Clock frequency	fc	XIN, XOUT		1.0	16.0	MHz

### 20.2.2 MCU mode (Except Flash Programming or erasing)

(V<sub>SS</sub> = 0 V, Topr = -40 to 85°C)

Parameter	Symbol	Pins	Condition		Min	Max	Unit
Supply voltage	V <sub>DD</sub>		fc = 16 MHz	NORMAL1, 2 mode	4.0	5.5	V
				IDLE0, 1, 2 mode			
			fc = 8 MHz	NORMAL1, 2 mode	2.7(Note1)		
				IDLE0, 1, 2 mode			
			fs = 32.768 kHz	SLOW1, 2 mode			
				SLEEP0, 1, 2 mode			
	STOP mode						
Input high level	V <sub>IH1</sub>	Except hysteresis input	V <sub>DD</sub> ≥ 4.5 V		V <sub>DD</sub> × 0.70	V <sub>DD</sub>	
	V <sub>IH2</sub>	Hysteresis input			V <sub>DD</sub> × 0.75		
	V <sub>IH3</sub>				V <sub>DD</sub> < 4.5 V		V <sub>DD</sub> × 0.90
Input low level	V <sub>IL1</sub>	Except hysteresis input	V <sub>DD</sub> ≥ 4.5 V		0	V <sub>DD</sub> × 0.30	
	V <sub>IL2</sub>	Hysteresis input				V <sub>DD</sub> × 0.25	
	V <sub>IL3</sub>					V <sub>DD</sub> < 4.5 V	V <sub>DD</sub> × 0.10
Clock frequency	fc	XIN, XOUT	V <sub>DD</sub> = 2.7 V to 5.5 V		1.0	8.0	MHz
			V <sub>DD</sub> = 4.0 V to 5.5 V			16.0	
	fs	XTIN, XTOUT	V <sub>DD</sub> = 2.7 V to 5.5 V		30.0	34.0	kHz
LCD reference voltage range	V1		LCD booster circuit enable (V3 ≥ V <sub>DD</sub> )		0.9	1.8	V
Capacity for LCD booster circuit	C <sub>LCD</sub>				0.1	0.47	uF

Note 1: When the supply voltage is V<sub>DD</sub> < 3.0V, the operating temperture is Topr = -20 to 85 °C.

## 20.2.3 Serial PROM mode

(V<sub>SS</sub> = 0 V, T<sub>opr</sub> = -10 to 40 °C)

Parameter	Symbol	Pins	Condition	Min	Max	Unit
Supply voltage	V <sub>DD</sub>		NORMAL 1, 2 modes	4.5	5.5	V
Input high voltage	V <sub>IH1</sub>	Except hysteresis input	V <sub>DD</sub> ≥ 4.5 V	V <sub>DD</sub> × 0.70	V <sub>DD</sub>	
	V <sub>IH2</sub>	Hysteresis input		V <sub>DD</sub> × 0.75		
Input low voltage	V <sub>IL1</sub>	Except hysteresis input	V <sub>DD</sub> ≥ 4.5 V	0	V <sub>DD</sub> × 0.30	
	V <sub>IL2</sub>	Hysteresis input			V <sub>DD</sub> × 0.25	
Clock frequency	fc	XIN, XOUT		2.0	16.0	MHz

20.3 DC Characteristics

(V<sub>SS</sub> = 0 V, T<sub>opr</sub> = -40 to 85°C)

Parameter	Symbol	Pins	Condition		Min	Typ.	Max	Unit
Hysteresis voltage	V <sub>HS</sub>	Hysteresis input			–	0.9	–	V
Input current	I <sub>IN1</sub>	TEST	V <sub>DD</sub> = 5.5 V, V <sub>IN</sub> = 5.5 V/0 V		–	–	±2	μA
	I <sub>IN2</sub>	Sink open drain, Tri-state						
	I <sub>IN3</sub>	$\overline{\text{RESET}}$ , $\overline{\text{STOP}}$						
Input resistance	R <sub>IN2</sub>	$\overline{\text{RESET}}$ pull-up	V <sub>DD</sub> = 5.5 V, V <sub>IN</sub> = 0 V		100	220	450	kΩ
Output leakage current	I <sub>LO</sub>	Sink open drain, Tri-state	V <sub>DD</sub> = 5.5 V, V <sub>OUT</sub> = 5.5 V/0 V		–	–	±2	μA
Output high voltage	V <sub>OH</sub>	C-MOS, Tri-st port	V <sub>DD</sub> = 4.5 V, I <sub>OH</sub> = –0.7 mA		4.1	–	–	V
Output low voltage	V <sub>OL</sub>	Except XOUT	V <sub>DD</sub> = 4.5 V, I <sub>OL</sub> = 1.6 mA		–	–	0.4	
LCD output voltage use LCD driver's booste	V <sub>2-3OUT</sub>	V2 terminal	V3 ≥ V <sub>DD</sub>		–	V1 x 2	–	V
		V3 terminal	Reference supply terminal :V1 SEG/COM terminal no load		–	V1 x 3	–	
Supply current in NORMAL 1, 2 mode	I <sub>DD</sub>		V <sub>DD</sub> = 5.5 V V <sub>IN</sub> = 5.3/0.2 V fc = 16 MHz fs = 32.768 kHz	When a program operates on flash memory (Note5,6)	–	15.5	16.5	mA
Supply current in IDLE 0, 1, 2 mode					–	6	8.3	
Supply current in SLOW 1 mode			V <sub>DD</sub> = 3.0 V V <sub>IN</sub> = 2.8/0.2 V fs = 32.768 kHz LCD drive is not enable.	When a program operates on flash memory (Note5,6)	–	25	260	μA
				When a program operates on RAM	–	20	24	
Supply current in SLEEP 1 mode				–	9	21		
Supply current in SLEEP 0 mode				–	8	18		
Supply current in STOP mode			V <sub>DD</sub> = 5.5 V V <sub>IN</sub> = 5.3 V/0.2 V	–	0.5	10		

- Note 1: Typical values show those at T<sub>opr</sub> = 25°C, V<sub>DD</sub> = 5 V
- Note 2: Input current (I<sub>IN1</sub>, I<sub>IN2</sub>); The current through pull-up or pull-down resistor is not included.
- Note 3: I<sub>DD</sub> does not include I<sub>REF</sub> current.
- Note 4: The supply currents of SLOW 2 and SLEEP 2 modes are equivalent to IDLE 0, 1, 2.
- Note 5: When a program is executing in the flash memory or when data is being read from the flash memory, the flash memory operates in an intermittent manner, causing peak currents in the operation current, as shown in Figure 20-1.  
In this case, the supply current I<sub>DD</sub> (in NORMAL1, NORMAL2 and SLOW1 modes) is defined as the sum of the average peak current and MCU current.
- Note 6: When designing the power supply, make sure that peak currents can be supplied. In SLOW1 mode, the difference between the peak current and the average current becomes large.

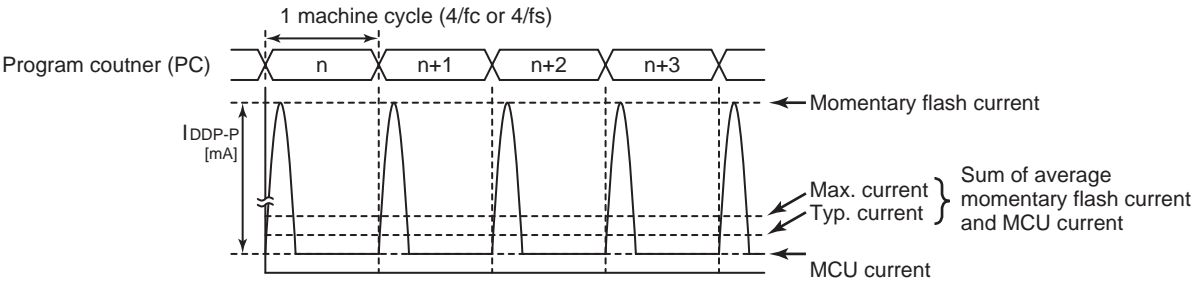


Figure 20-1 Intermittent Operation of Flash Memory



## 20.4 AD Conversion Characteristics

(V<sub>SS</sub> = 0.0 V, 4.5 V ≤ V<sub>DD</sub> ≤ 5.5 V, T<sub>opr</sub> = -40 to 85°C)

Parameter	Symbol	Condition	Min	Typ.	Max	Unit
Analog reference voltage	V <sub>AREF</sub>		A <sub>VDD</sub> – 1.0	–	A <sub>VDD</sub>	V
Power supply voltage of analog control circuit (Note6)	A <sub>VDD</sub>		V <sub>DD</sub>			
	A <sub>VSS</sub>		V <sub>SS</sub>			
Analog reference voltage range (Note4)	ΔV <sub>AREF</sub>		3.5	–	–	
Analog input voltage	V <sub>AIN</sub>		A <sub>VSS</sub>	–	V <sub>AREF</sub>	
Power supply current of analog reference voltage	I <sub>REF</sub>	V <sub>DD</sub> = A <sub>VDD</sub> = V <sub>AREF</sub> = 5.5 V V <sub>SS</sub> = A <sub>VSS</sub> = 0.0 V	–	0.6	1.0	mA
Non linearity error		V <sub>DD</sub> = A <sub>VDD</sub> = 5.0 V V <sub>SS</sub> = A <sub>VSS</sub> = 0.0 V V <sub>AREF</sub> = 5.0 V	–	–	±2	LSB
Zero point error			–	–	±2	
Full scale error			–	–	±2	
Total error			–	–	±2	

(V<sub>SS</sub> = 0.0 V, 2.7 V ≤ V<sub>DD</sub> < 4.5 V, T<sub>opr</sub> = -40 to 85°C)

Parameter	Symbol	Condition	Min	Typ.	Max	Unit
Analog reference voltage	V <sub>AREF</sub>		A <sub>VDD</sub> − 1.0	−	A <sub>VDD</sub>	V
Power supply voltage of analog control circuit (Note6)	A <sub>VDD</sub>		V <sub>DD</sub>			
	A <sub>VSS</sub>		V <sub>SS</sub>			
Analog reference voltage range (Note4)	ΔV <sub>AREF</sub>		2.5	−	−	
Analog input voltage	V <sub>AIN</sub>		V <sub>SS</sub>	−	V <sub>AREF</sub>	
Power supply current of analog reference voltage	I <sub>REF</sub>	V <sub>DD</sub> = A <sub>VDD</sub> = V <sub>AREF</sub> = 4.5 V V <sub>SS</sub> = A <sub>VSS</sub> = 0.0 V	−	0.5	0.8	mA
Non linearity error		V <sub>DD</sub> = A <sub>VDD</sub> = 2.7 V V <sub>SS</sub> = A <sub>VSS</sub> = 0.0 V V <sub>AREF</sub> = 2.7 V	−	−	±2	LSB
Zero point error			−	−	±2	
Full scale error			−	−	±2	
Total error			−	−	±2	

Note 1: The total error includes all errors except a quantization error, and is defined as a maximum deviation from the ideal conversion line.

Note 2: Conversion time is different in recommended value by power supply voltage.  
About conversion time, please refer to "Register Configuration".

Note 3: Please use input voltage to AIN input Pin in limit of V<sub>AREF</sub> to V<sub>SS</sub>. When voltage of range outside is input, conversion value becomes unsettled and gives affect to other channel conversion value.

Note 4: Analog reference voltage range: ΔV<sub>AREF</sub> = V<sub>AREF</sub> - V<sub>SS</sub>

Note 5: When AD is used with V<sub>DD</sub> < 2.7 V, the guaranteed temperature range varies with the operating voltage.

Note 6: The A<sub>VDD</sub> pin should be fixed on the V<sub>DD</sub> level even though AD converter is not used.

## 20.5 AC Characteristics

( $V_{SS} = 0\text{ V}$ ,  $V_{DD} = 4.0\text{ to }5.5\text{ V}$ ,  $T_{opr} = -40\text{ to }85^{\circ}\text{C}$ )

Parameter	Symbol	Condition	Min	Typ.	Max	Unit
Machine cycle time	tcy	NORMAL1, 2 mode	0.25	—	4	μs
		IDLE1, 2 mode				
		SLOW1, 2 mode	117.6	—	133.3	
		SLEEP1, 2 mode				
High level clock pulse width	t <sub>WCH</sub>	For external clock operation (XIN input) fc = 16 MHz	—	31.25	—	ns
Low level clock pulse width	t <sub>WCL</sub>					
High level clock pulse width	t <sub>WCH</sub>	For external clock operation (XTIN input) fs = 32.768 kHz	—	15.26	—	μs
Low level clock pulse width	t <sub>WCL</sub>					

( $V_{SS} = 0\text{ V}$ ,  $V_{DD} = 2.7\text{ to }5.5\text{ V}$ ,  $T_{opr} = -40\text{ to }85^{\circ}\text{C}$ )

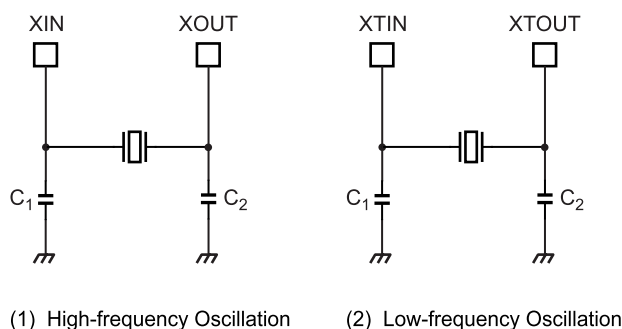
Parameter	Symbol	Condition	Min	Typ.	Max	Unit
Machine cycle time	t <sub>cy</sub>	NORMAL1, 2 mode	0.5	—	4	μs
		IDLE1, 2 mode				
		SLOW1, 2 mode	117.6	—	133.3	
		SLEEP1, 2 mode				
High level clock pulse width	t <sub>WCH</sub>	For external clock operation (XIN input) f <sub>c</sub> = 8 MHz	—	62.5	—	ns
Low level clock pulse width	t <sub>WCL</sub>					
High level clock pulse width	t <sub>WCH</sub>	For external clock operation (XTIN input) f <sub>s</sub> = 32.768 kHz	—	15.26	—	μs
Low level clock pulse width	t <sub>WCL</sub>					

Note 1: When the supply voltage is  $V_{DD} < 3.0\text{V}$ , the operating temperature is  $T_{opr} = -20\text{ to }85^{\circ}\text{C}$ .

## 20.6 Flash Characteristics

Parameter	Condition	Min	Typ.	Max	Unit
Number of guaranteed writes to flash memory	$V_{SS} = 0\text{ V}$ , $T_{opr} = -10\text{ to }40^{\circ}\text{C}$	–	–	100	Times

## 20.7 Recommended Oscillating Conditions



Note 1: To ensure stable oscillation, the resonator position, load capacitance, etc. must be appropriate. Because these factors are greatly affected by board patterns, please be sure to evaluate operation on the board on which the device will actually be mounted.

Note 2: For the resonators to be used with Toshiba microcontrollers, we recommend ceramic resonators manufactured by Murata Manufacturing Co., Ltd.

For details, please visit the website of Murata at the following URL:  
<http://www.murata.com>

## 20.8 Handling Precaution

- The solderability test conditions for lead-free products (indicated by the suffix G in product name) are shown below.

1. When using the Sn-37Pb solder bath
  - Solder bath temperature = 230 °C
  - Dipping time = 5 seconds
  - Number of times = once
  - R-type flux used
2. When using the Sn-3.0Ag-0.5Cu solder bath
  - Solder bath temperature = 245 °C
  - Dipping time = 5 seconds
  - Number of times = once
  - R-type flux used

Note: The pass criterion of the above test is as follows:

Solderability rate until forming  $\geq 95\%$

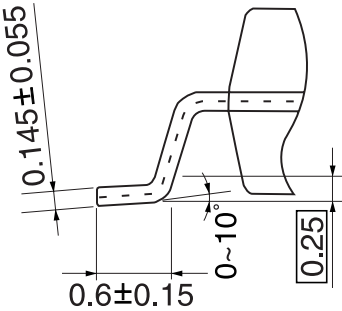
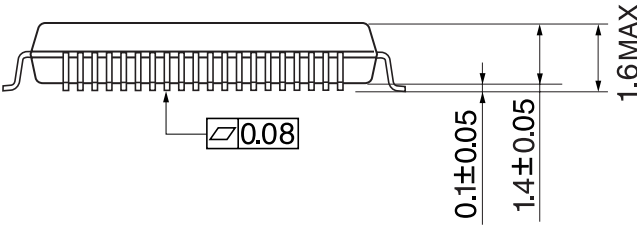
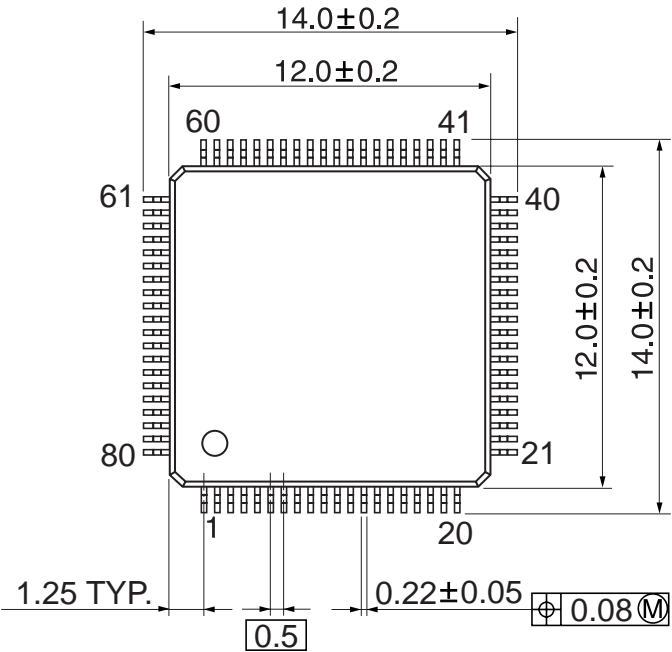
- When using the device (oscillator) in places exposed to high electric fields such as cathode-ray tubes, we recommend electrically shielding the package in order to maintain normal operating condition.



# 21. Package Dimensions

LQFP80-P-1212-0.50E Rev 01

Unit: mm





This is a technical document that describes the operating functions and electrical specifications of the 8-bit microcontroller series TLCS-870/C (LSI).

Toshiba provides a variety of development tools and basic software to enable efficient software development.

These development tools have specifications that support advances in microcomputer hardware (LSI) and can be used extensively. Both the hardware and software are supported continuously with version updates.

The recent advances in CMOS LSI production technology have been phenomenal and microcomputer systems for LSI design are constantly being improved. The products described in this document may also be revised in the future. Be sure to check the latest specifications before using.

Toshiba is developing highly integrated, high-performance microcomputers using advanced MOS production technology and especially well proven CMOS technology.

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